HEWLETT-PACKARD Service Manual Book 2

> 8642A/B SECTION 8 (continued)

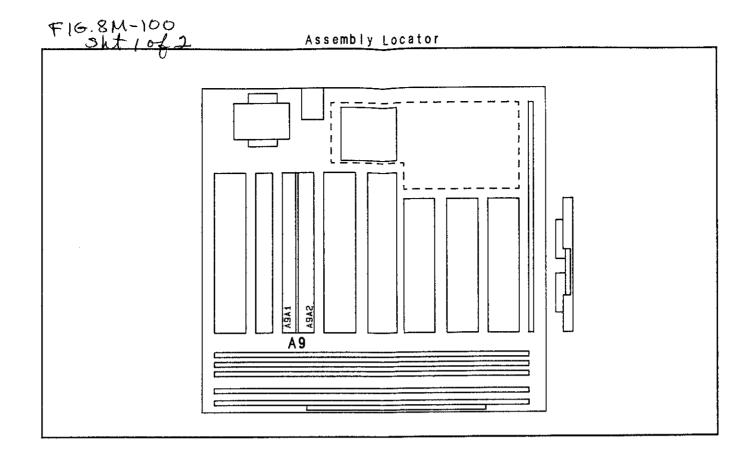
module Level Service

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A9 IF Loop Module



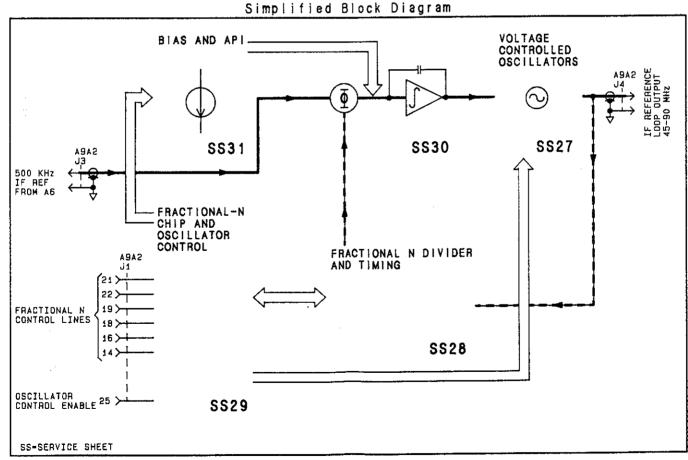
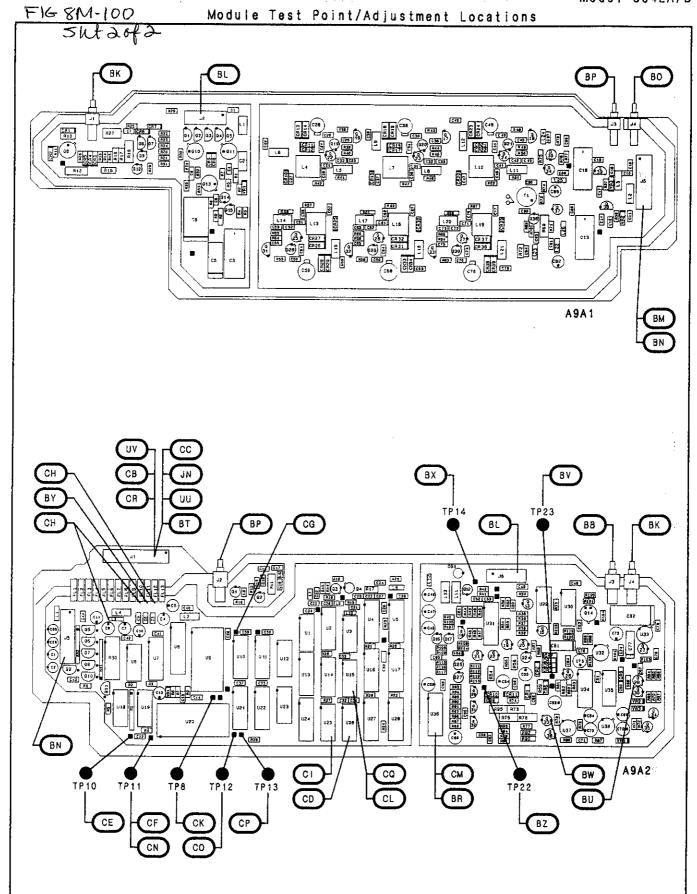
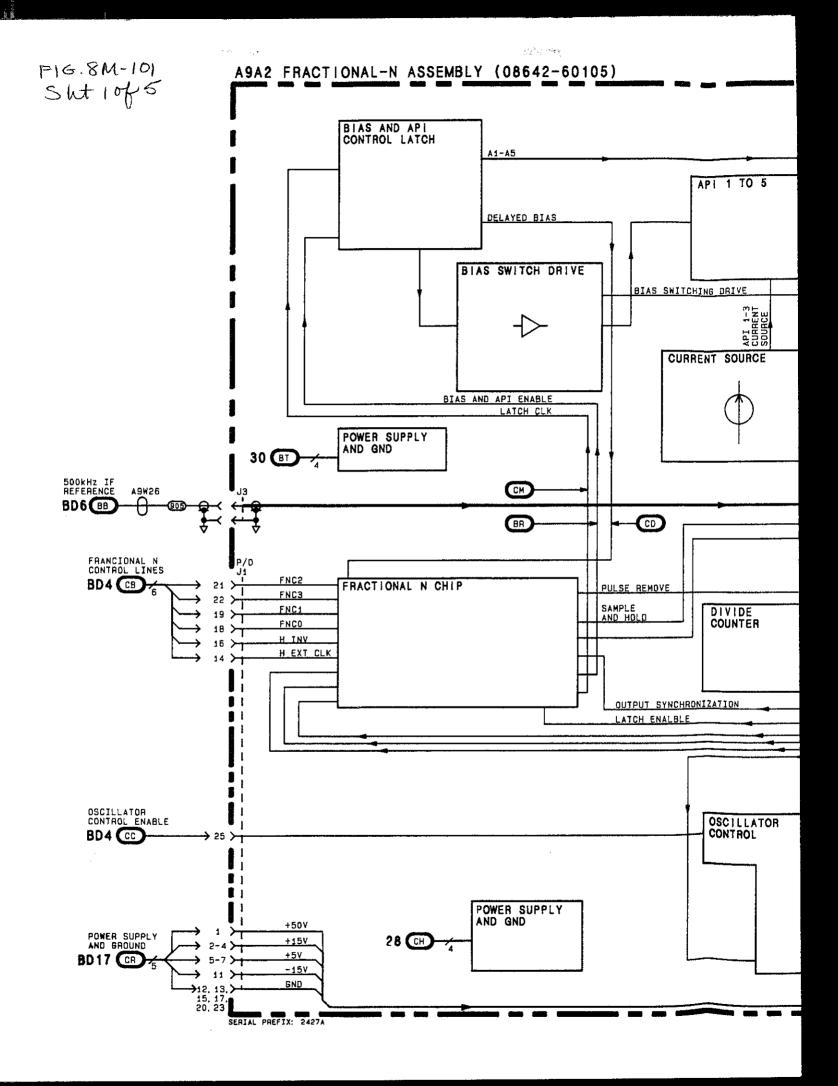
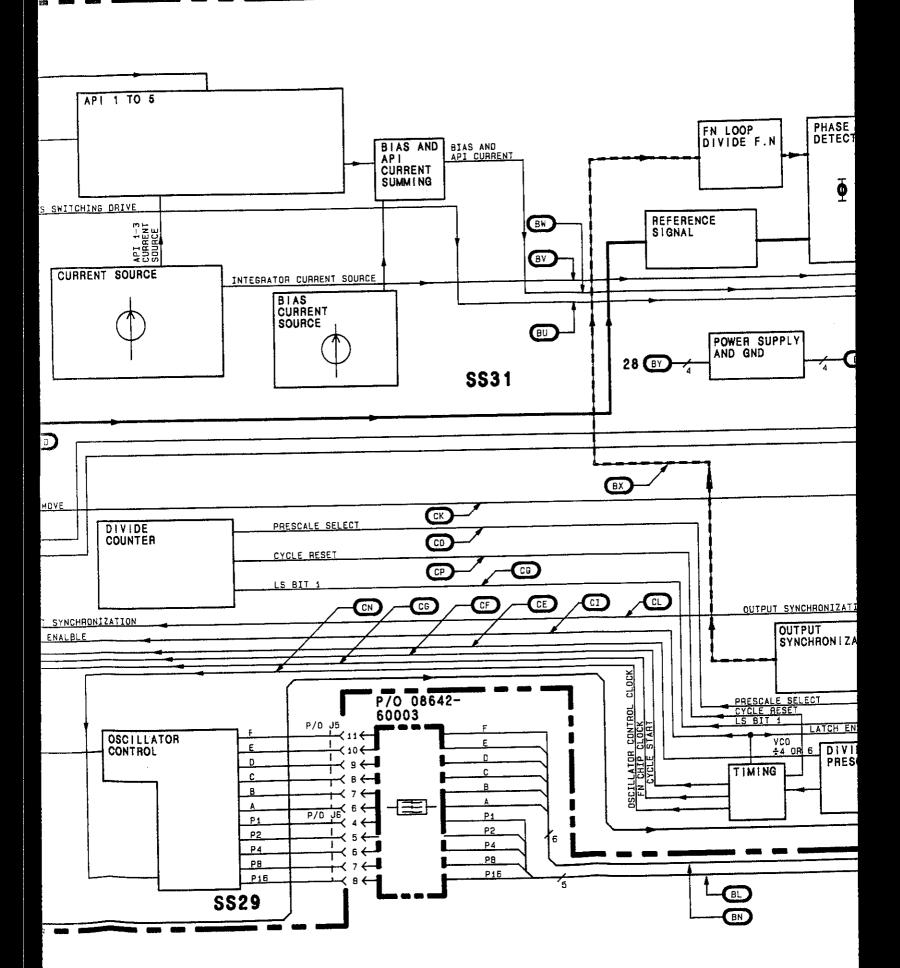


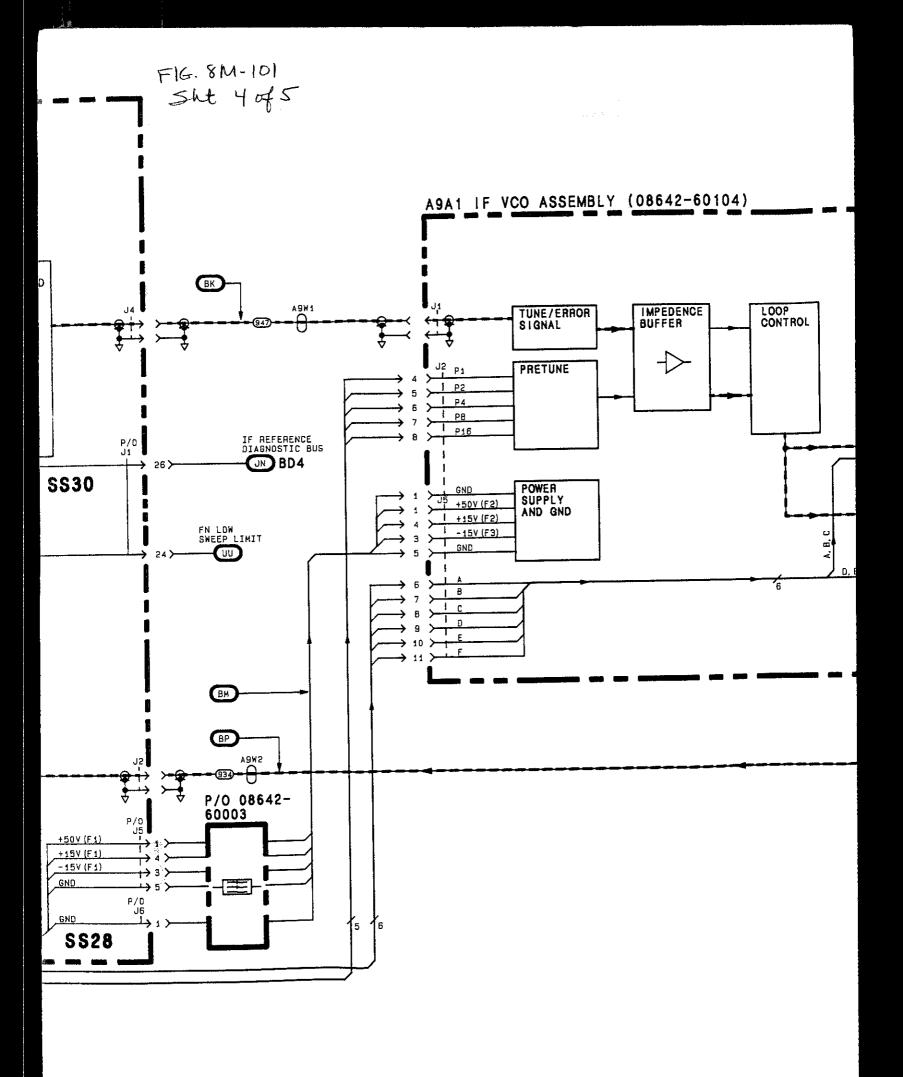
Figure 8M-100 BD10 General Information.







 $(\star, (\neg \gamma_i) \cap \overline{\mathcal{T}}_i)$ 



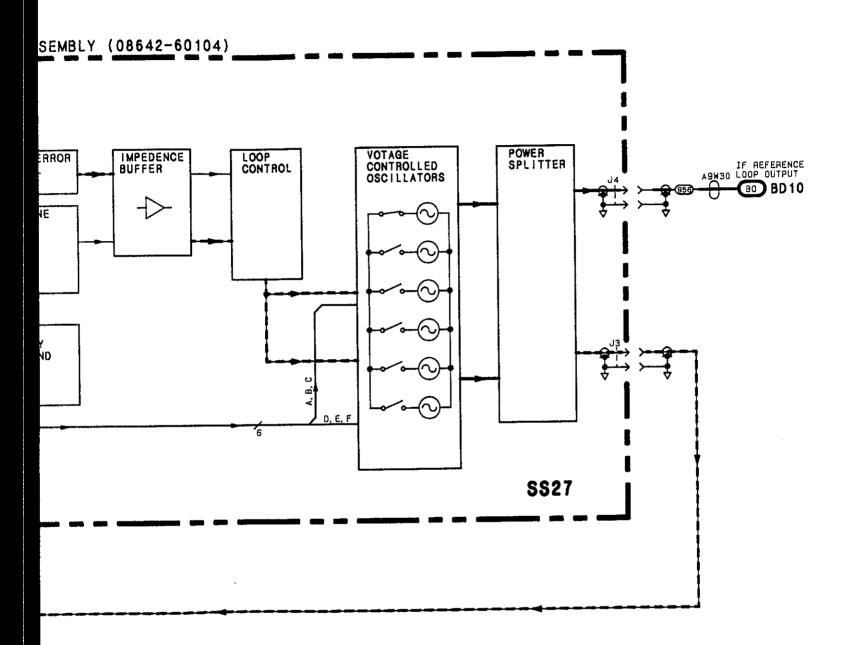
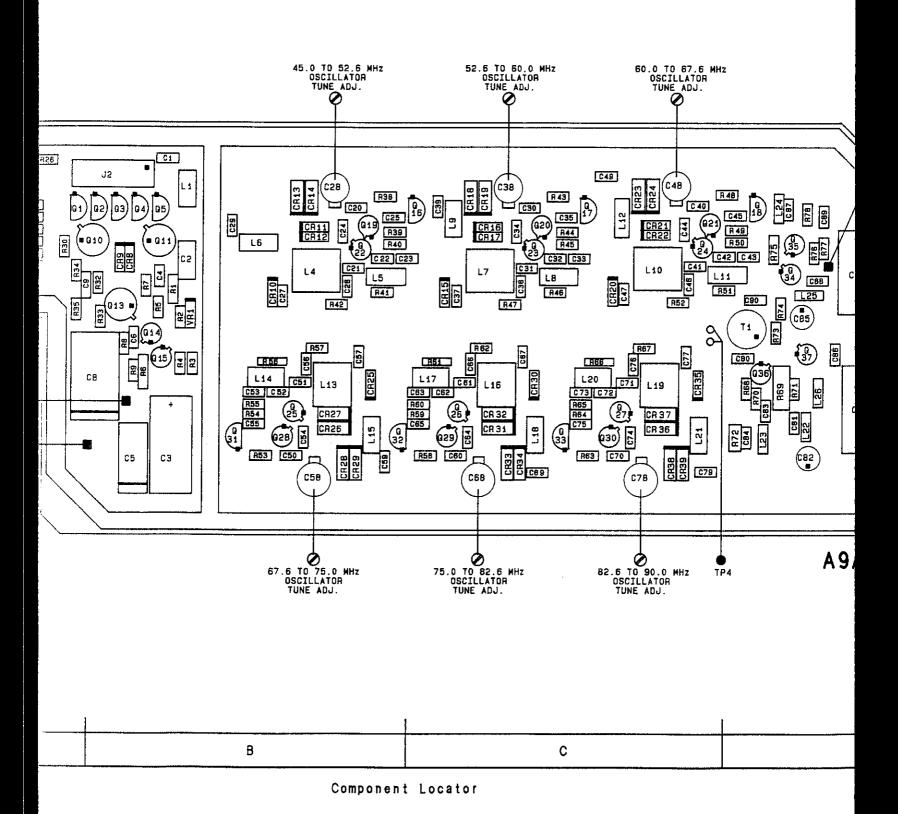
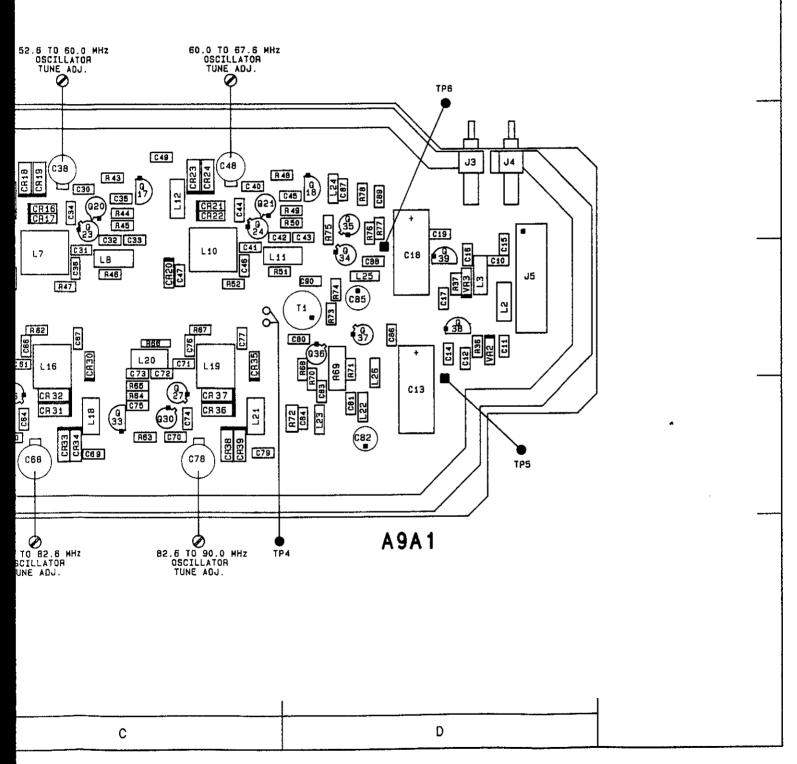
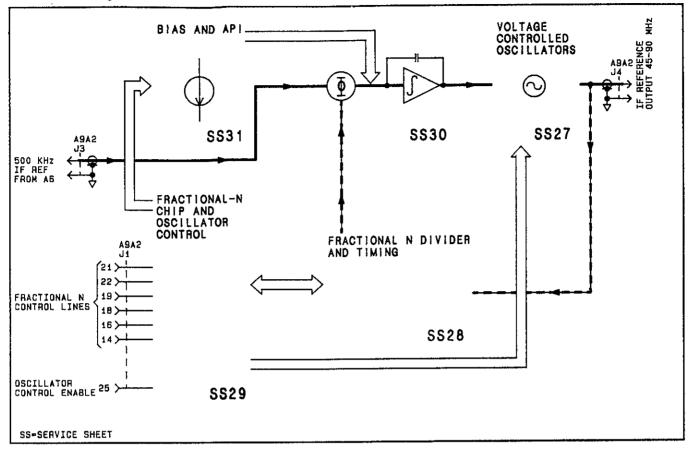


Figure 8M-102. SERVICE SHEET 27 INFORMATION







Reference Block Diagram

# Component Coordinates

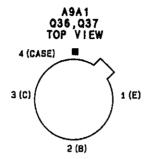
СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C1 C2 C3 C4 C5 C6 C7 C8	8 B B B B B B B A B A B A B A B A B A B	0 BB	G; 1 G; 1 G; 2 G; 1 G; 1 G; 1 G; 1 G; 2	C75 C76 C77 C78 C79 C80 C81 C82 C83	C. 3 C. 2 C. 3 C. 3 C. 3 C. 3 C. 3 C. 3 C. 3 C. 3	CR21 CR22 CR23 CR24 CR25 CR26 CR27 CR28 CR29	C.C.C.C.B.B.B.B.B.B.B.B.B.B.B.B.B.B.B.B	L12 L13 L14 L15 L16 L17 L18 L19 L20		022 023 024 025 026 027 028 029	B, 1 C, 1 B, 2 C, 3 B, 3 C, 3 B, 3 C, 3 C, 3	R19 R20 R21 R22 R23 R24 R25 R26 R27	A, 1 A, 1 A, 1 A, 1 A, 1 A, 1 A, 1 A, 1	956 957 959 959 960 961 962 963	8.8.0.0.0.0.0.0.0.0.0.0.0.0.0.0.0.0.0.0		
C10 C11 C12 C13 C14 C15 C16 C17	อออออออ อออออออ ออออออ อออออ อออออ อออออ	C47 C48 C49 C50 C51 C52 C53 C54	C. C. S.	C84 C85 C86 C87 C69 C90	0.3 0.2 0.1 0.1 0.1 0.2	CR30 CR31 CR32 CR33 CR34 CR35 CR35 CR36 CR37	ງ ເປັນປີ ປີ ປ	L21 L22 L23 L24 L25 L26	C.33 D.33 D.22 D. 4.1 B.1	031 032 033 034 035 036 037 038	8.8.3.3.2.1.2.2.2.2.2.2.2.2.2.2.2.2.2.2.2.2	R28 R29 R30 R31 R32 R33 R34 R35	A.A.A.B.B.A.A.D.	R65 R66 R67 R68 R69 R70 R71 R72 R73			
C18 C19 C20 C21 C22 C23 C24 C25 C26	0. 1 0. 1 8. 1 8. 1 8. 1 8. 1	C55 C56 C57 C58 C59 C60 C61 C62 C63	8.8.8.8.6.C.C.C.C.	CR2 CR3 CR4 CR5 CR6 CR7 CR8 CR9	A. 1 A. 1 A. 1 A. 1 A. 1 B. 1	CR39 J1 J2 J3 J4 J5	C. 3 A. 1 B. 1 D. 1 D. 1 D. 2	03 04 05 06 07 08 09	B. 1 B. 1 B. 1 A. 1 A. 1 A. 1 B. 1	R1 R2 R3 R4 R5 R6	B, 22 22 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	R37 R38 R39 R40 R41 R42 R43 R44	121112211 108886660	R74 R75 R76 R77 R78	D. 2 D. 1 D. 1 D. 1 D. 2		
C27 C28 C29 C30 C31 C32 C33	8 8 8 C C C C C C C C C C C C C C C C C	C64 C65 C66 C67 C68 C69 C70	ເວີດ ເວີດ ເວີດ ເວີດ ເສສາຂາຂາສາສາຂາຂ ເສສາຂາຂາສາສາຂາຂາຂາຂາຂາຂາຂາຂາຂາຂາຂາຂາຂາຂາ	CR10 CR11 CR12 CR13 CR14 CR15 CR15 CR16	12 1 1 1 1 1 2 1 1 B B B B C C C C	L1 L2 L3 L4 L5 L6 L7	8.00,222 8.00,832 8.00,222 8.00,222	9112 912 913 914 915 916 917	8.4.8.2.2.1.1.1.1.1	RB R9 R10 R11 R12 R13 R14 R15	B, 2 B, 1 A, 1 A, 2 A, 1 A, 1 A, 1	R45 R46 R47 R48 R49 R50 R51 R52	12211122	TP1 TP2 TP3 TP5 TP6 VR1 VR2	A, 23 B, 33 D, 0, 22 B, 22 B, 23 B,		
C35 C36 C37	0.00	C72 C73 C74	C. 3	CR18 CR19 CR20	C, 1 C, 1 C, 2	L9 L10 L11	C, 2 C, 2	019 020 021	B. 1 C. 1 C. 1	R16 R17 R18	A. 2 A. 1 A, 1	R53 R54 R55	B. 3 B. 3 B. 3	VR3	D, 2		

A9 MODULE BD 10

SEE REVERSE SIDE

## Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.



# **CHANGES**

### All Serial Prefixes

On the component locator:

• <u>C85</u> - Delete C85.

# In component coordinates:

• <u>C85</u> - Delete C85.

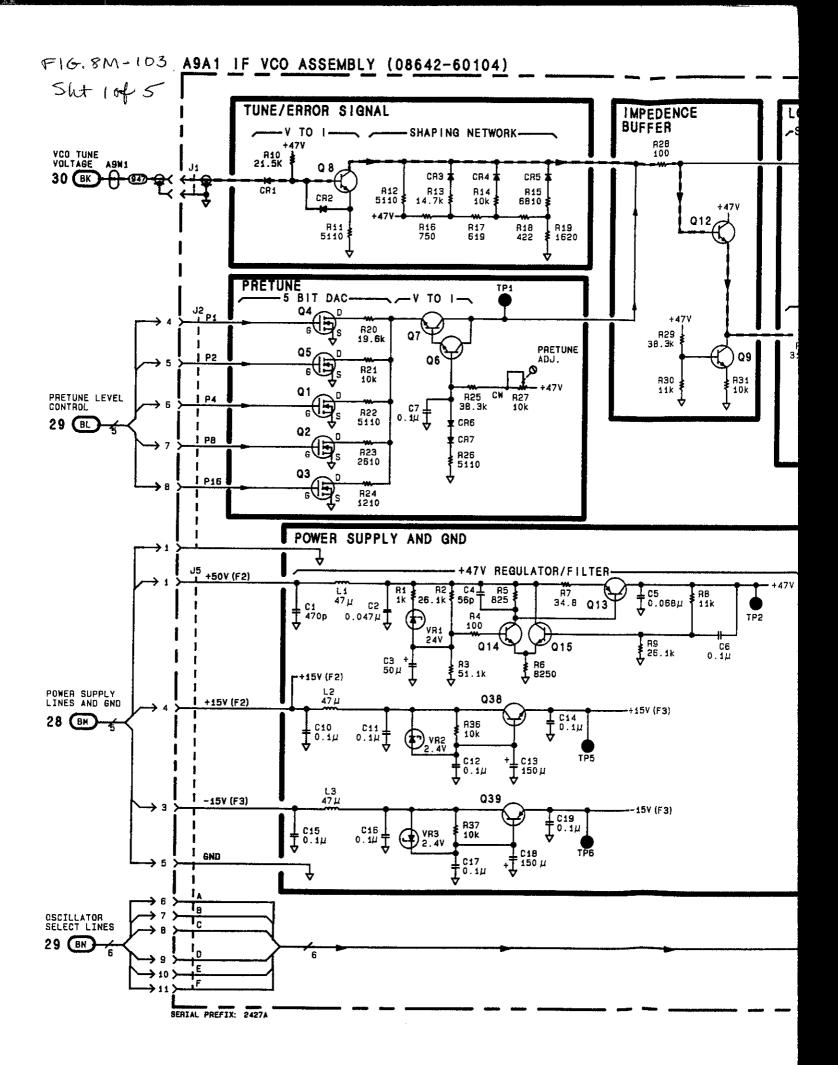
### On the schematic:

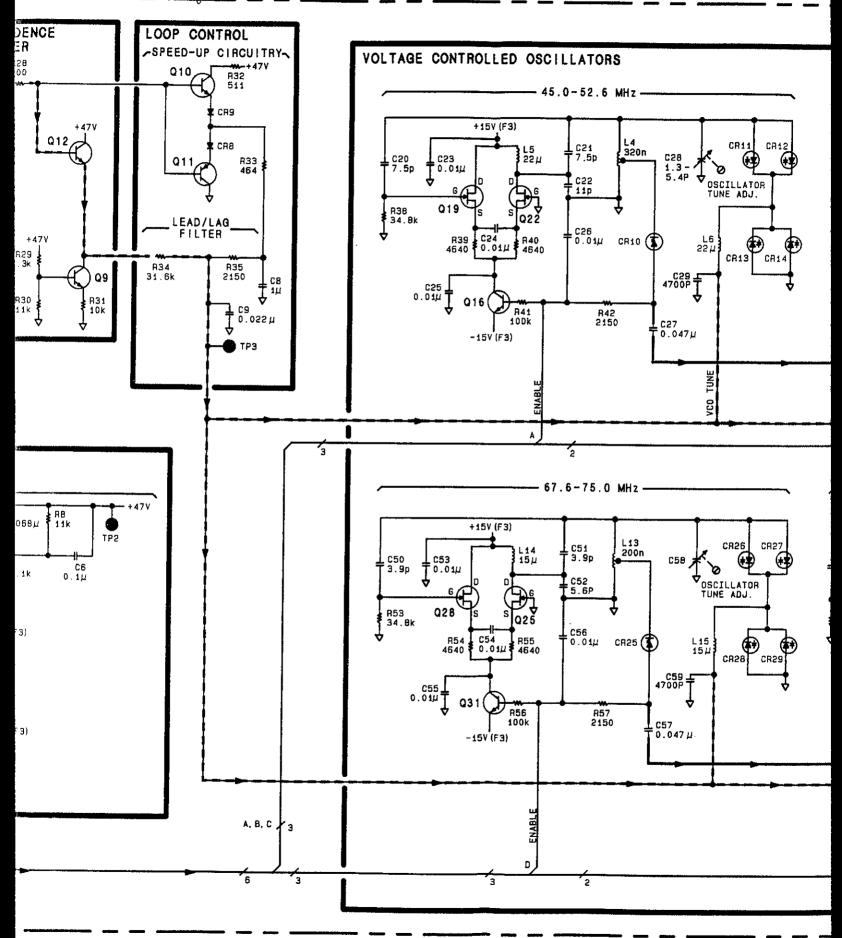
- <u>C9</u> In LOOP CONTROL, change C9 to 0.047μ.
- C28, C38, C48 + In VOLTAGE CONTROLLED OSCILLATORS, change C28, C38, and C48 (all labeled "OSCILLATOR TUNE ADJUST") ranges to span 1.7 to 7.4p.
- <u>C85</u> In POWER SPLITTER, delete C85. In the same location, change +15V(F2) to +15V(F3).
- C30, C31, C32 In VOLTAGE CONTROLLED OSCILLATORS, under the "52.6-60.0 MHz bracket, change C30 and C31 to 6.8p. In the same location, change C32 to 10p.

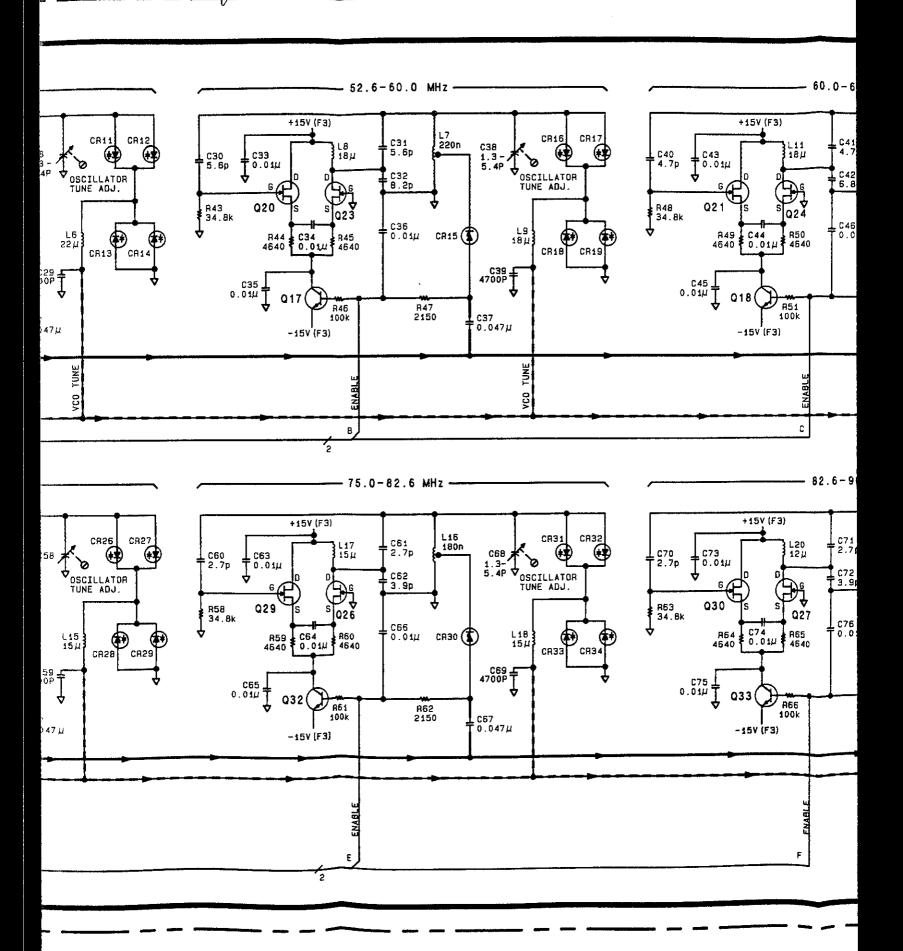
# 2615A and above

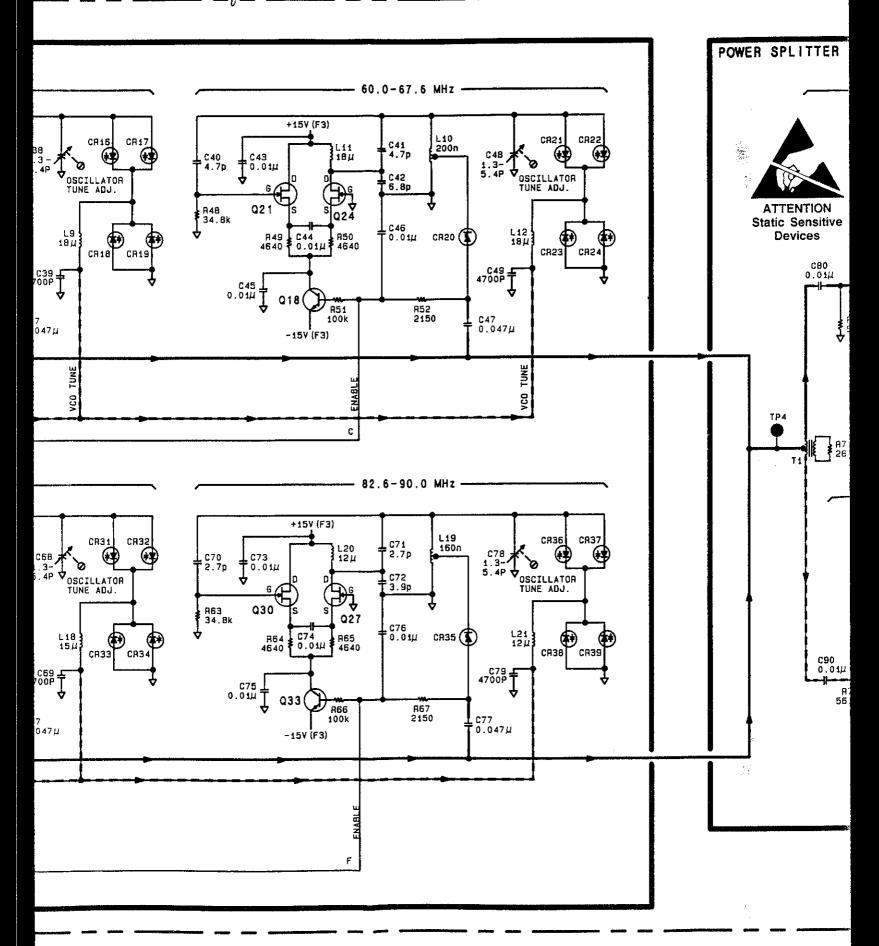
### On the schematic:

- <u>C70</u> In VOLTAGE CONTROLLED OSCILLATORS, under the "82.6 90.0 MHz bracket, change C70 from 2.7p to 2.2 pF.
- C71 In VOLTAGE CONTROLLED OSCILLATORS, under the "82.6 90.0 MHz bracket, change C71 from 2.7p to 3.3 pF.
- R78 In the lower portion of POWER SPLITTER, connect the base of Q35 to ground and delete R78.





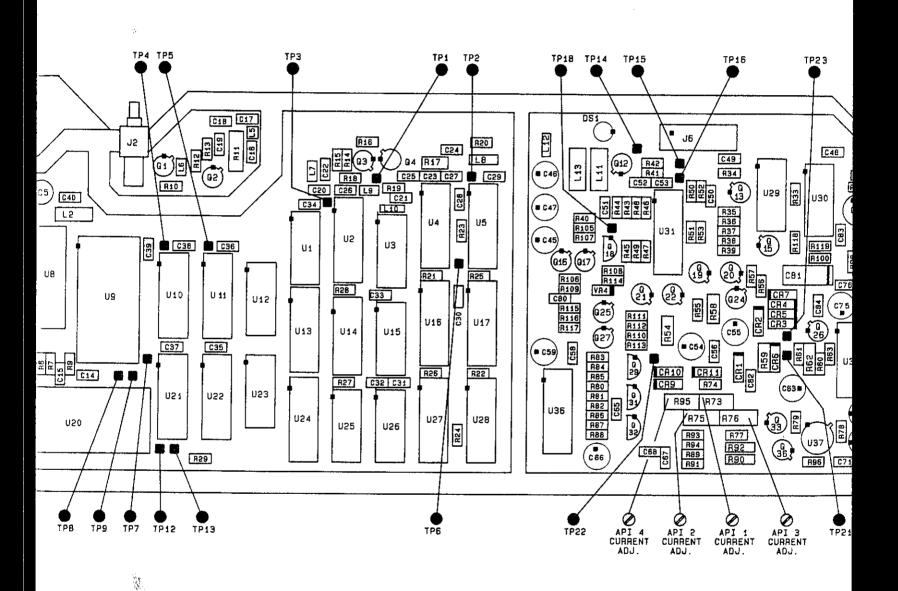




**SS27** 

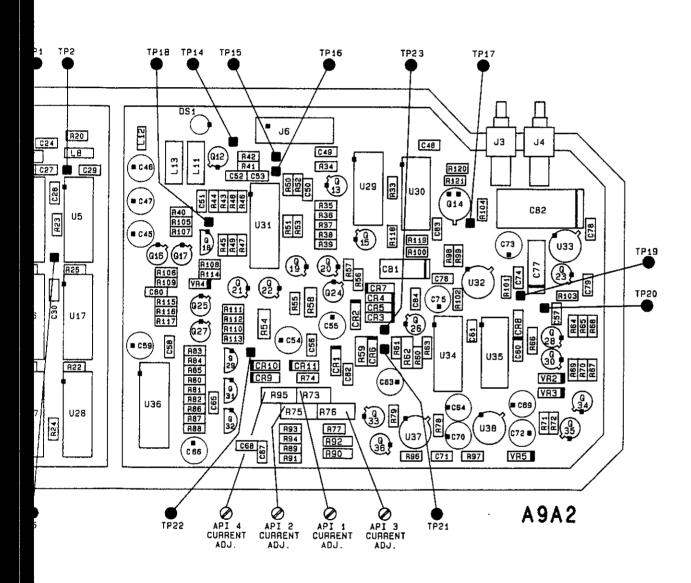
Figure 8M-103 8M-103

Figure 8M-104. SERVICE SHEET 28 INFORMATION



C

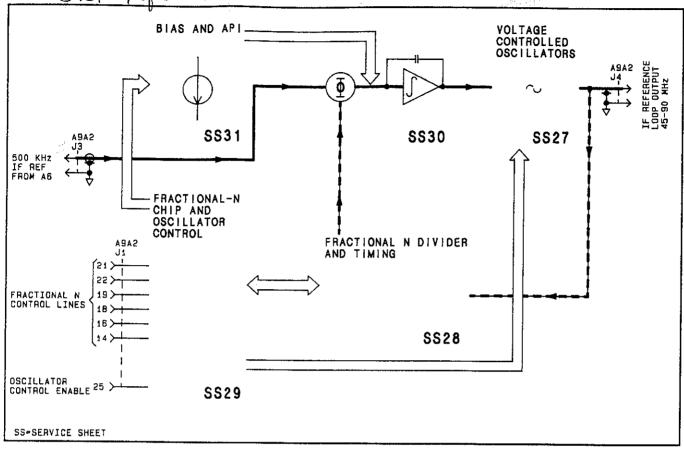
В



D

С

FIG. 8M-104 Sht 445



Reference Block Diagram

# Component Coordinates

							<u> </u>										
СОМР	X,Y	СОМР	X,Y	COMP	X,Y	COMP	X,Y	СОМР	X,Y	COMP	X,Y	СОМР	X,Y	COMP	X,Y	COMP	X,Y
C28 C29 C30 C85 C86 FL10 FL11 FL11	AAAAAAAAAABBBBBBBBBBCCBBCCCCAA AAAA	J1 J2 J5 L12 L12 L13 L15 L10 G1 G2 G3 G4 R11 R14 R15 R17 R18 R19 R11 R12 R12 R12 R12 R12 R12 R12 R12 R12	A.B. A.A.A.B.B.B.C.B.B.B.B.B.B.B.B.B.B.B.B.C	TP1 TP2 TP4 TP6 TP10 TP11 U2 U15 U15 U16 U17 U27 U28	B.C.B.B.C.B.A.A. B.B.C.C.B.C.C.C.C.C.C.C.C.C.C.C.C.C.C.												

SEE REVERSE SIDE

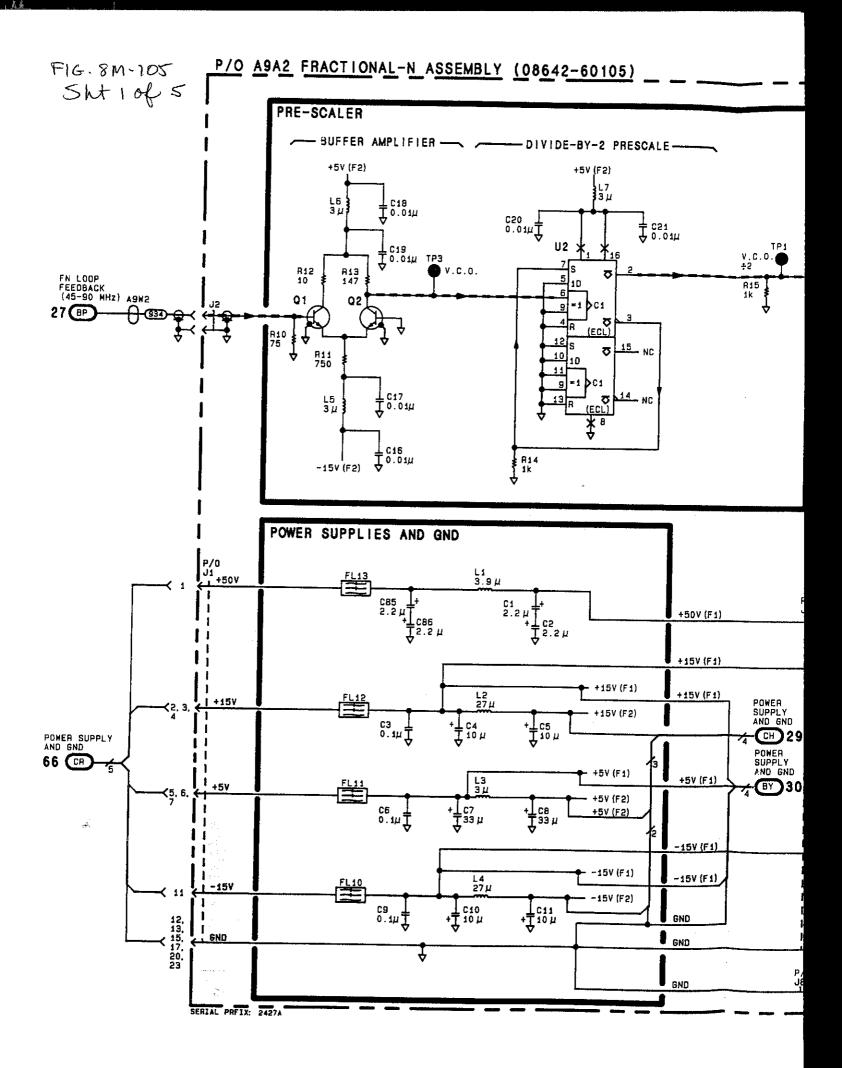
A9A1

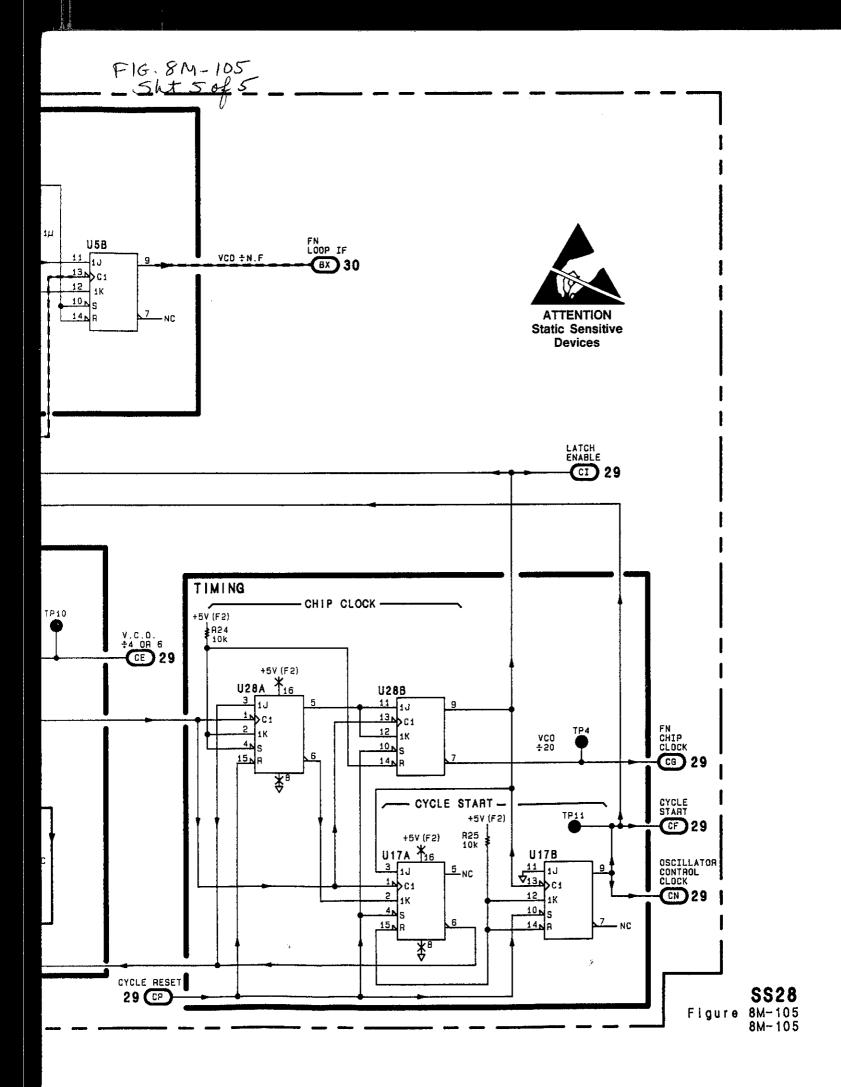
IF VCO ASSEMBLY

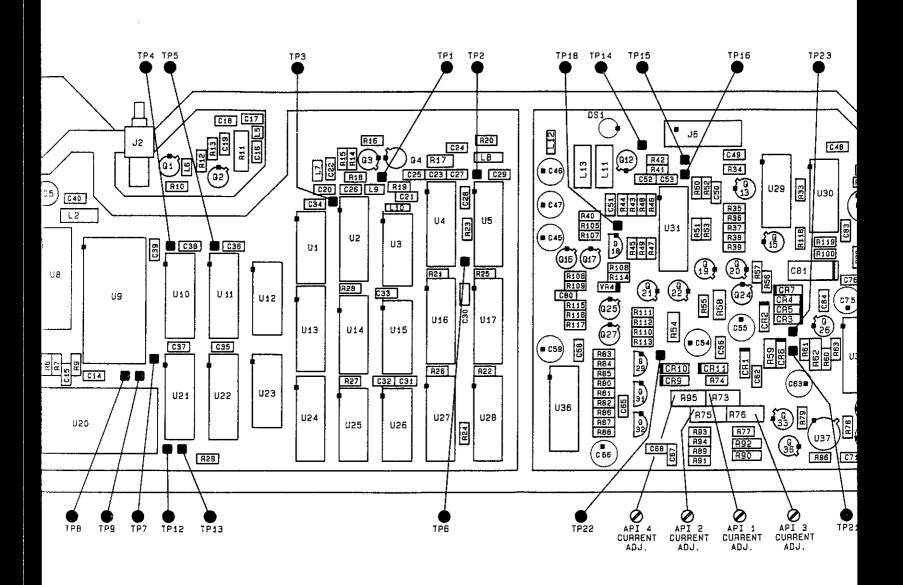
**SS27** 

N	Λ	ł	۵	S	•

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the
  module configuration code. When servicing a module, note any changes that apply specifically to its module
  configuration code.
- 2. A9 FL1, A9 FL2 are low pass feedthrough filters passing through the center of the module to make connections between two {2} printed circuit boards.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.







C

В

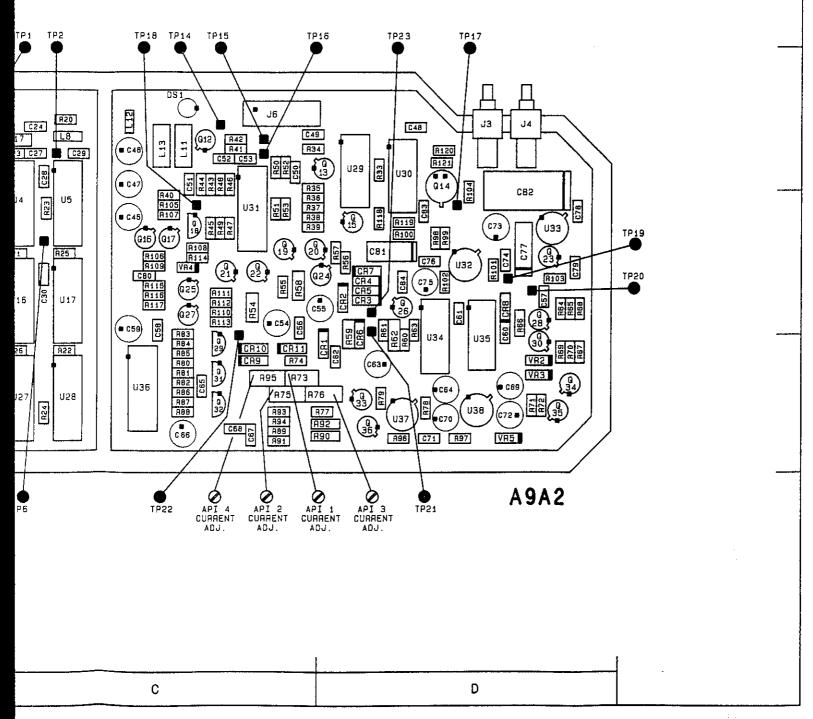
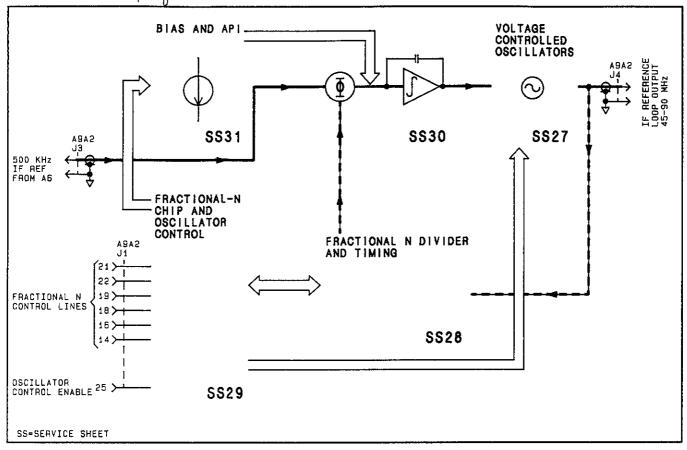


FIG. 8M-106 Sht 4 of 5



Reference Block Diagram

### Component Coordinates

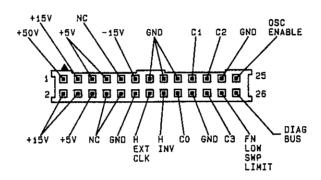
COMP X,Y			СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	COMP	X,Y	COMP	X,Y	COMP	X,Y	СОМР	X,Y
C12 C13 A,33 C14 A,33 C15 C31 C31 C31 C32 C33 C33 C33 C33 C33 C33 C33 C33 C33	Q5 Q6 Q7 Q8 Q9 Q10 Q11 R12 R3 R45 R6 R7 R8 R9 R27 R827 R9 R31 R31 R7 R7 R7 R7 R7 R7 R7 R7 R7 R7 R7 R7 R7	AAAAAA AAAAAAAAAAAAAAAAAAAAAAAAAAAAAAA	U1 U6 U7 U8 U9 U111 U114 U114 U114 U114 U114 U114 U	B.A.A.B.B.B.B.B.A.A.B.B.B.B.B.B.B.B.B.B												

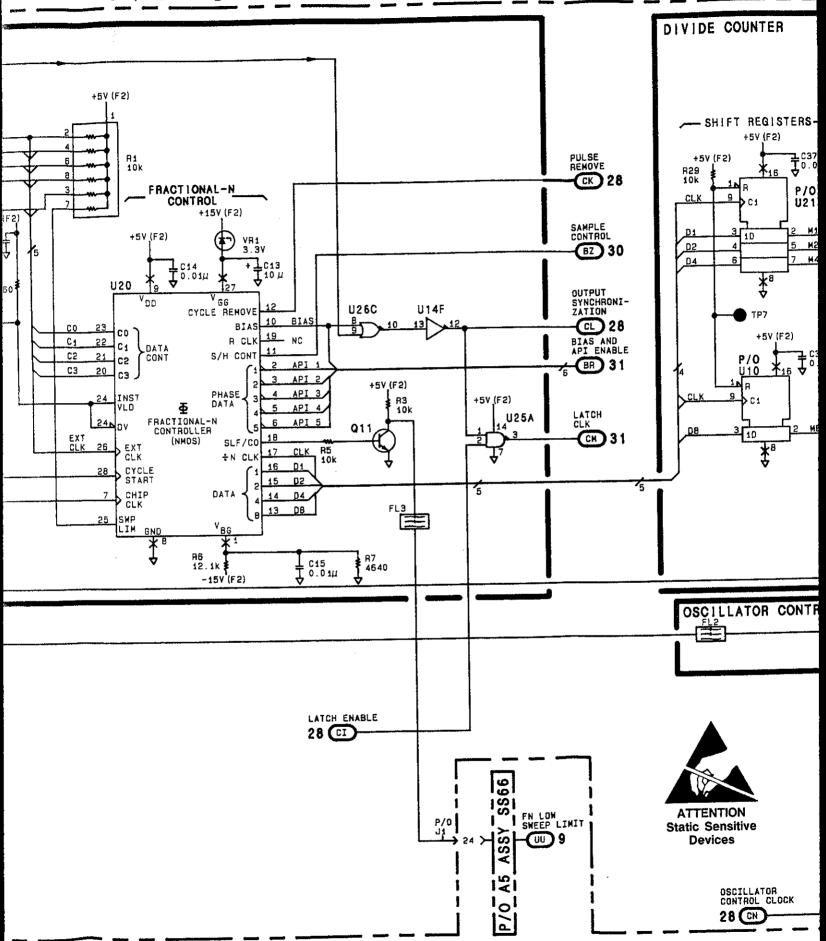
P/O FRACTIONAL-N SS28
A9A2 ASSEMBLY SEE REVERSE SIDE

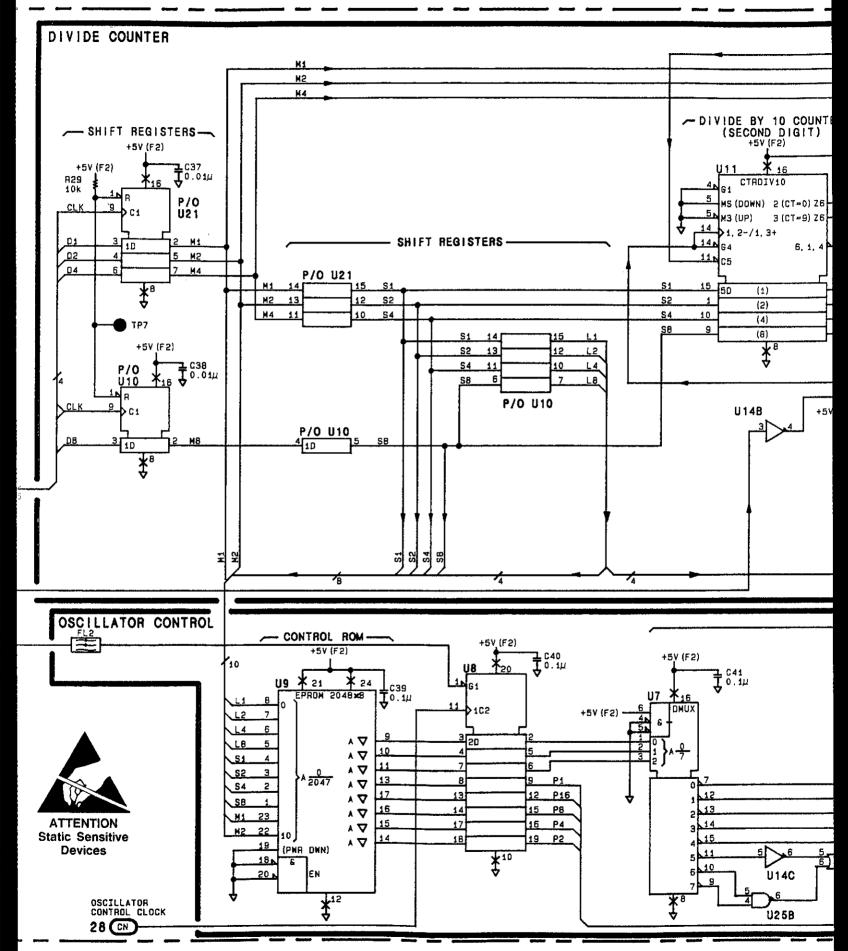
### Notes:

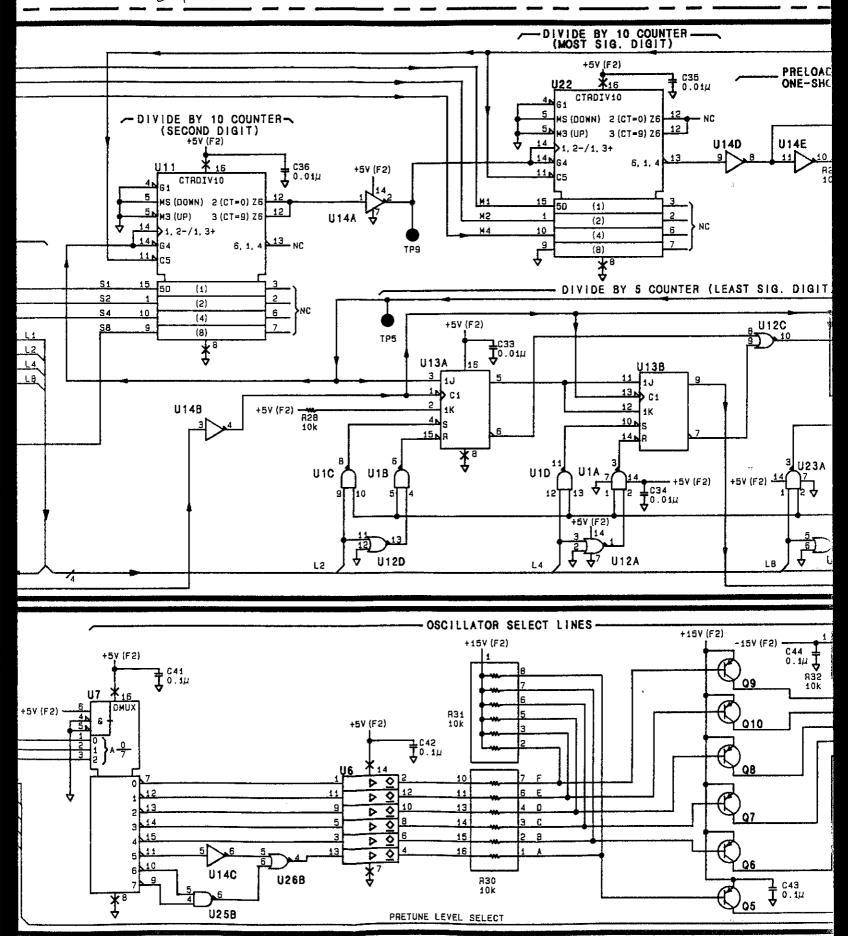
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the
  module configuration code. When servicing a module, note any changes that apply specifically to its module
  configuration code.
- 2. A9 FL4-FL9 must have solder connection from notched portion of shielding to outer body of feedthroughs.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- 4. A9 FL1, A9 FL2 are low pass feedthrough filters passing through the center of the module to make connections between two (2) printed circuit boards.

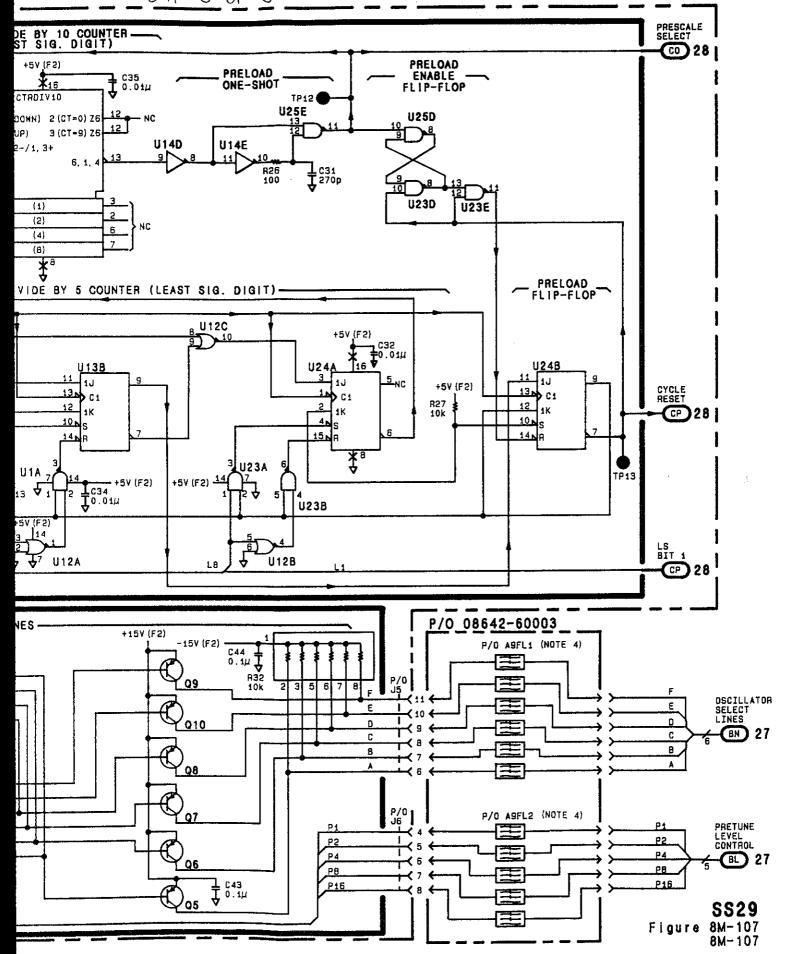
### CABLE PLUG TO A9A2 J1











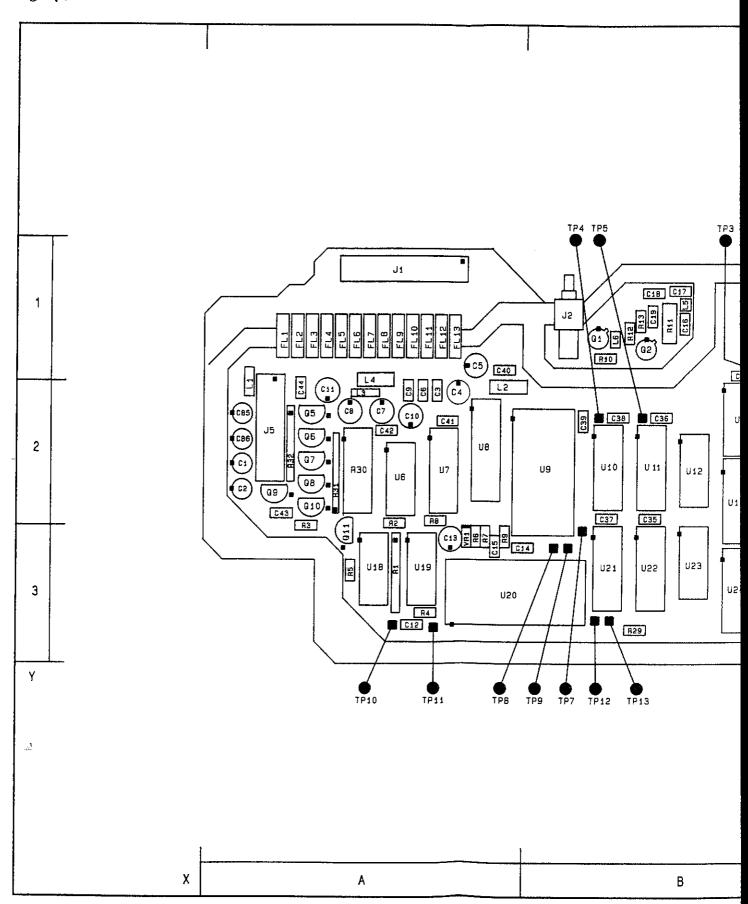
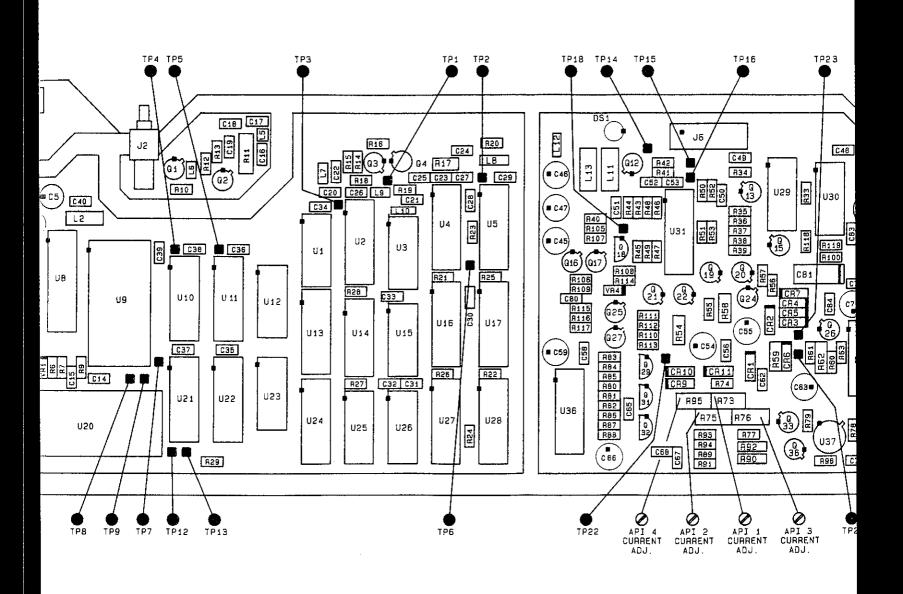
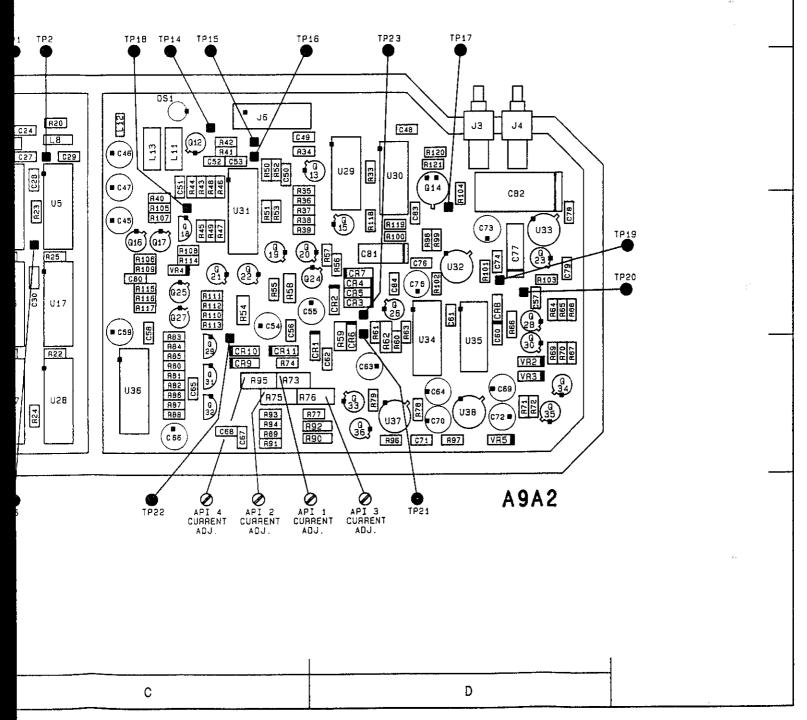


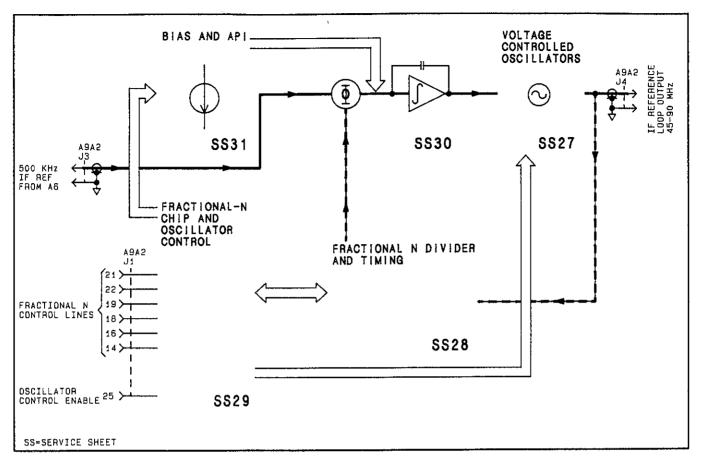
Figure 8M-108. SERVICE SHEET 30 INFORMATION



В

С





Reference Block Diagram

## Component Coordinates

СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C45 C46 C47 C48 C50 C52 C55 C55 C55 C73 C75 C76 C77 C78 C79 C80 C81 C82 C83 C84		DS1 FL1 J3 J4 L112 G12 G13 G14 G15 G17 G18 G22 G22 G22 G227	C. A. D.D. C.C.C. C.D.D.G.C.C.G.C.G.C.G.G.G.G.G.G.G.G.G.G.	RRRRRRRRRRRRRRRRRRRRRRRRRRRRRRRRRRRRRR		R108 R109 R1101 R1112 R1113 R1114 R1115 R1116 R1119 R120 TP115 TP16 TP17 TP19 TP20 TP20 TP20 TP20 TP20 U30 U31 U32 U33 VR4	0.0000000000000000000000000000000000000										

P/O FRACTIONAL-N SS29

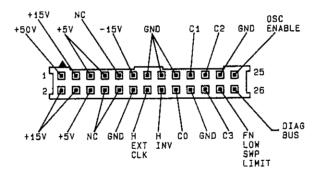
SEE REVERSE SIDE

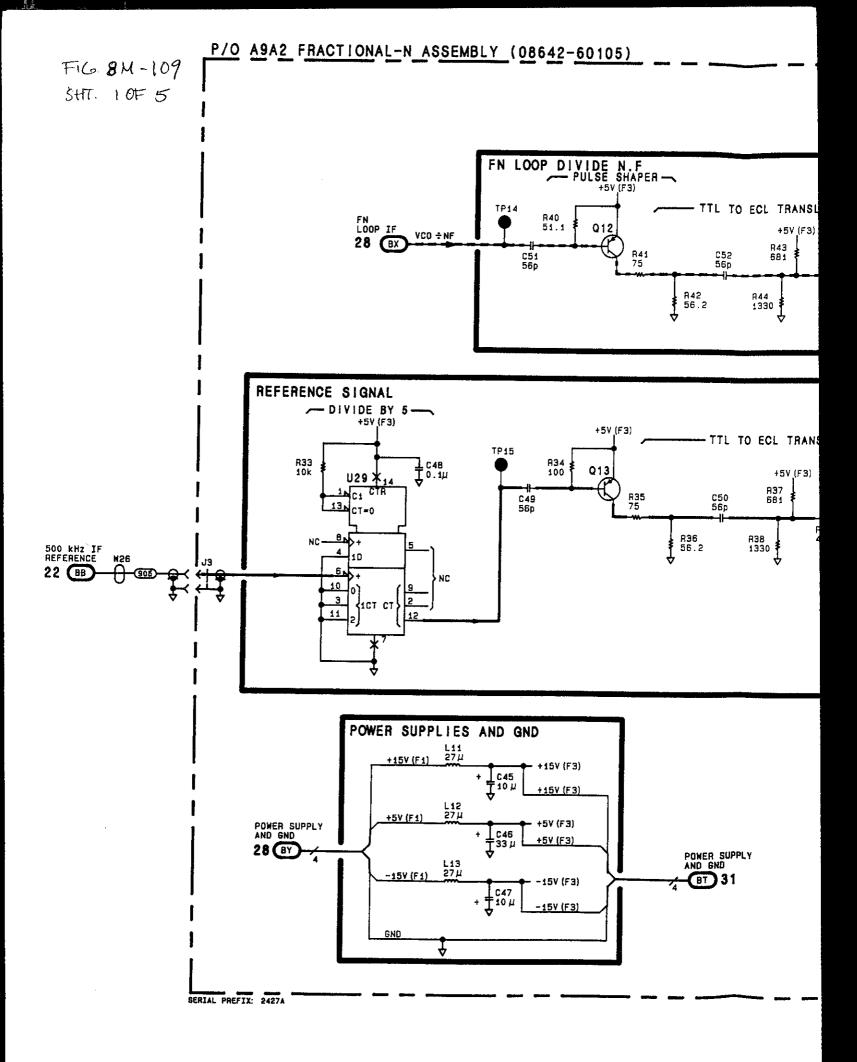
#### Notes:

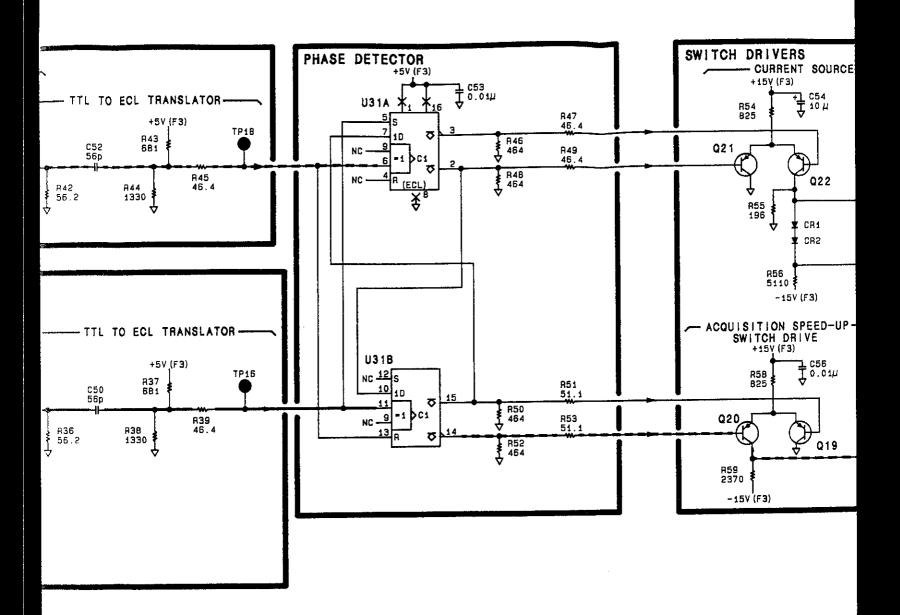
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.



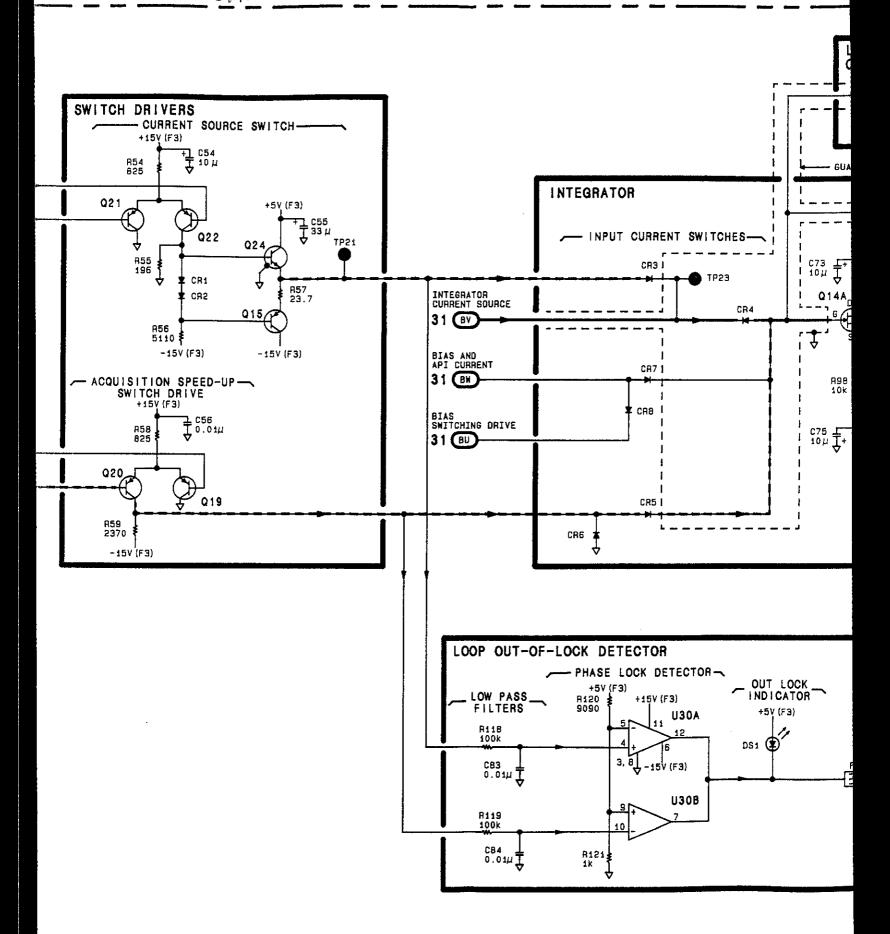
# CABLE PLUG TO A9A2 J1

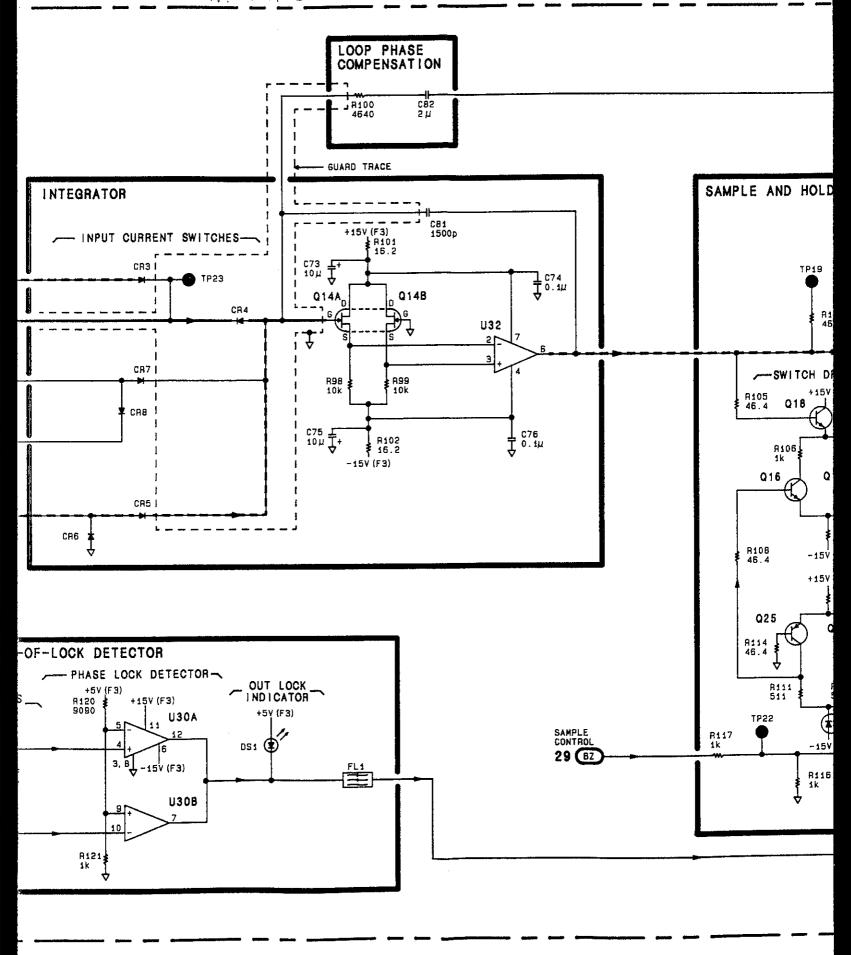


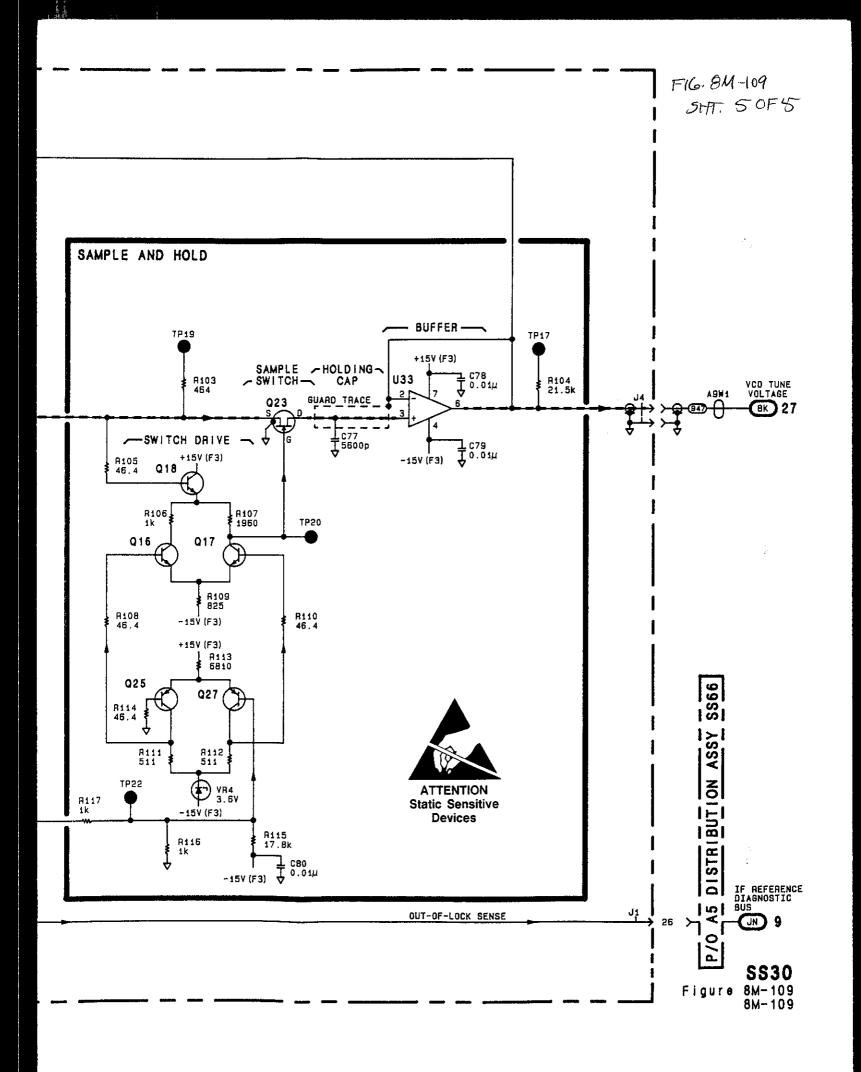




PONER SUPPLY AND GND BT 31







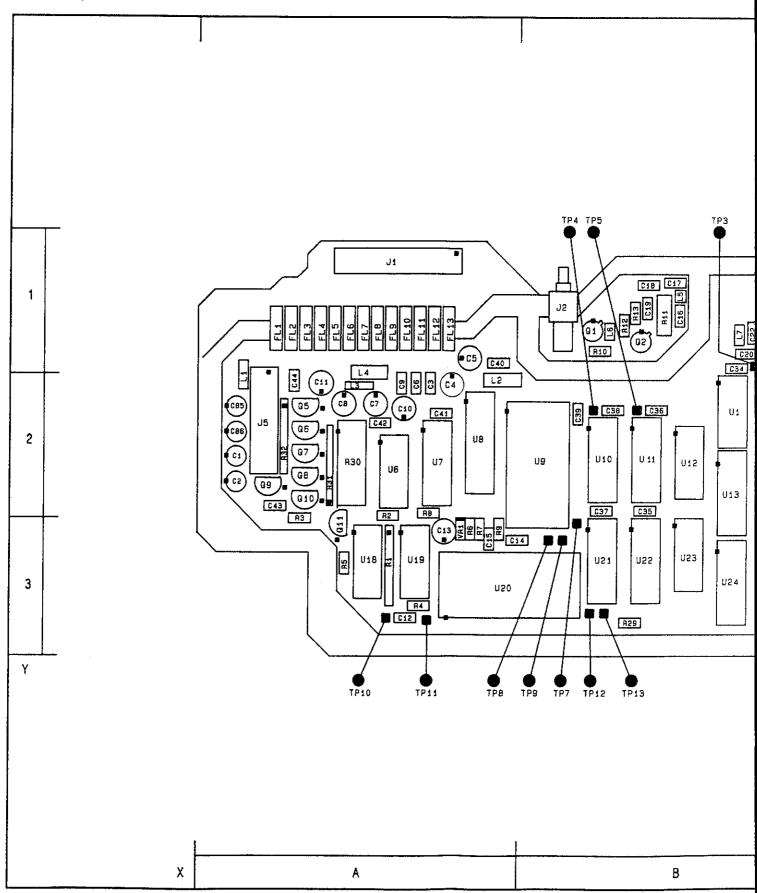
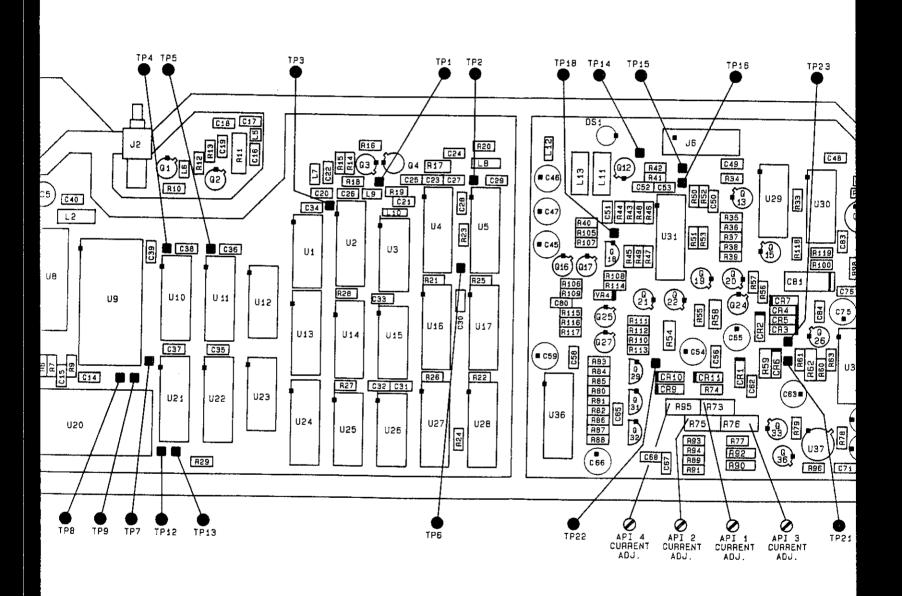
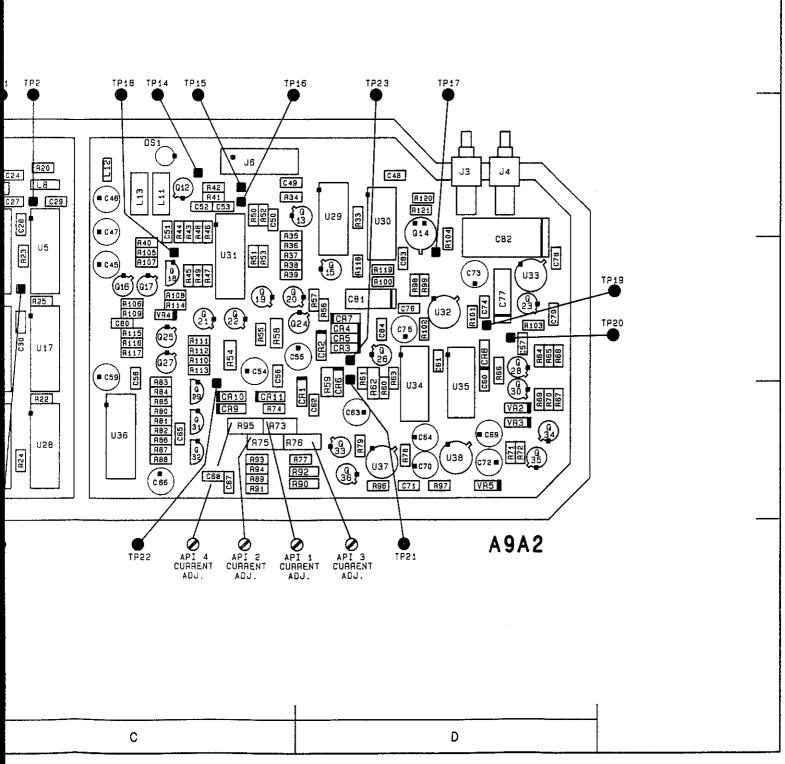


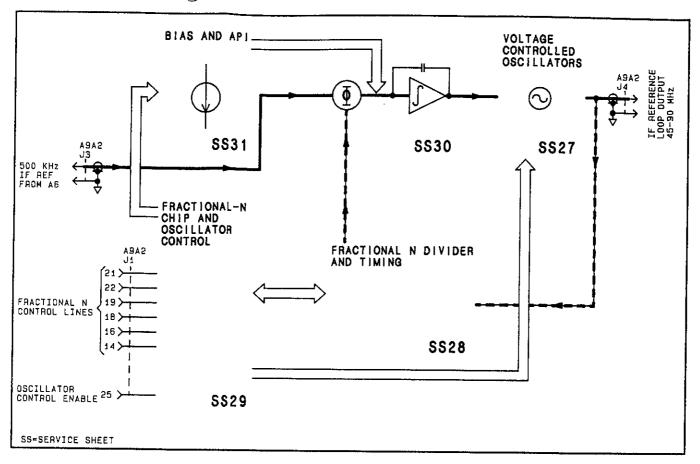
Figure 8M-110. SERVICE SHEET 31 INFORMATION



C

В





Reference Block Diagram

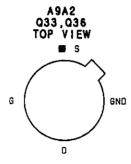
## Component Coordinates

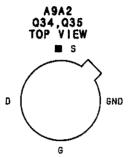
COMP X	Y COMP	X,Y	СОМР	X,Y	СОМР	X,Y	COMP	X,Y	СОМР	X.Y	СОМР	X.Y	СОМР	X.Y	COMP	х.у
COMP X	R60 R612 R62 R63 R64 R65 R67 R66 R67 R68 R69 R71 R72 R73 R74		COMP R97 U35 U35 U36 U37 U38 VA2 VR3 VR5	X,Y 0.3 0.3 0.3 0.3 0.3 0.3 0.3 0.3	СОМР	X,Y	СОМР	X,Y	COMP	X,Y	COMP	X,Y	COMP	Х, Y	COMP	Х,Ү
CR11 C. 3  026 D. 2  029 C. 3  031 C. 3  032 D. 3  034 D. 3  035 D. 3	R80 R812 R83 R845 R867 R867 R890 R890 R891 R893 R893 R893	ສອດສອດສອດສອດສອດສອດສອດສອດສອດສອດສອດສອດສອດສ														

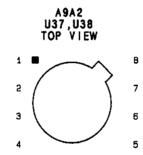
P/O FRACTIONAL-N SS30 SEE REVERSE SIDE

### Notes:

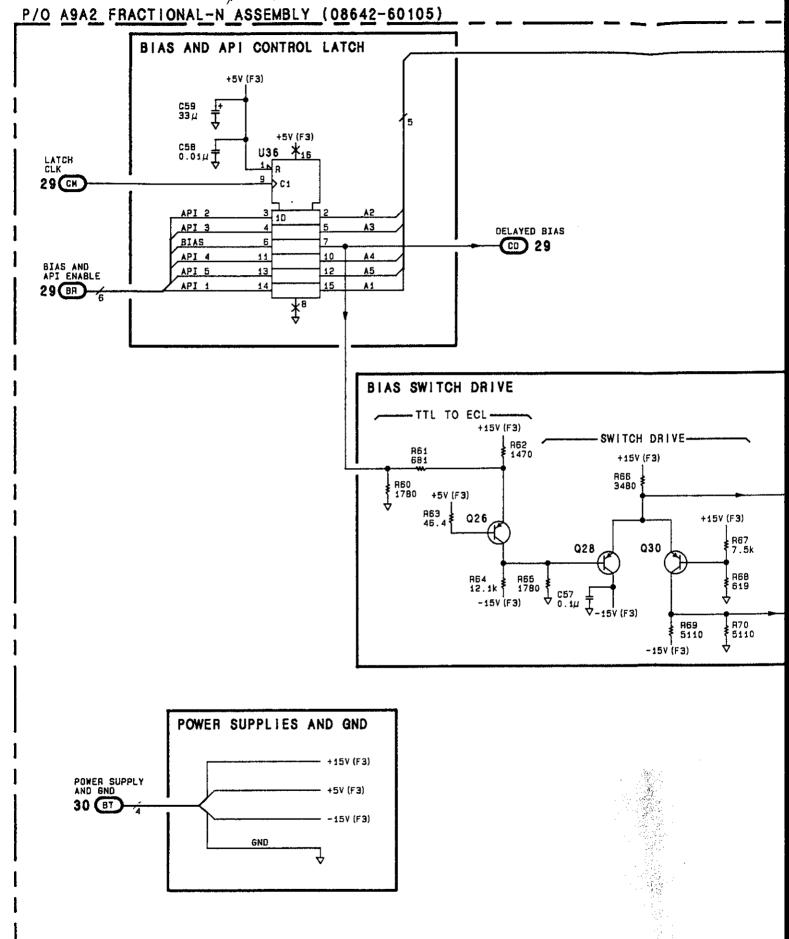
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

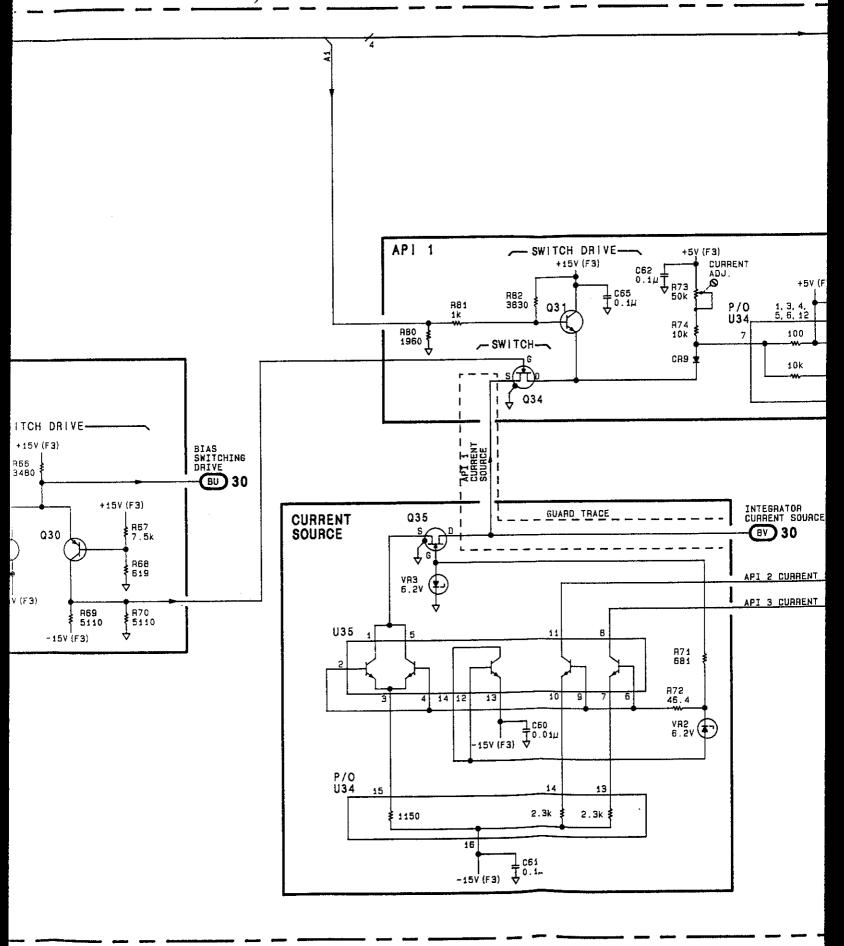


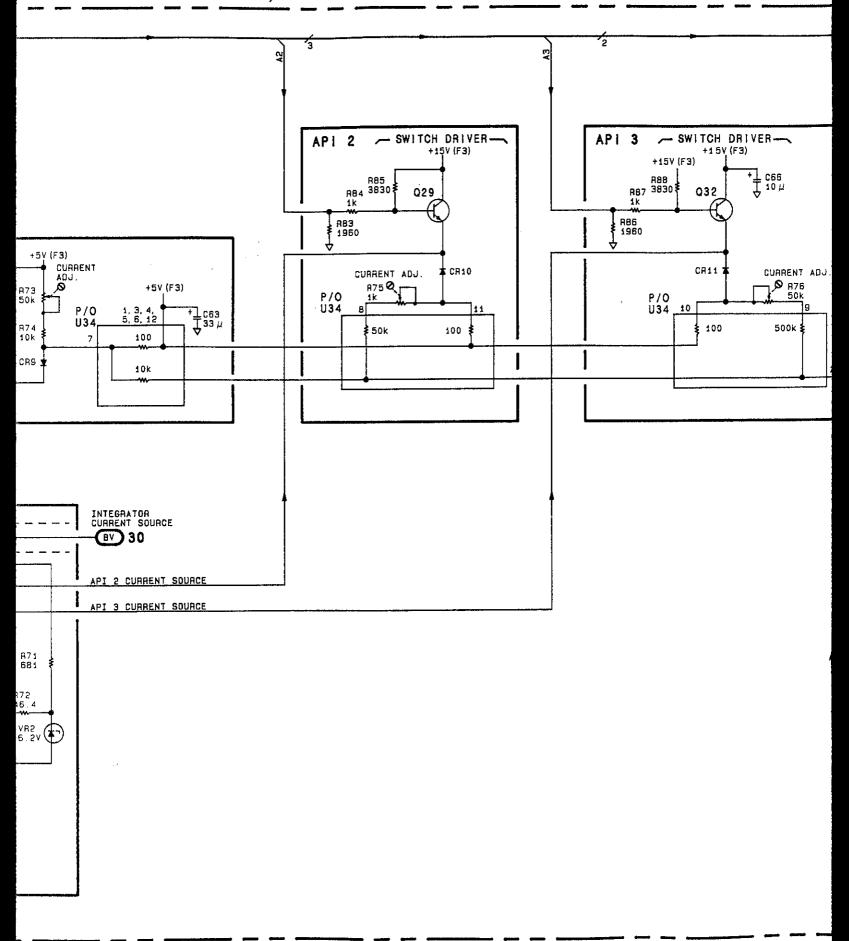


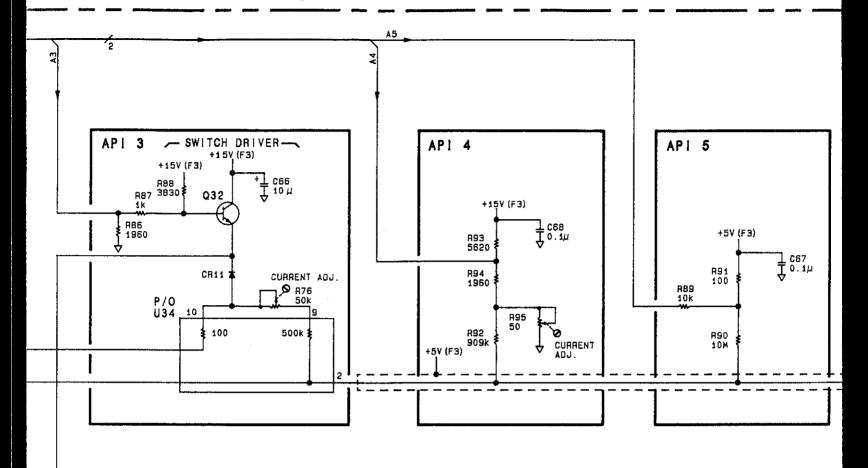


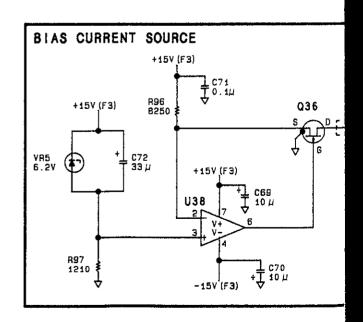
SERIAL PREFIX: 2427A

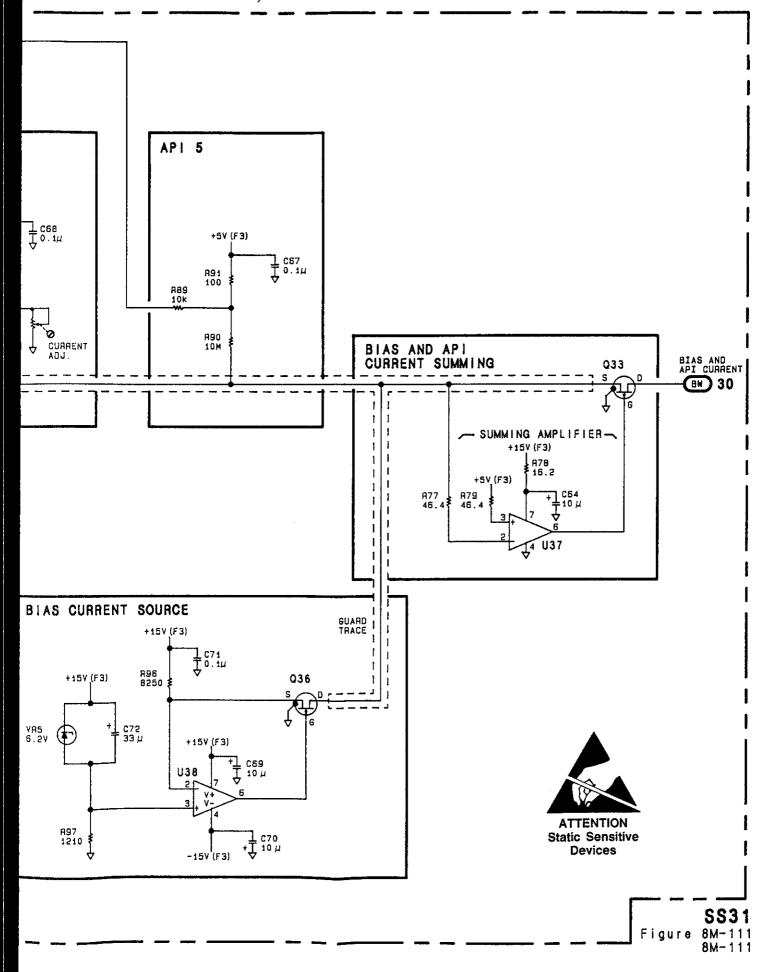




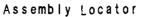


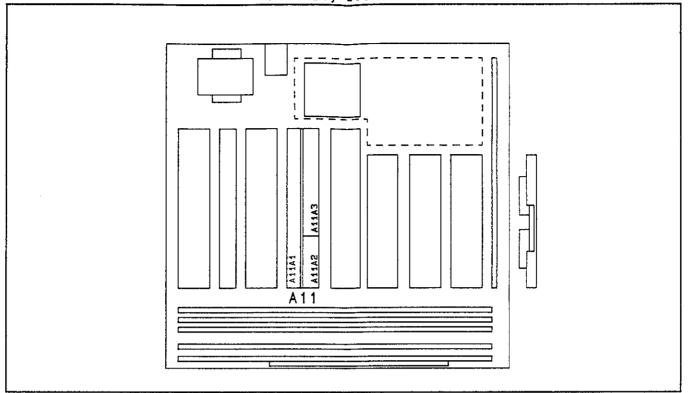






All Reference Loop Module





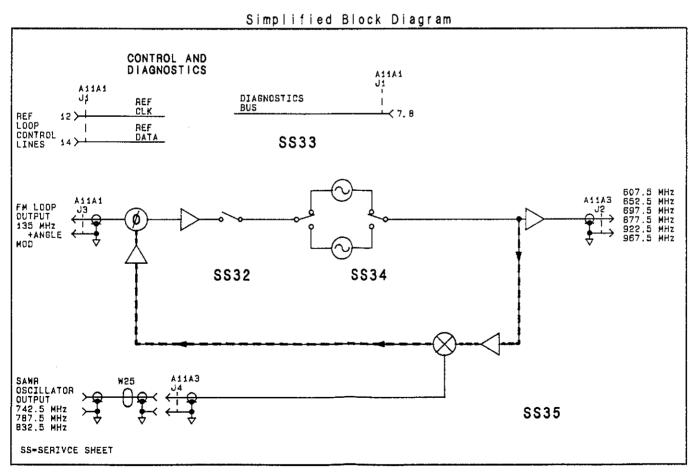
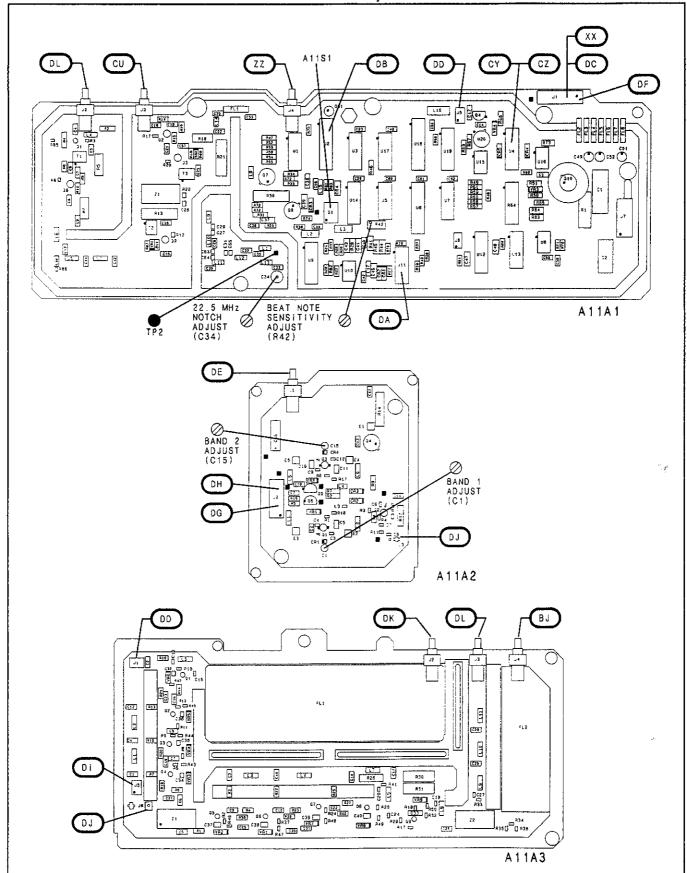
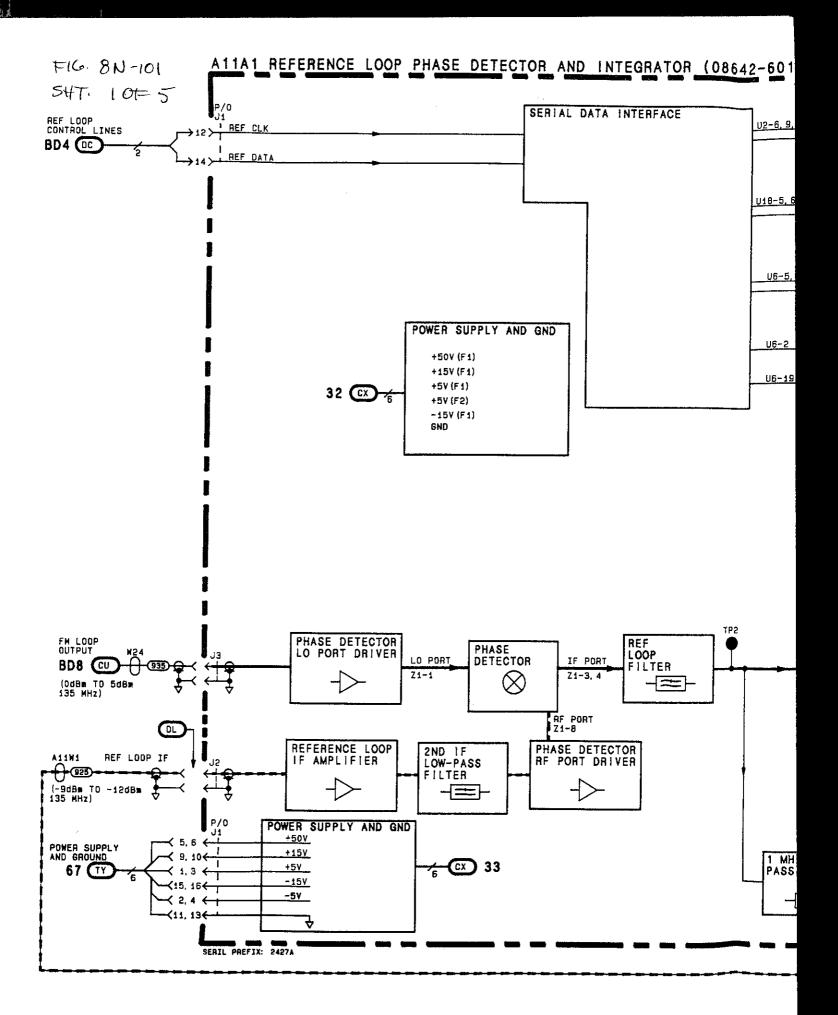
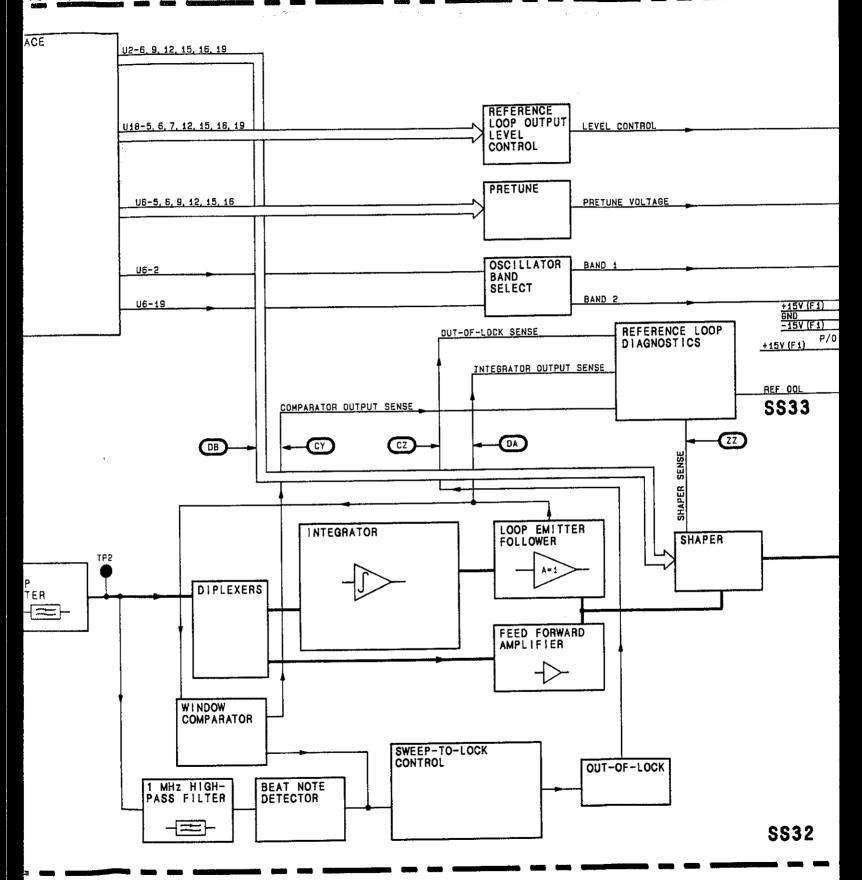


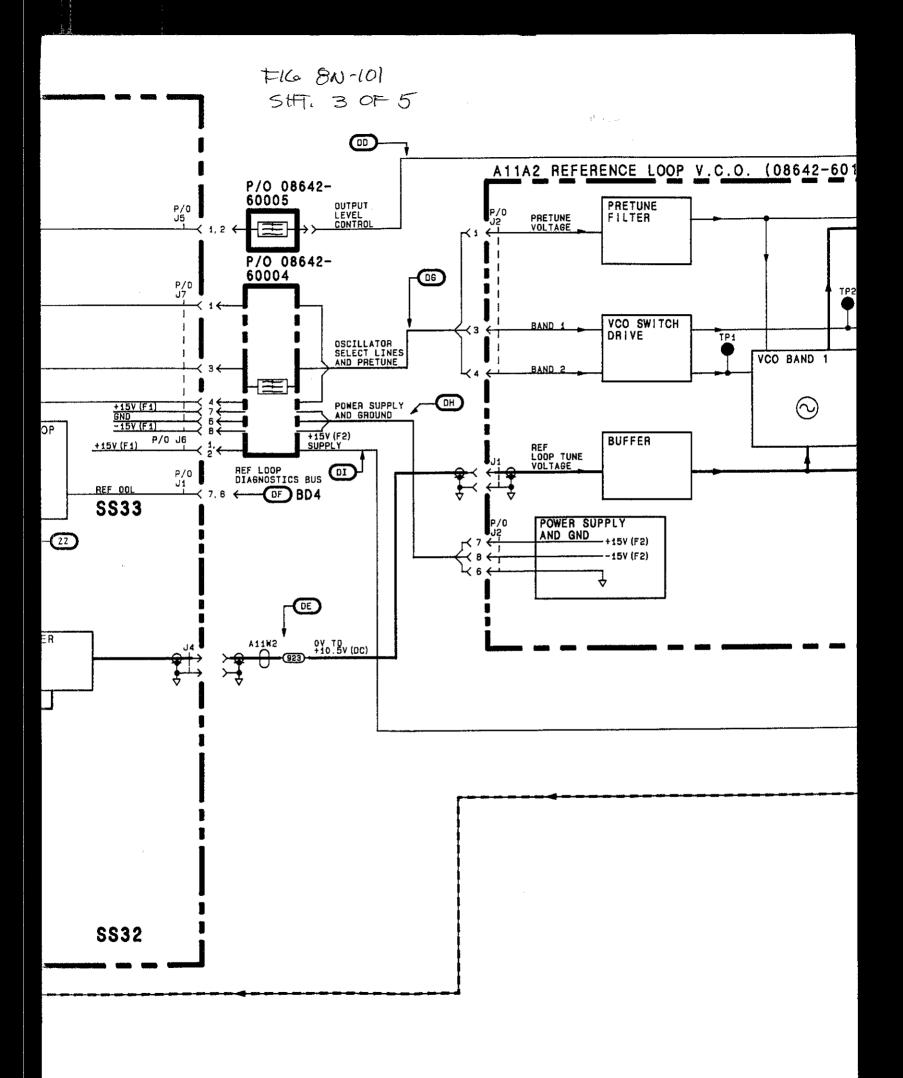
Figure 8N-100 BD11 General Information.

5H7- ZOF ZModule Test Point/Adjustment Locations









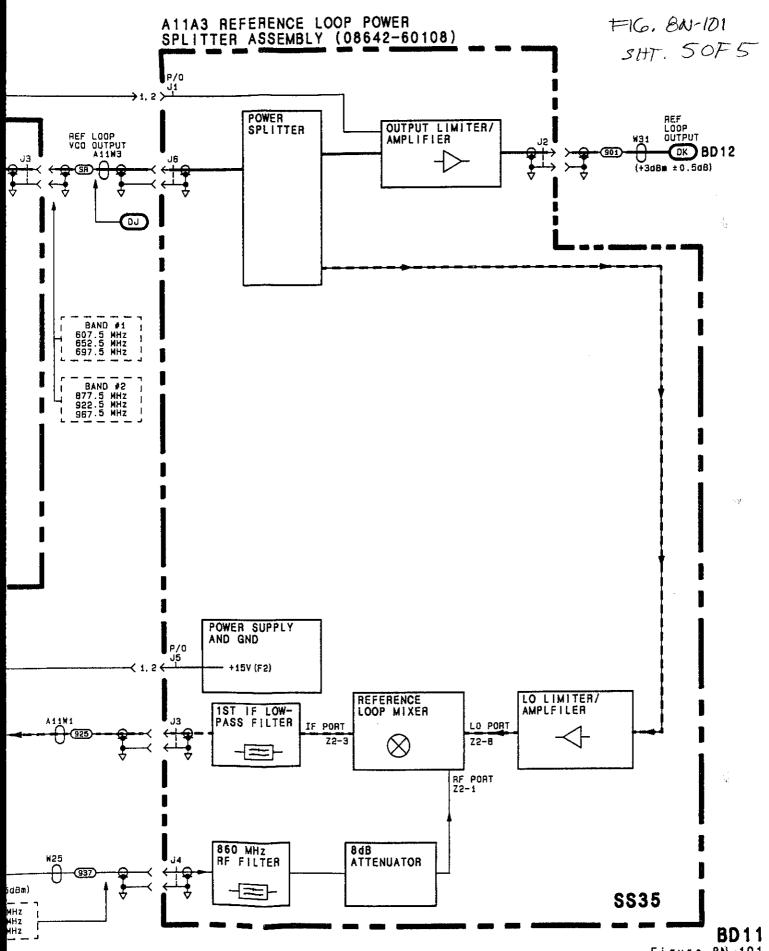


Figure 8N-101 8N-101

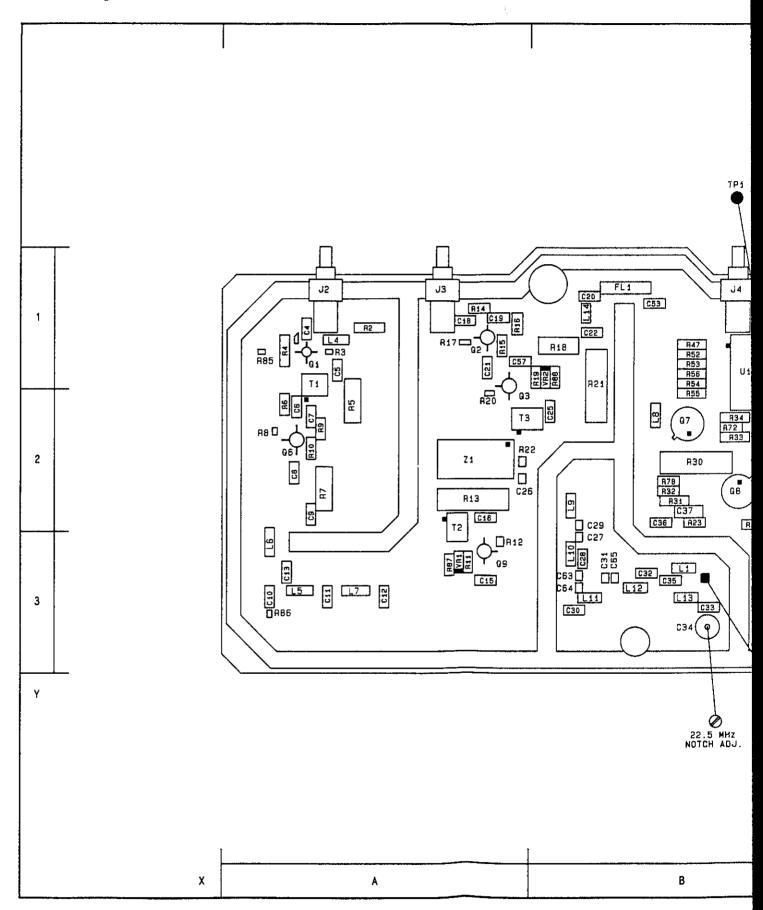
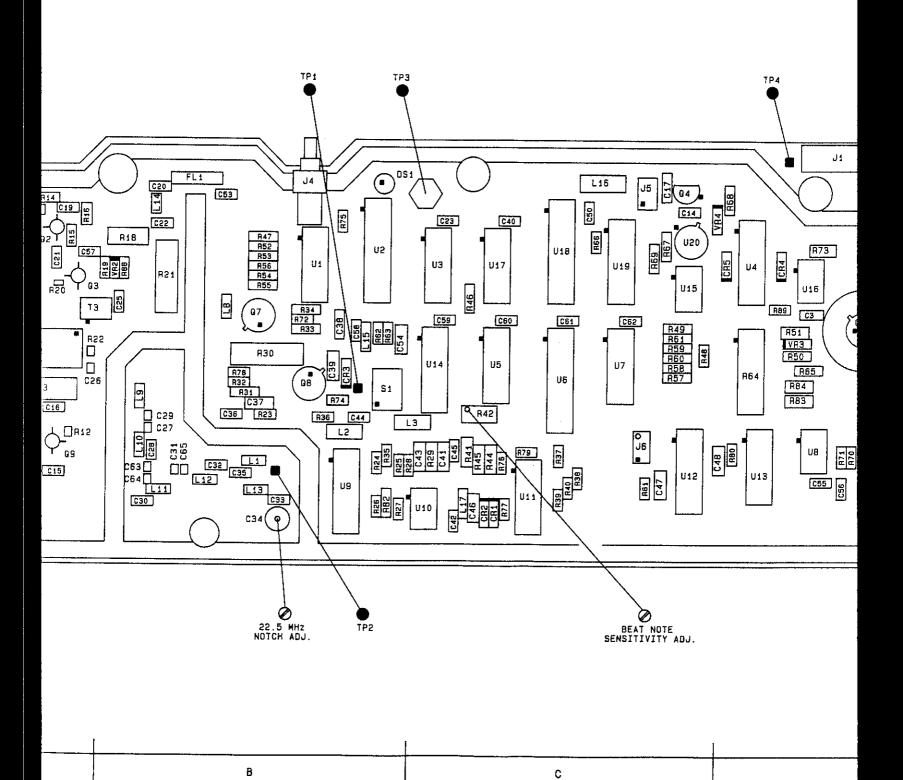
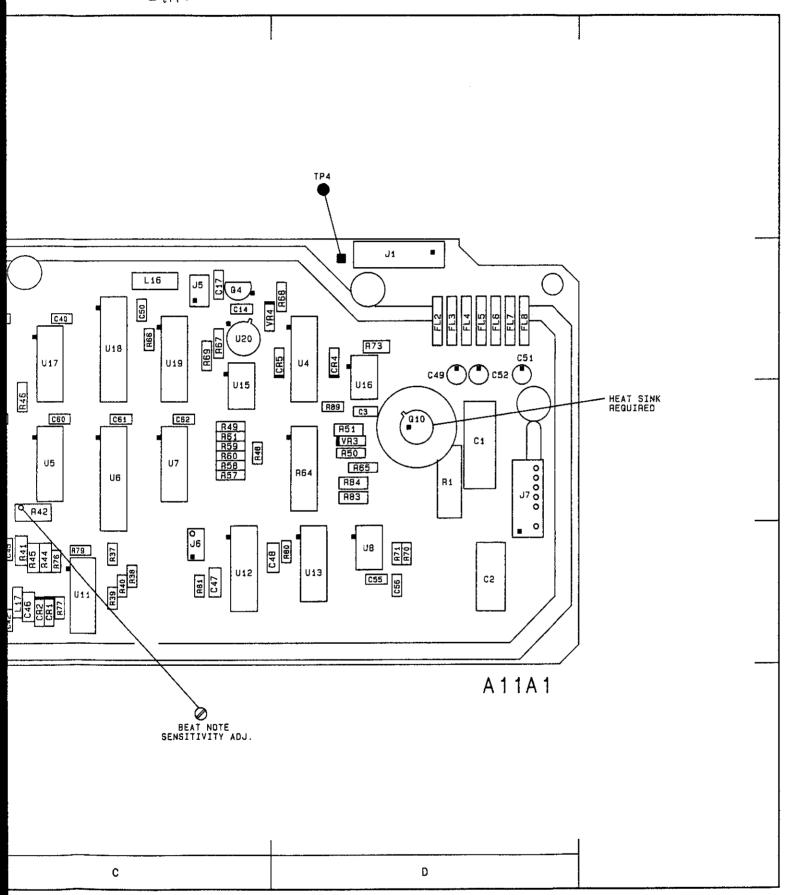
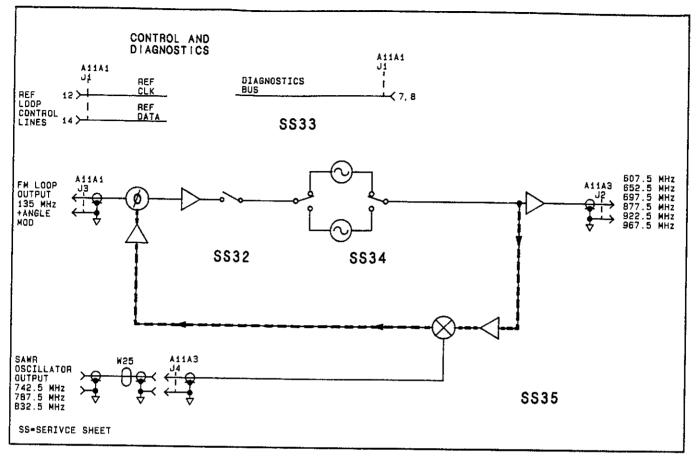


Figure 8N-102. SERVICE SHEET 32 INFORMATION







Reference Block Diagram

COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,	COMP X,Y	COMP X,Y
1 D. 2 A. 1 2 C C C C C C C C C C C C C C C C C C	C45 C.3 C46 C.3 C47 C.3 C47 C.3 C49 C.5 C51 C.5 C55 C.5 C55 C.5 C55 C.5 C55 C.5 C55 C.5 C55 C.5 C64 C.5 C65 C.	L1	R2 R3 A.112222222233332111121223333332222233333122222333333	R399 C.C. 33221122122332233331331 R442 R445 R447 R553 R555 R553 R570124 R577 R99 C.C. B.A.A.B. R888 R777 R880 R888 R888 R888 R888 R888	S1 B. 2 T1 A. 12 T3 A. 2 T71 B. 2 TP2 B. 3 TP3 C. 1 U1 B. 1 U8 D. 3 U90 C. 3 U11 C. 3 U12 C. 3 U13 D. 3 V11 A. 3 V12 A. 3 V12 A. 3 V14 A. 2		John A, I	OOMF A,1

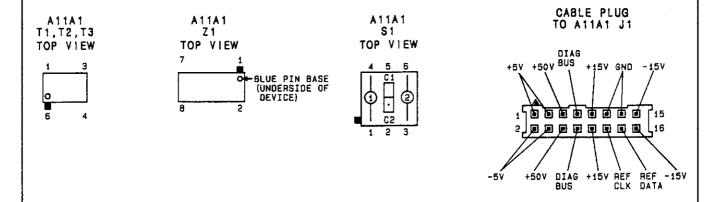
A11 MODULE BD 1 1

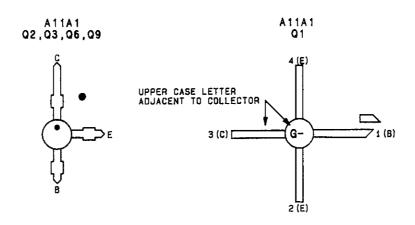
SEE REVERSE SIDE

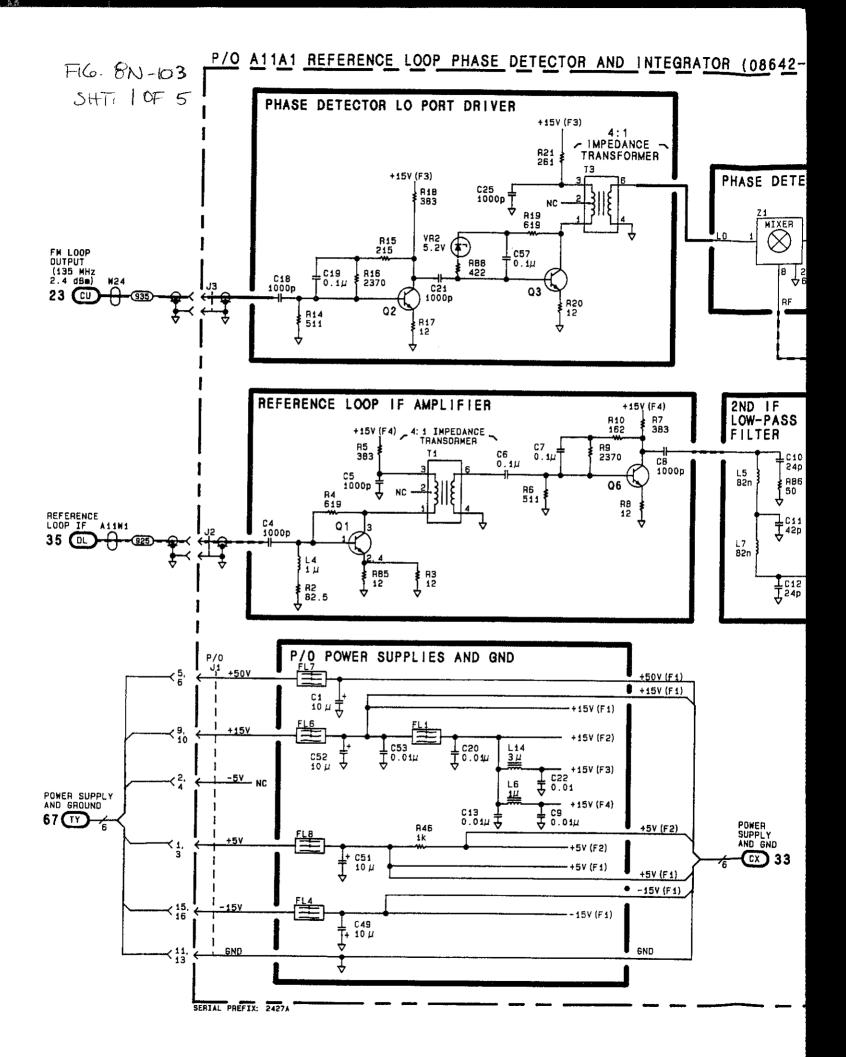
Service

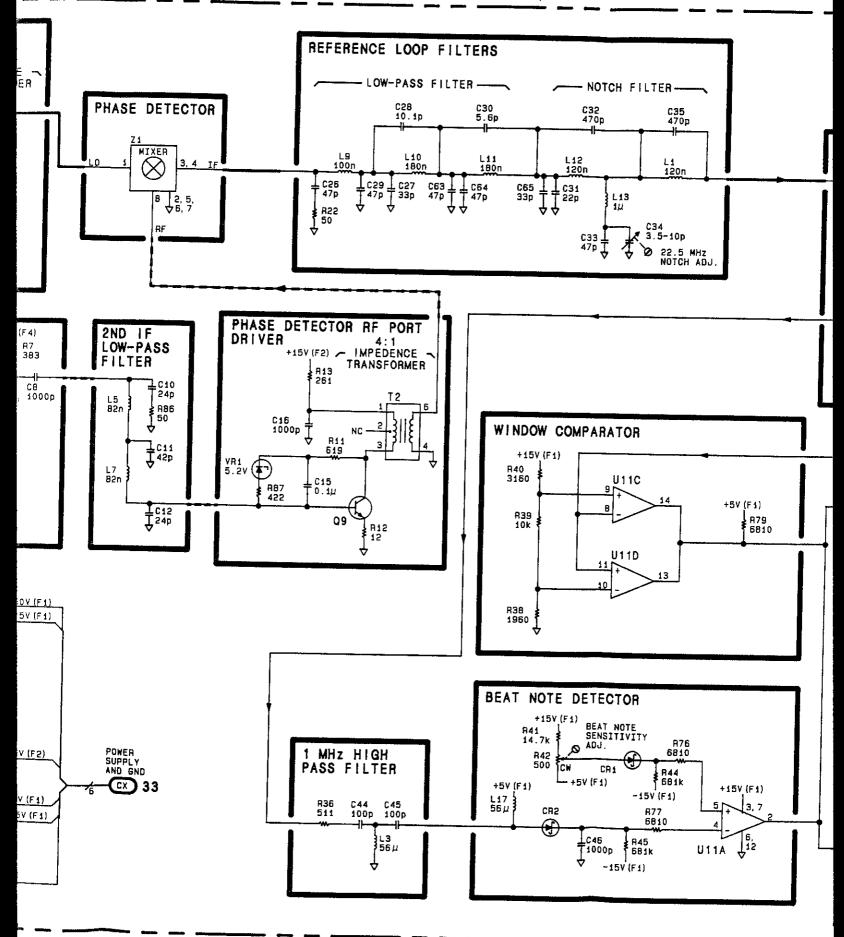
#### Notes:

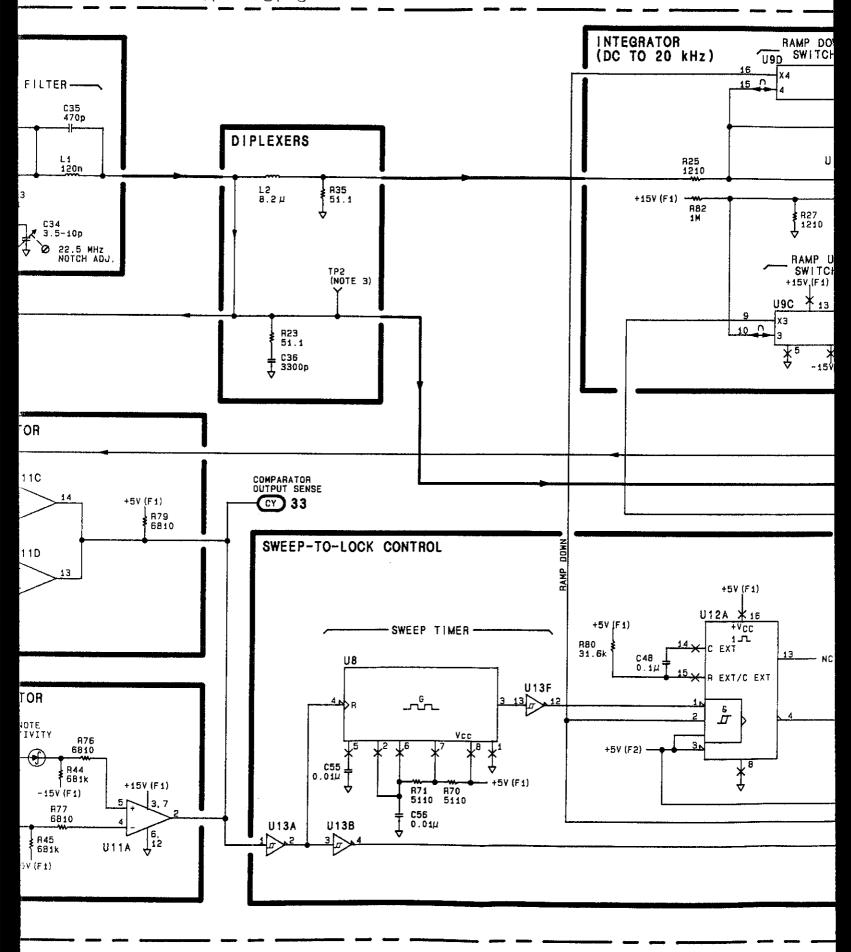
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. Feedthrough filter outer body must be soldered to the shielding in the area where shielding is notched.
- 3. Test point requres high impedance (>500  $\mathfrak Q$ ) probe. See Bench Service Kit (HP part number 11802A) .
- 4. All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

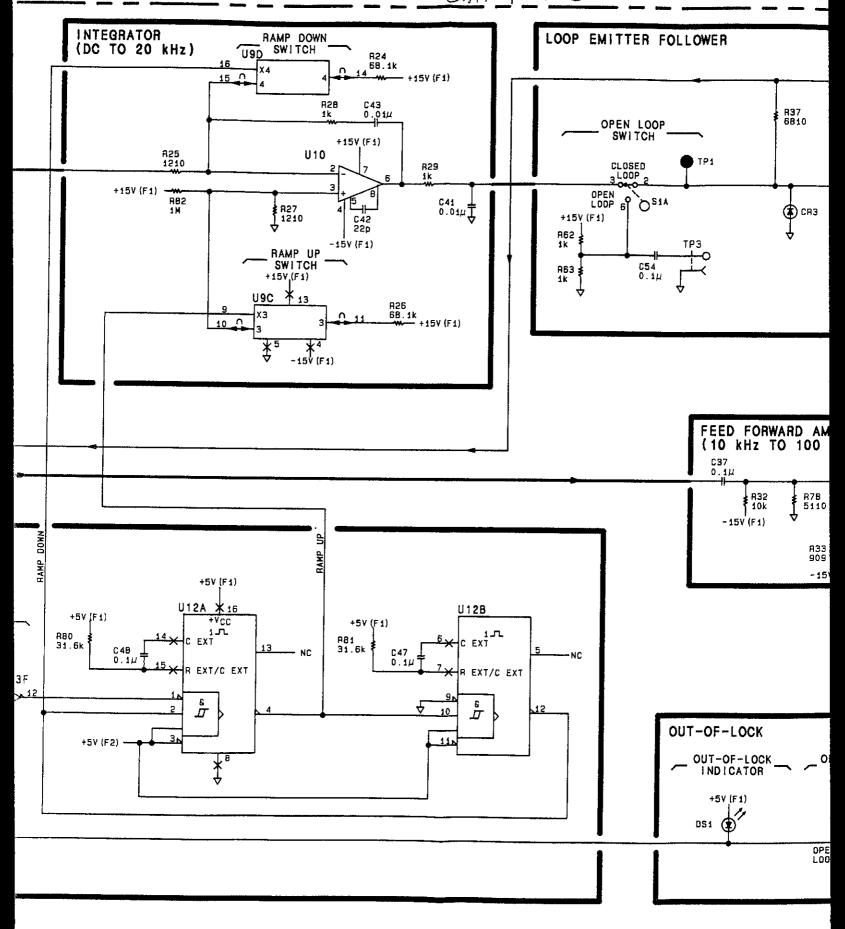


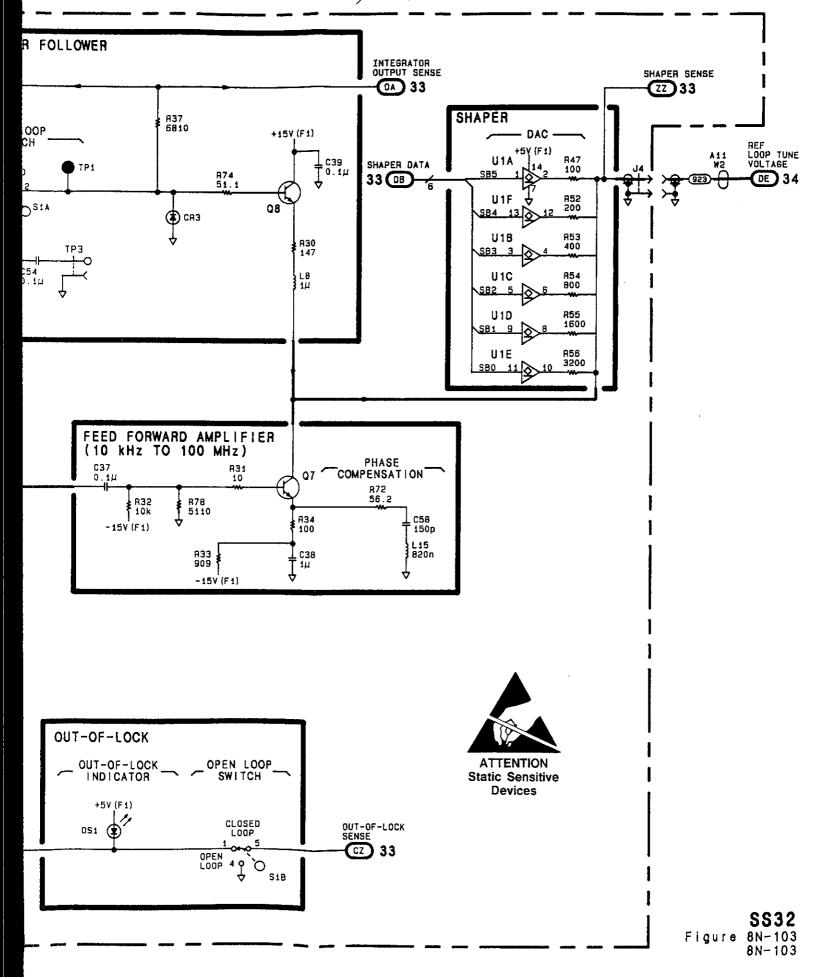












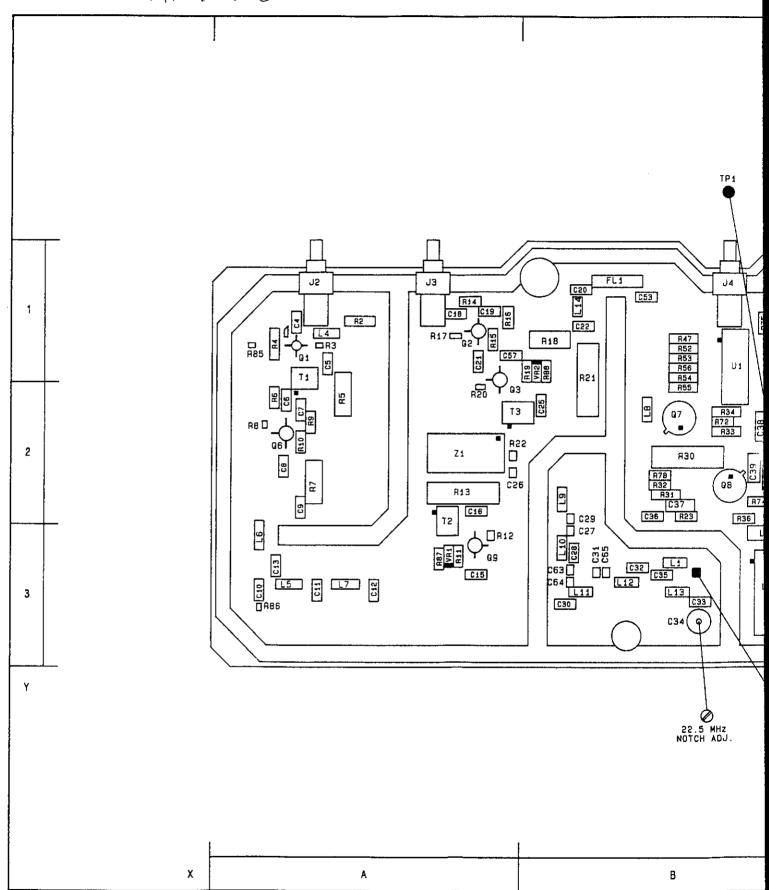
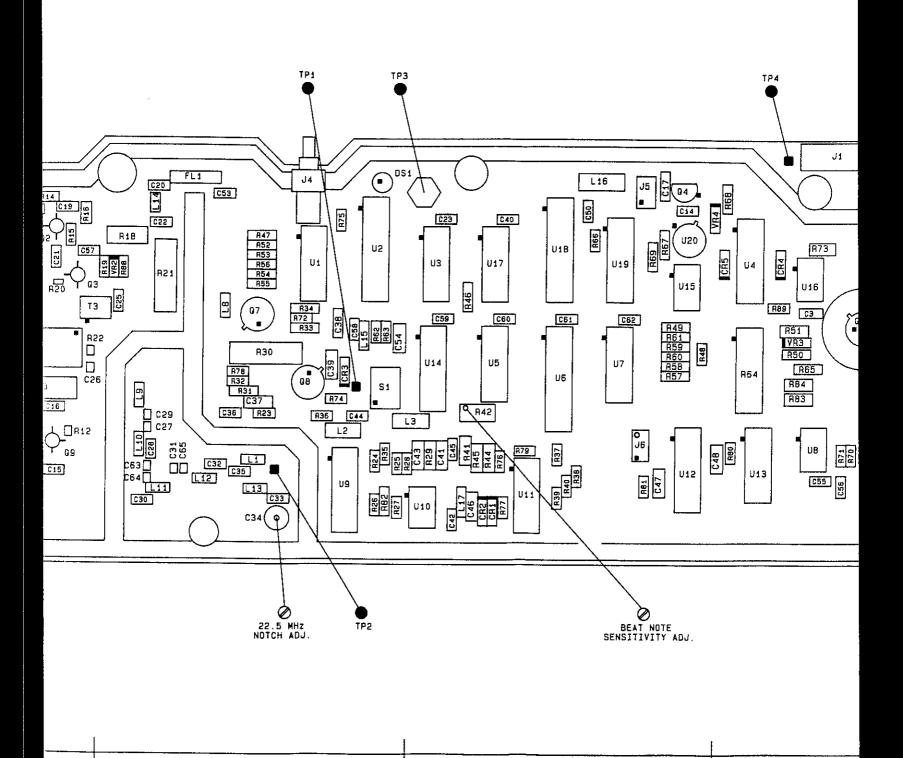


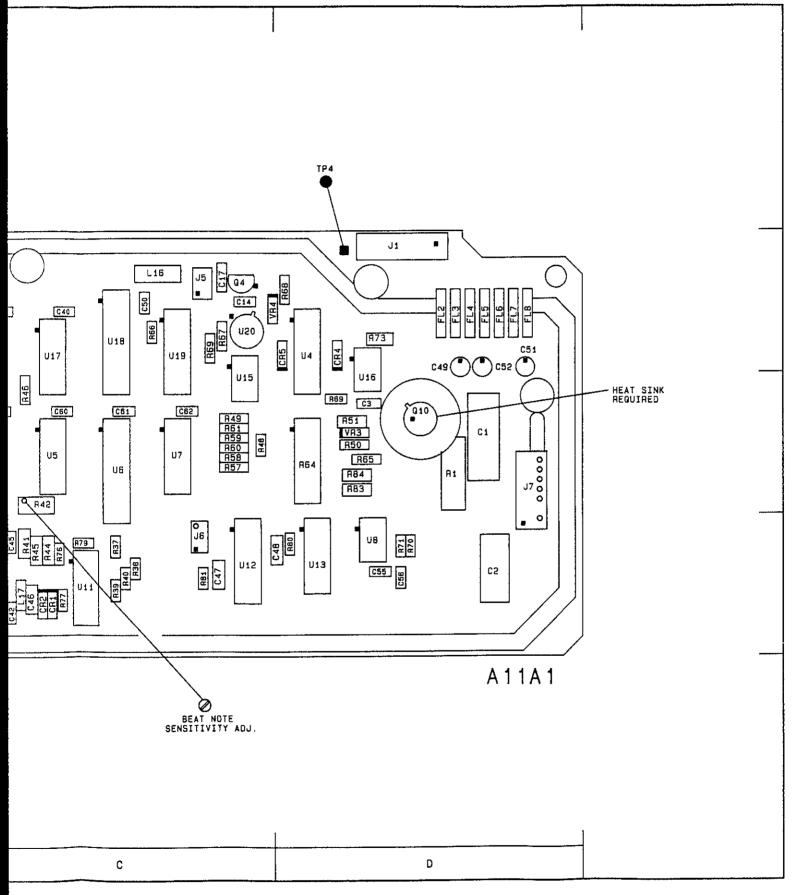
Figure 8N-104. SERVICE SHEET 33 INFORMATION

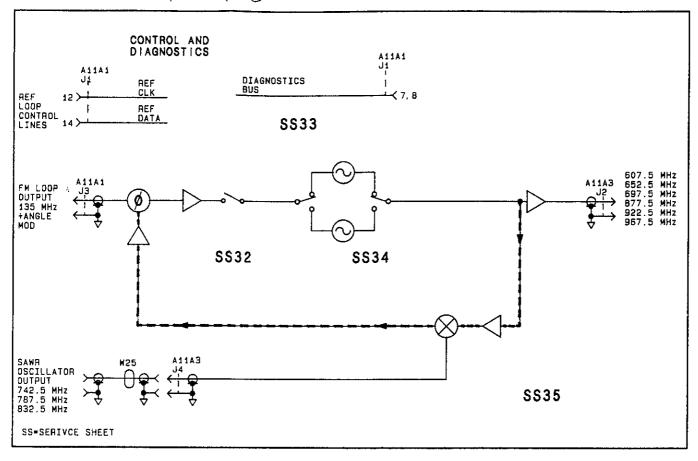


Component Locator

С

В





Reference Block Diagram

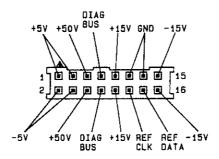
СОМР	X,Y	СОМР	ΧY	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C2 C3 C14 C23 C14 C23 C59 C66 C66 C66 C7 C7 C7 C7 C7 C7 C7 C7 C7 C7 C7 C7 C7		R1484901178601449014786578667866786678849		U2 U3 U4 U5 U6 U7 U13 U14 U15 U16 U17 V18 U19 U20 VR3 VR4	B. 1112222322211111 21												

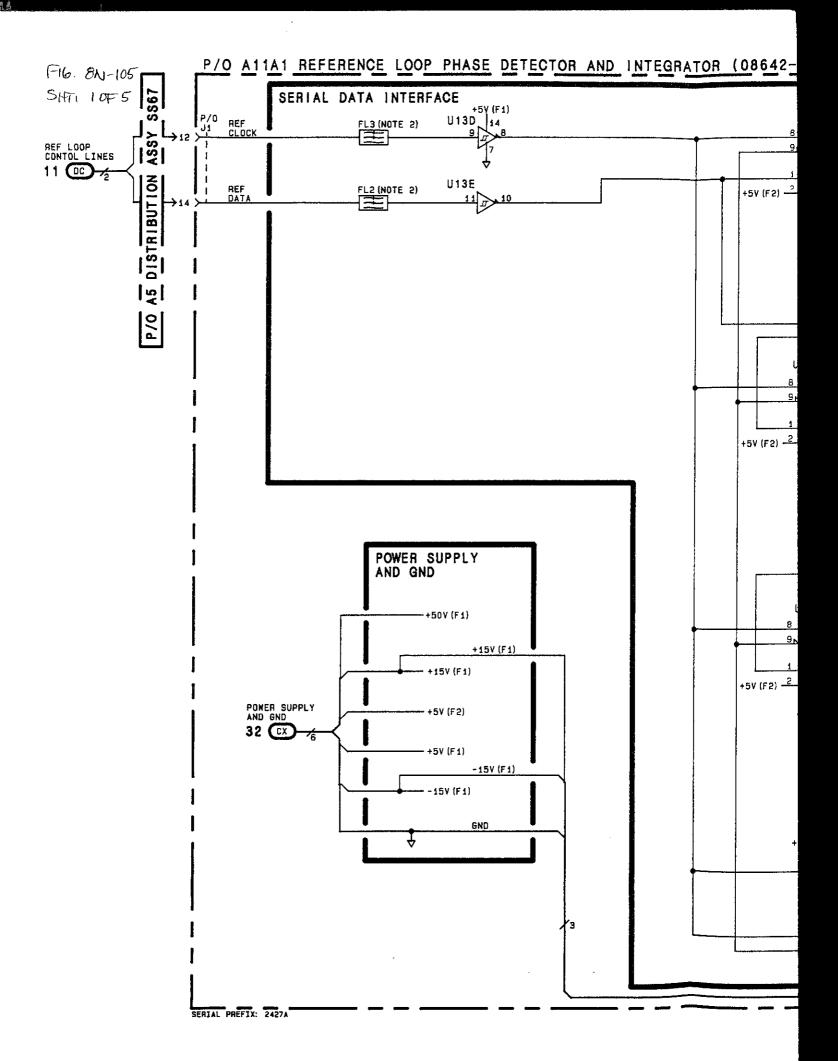
REFERENCE LOOP PHASE DETECTOR AND INTEGRATOR P/O A11A1 SEE REVERSE SIDE

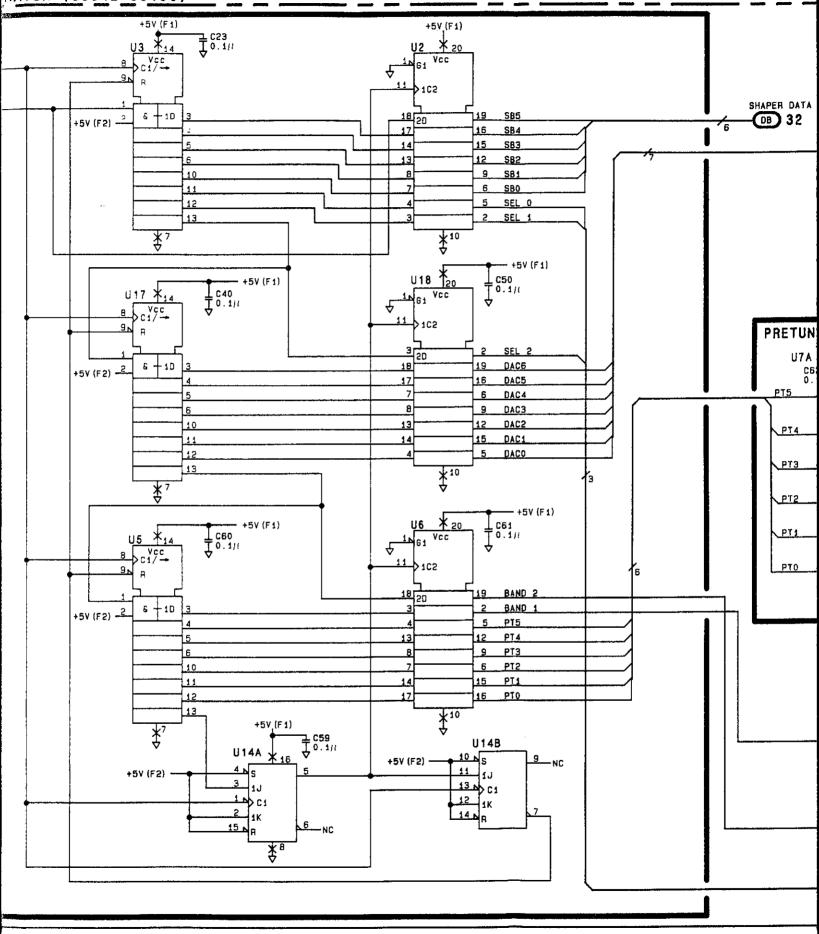
#### Notes:

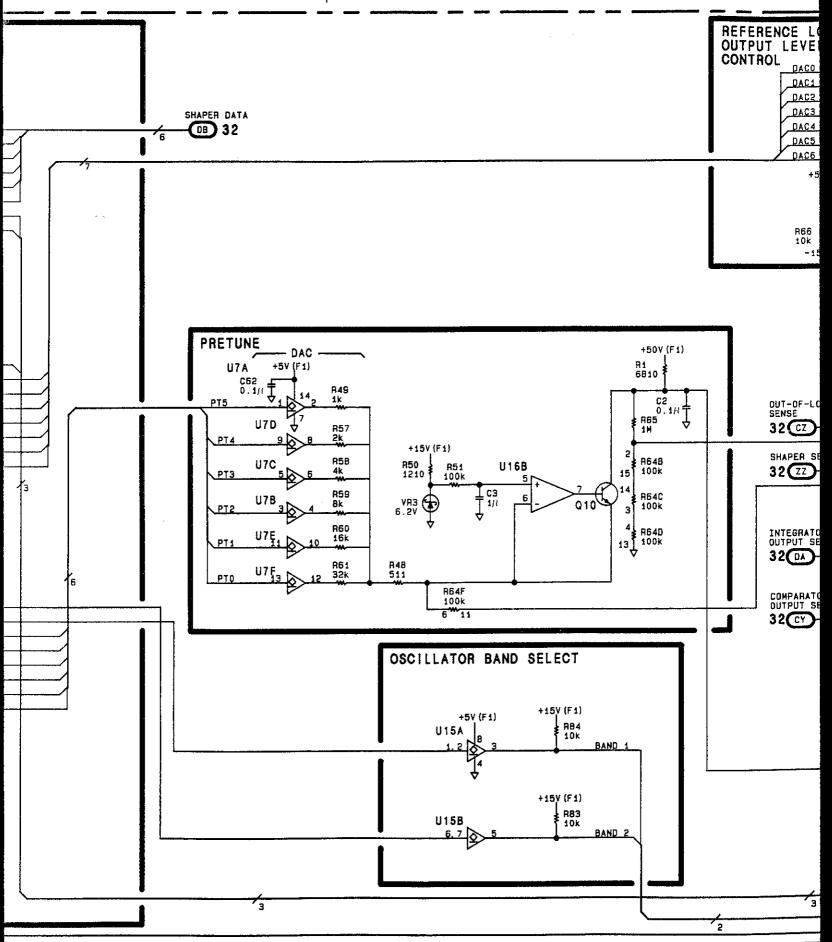
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the
  module configuration code. When servicing a module, note any changes that apply specifically to its module
  configuration code.
- 2. Feedthrough filter outer body must be soldered to the shielding in the area where shielding is notched.
- 3. All FL1 is an array of feed through filters passing through the center of the module to make connections between two (2) printed circuit boards.
- A11 FL2, A11 FL3 are low pass feedthrough filters passing through the center of the module to make connections between two (2) printed circuit boards.
- 5. All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

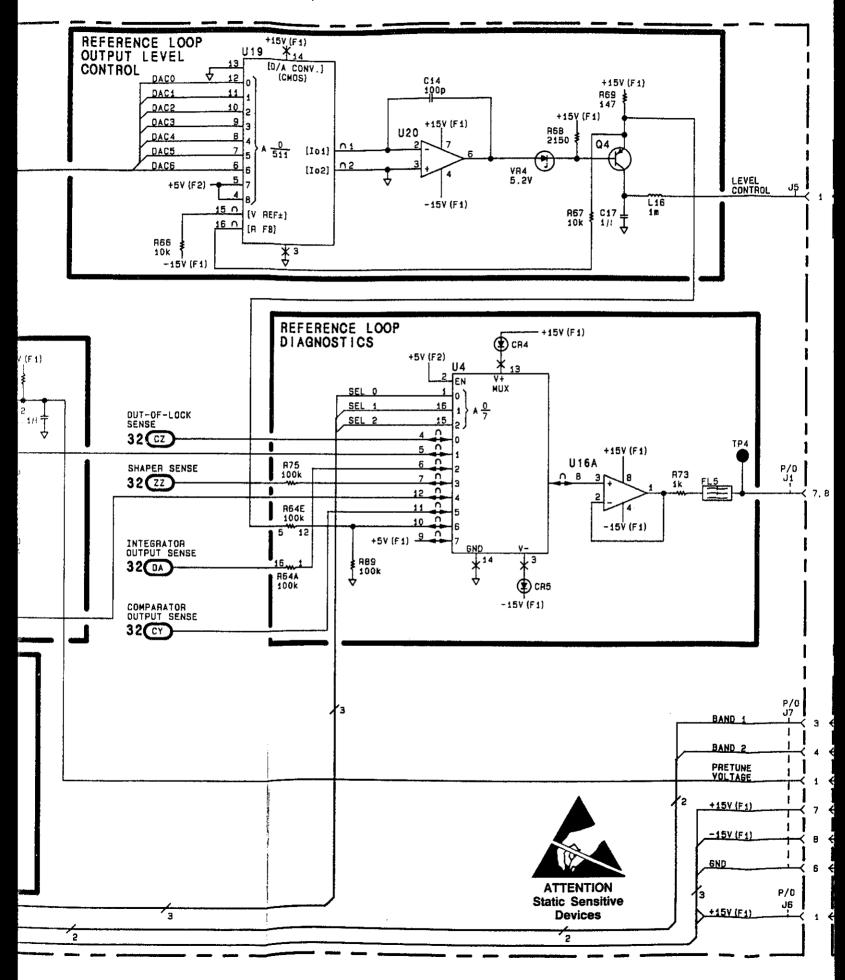
CABLE PLUG TO A11A1 J1

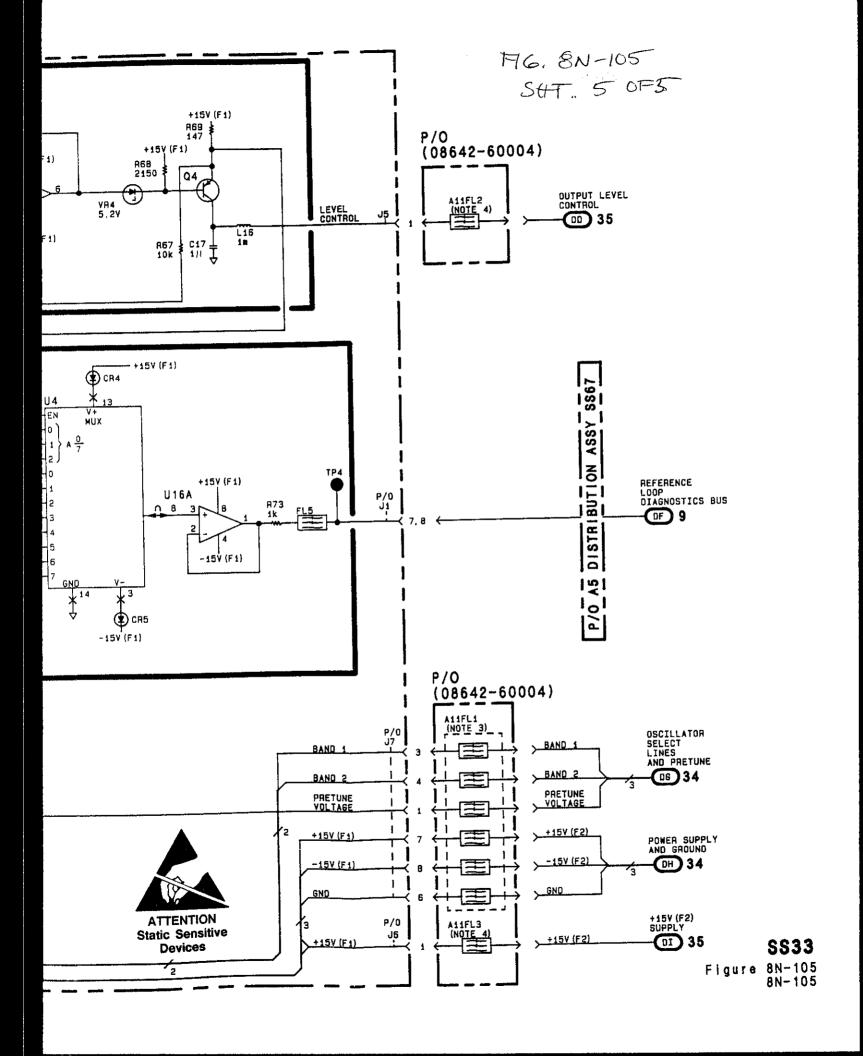












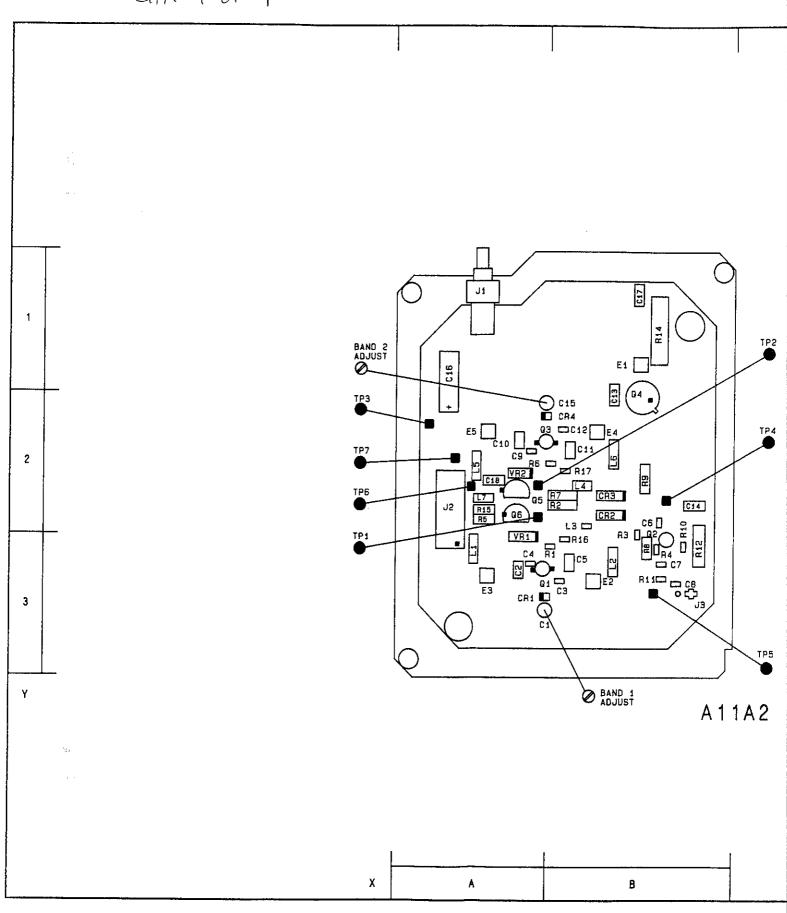
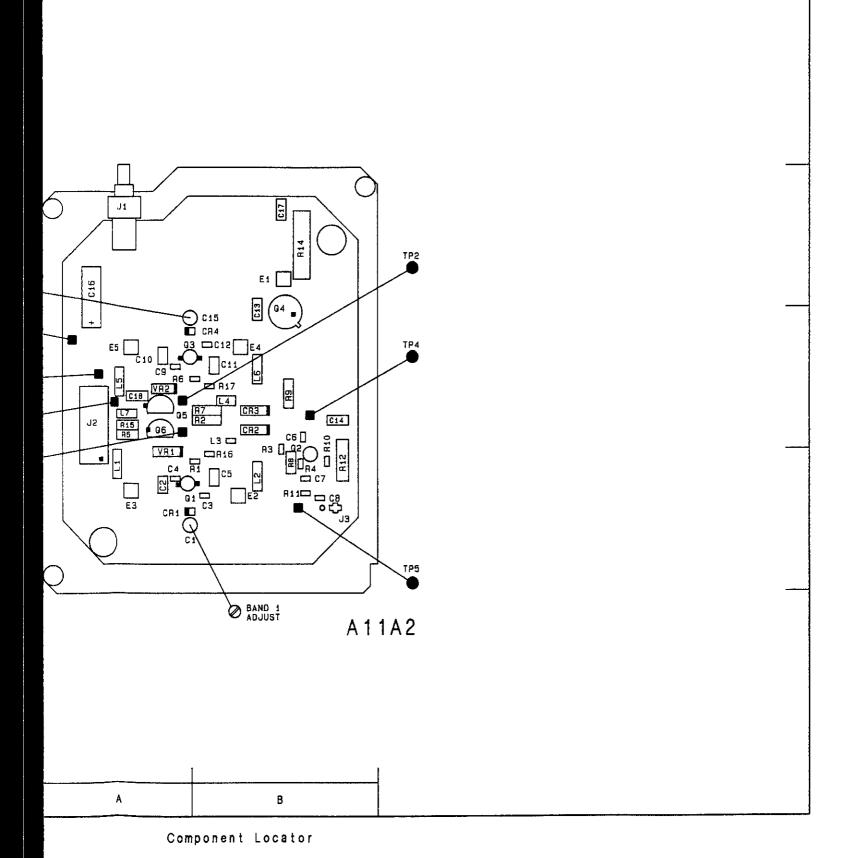
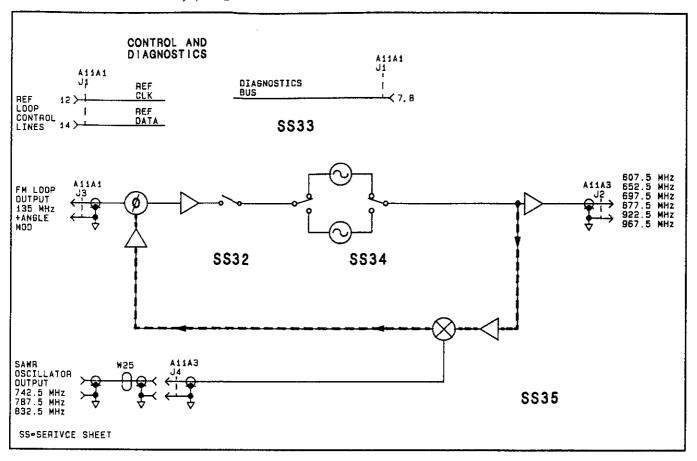


Figure 8N-106. SERVICE SHEET 34 INFORMATION

Component Locator





Reference Block Diagram

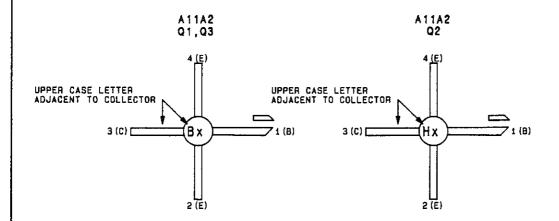
00110	[ , , , ]																
	-					COMP	X,Y	COMP	X,Y	COMP	X,Y	COMP	X,Y	COMP	X, Y	COMP	X,Y
COMP C1 C2 C3 C4 C5 C6 C7 C8 C9 C10 C11 C12 C13 C14 C15 C16 C17 C18 CR1 CR2 CR3	X , Y A , 3 3 3 3 3 3 3 3 3 3 2 3 3 3 2 2 2 2 2	COMP J1 J2 J3 L1 L2 L3 L4 L5 L6 L7 G1 G2 G3 G4 G6	X . Y A . A . B . A . B . A . B . A . A . B . A . A	COMP R1 R2 R3 R4 R5 R6 R7 R8 R9 R10 R11 R12 R14 R15 R16 R17 TP1 TP2 TP3 TP4	X	СОМР	X,Y	COMP	X,Y	COMP	X,Y	COMP	X,Y	СОМР	X,Y	СОМР	X,Y
CR3 CR4	A, 3 B, 2 B, 2 B, 2			TP5 TP6 TP7	B. 3												
E123345	B. 1 B. 3 B. 2 B. 2 B. 2			VR1 VR2	A, 2 A, 2 A, 2												

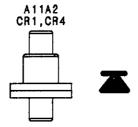
P/O A11A1 REFERENCE PHASE DETECTOR SS33

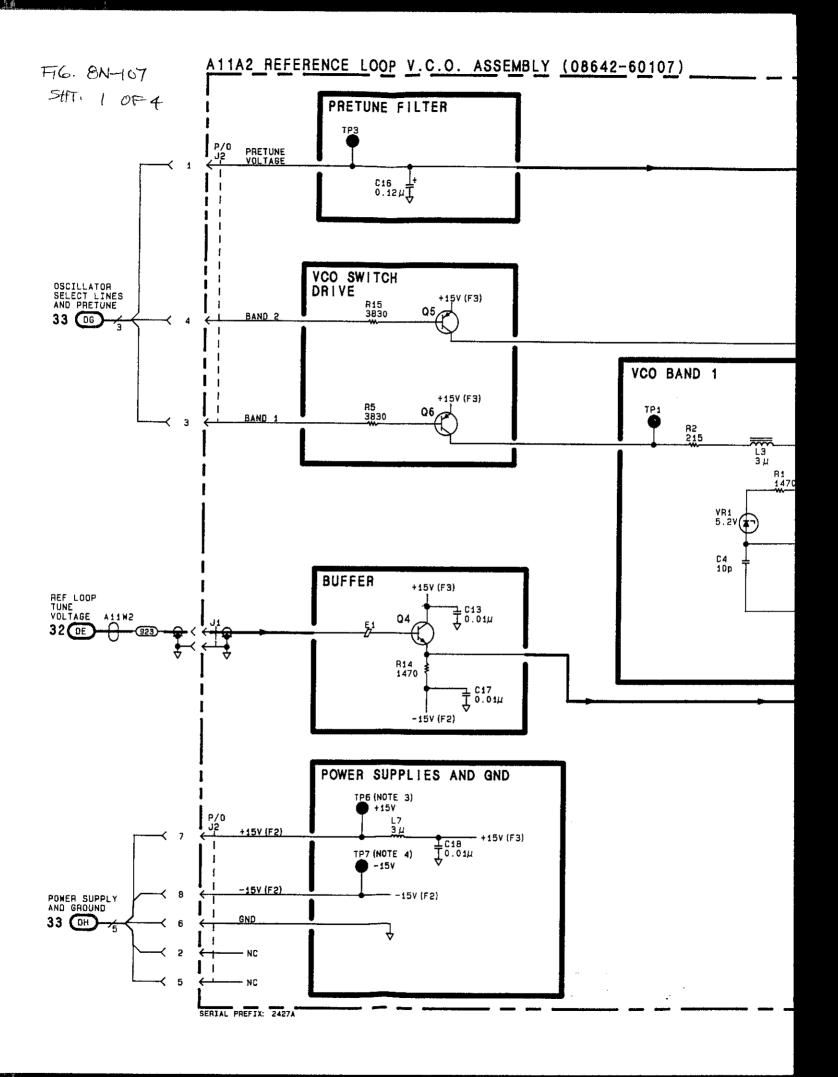
8

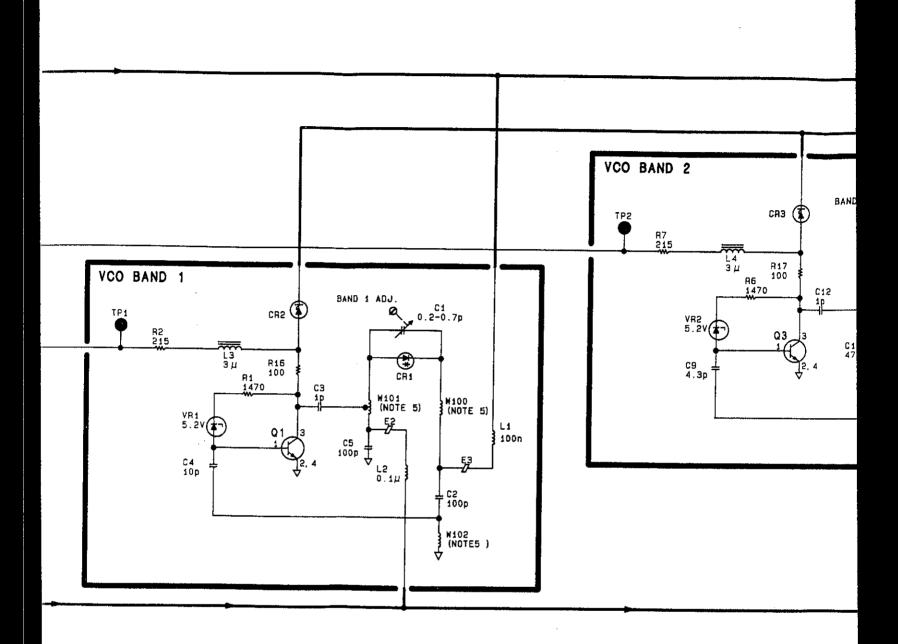
#### Notes:

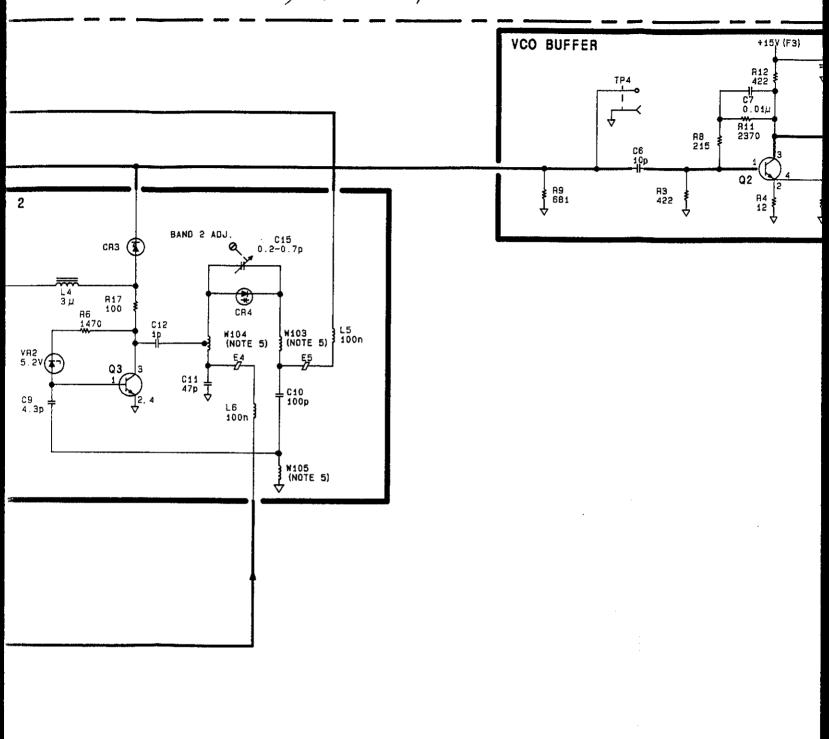
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. AliA2 J3 consists of a clip and a single connector.
- 3. TP6 is labeled +i5V on the printed circuit board.
- 4. TP7 is labeled -15V on the printed circuit board.
- 5. W100-W105 are printed circuit trace inductors.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

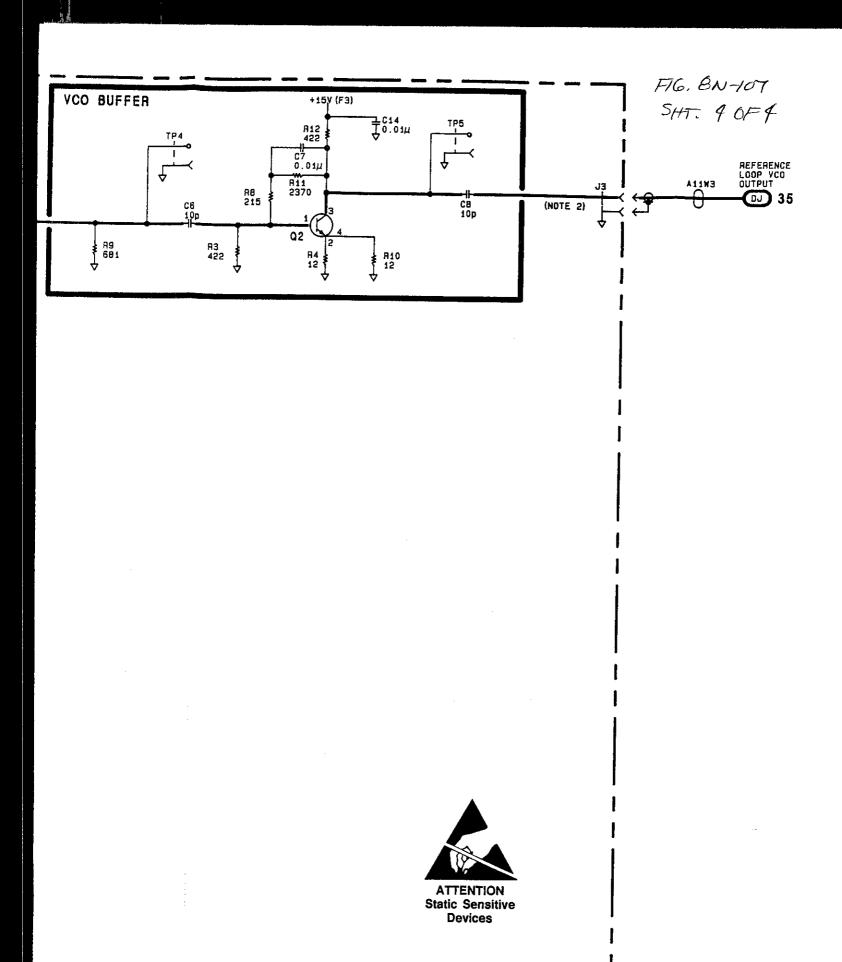






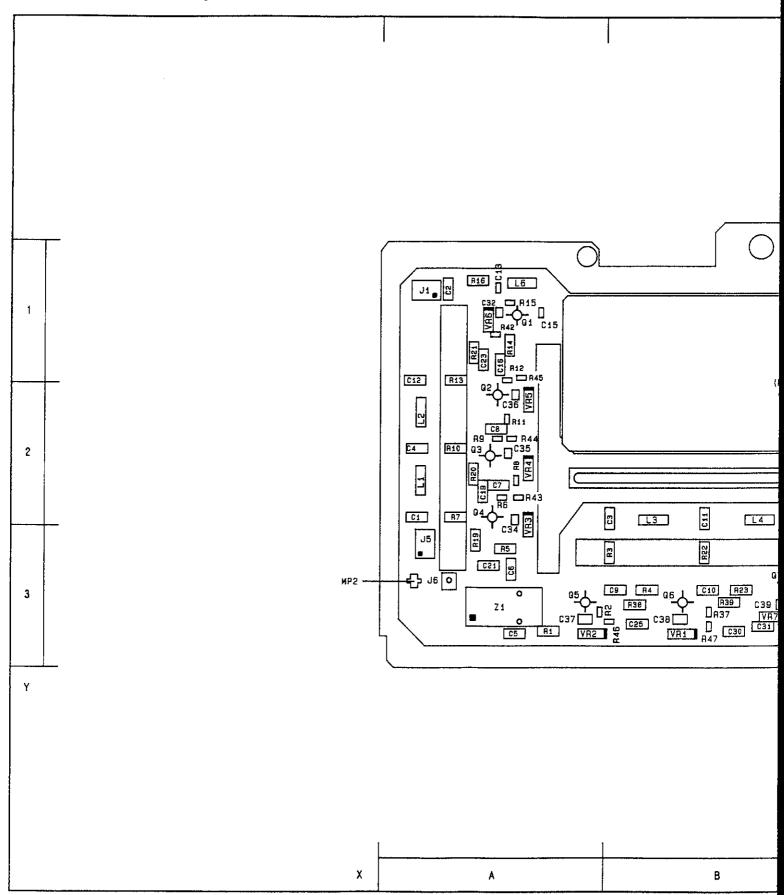


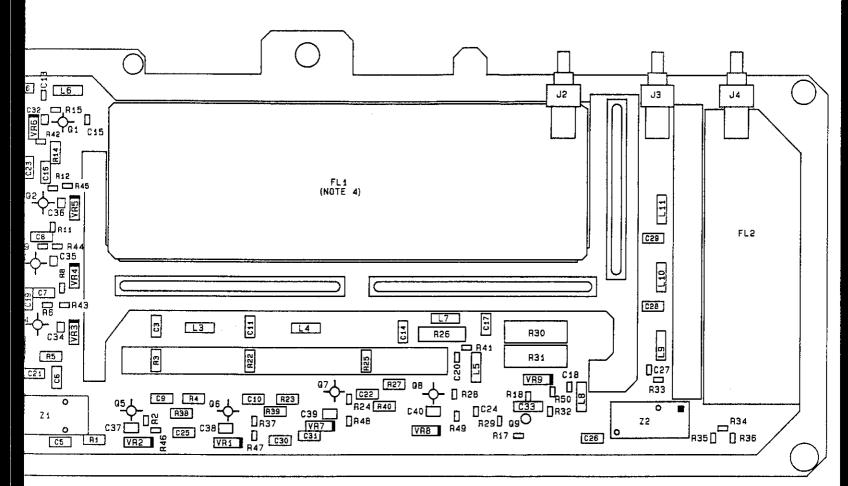




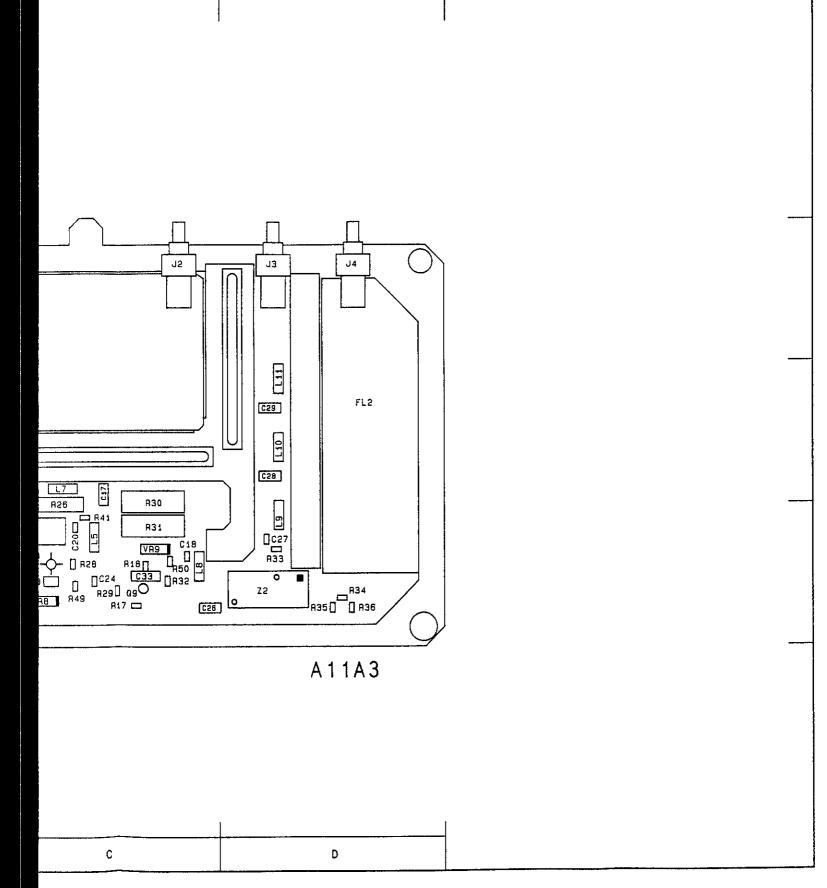
**SS34** 

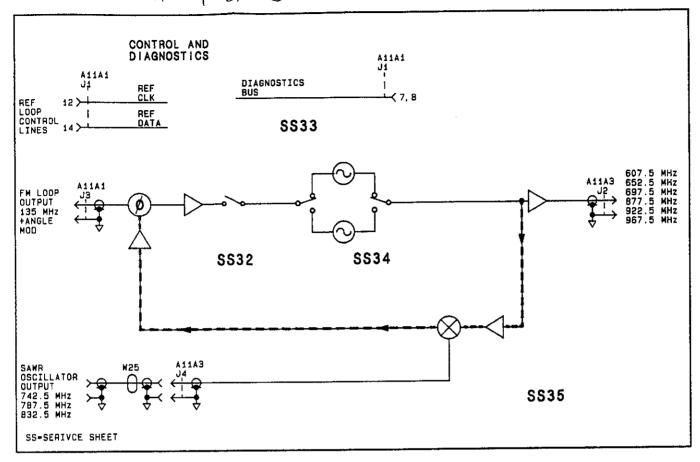
Figure 8N-107 8N-107





A11A3





Reference Block Diagram

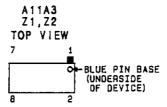
СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C2 CC4 CC5 CC5 CC7 CC112 CC112 CC114 CC115 CC116	21223322332113112323331133332233132223	C38 C39 C40 FL12 J34 J56 L1234 J56 L1234 J56 L1234 J56 L1234 J56 L1234 J67 B90 C40 B90 B90 B90 B90 B90 B90 B90 B90 B90 B9	333 12 111133 2222312322 3 122233332 3 122233333	R1 R2 R3 R5 R6 R10 R112 R115 R115 R116 R110 R116 R116 R116 R116 R116 R116	. A.B.B.A.A.A.A.A.A.A.A.C.C.A.A.B.B.B.B.C.C.C.C	R38 R39 R40 R41 R42 R44 R45 R47 R48 R50 VR1 VR2 VR3 VR45 VR7 VR6 VR7 VR8 VR9 Z1 Z2	BBCCAAAABBBCC BAAAAABCC AC										

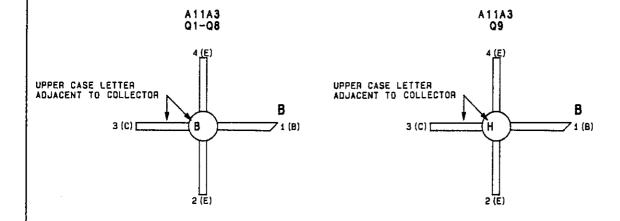
A11A2 REFERENCE LOOP SS34

SEE REVERSE SIDE

#### Notes:

- Each module in the HP 8542 has a nine digit module identification code. The first four digits comprise the
  module configuration code. When servicing a module, note any changes that apply specifically to its module
  configuration code.
- 2. L12-L18 are printed circuit trace inductors.
- 3. A11A3 J6 consists of a clip and single connector.
- 4. FL1 has polyiron shielding bordering the filter image (PC trace). It must be positioned so that none of the image area is covered by the polyiron. If the polyiron moves, recalibration may be necessary.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.





### **CHANGES**

# 2529A and above

In Schematic General Information:

Revise Note 4 to include FL2.

On the schematic:

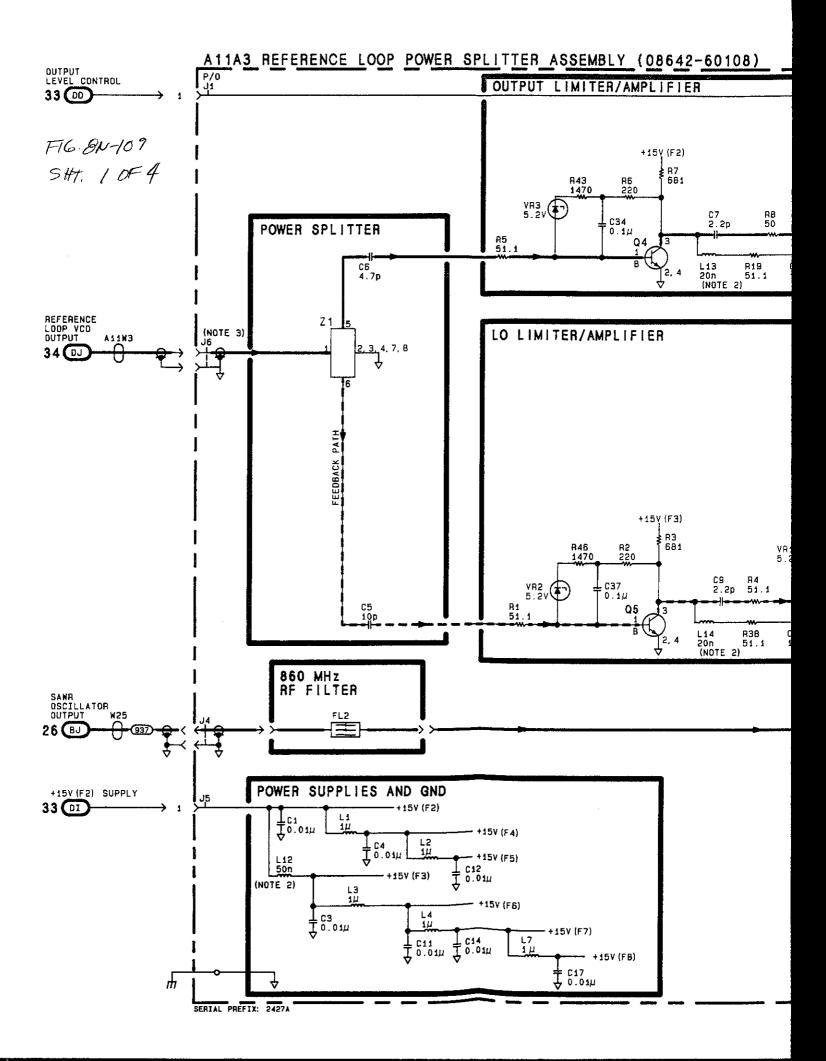
• In 860 MHz RF FILTER, add "NOTE 4" next to FL2.

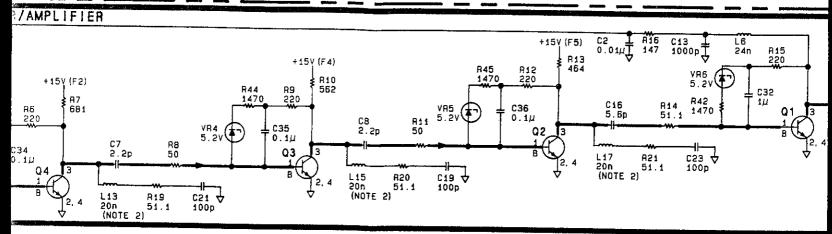
On the schematic:

• AllA3 L8 - In LO LIMITER/AMPLIFIER change the value of L8 to 36n Henries.

2535A and above

> SS35 8N-108.1







(FB)

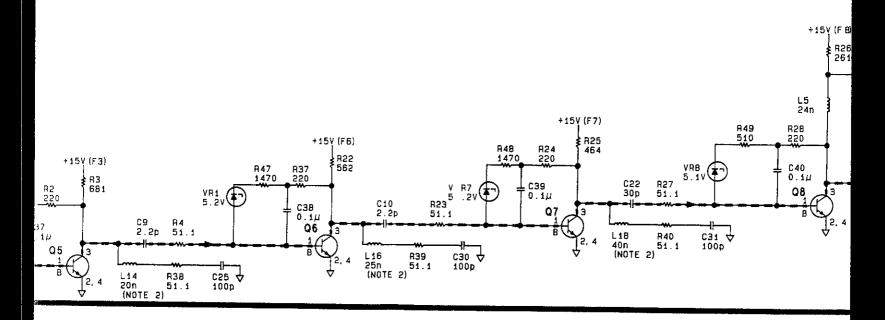
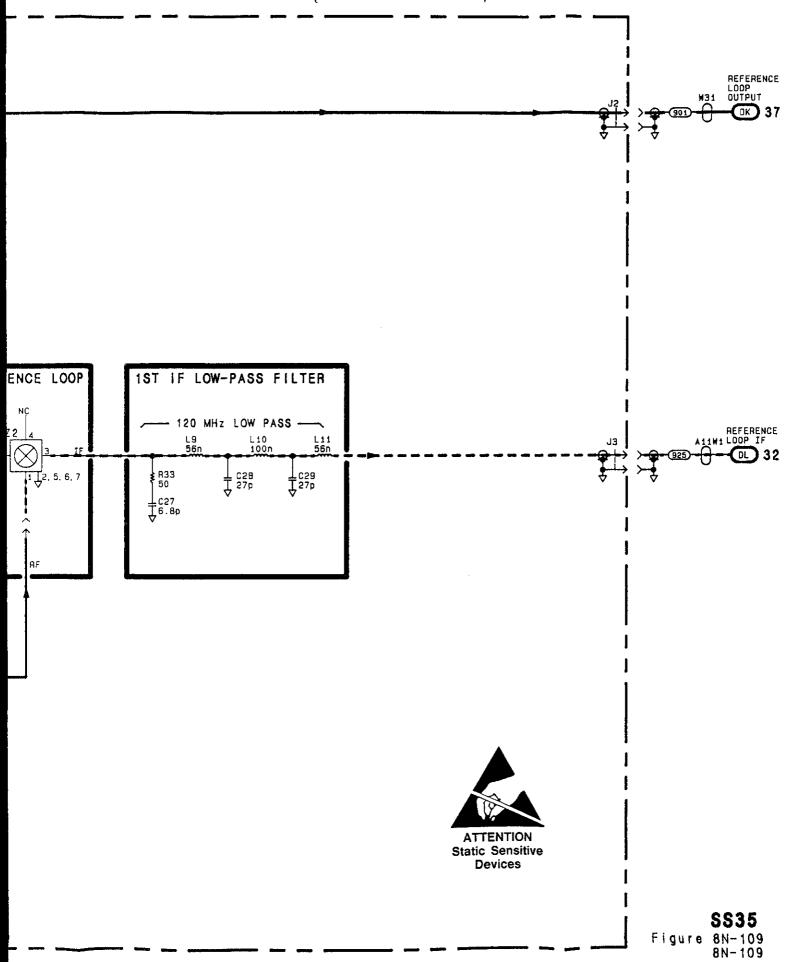
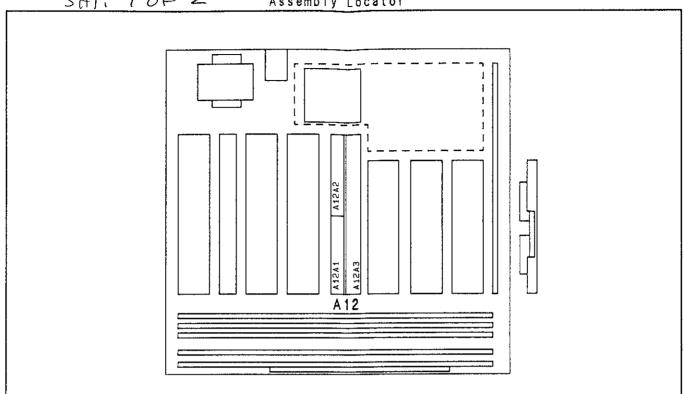


FIG. 8N-109 SHT. 3 0+4 13 1000p R15 220 - OUTPUT FILTER -⊥ c32 1μ FL1 (NOTE 4) 4 1470 1 1470 01 C15 10p C23 V +15Y (FB) +157 (F 8) R26 261  $\stackrel{\textstyle \perp}{ \downarrow} \begin{tabular}{l} $C18 \\ \hline 0.01 $\mu$ \end{tabular}$ REFERENCE LOOP MIXER 1ST IF LOW-L.8 24n ₹ 841 50 15 24n Ţ 1000p 832 220 849 510 R28 220 - 120 MHz L9 56n VR9 4.7v Q9 C40 0.1µ C26 30p 1 2, 5, 6, 7 ₹ #33 50 C24 22p 08 H29 510 ₹ ¥ A18 12 C31 V RF 8dB ATTENUATOR R34 45 R36 130 R35 130



# A12 Sum Loop/Divider Module



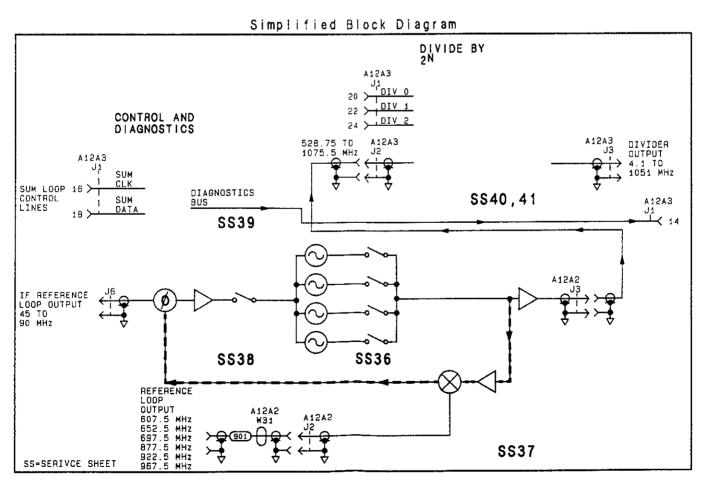
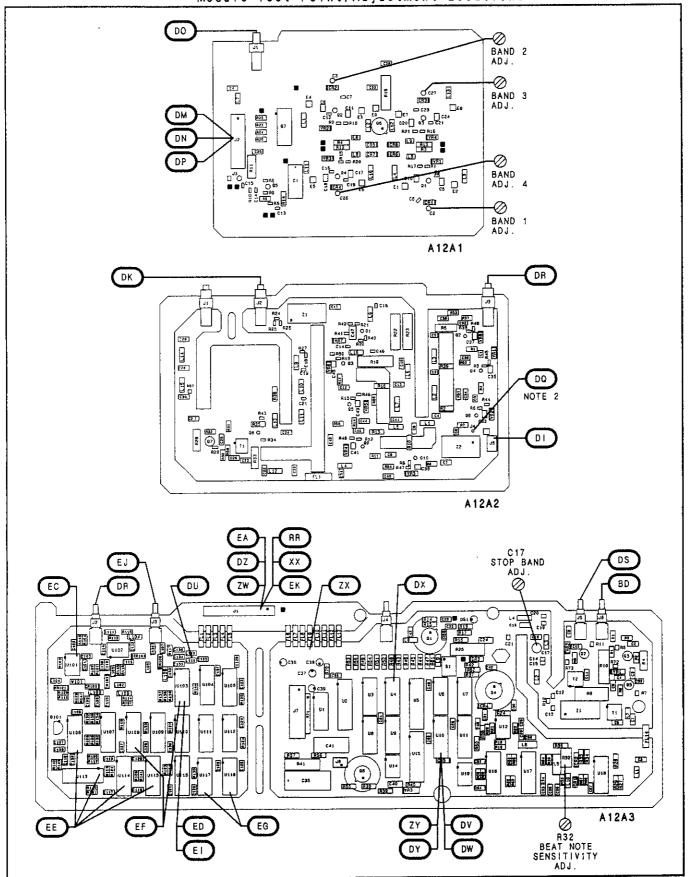
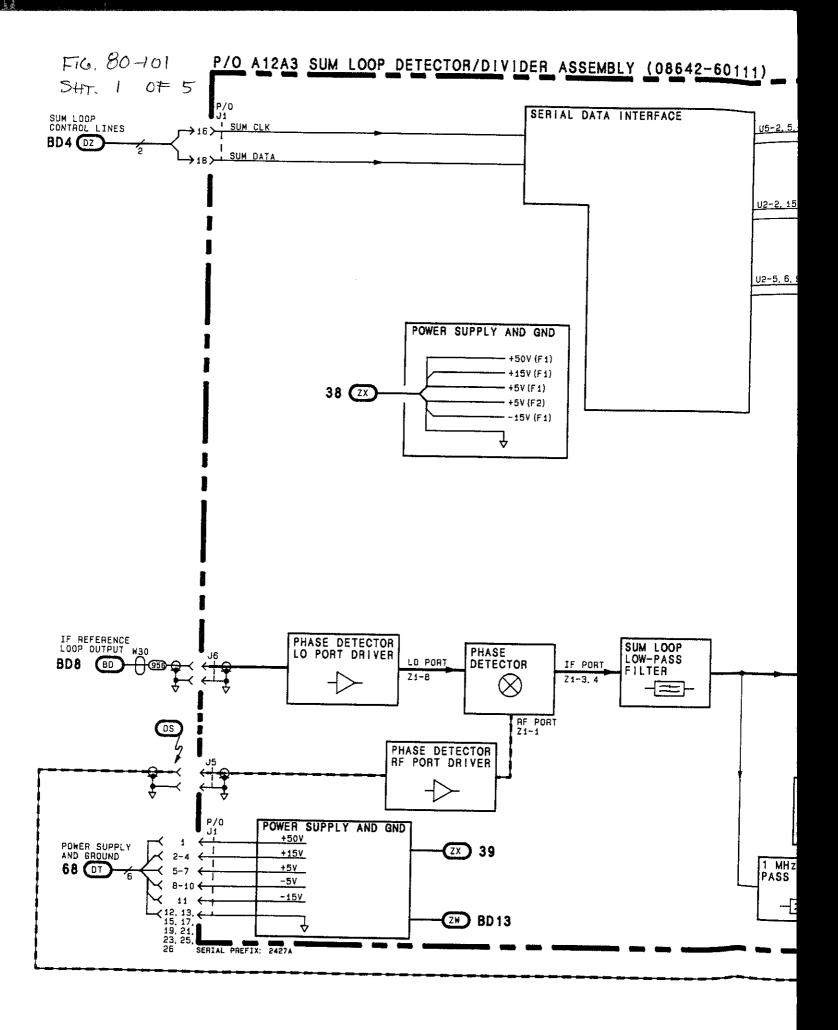
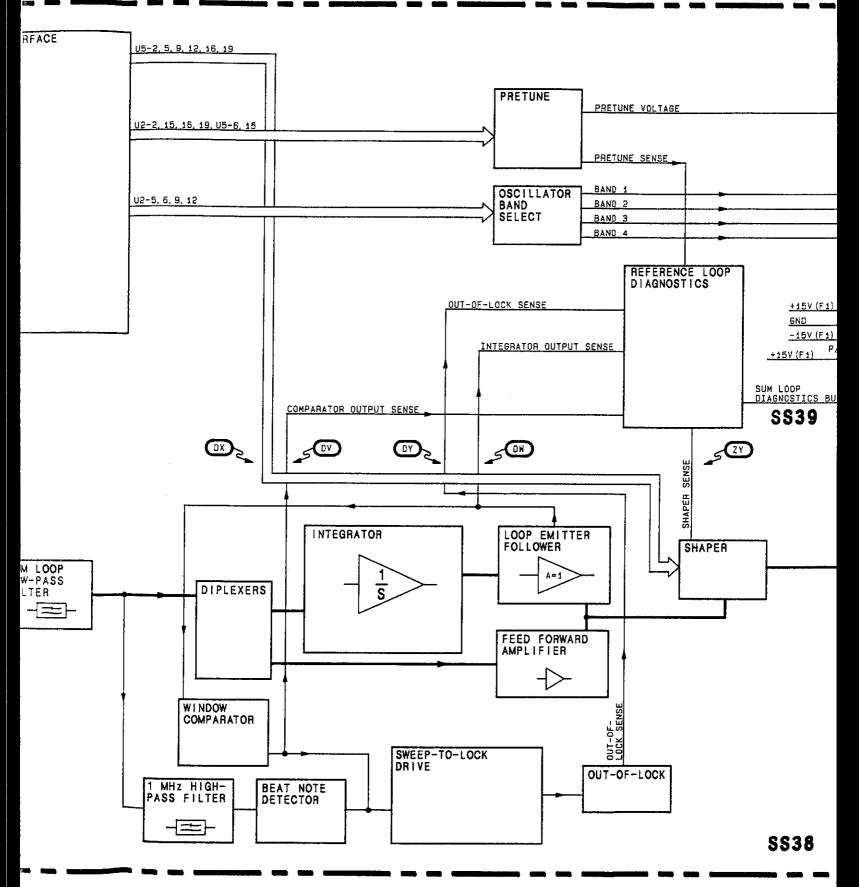


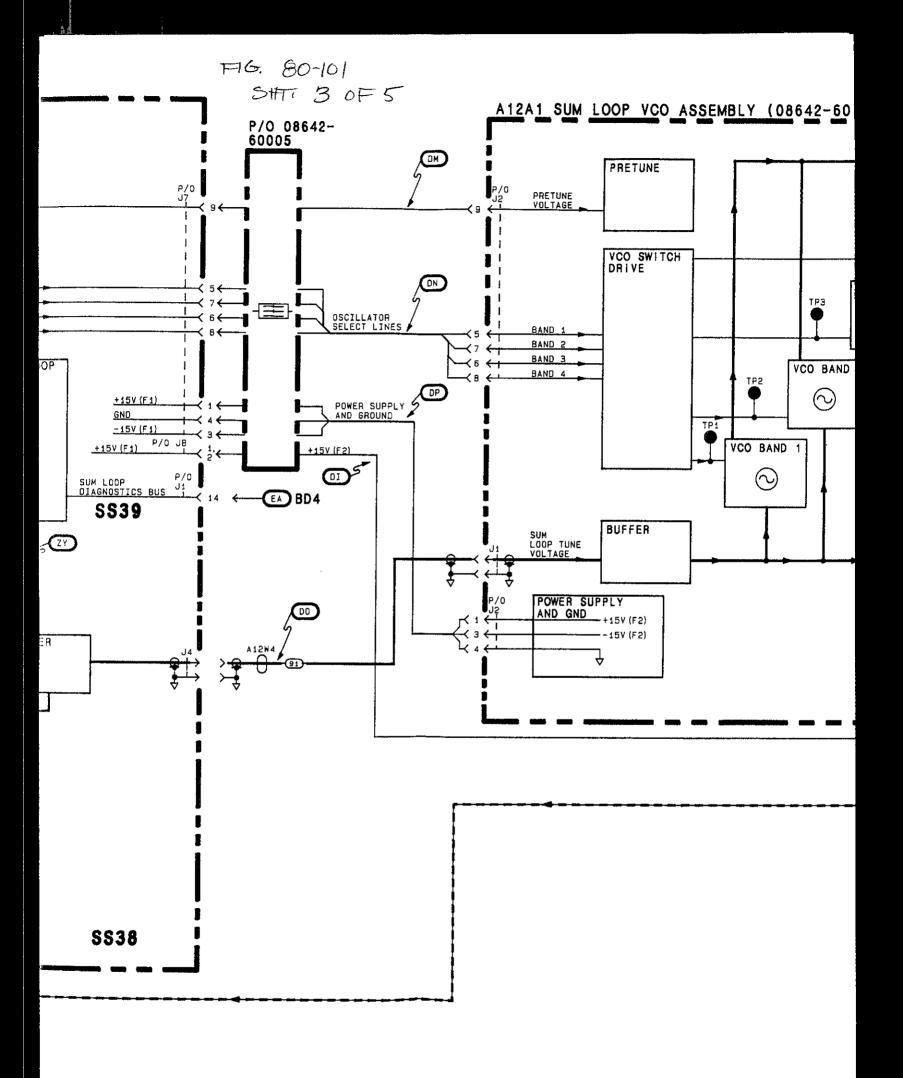
Figure 80-100 BD12,13 General Information.

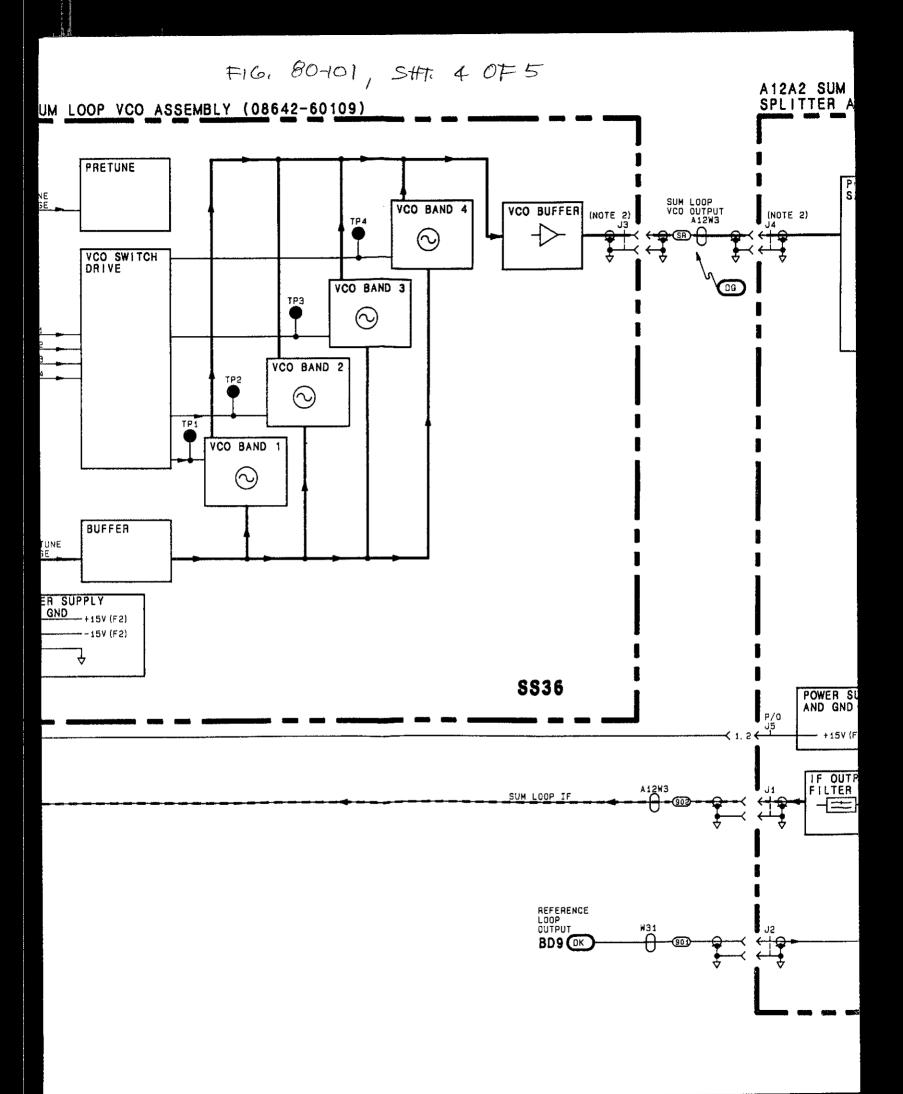
Module Test Point/Adjustment Locations

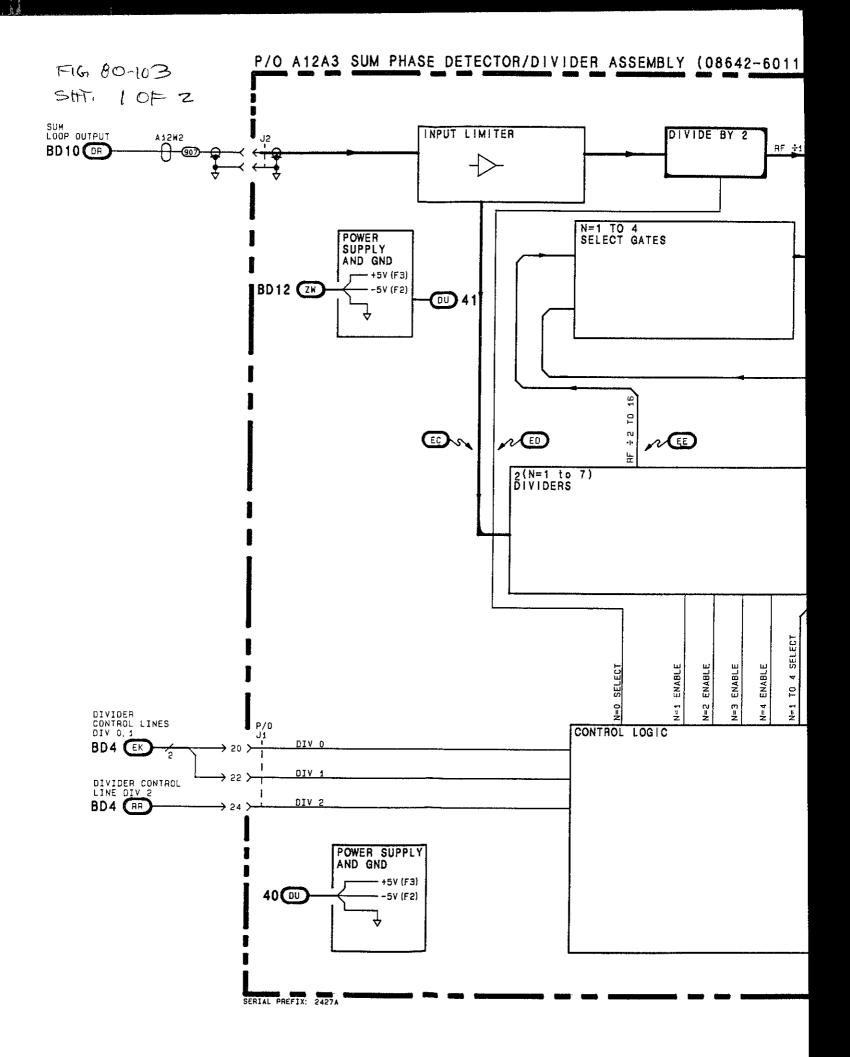


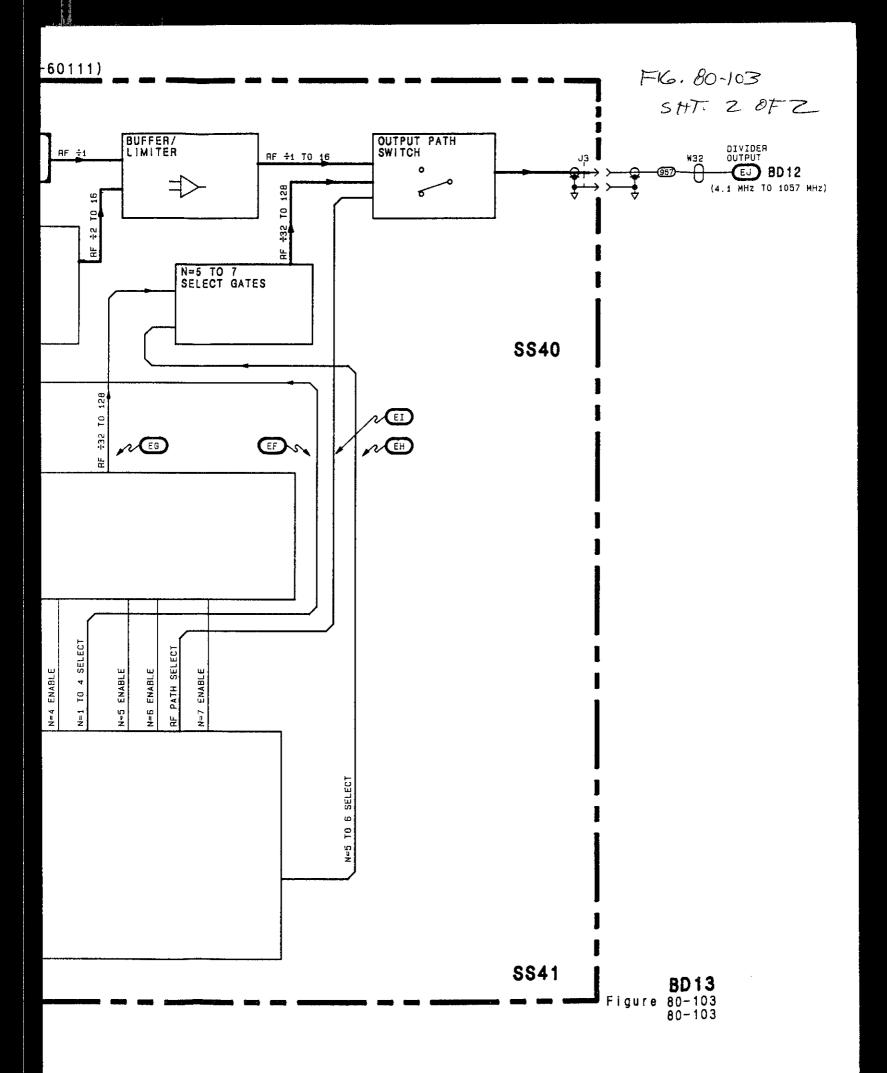






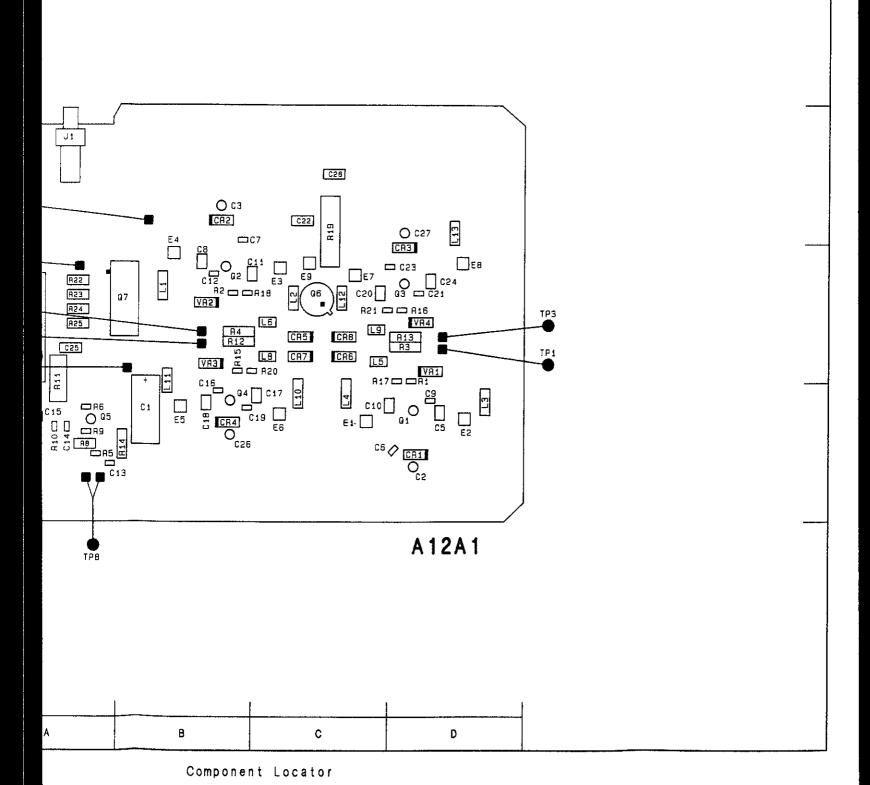


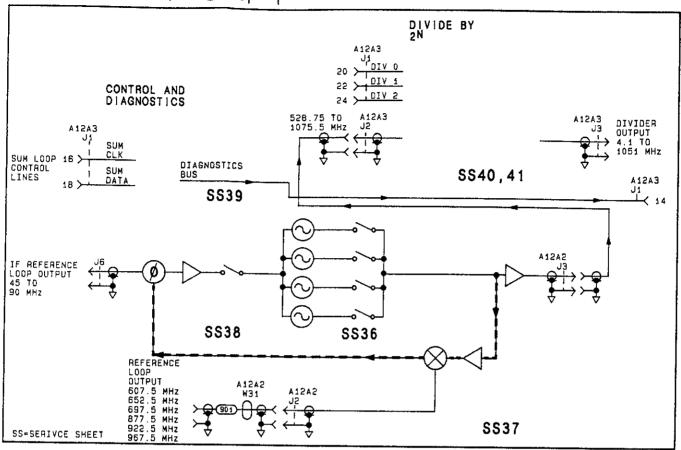




A

Figure 80-104. SERVICE SHEET 36 INFORMATION





Reference Block Diagram

# Component Coordinates

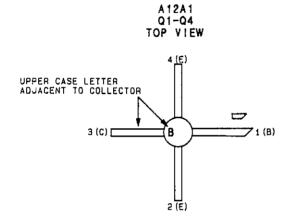
COMP X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	COMP	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X , Y
C1 C2 C3 C4 C5 C5 C6 C7 C8 C9 C11 C12 C13 C14 C15 C16 C17 C18 C10 C114 C15 C114 C15 C114 C15 C117 C118 C118 C117 C118 C118 C118 C118	J123 J123 L123 L156 L578 J1112 L1123			D.B.D.B.A.A.A.A.B.D.B.B.D.B.C.C.A.A.A.       D.B.D.B.B.B.A.A.A.A.A.B.D.B.B.B.A.A.A.	VR1 VR2 VR3 VR4	D.B.B.D.										

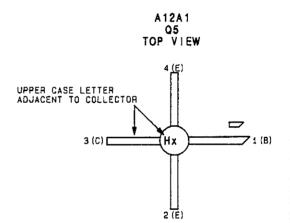
A12 MODULE BD13

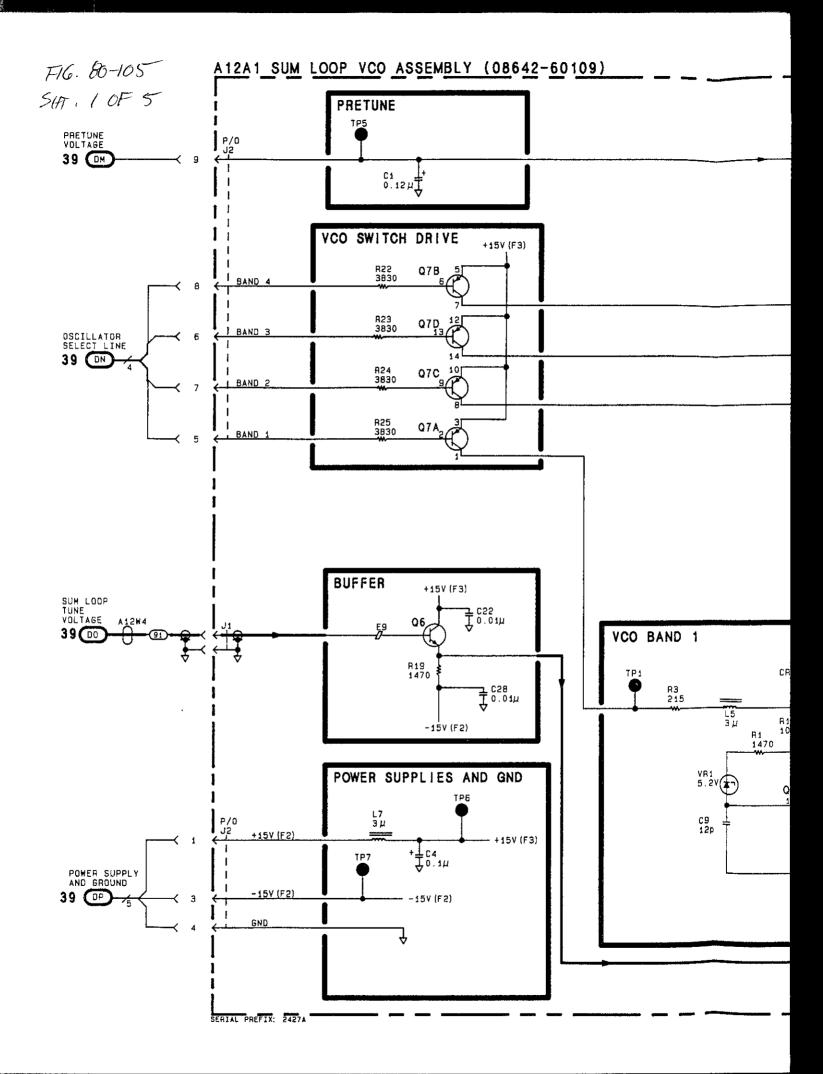
SEE REVEASE SIDE

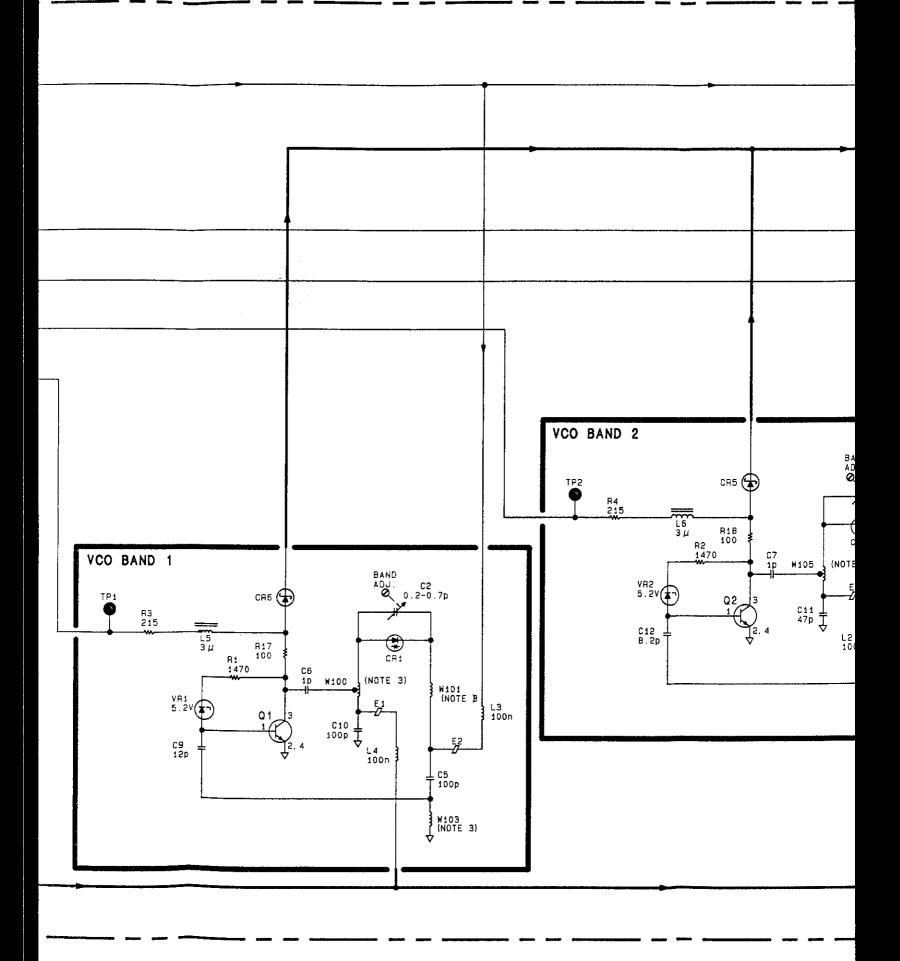
# Notes:

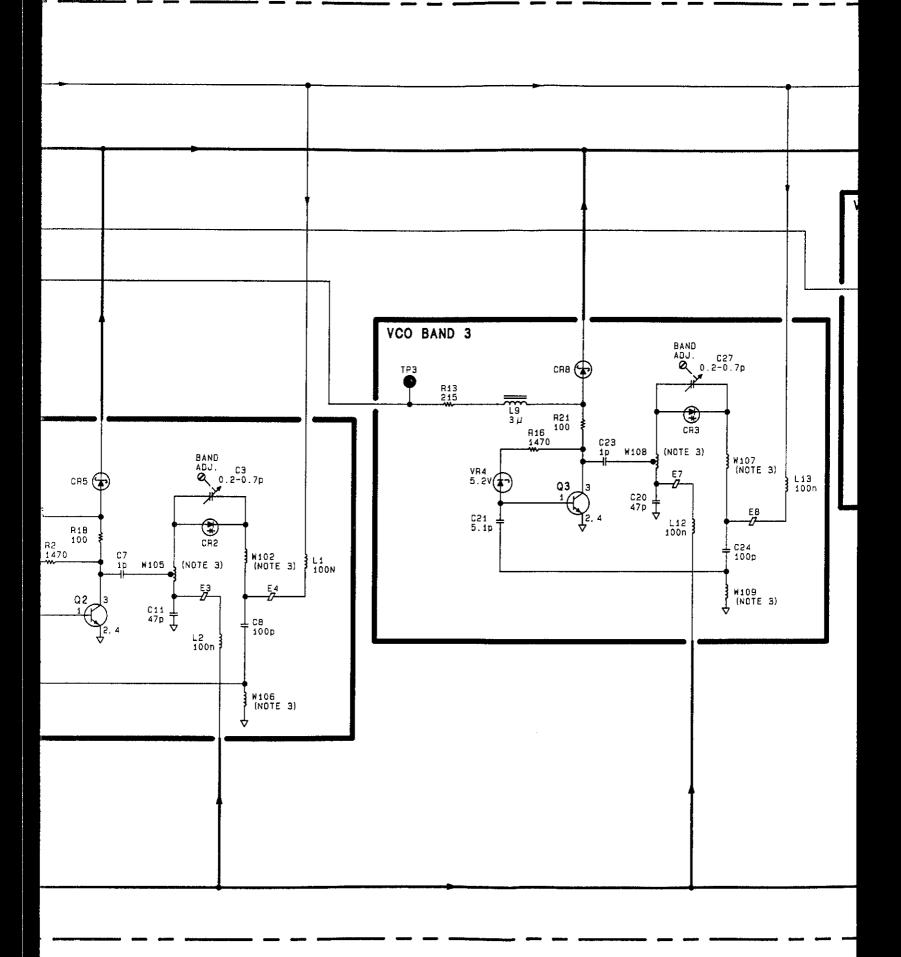
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. A12A1 J3 consists of a clip and a single connector.
- 3. W100-W111 are printed circuit trace inductors.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

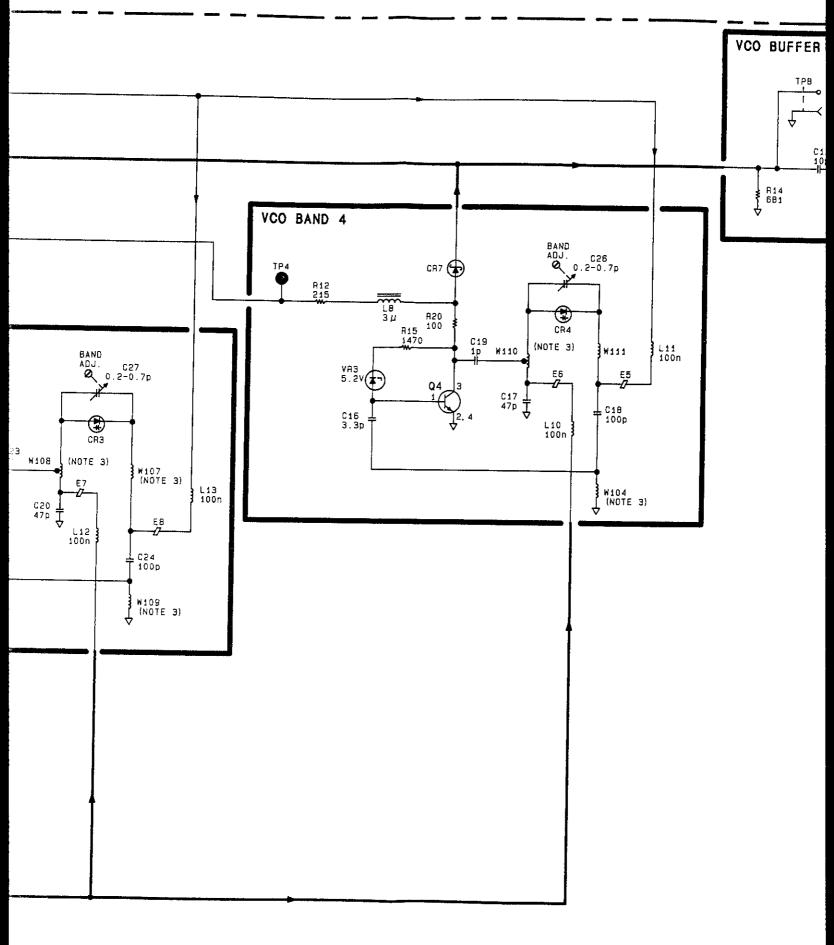


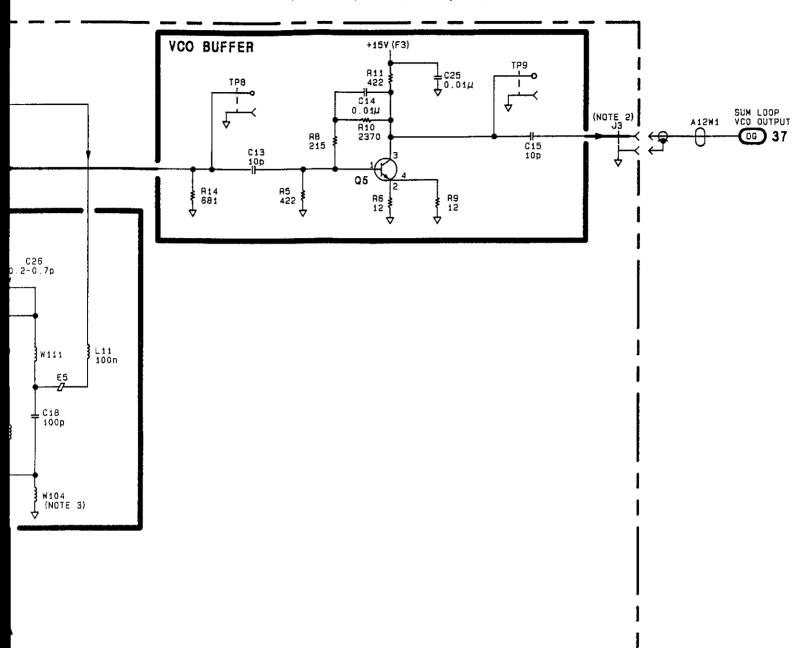














**\$\$36**Figure 80-105
80-105

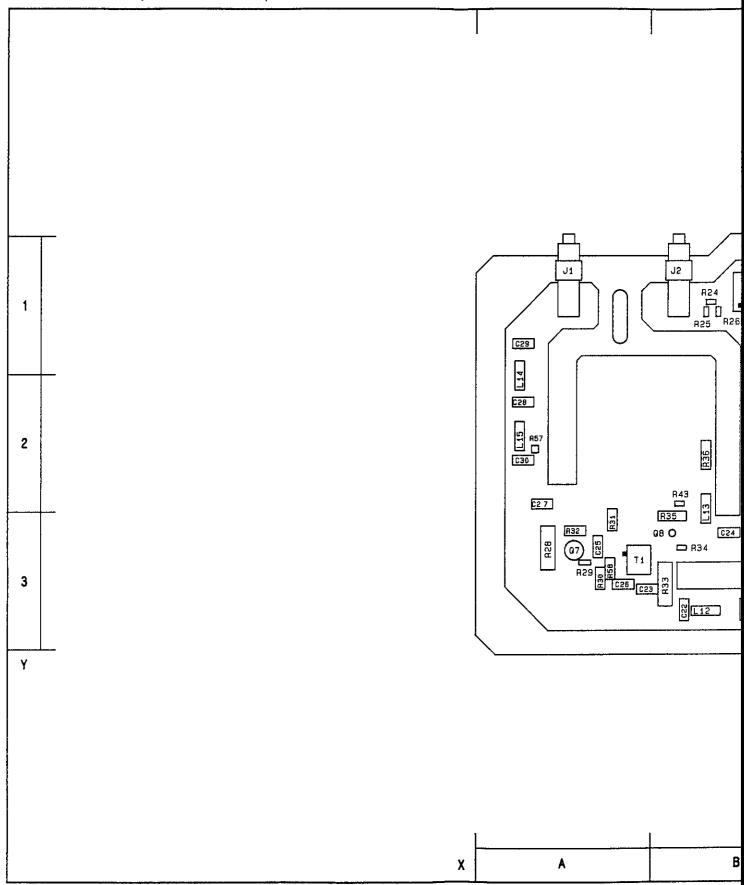
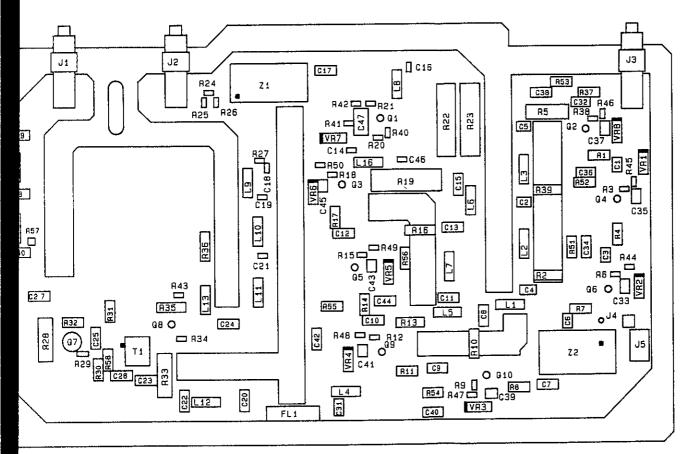
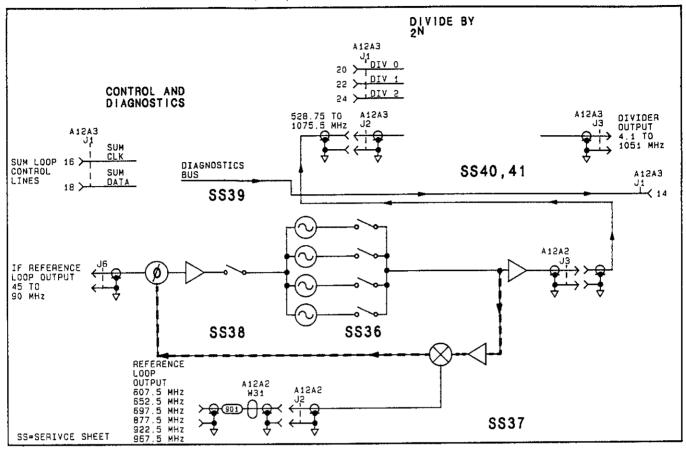


Figure 80-106. SERVICE SHEET 37 INFORMATION



A12A2



Reference Block Diagram

# Component Coordinates

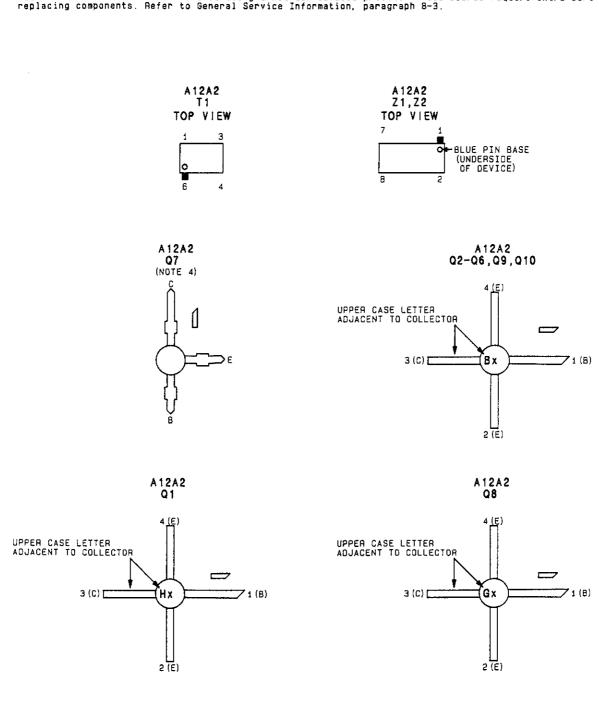
СОМР	X,Y	COMP	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C1 C2 C3 C4 C5 C6 C7 C8 C9 C11 C12 C12 C14 C15 C17 C18 C19 C20 C21 C22 C22 C22 C22 C22 C22 C22 C23 C23 C23	00000000000000000000000000000000000000	C38 C39 C41 C42 C444 C445 C447 FL1 J22 J34 J5 L12 L11 L11 L11 L11 L11 L11 L11 L11 L11	1333322211 3 11133 2213322122232221 1333322211 3 11133 2213322122232222	01 02 03 03 03 03 03 03 03 03 03 03 03 03 03		A27 R28 R30 R31 R33 R33 R33 R33 R33 R33 R33	8.4.4.4.8.8.8.8.0.0.0.0.0.0.0.0.0.0.0.0.	VA1 VA2 VA3 VA4 VA5 VA6 VA7 VAB Z1 Z2	0.0.0332211 B.0. B.0.								

A12A1 SUM LOOP SS36

SEE REVERSE SIDE

### Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. A12A2 J4 consists of a clip and a single connector.
- 3. L17-L22 are printed circuit trace inductors.
- 4. 97 is mounted with printed side of device toward solder side of board.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.



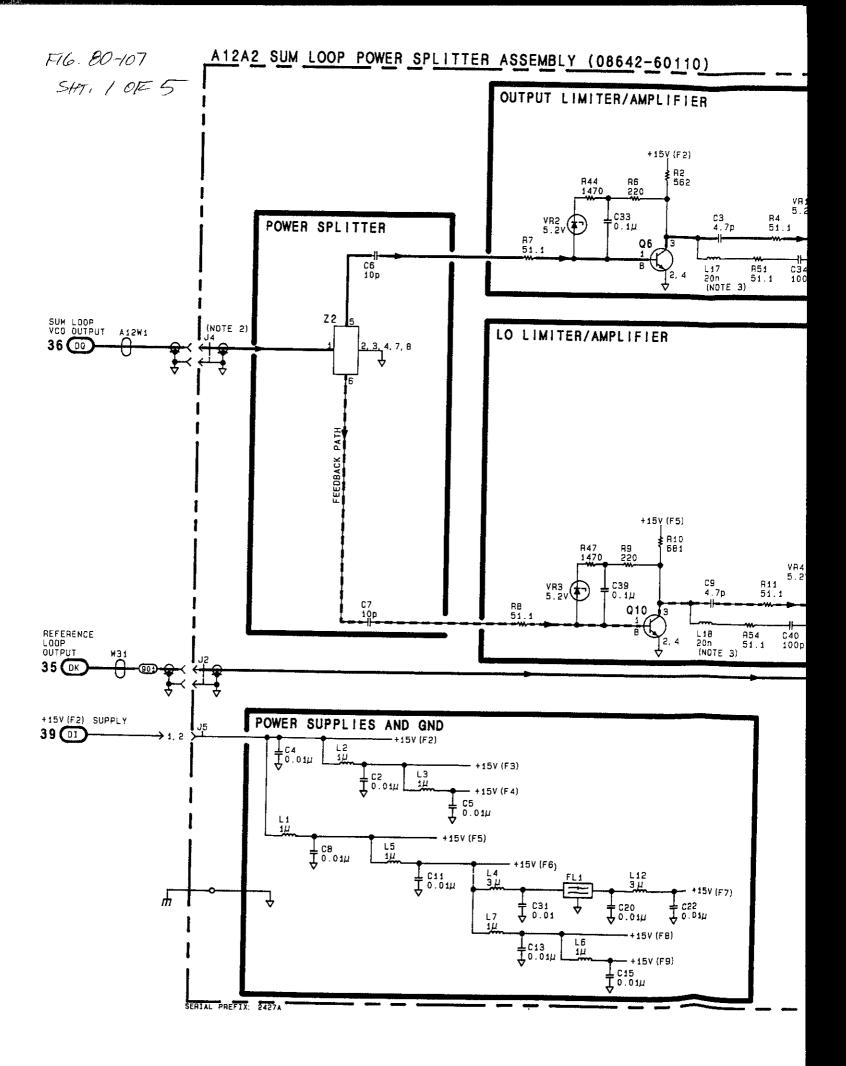
Schematic General Information

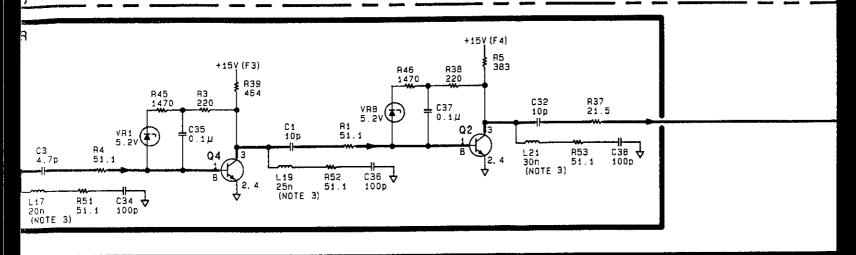
# **CHANGES**

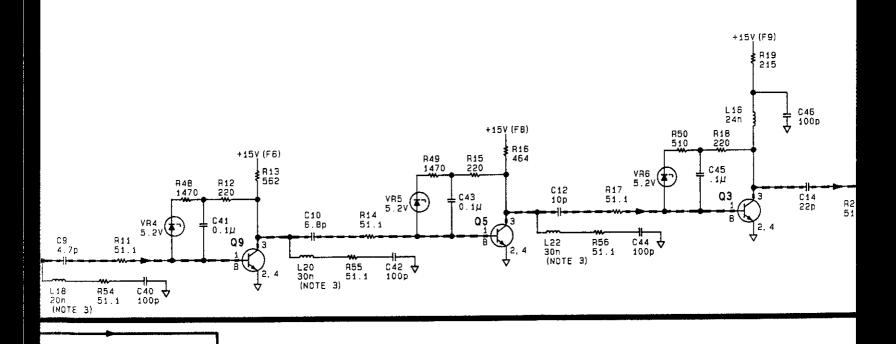
# 2613A and above

## On the schematic:

• In the upper left portion of the schematic change the A12 part number to 08642-60210.

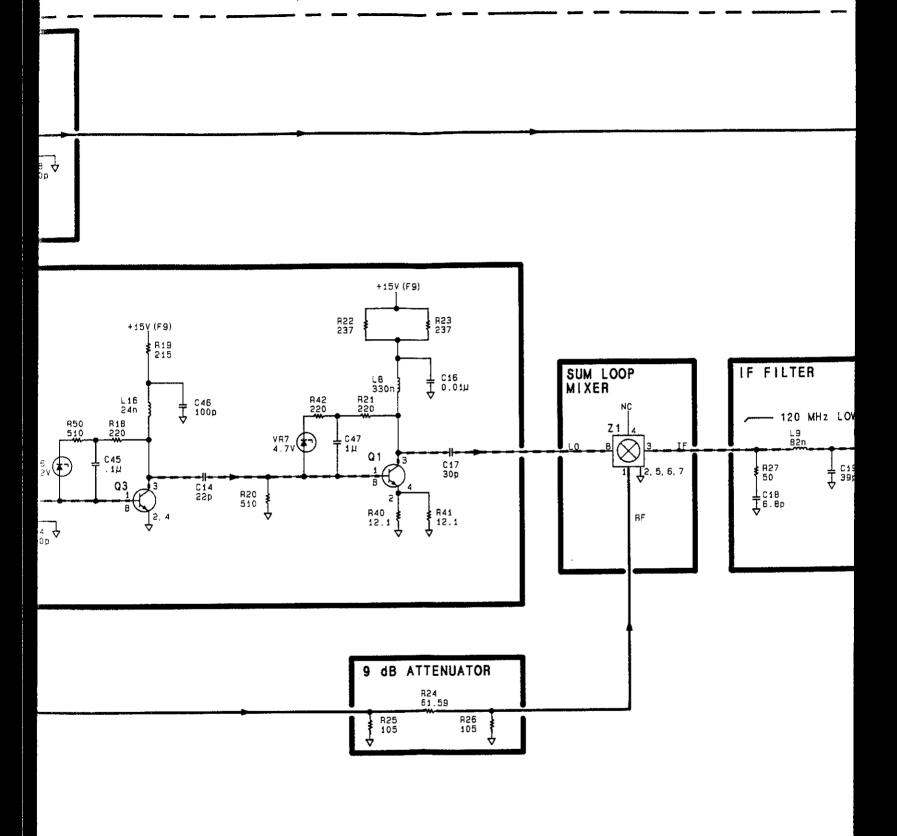


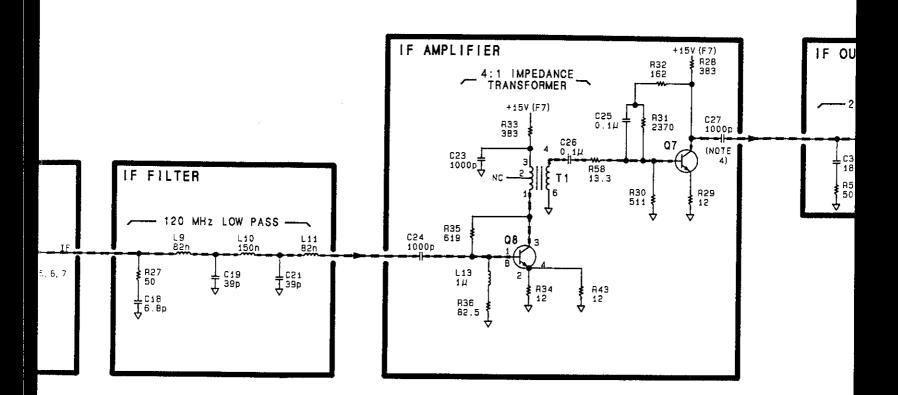


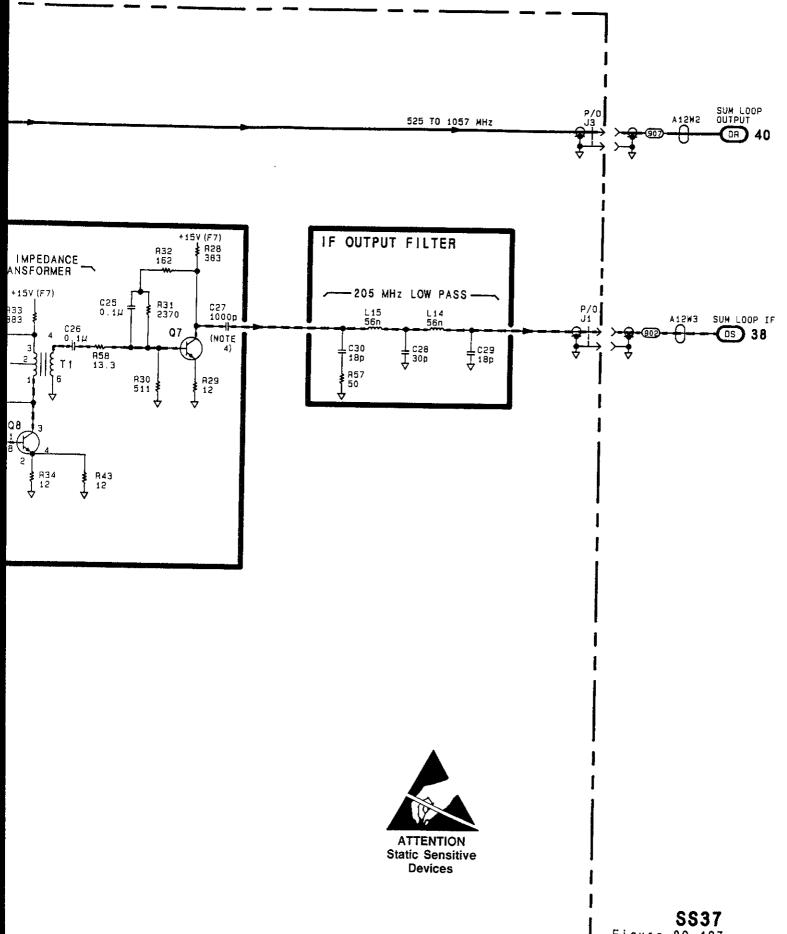


- +15V (F7)

522 . 01µ







**SS37** Figure 80-107 80-107

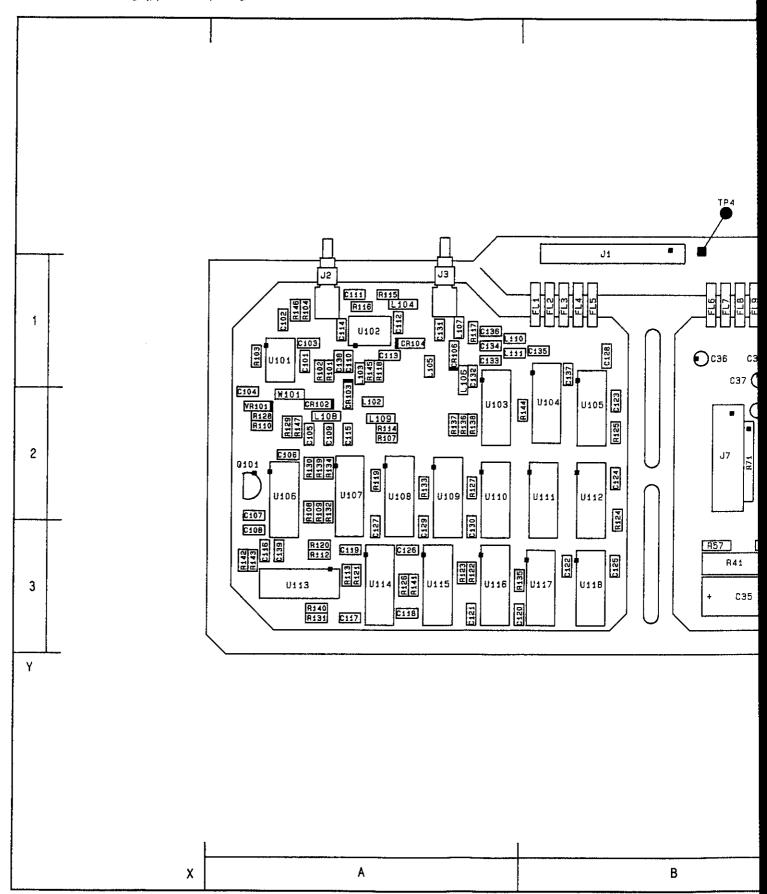
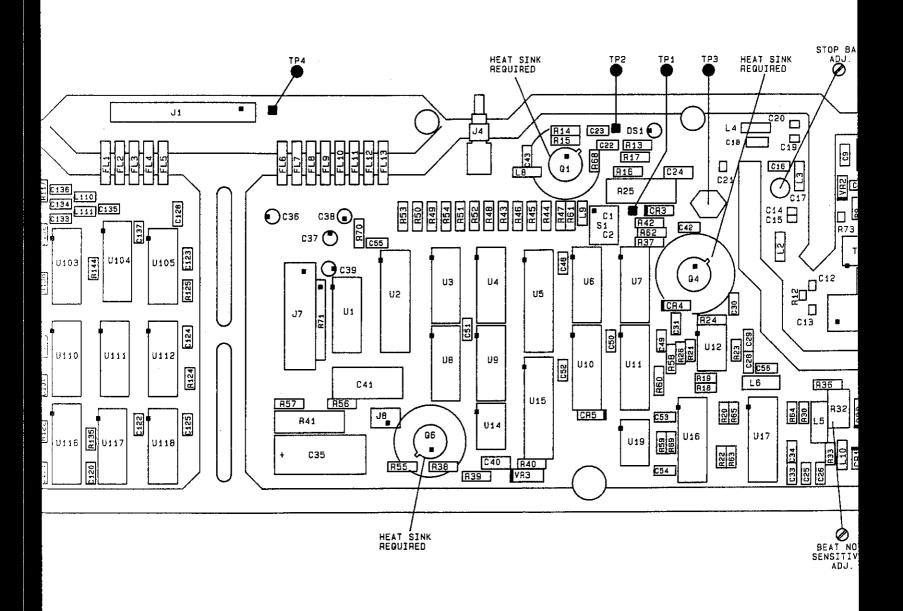


Figure 80-108. SERVICE SHEET 38 INFORMATION

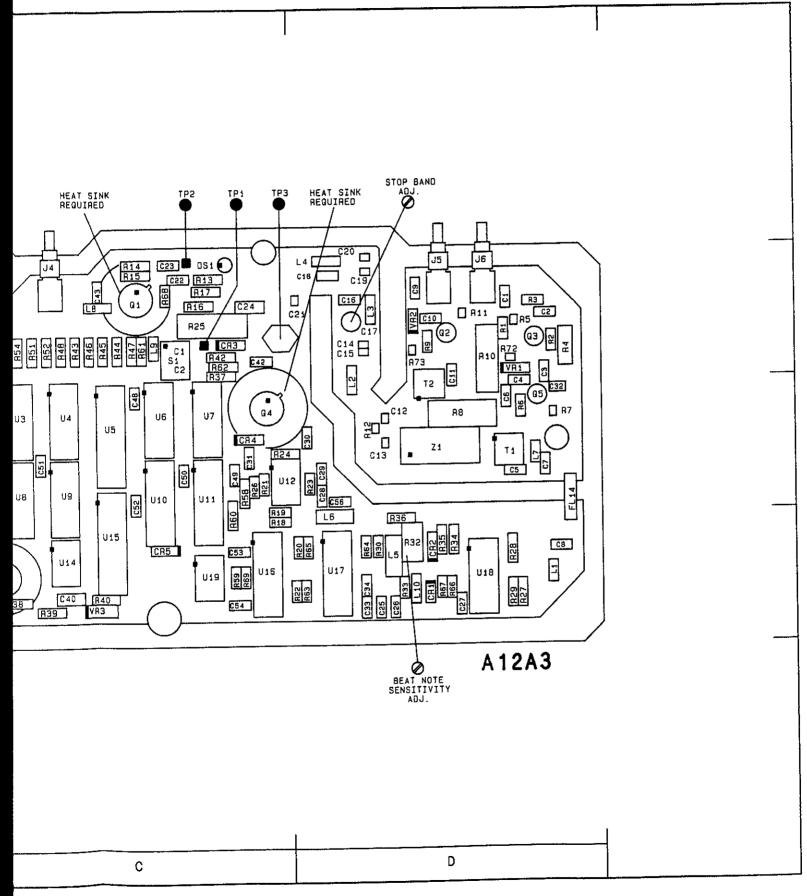


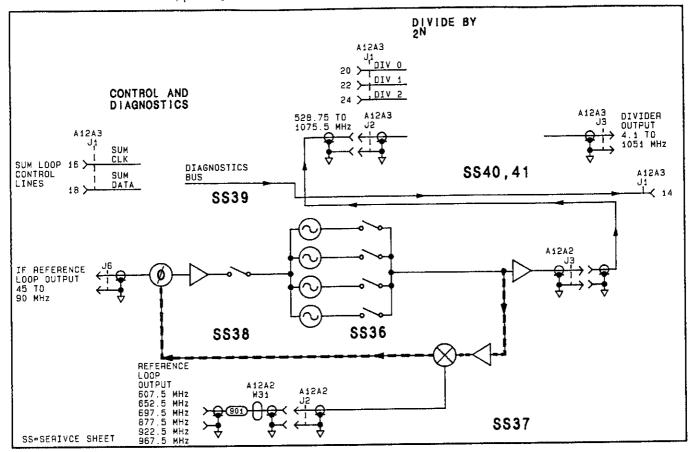
Component Locator

В

C

F16. 80-108 SHT, 3 OF 5





Reference Block Diagram

# Component Coordinates

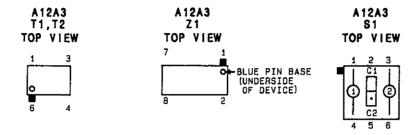
COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y
COMP X, Y  C1	C38 B. 1 C38 B. 2 C42 C. 13 C54 C. 3 C55 C. 1 C55 C. 1 C55 C. 1 C7 C. 1 C81 C.	G1 G1 G2 G3 G4 G5 G6 G7 G7 G1 G8 G8 G9 G9 G9 G9 G9 G9 G9 G9 G9 G9 G9 G9 G9	R33 D. 3 R36 D. 3 R35 D. 3 R36 D. 3 R37 C. 2 R42 C. 1 R43 C. 1 R44 C. 1 R45 C. 1 R46 C. 1 R46 C. 1 R46 C. 1 R47 C. 1 R48 C. 1 R48 C. 1 R59 C. 3 R62 C. 1 R63 D. 3 R64 D. 3 R65 R65 D. 3 R64 C. 1 R59 C. 1 R51 C. 1	U4				

A12A2 SUM LOOP POWER SPLITTER SS37

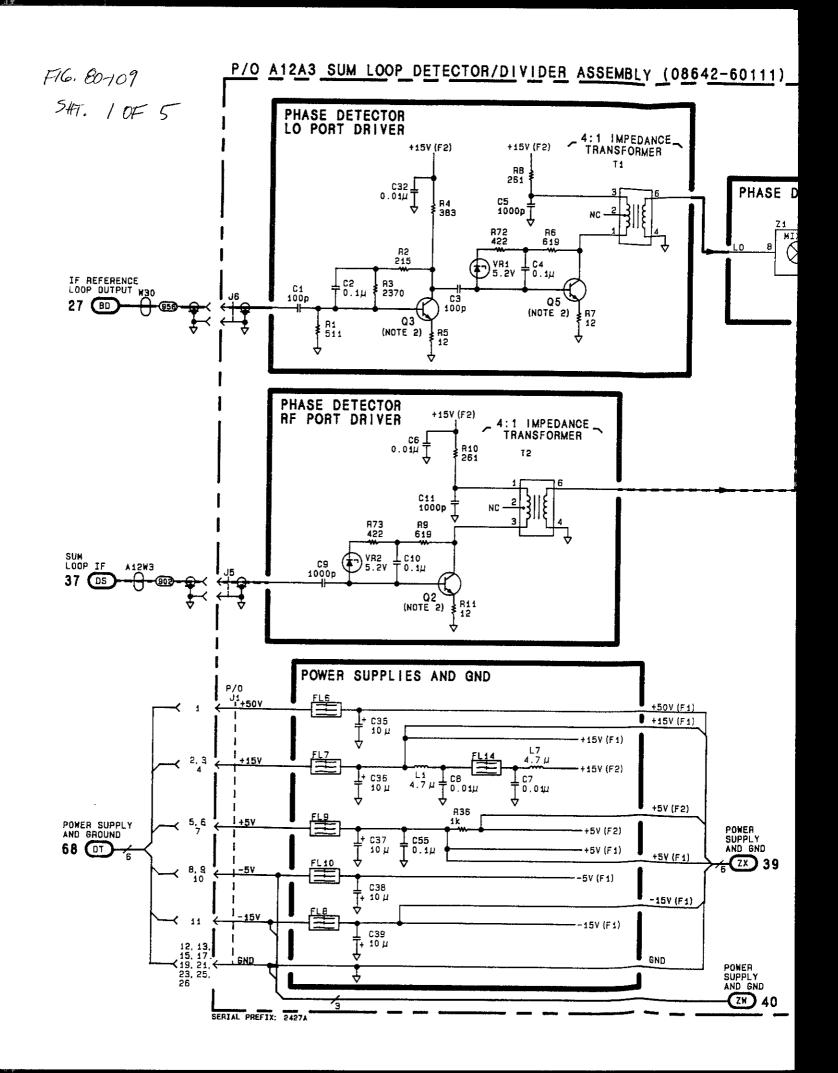
SEE REVERSE SIDE

## Notes:

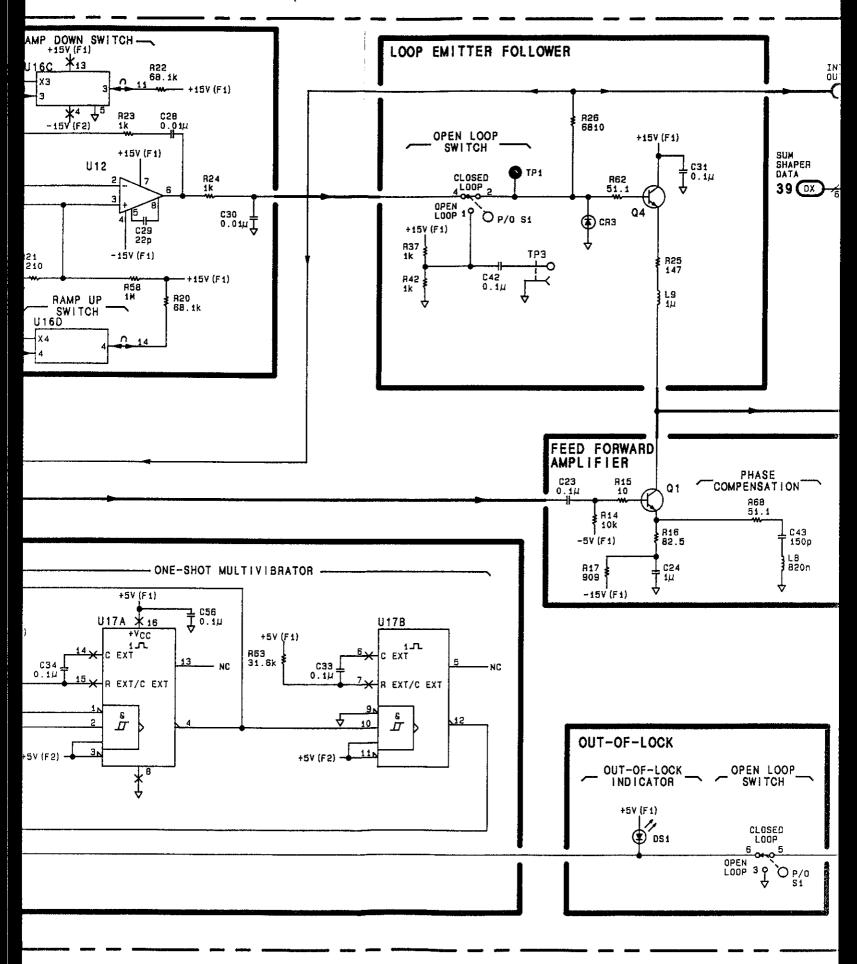
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. Q2, Q3, Q5 are mounted with printed side of device toward solder side of board.
- 3. Test point requires high impedance (500 tl) probe. See Bench Service Kit (HP part number 11802A).
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

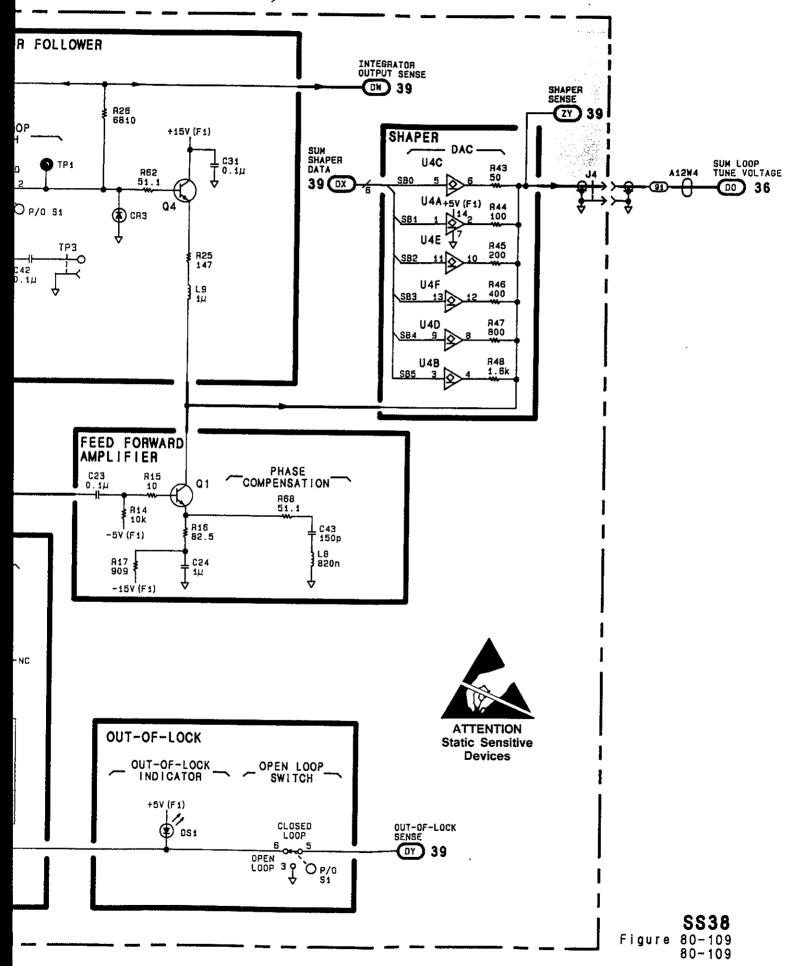


A12A3 Q2,Q3,Q5



SUPPLY AND GND





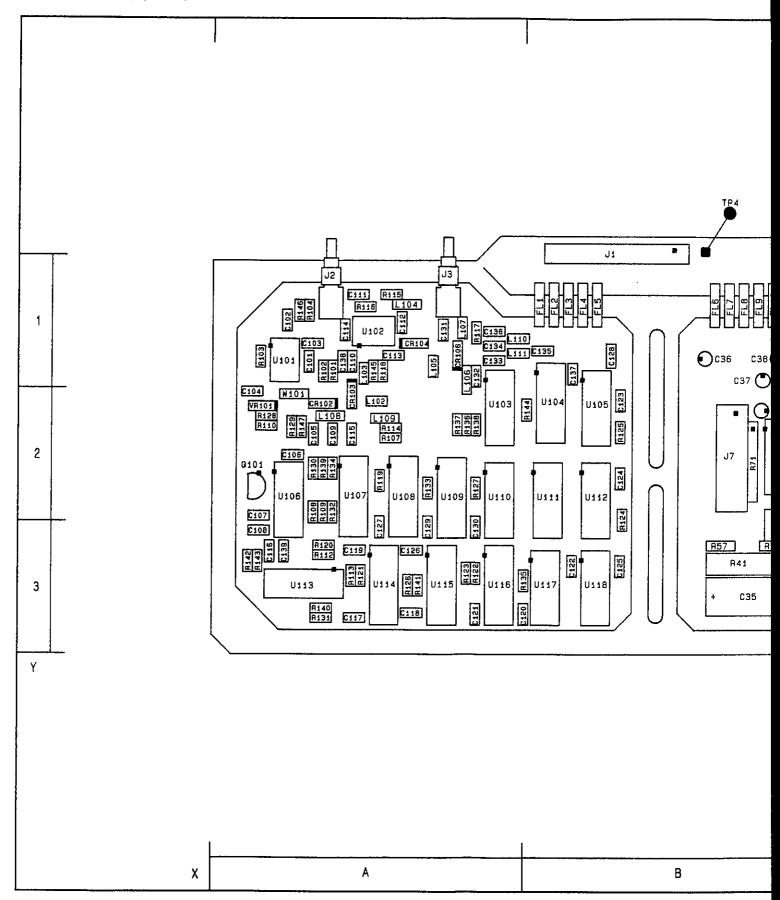
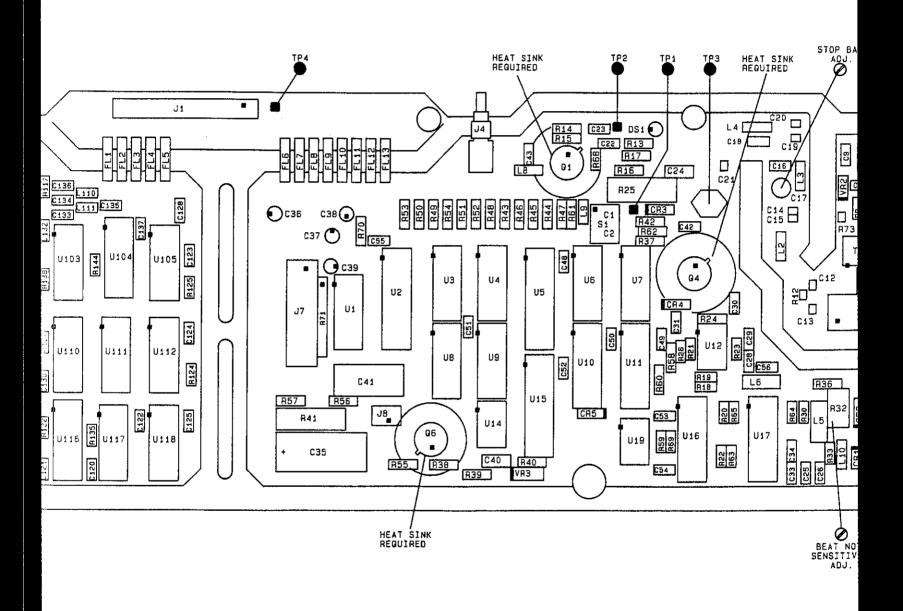
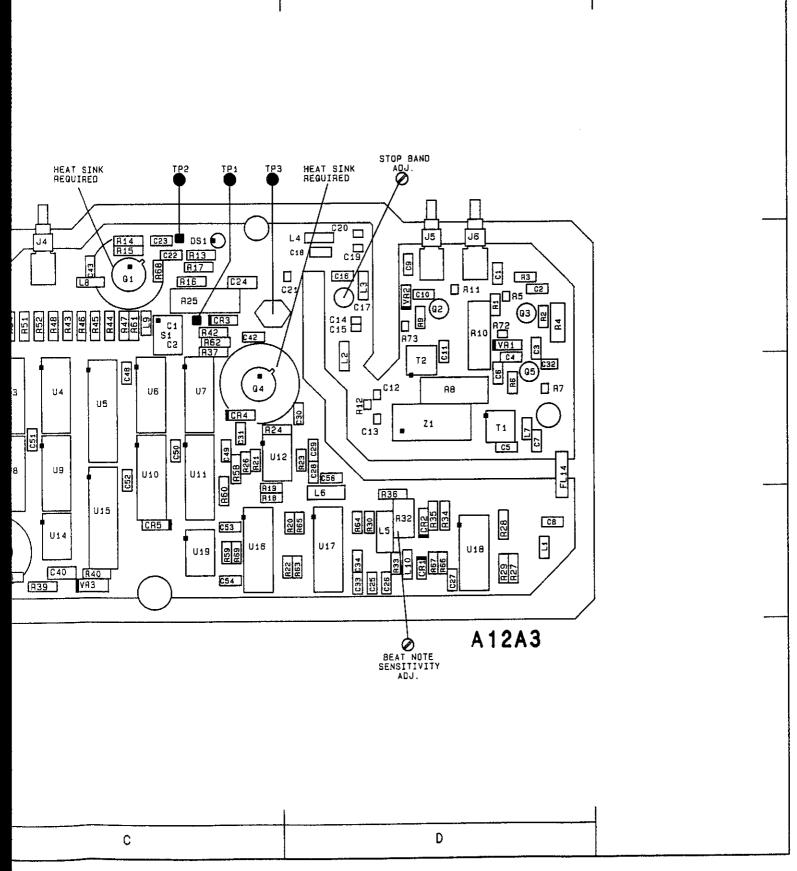


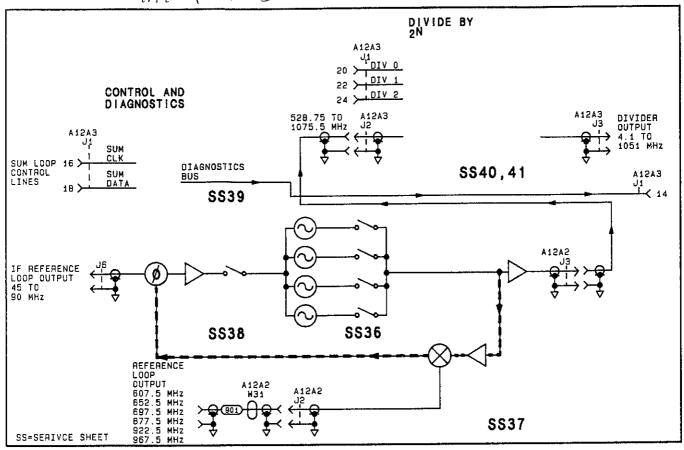
Figure 80-110. SERVICE SHEET 39 INFORMATION



C

В





Reference Block Diagram

# Component Coordinates

СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	COMP	X,Y	СОМР	X,Y
0 C41 C48 C49 C50 C51 C52 CR4 CR5 FL11 FL12 FL13 J1 J4 J7 J8	CB. 3 3 2 2 2 2 2 2 2 3 B. 1 1 1 2 3 B. C.	R3B R39 R41 R49 R51 R52 R55 R55 R55 R57 R60 R70 R71															
96	C. 3	U1 U2 U3 U5 U6 U7 U8 U9 U10 U11 U14 U15 VA3	. พละเล่นเล่นเล่น เล่ เล่นเล่นเล่นเล่น เล่								TIM F	000					

P/O SUM LOOP DETECTOR/DIVIDER SS38

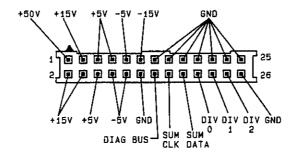
l

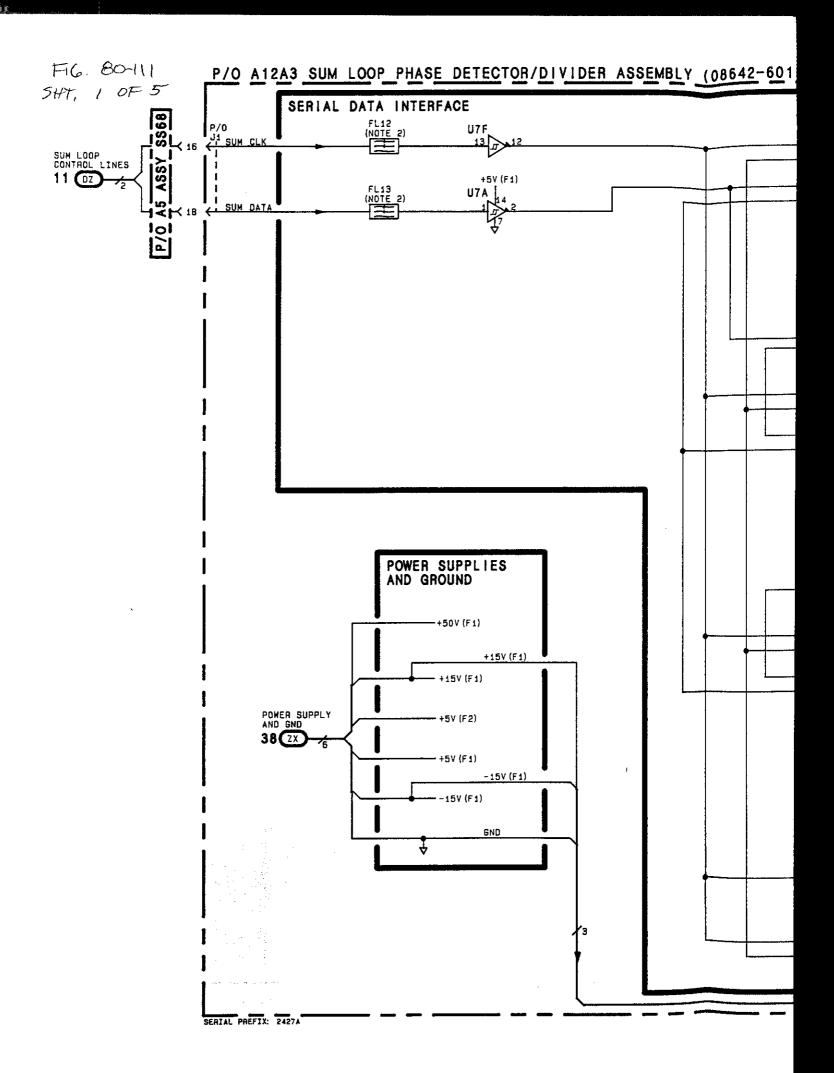
Model 8642A/B

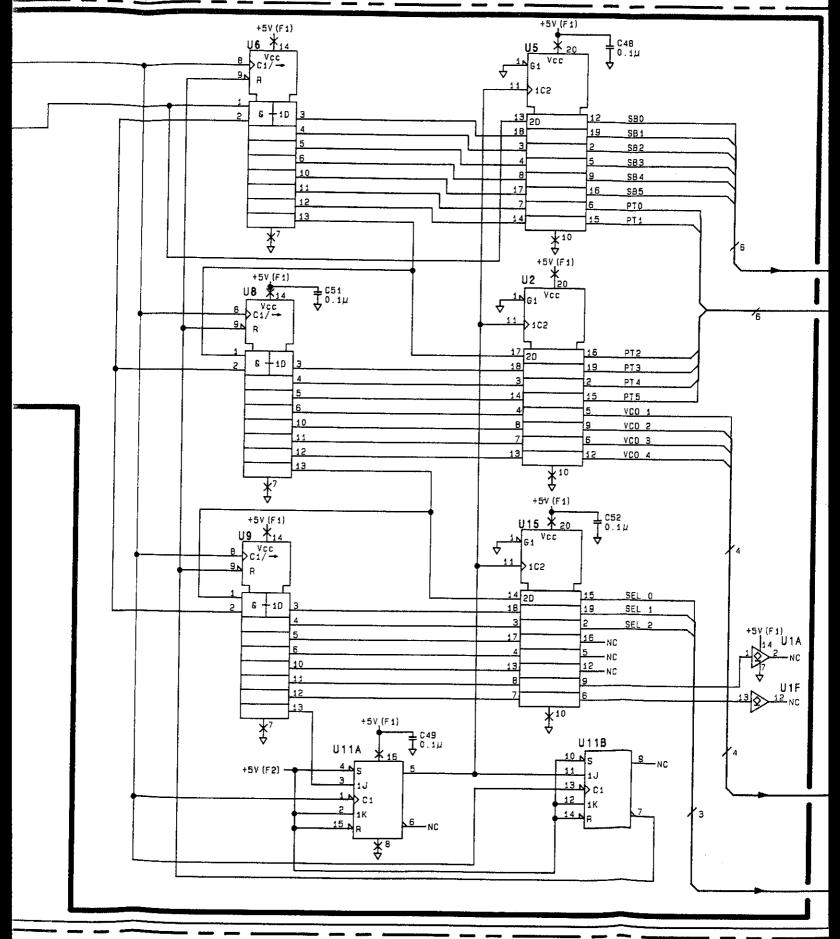
#### Notes:

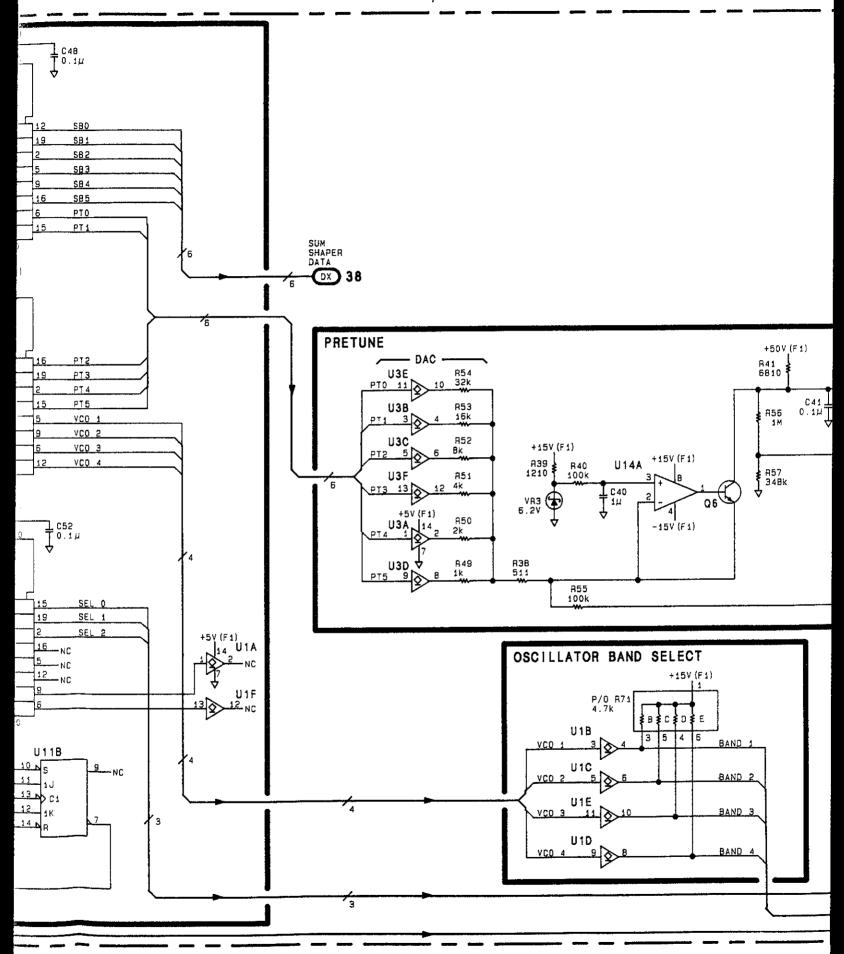
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. Feedthrough filter outer body must be soldered to the shielding in the area where shielding is notched.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

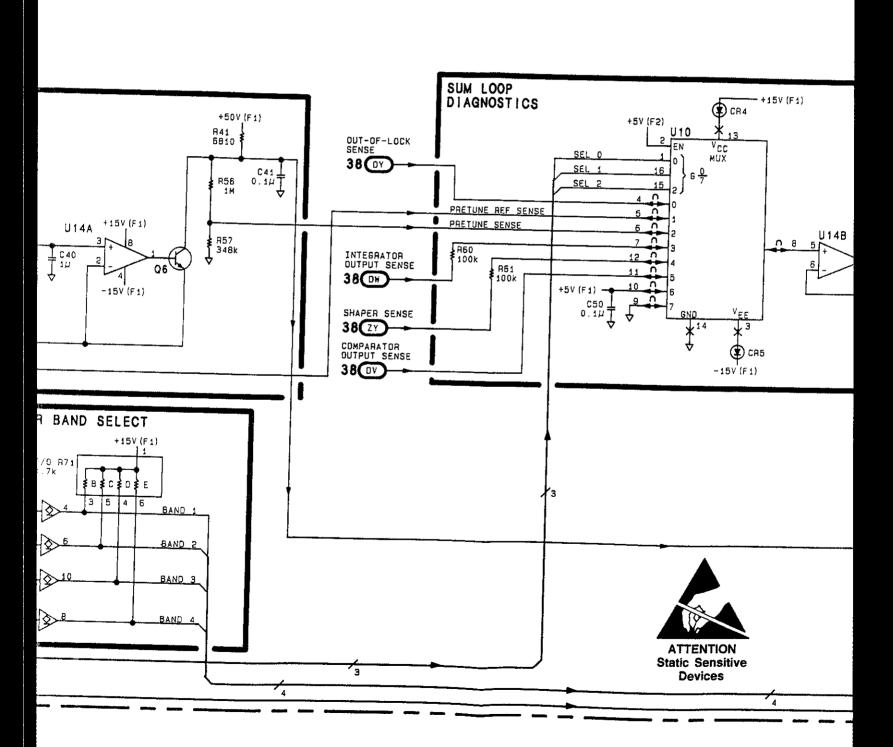
## CABLE PLUG TO A12A3 J1

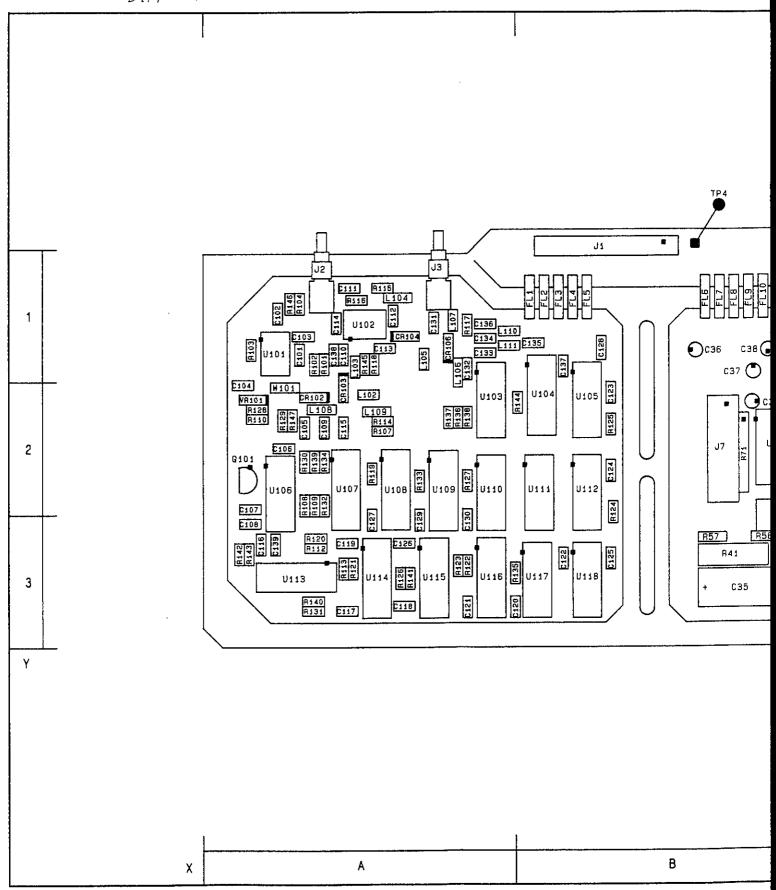


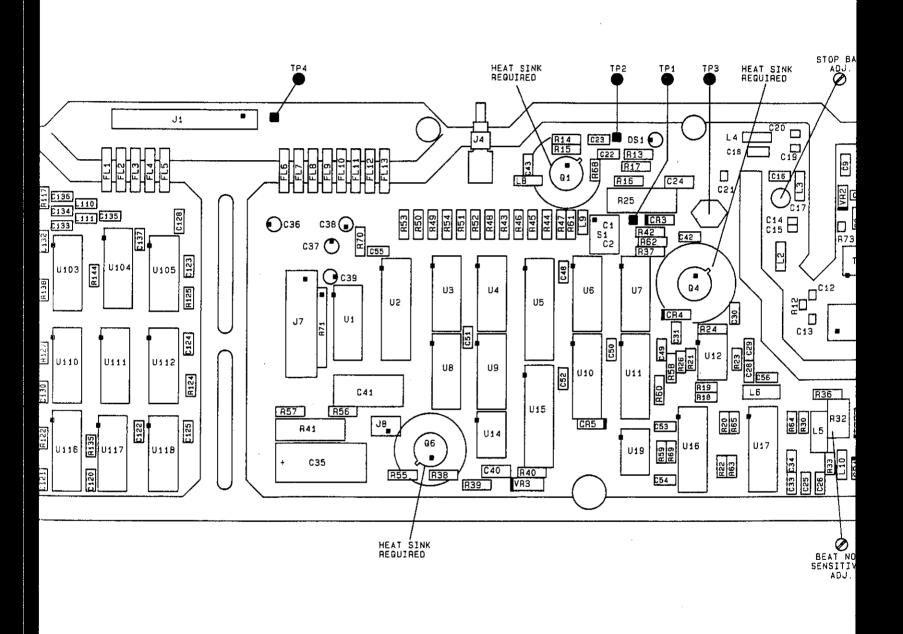






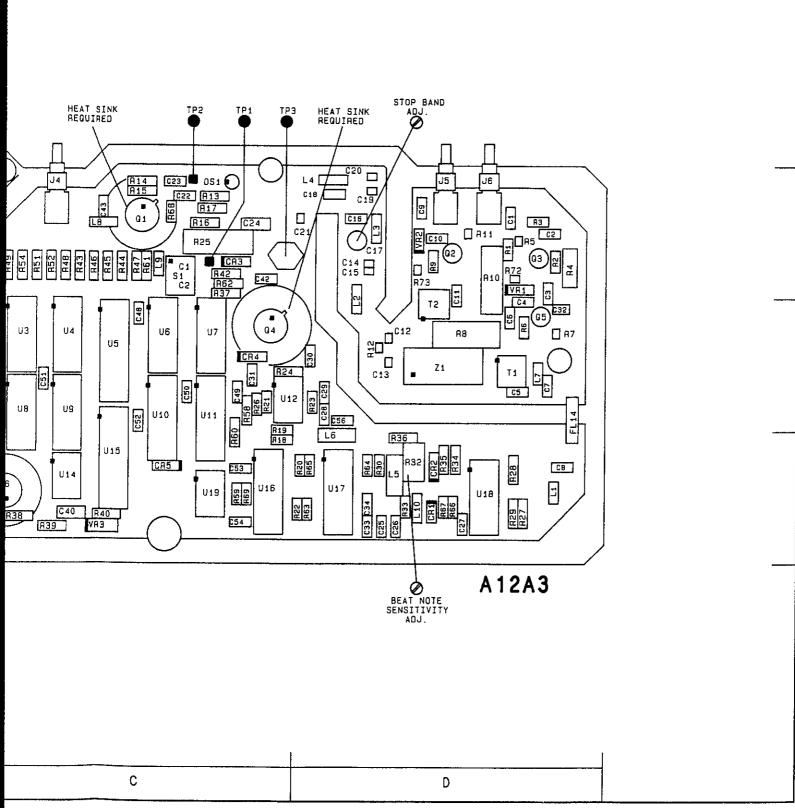


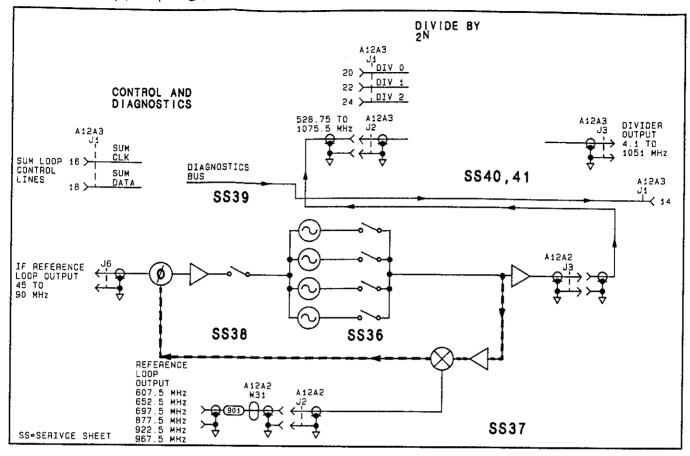




C

В





Reference Block Diagram

## Component Coordinates

COMP   X, Y   COMP   X, Y

P/O A12A3

SUM LOOP PHASE DETECTOR/DIVIDER ASSEMBLY

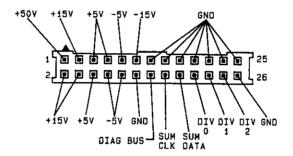
**SS39** 

SEE REVERSE SIDE

#### Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

#### CABLE PLUG TO A12A3 J1



# **CHANGES**

## All Serial Prefixes

#### On the schematic:

# 2530A and above

a comment of the second

• In the lower right portion of the foldout, change the figure and page numbers for SS40 to 80-113.

## On the Component Locator:

R164, R165, R166, C145, C146, C147 - Replace the appropriate portion of the component locator with the partial on 80-112.2

## In Component Coordinates:

• Replace the Component Coordinates table with the one shown on page 80-112.2

## On the schematic:

- R103, R118, R146, R147, L112 In INPUT LIMITER, change the value of R103 to 100 ohms. Change the value of R146 and R147 to 261 ohms. In BUFFER/LIMITER, change the value of R118 to 100 ohms. Change W101 symbol to an inductor. Label it L112, and assign it a value of 18n.
- R164, R165, R166, C145, C146, C147 Replace the appropriate portion of SS40 with the schematic partial on 80-112.3

#### 2543A and above

#### On the Component Locator:

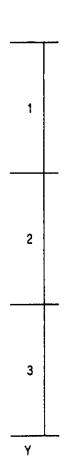
 Replace the partial Component Locator shown on page 80-112.2 with the partial on 80-112.3

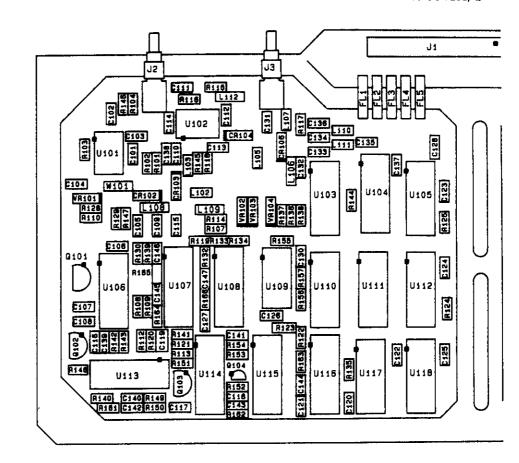
## In Component Coordinates:

• Replace the Component Coordinates table on 80-112.2 with the table on 80-112.3

#### On the schematic:

C133, C135, L111, R103, R147, L102, R118 - Replace the appropriate portion of SS40 with the schematic partial on 80-112.5. In 2N=0 DIVIDE, change the value of L102 to 15u Farads. In BUFFER/LIMITER, change the value of R118 to 121 ohms. Note selection procedure for R147 in the table below.





COMP COMP COMP X,Y U101 U102 U107 U112 A, 1 A, 1 A, 2 B, 2 C101 C102 C104 C105 C1101 C1112 C1113 C113 C113 C113 C133 C134 C135 C138 C136 C146 C146 C147 L102 L103 L104 L105 L106 L107 L108 L110 L111 L111 A. 2 A. 1 R1023 R1003 R1007 R1115 R1117 R1118 R1125 R1133 R1134 R1147 R1165 R1166 R1166 R1166 CR102 CR103 CR104 CR106 A, 2 A, 2 A, 1 A, 1 8, 1 8, 1 FL1 FL2 B. 1 A. 1 A. 1 73 75

Α

X

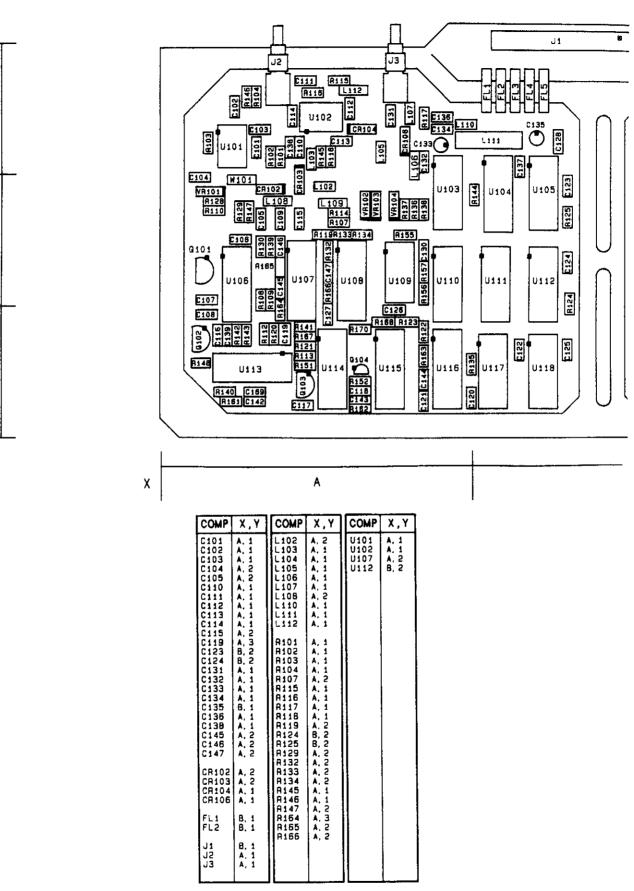
CHANGES TO FIGURE 80-112 (2530A to 2542A)

1

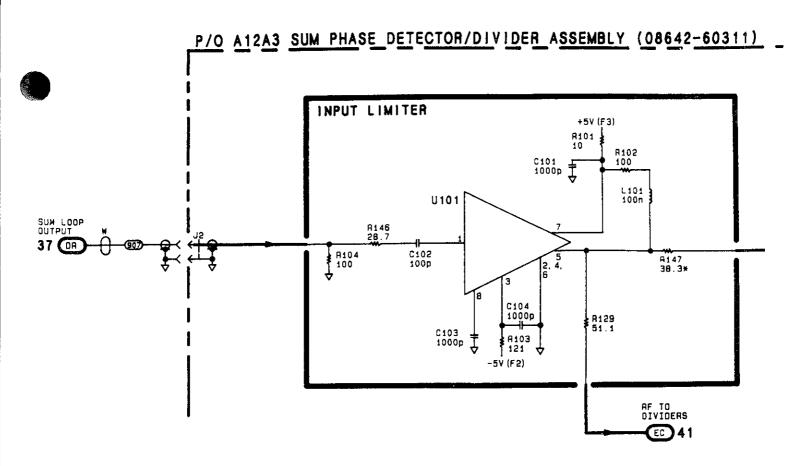
2

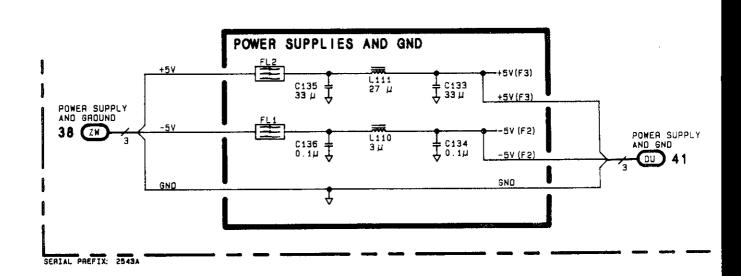
3

Υ

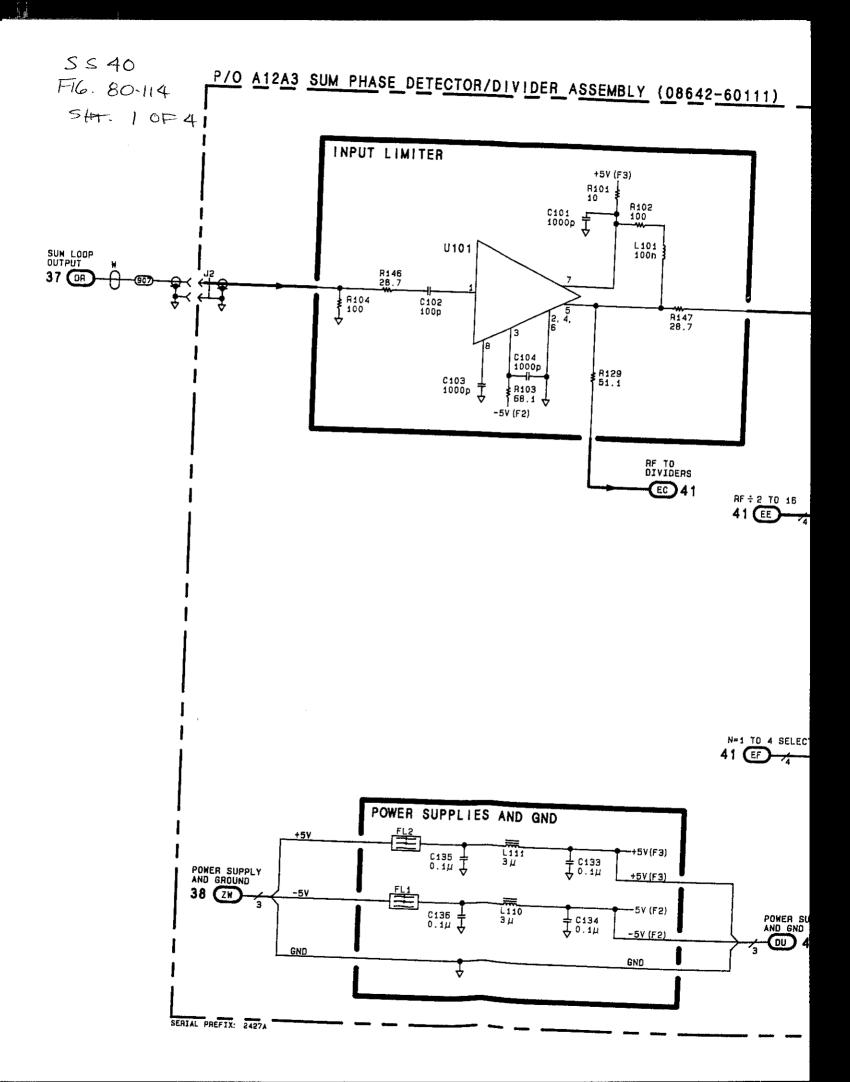


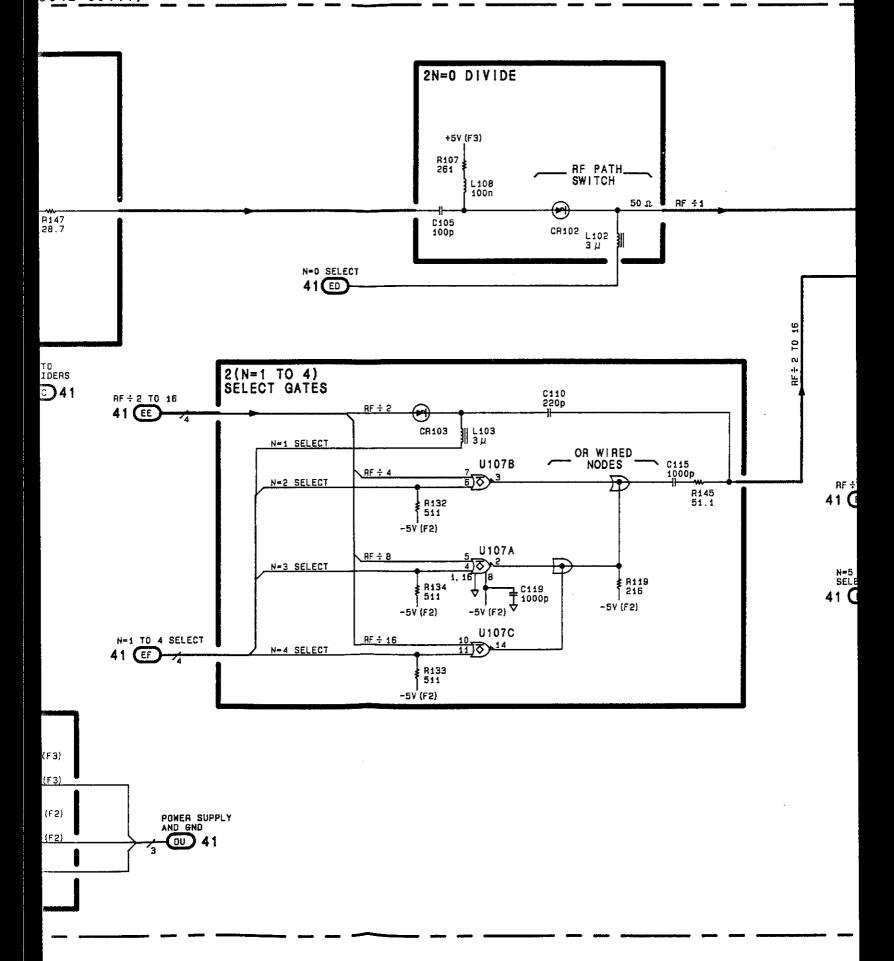
CHANGES TO FIGURE 80-112 (2543A and above)

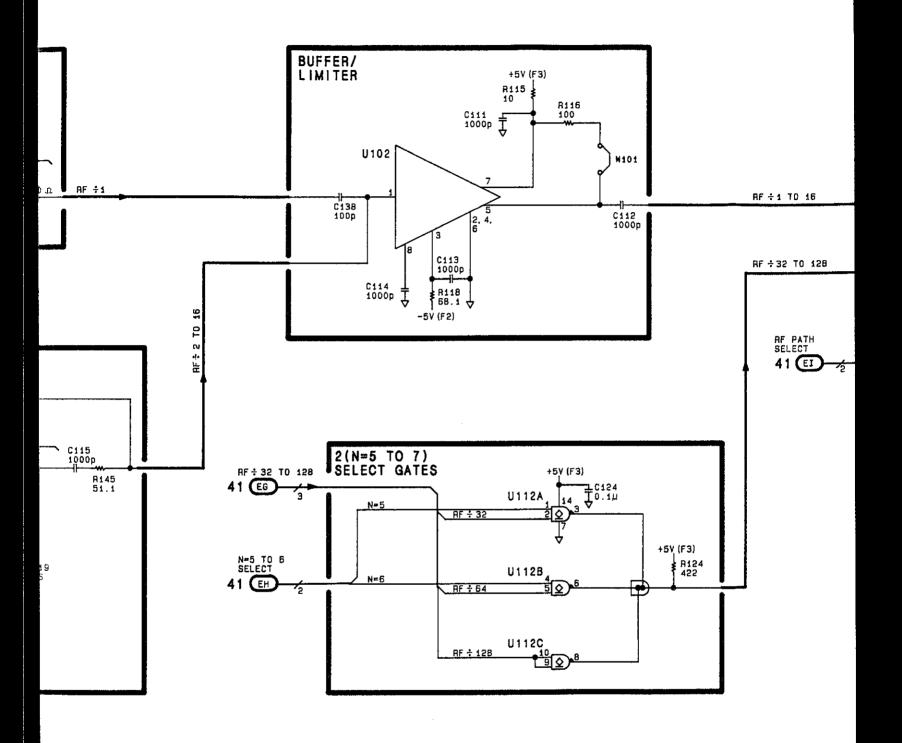


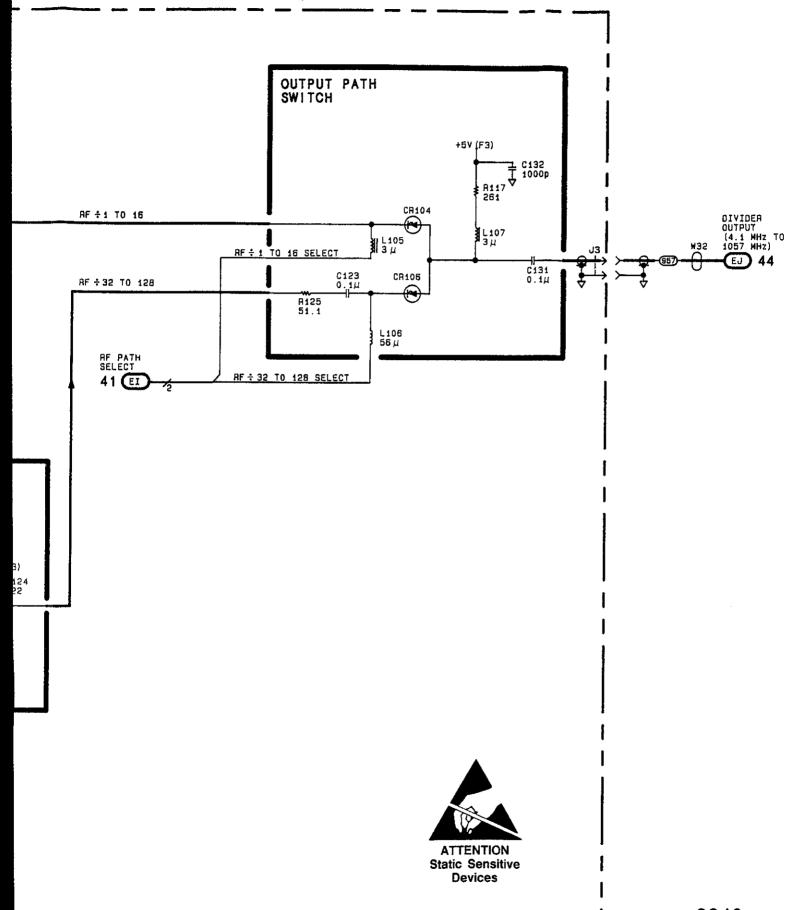


CHANGES TO FIGURE 80-113 (2543A and above)









**SS40** Figure 80-114 80-114

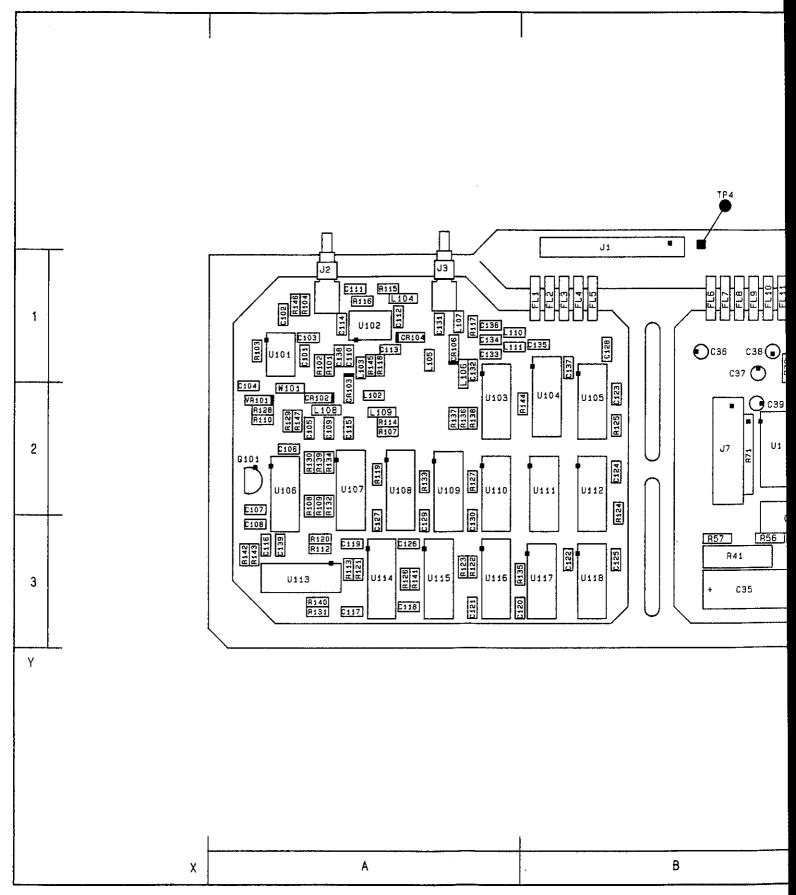
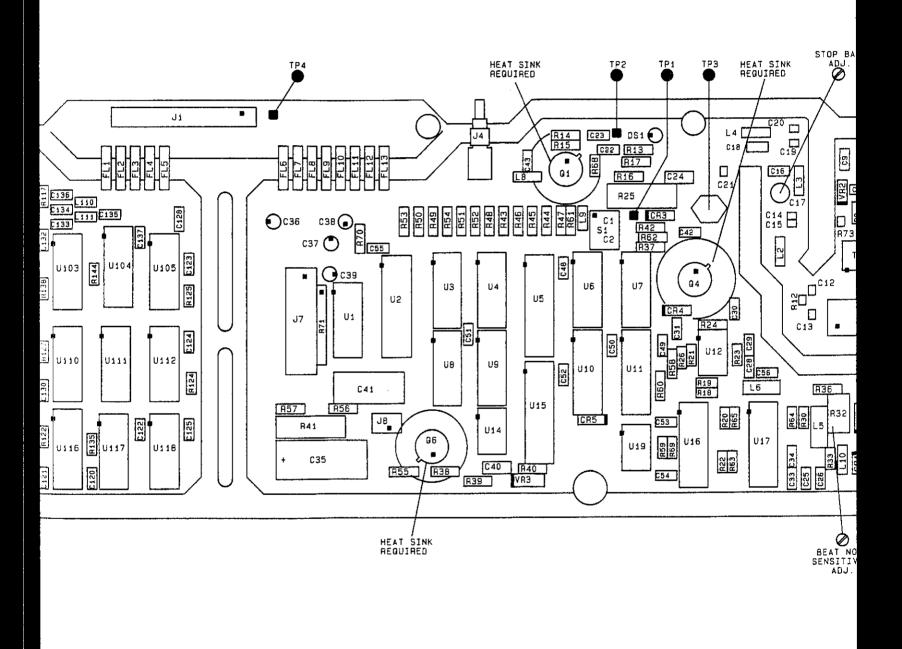
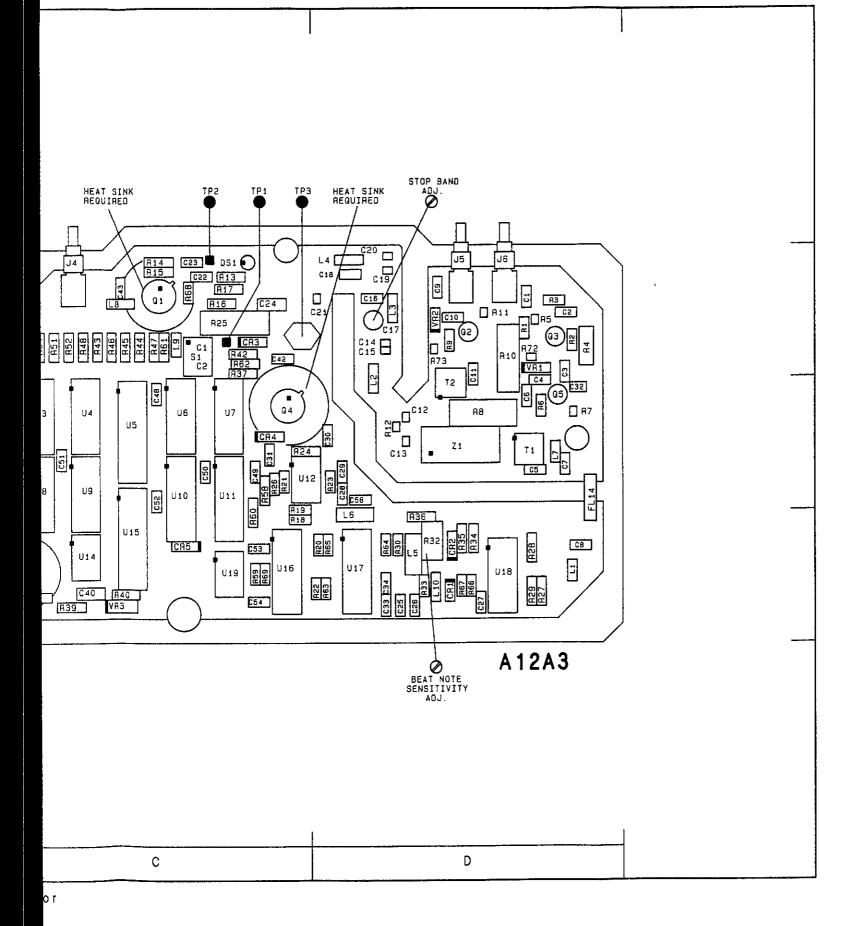


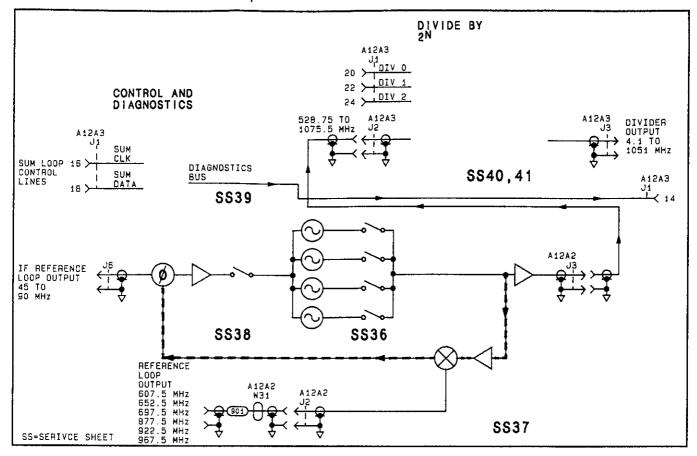
Figure 80-114. SERVICE SHEET 41 INFORMATION



В

C





Reference Block Diagram

# Component Coordinates

COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y
C106 A. 2 C107 A. 2 C107 A. 2 C108 A. 3 C116 A. 3 C1178 A. 3 C1120 B. 3 C1121 B. 3 C1121 B. 3 C1122 B. 3 C1122 B. 3 C1123 B. 1 C124 B. 3 C1124 B. 3 C1125 B. 3 C1126 B. 3 C1127 B. 1 C129 C127 A. 3 FL3 FL4 B. 1 L109 A. 2 G101 A. 2	A. 2 2 3 3 2 3 3 3 2 2 2 2 3 3 2 2 2 3 3 3 3 2 2 2 3 3 3 3 3 2 2 2 3 3 3 3 3 2 2 2 3 3 3 3 3 3 2 2 2 3	U103						

P/O A12A3 SEE REVERSE SIDE SUM LOOP PHASE DETECTOR/DIVIDER ASSEMBLY

**SS40** 

FIG. 80-114, SHT. 5 OF 5

Model 8642A/B

## Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

# **CHANGES**

## 2427A to 2527A

#### On the schematic:

- R131 In 2<sup>N=2</sup> DIVIDE, mange R131 value to 261 ohms.
- <u>U113, U114, U115</u> In 2<sup>N=2</sup> **DIVIDE**, extend pin 12 of U113 to connect with the node of R131 and U113 pin 9. Remove connection to pin 9 and label it NC. In 2<sup>N=3</sup> **DIVIDE**, extend pin 12 of U114 to connect with the node of R126 and U114 pin 9. Remove connection to pin 9 and label it NC. In 2<sup>N=4</sup> **DIVIDE**, extend pin 12 of U115 to connect with the node of R127 and U115 pin 9. Remove connection to pin 9 and label it NC.

## 2530A and above

#### On the Component Locator:

C129, C140-147, Q102-104, R108-R110, R126-R128, R131-R134, R138, R140-R143, R148-R166, VR102-VR104
 Replace appropriate portion of the component locator with the partial on 80-114.3

## In Component Coordinates:

• Replace Component Coordinates table with the one shown on page 80-114.3

# On the schematic:

• C129, C140-C147, Q102-Q104, R108-R110, R126-R128, R131-R134, R138, R140-R143, R148-R166, VR102-VR104 - Replace SS41 with the foldout on page 80-114.5

# 2543A and above

#### On the Component Locator:

• R167, R168, R169, R170 - Replace the appropriate portion of the component locator with the partial on 80-114.2

#### In Component Coordinates:

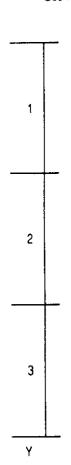
• Replace the Component Coordinates table with the one shown on page 80-114.2

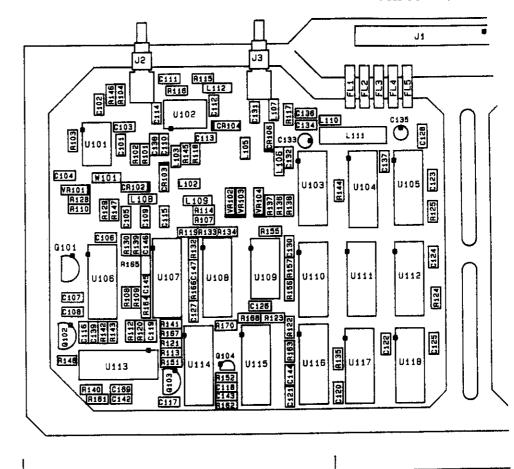
#### On the schematic:

• C140, C141, R167, R168, R169, R170 - Replace the appropriate portion of Figure 80-114.5 (page 80-114.5), with the schematic partial on page 80-114.4. Change the assembly part number from 08642-60211, to 08642-60311.



Model HP8642A/B





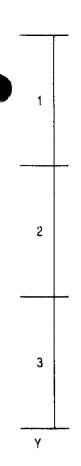
COMP	X,Y	COMP	X,Y	COMP	X,Y
C106 C107 C109 C116 C117 C120 C1216 C122 C122 C122 C123 C123 C123 C123 C124 C123 C137 C139 C143 C144 FL3 FL4 FL5 J1 L109 G101 G102 G103 G104	A.A.A.A.A.A.B.B.A.A.A.A.B.B.B.B.B.A	R108 R109 R1112 R1123 R11212 R1223 R1235 R1235 R1336 R1336 R1355 R1355 R1355 R1355 R1441 R1555 R1562 R167 R167 R167 R167 R167 R167 R167 R167	22233233332322222333332222333333	U103 U1045 U105 U108 U108 U1101 U1113 U1115 U1115 U1117 U1118 VA1012 VR103 VR104	A, 2

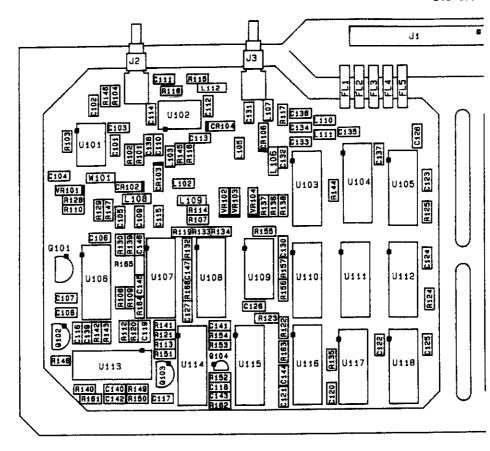
Α

Χ

CHANGES TO FIGURE 80-114 (2543A and above)

В



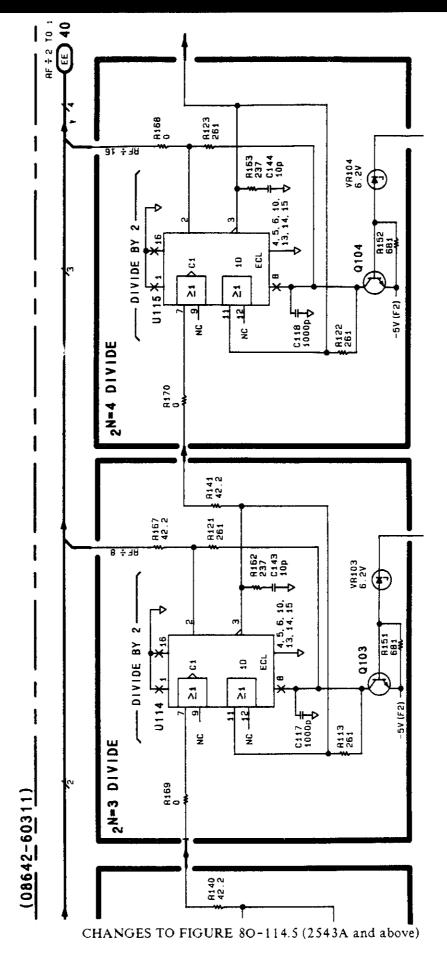


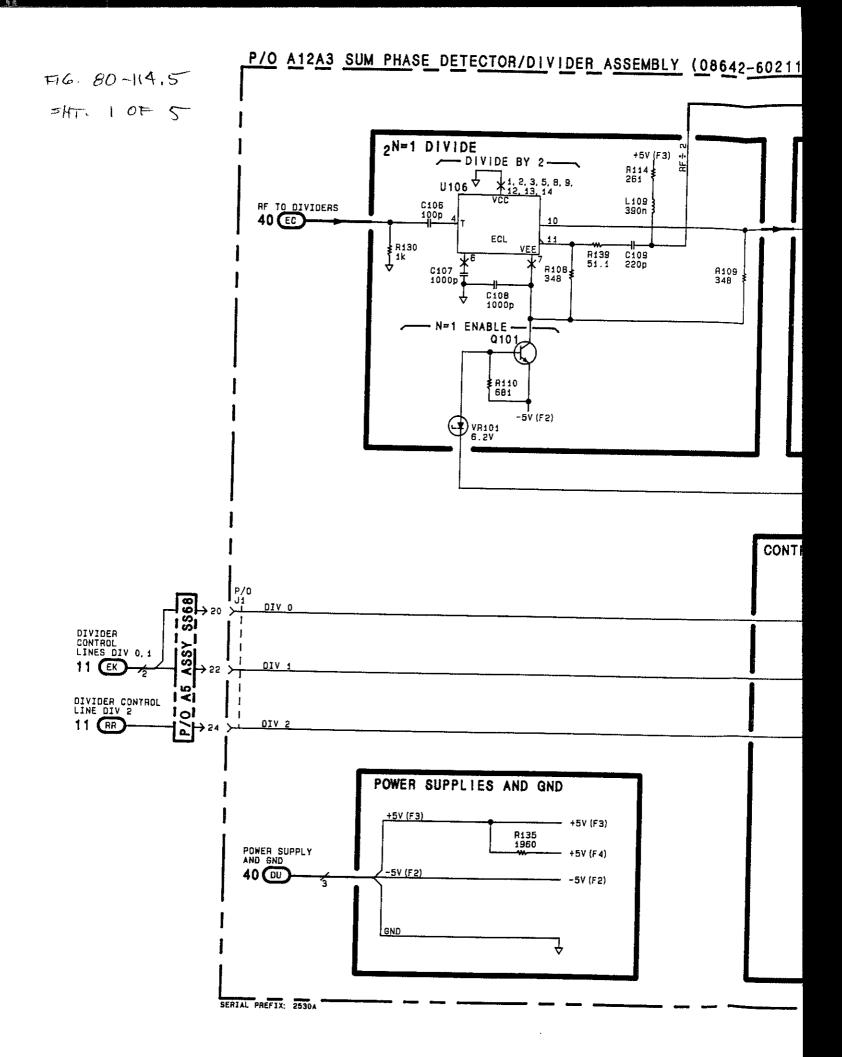
COMP	X,Y	СОМР	X,Y	COMP	X,Y
C106 C1117 C1118 C120 C1212 C122 C1225 C1226 C1227 C128 C1230 C137 C139 C140 C142 C144 C144 C144	A.A.A.A.A.A.A.B.B.A.A.B.B.A.A.A.A.A.B.B.B.B.A	R108 R1109 R1113 R1113 R1113 R1123 R1133 R1133 R1133 R1143 R11443 R1155	A.A.A.A.A.A.A.A.A.A.A.A.A.A.A.A.A.A.A.	U103 U104 U105 U108 U108 U110 U111 U113 U114 U115 U116 V1102 VR102 VR103 VR104	A.B.B.A.A.A.B.B.B.A.A.A.A.A.A.A.A.A.A.A

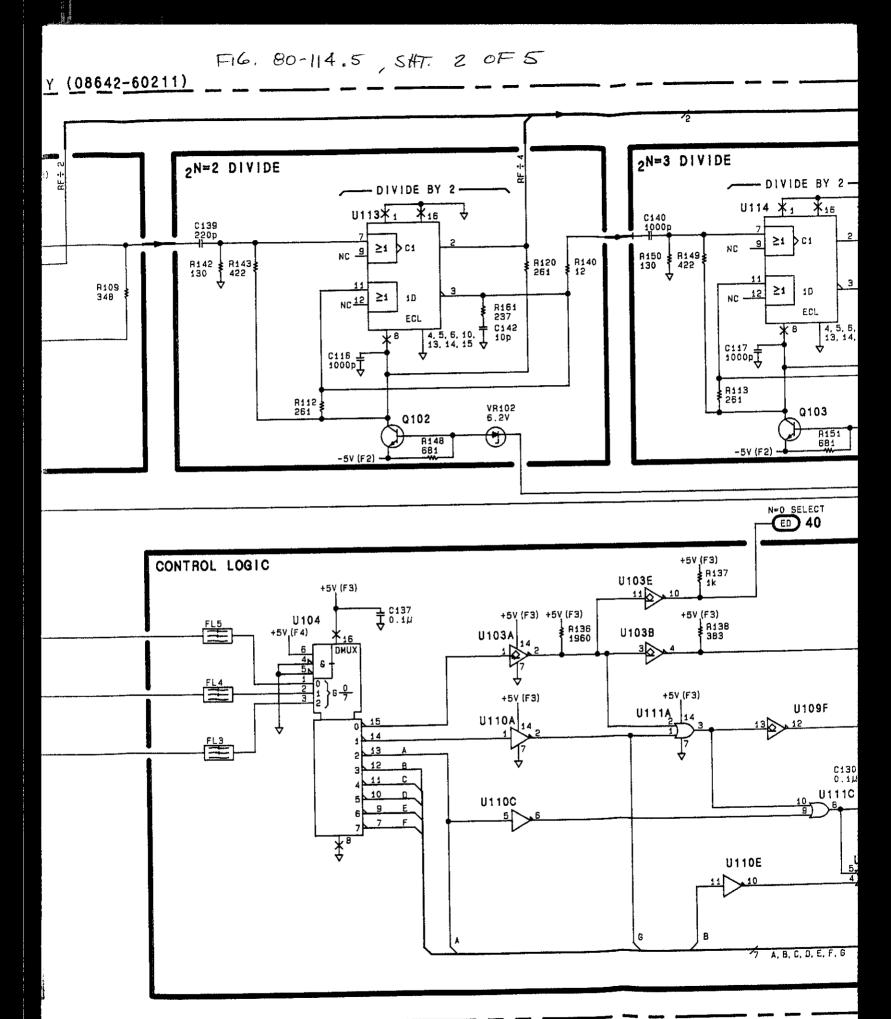
Α

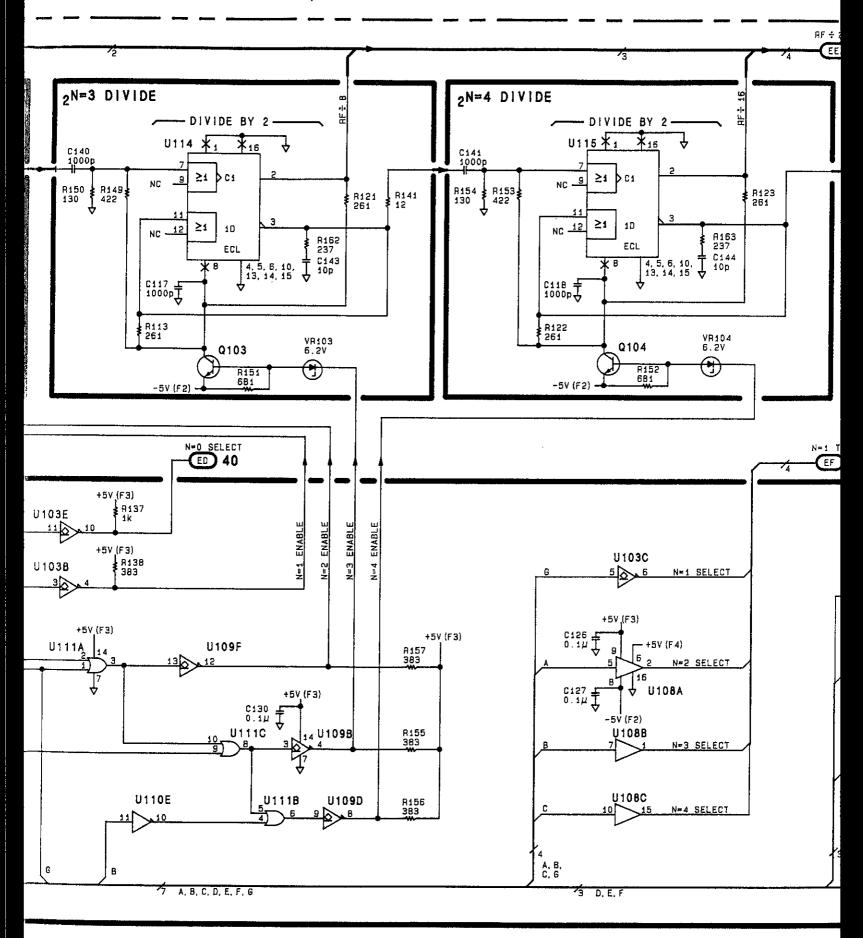
Χ

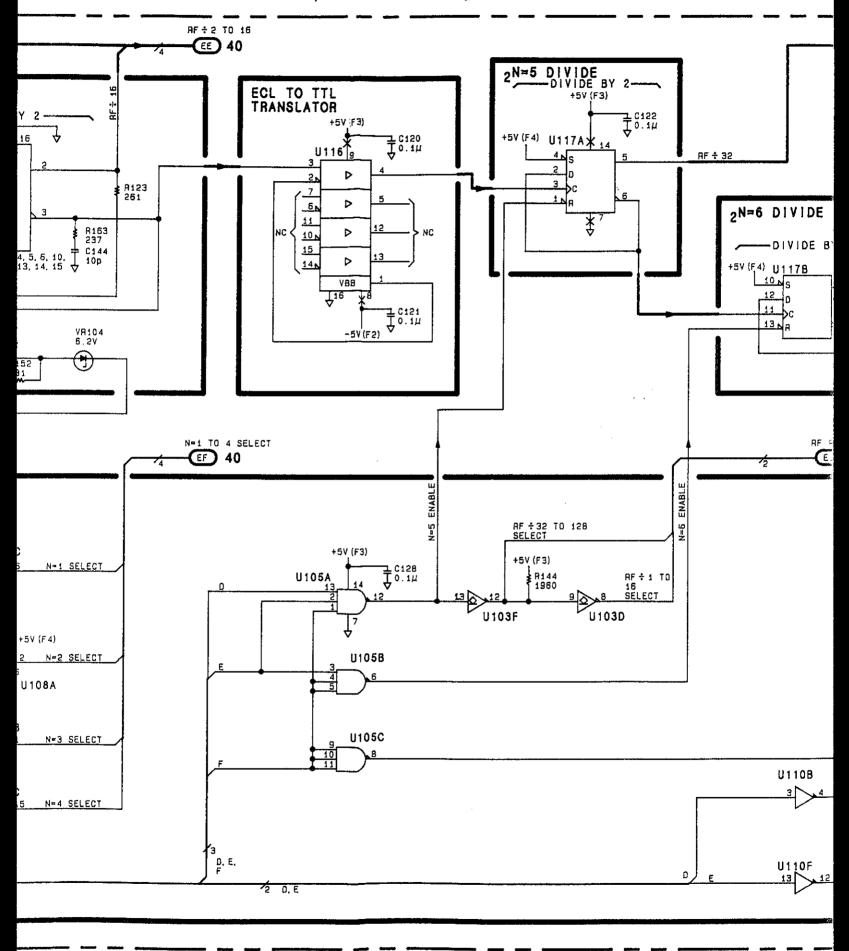
CHANGES TO FIGURE 80-114 (2530A to 2542A)

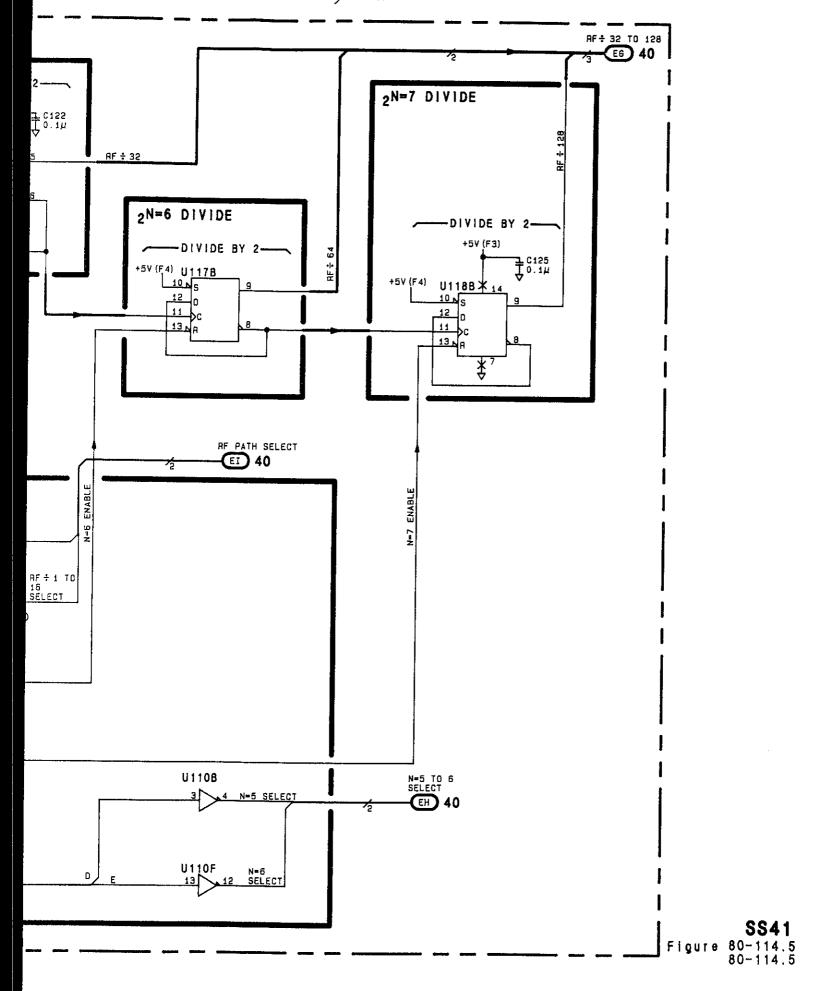


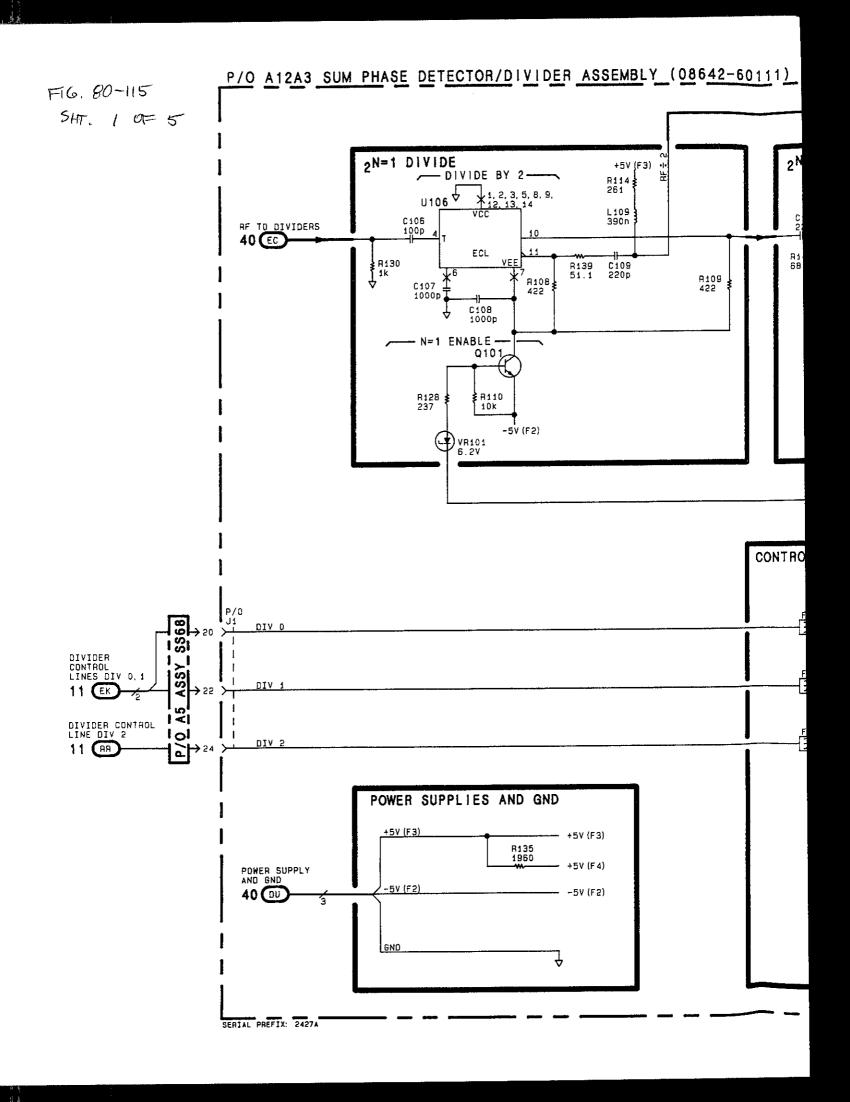


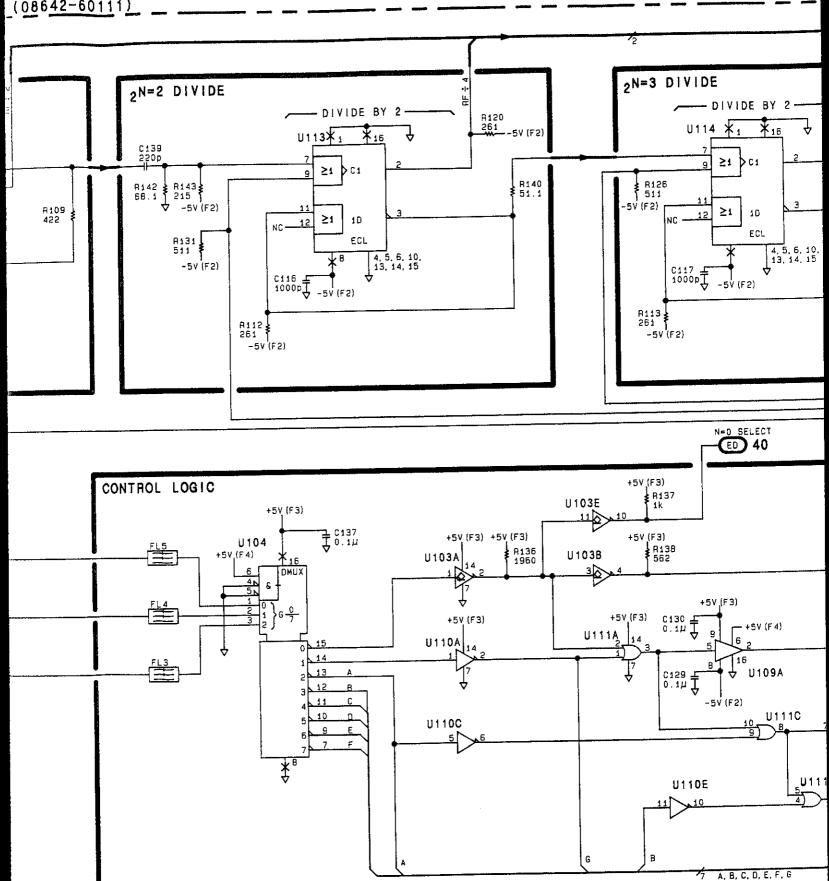


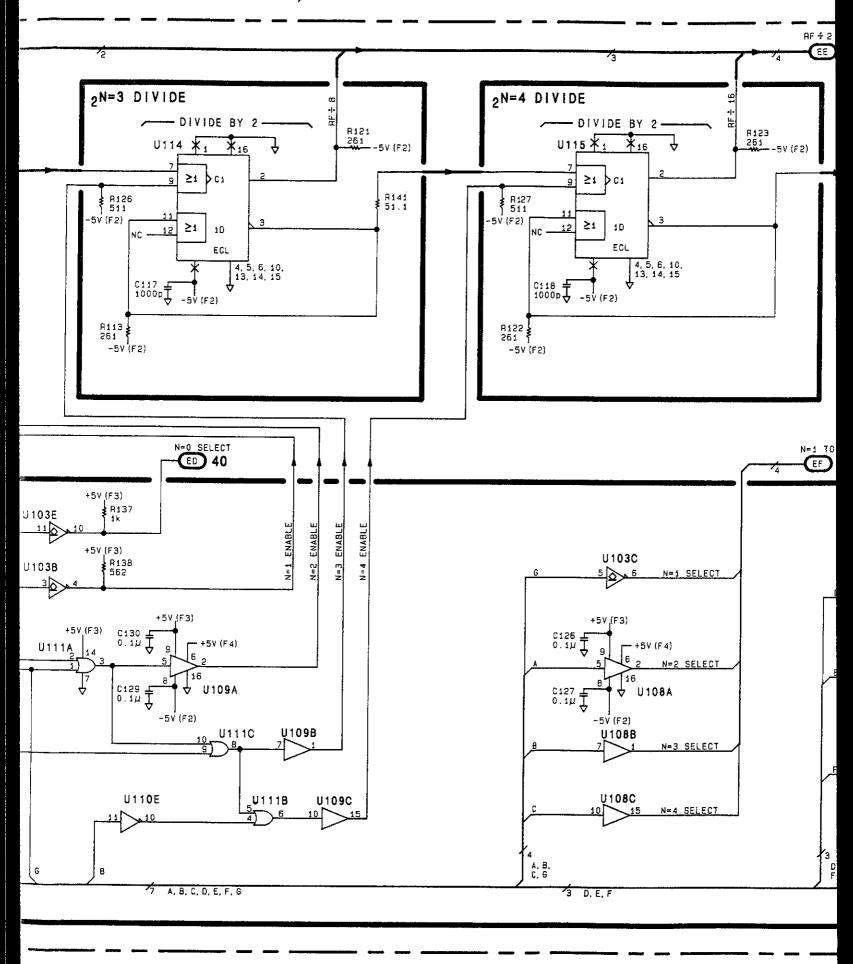


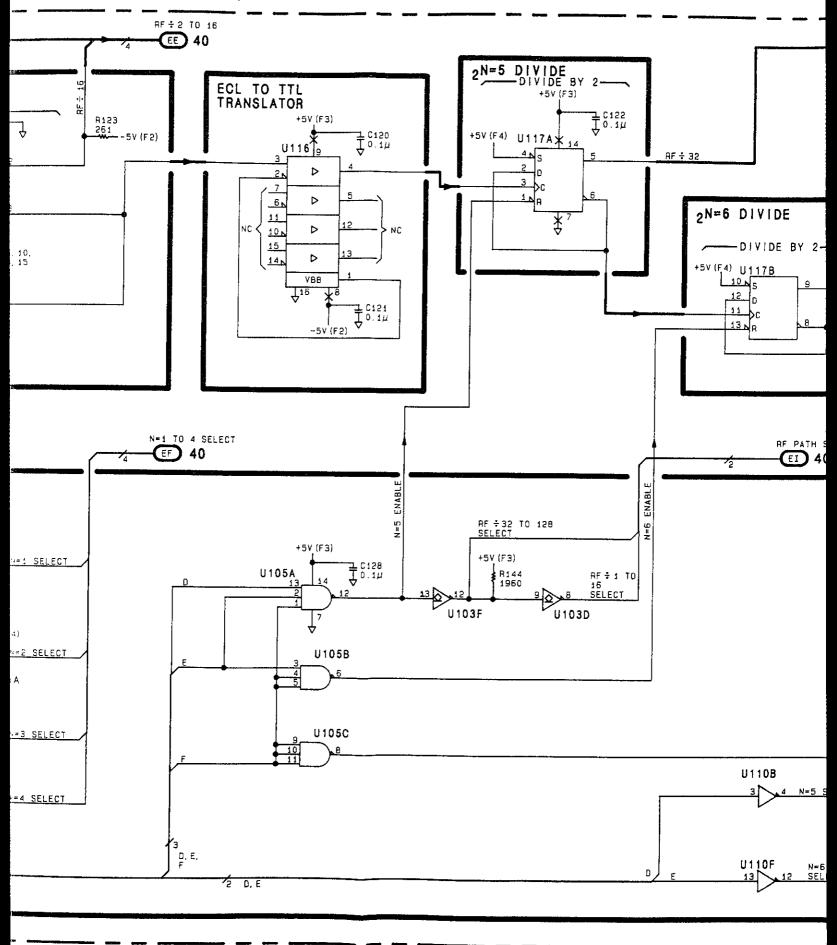


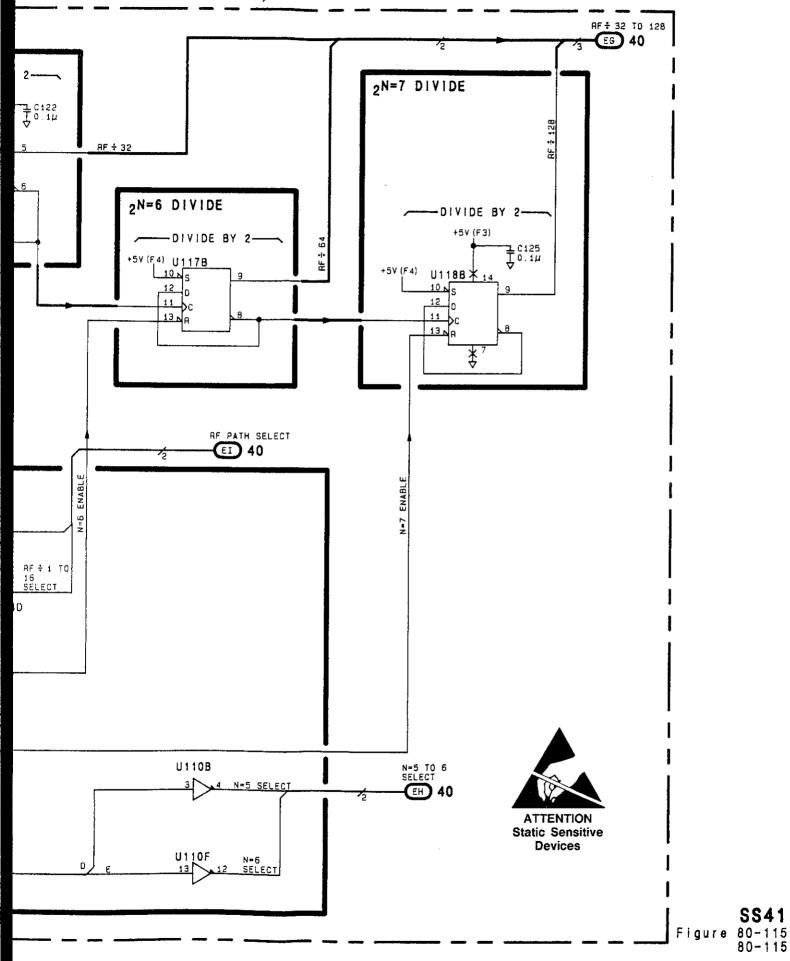




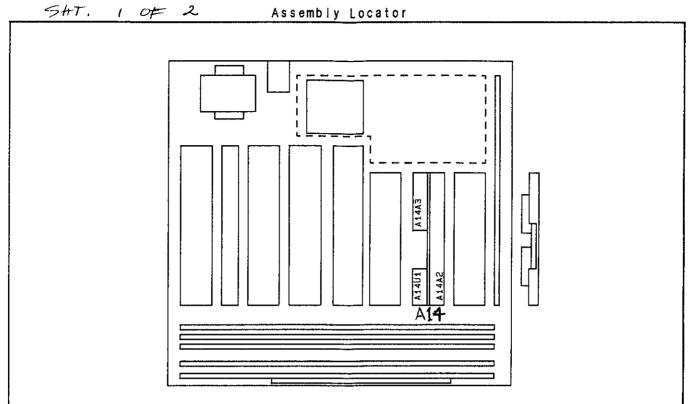








# A13 Output Filters/ALC Module

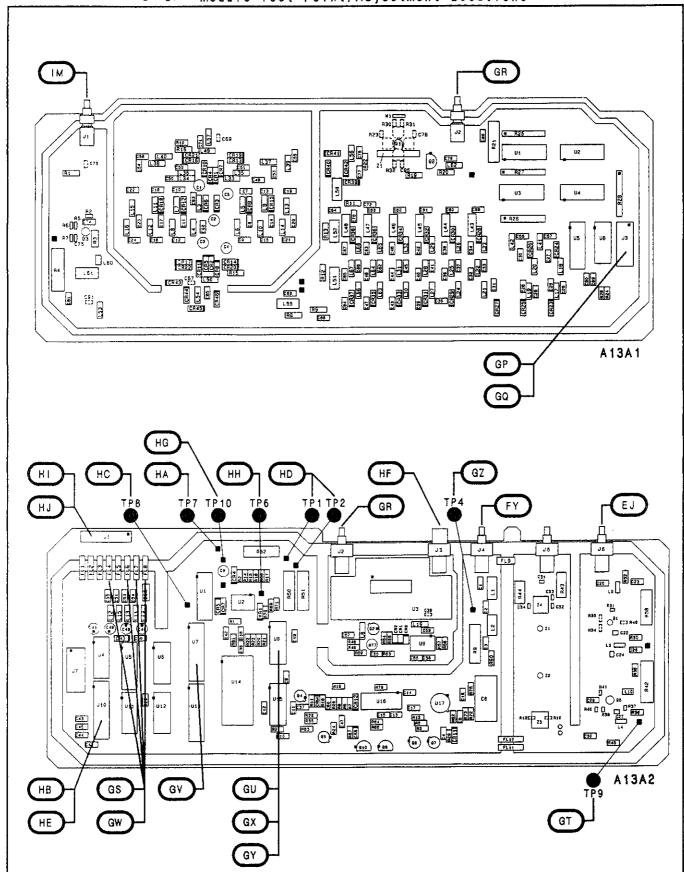


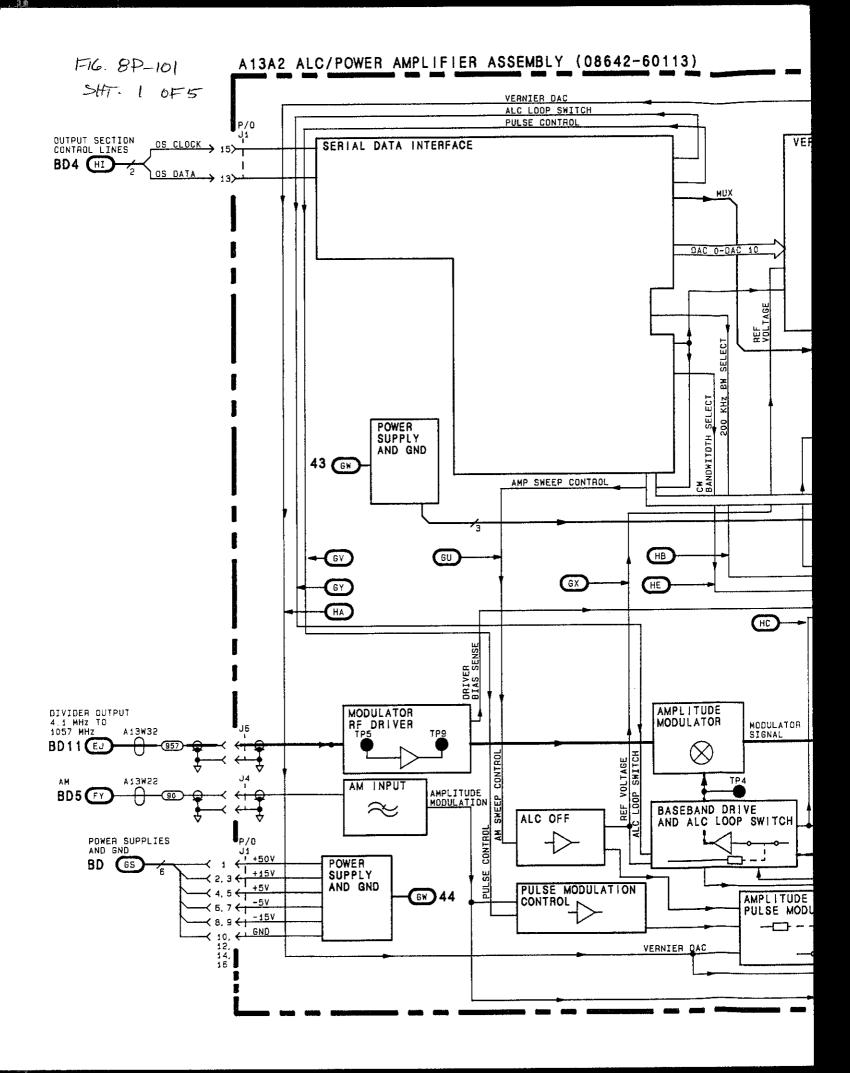
Simplified Block Diagram SERIAL DATA INTERFACE AND CONTROL A13A2 A13A2

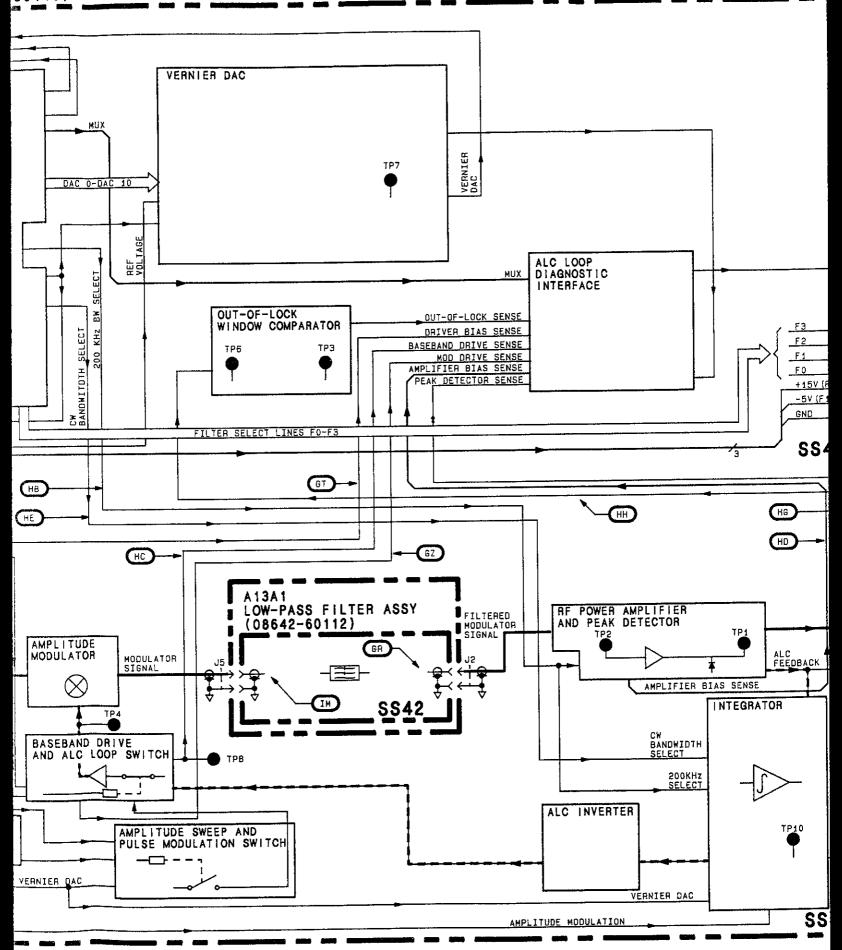
J1 OUTPUT

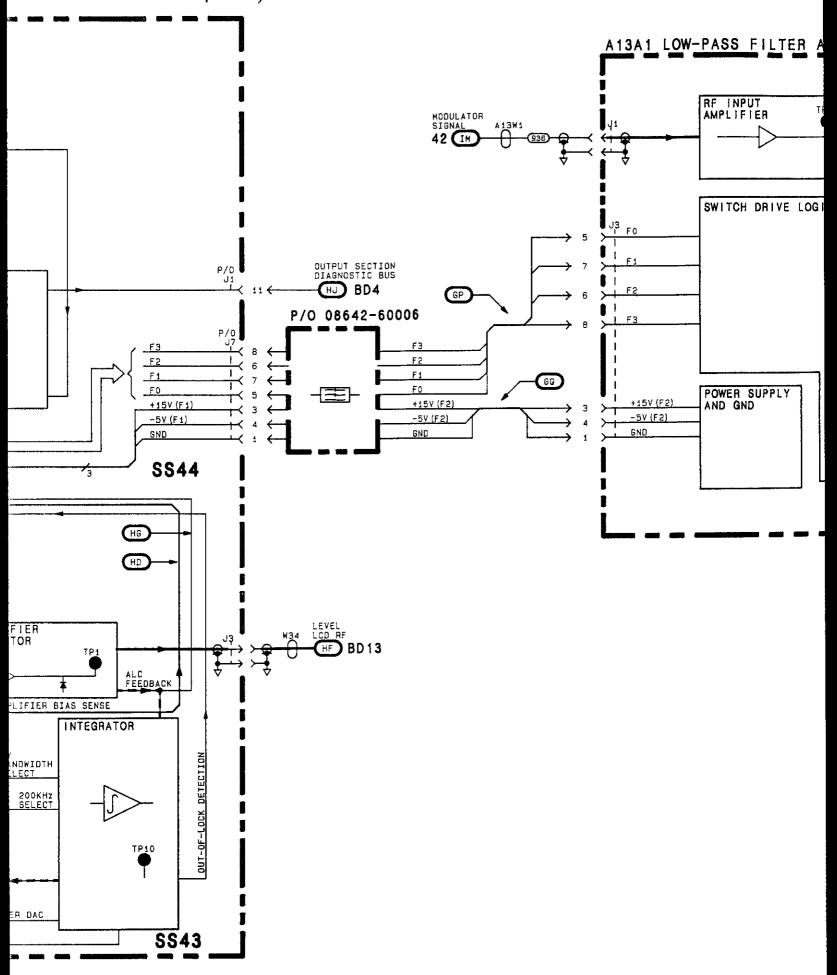
SECTION
DIAGNOSTIC BUS OS CLOCK SERIAL DATA INTERFACE ALC LOOP DIAGNOSTICS INTERFACE OUTPUT SECTION CONTROL LINES OS Data **SS44** VERNIER DAG P/O A13A1 LOW-PASS FILTER ASSY (08642A/B-60112) DIVIDER OUTPUT 4.1 TO 1057 MHz **SS42 SS43** SS-SERVICE SHEET

Figure 8P-100 BD14 General Information.









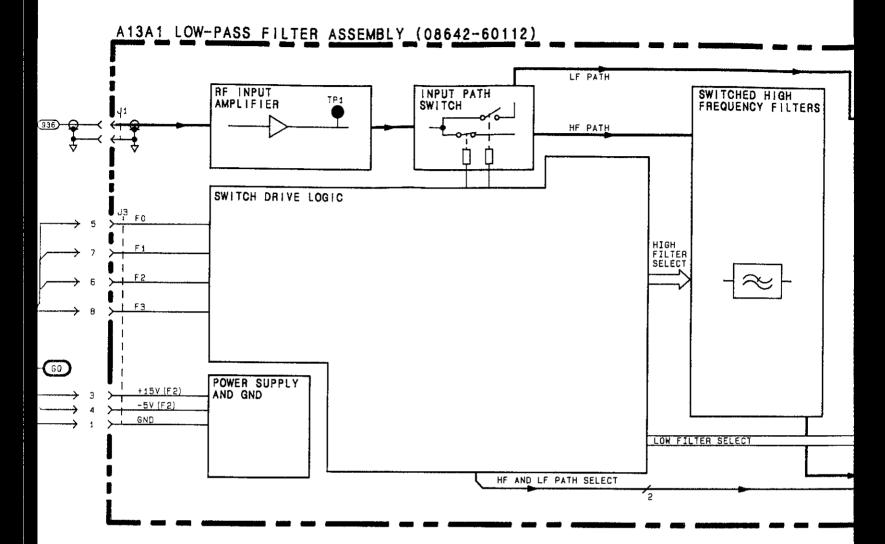
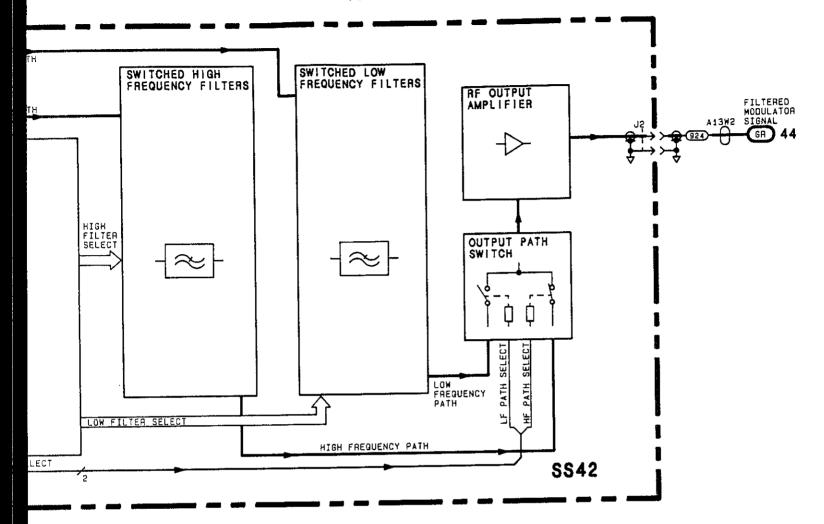


FIG. 8p-101 SHT. 5 OF 5



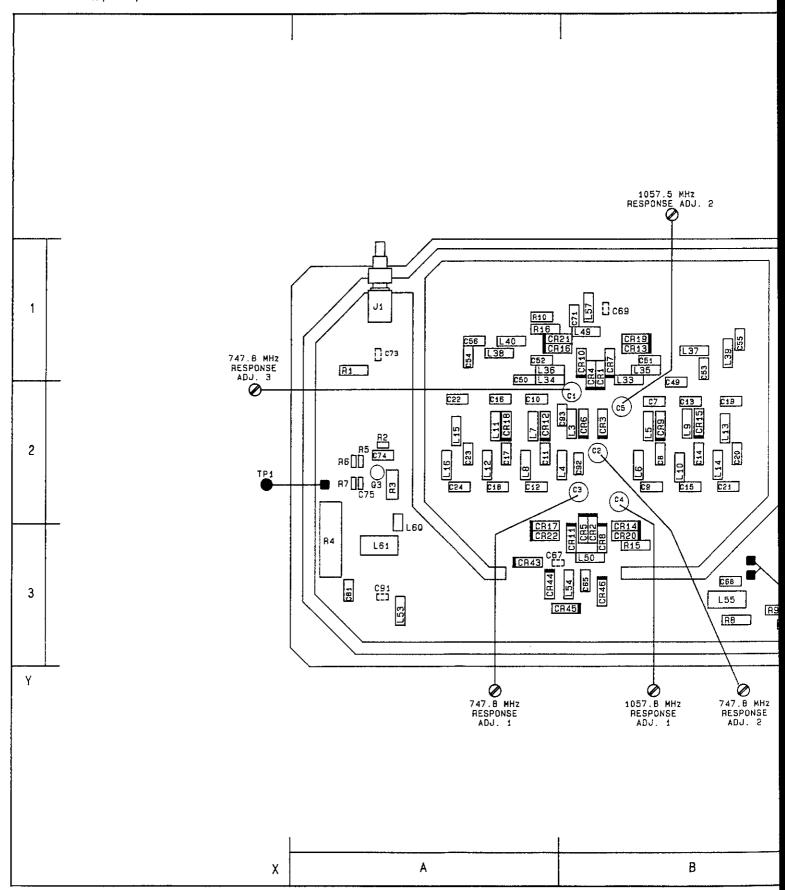
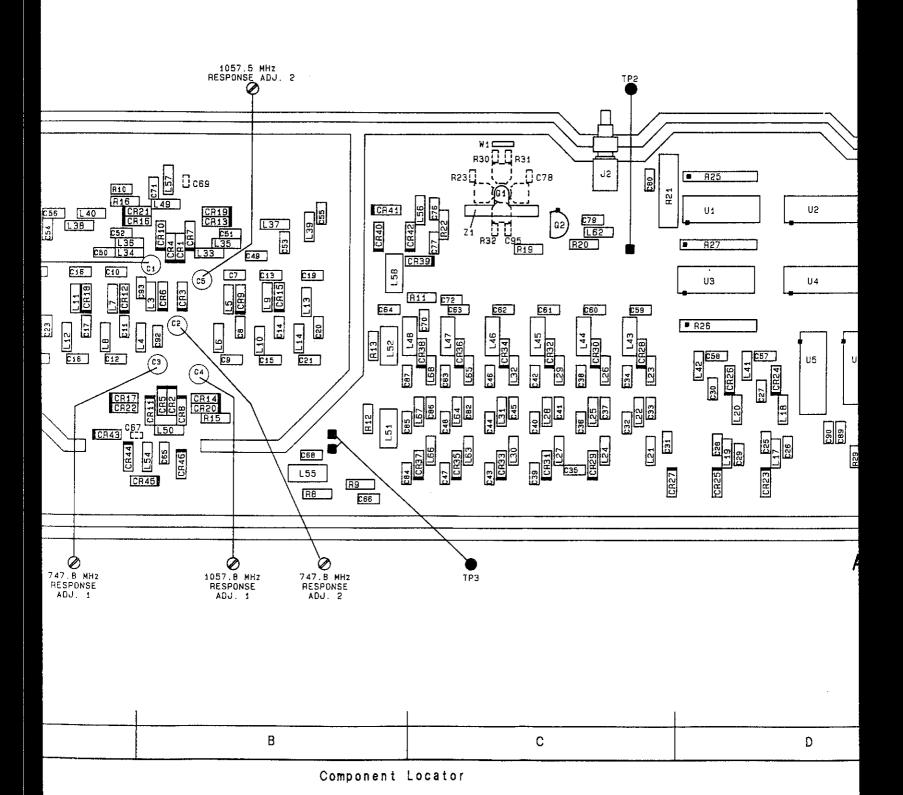
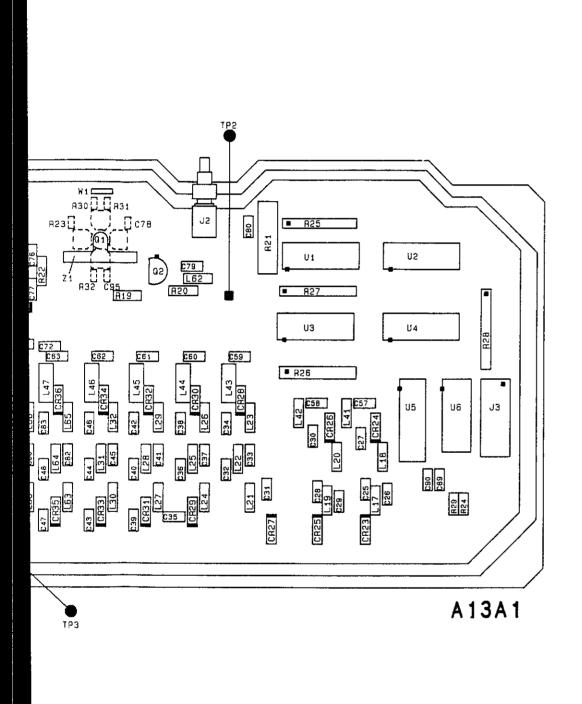


Figure 8P-102. SERVICE SHEET 42 INFORMATION

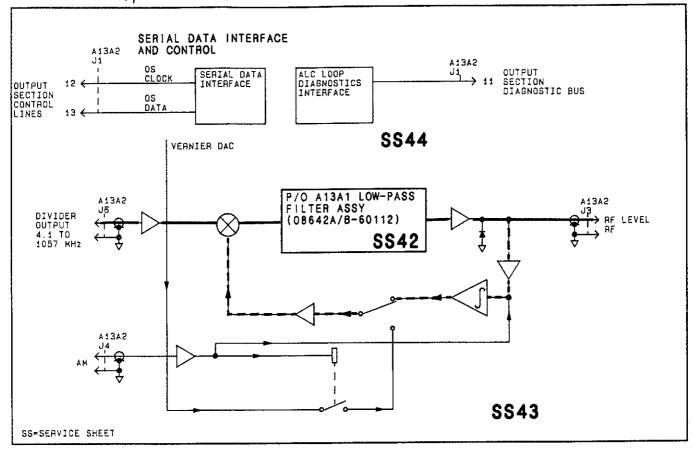




D

ator

С



Reference Block Diagram

#### Component Coordinates

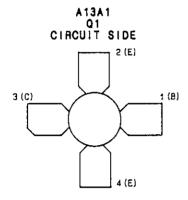
СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C1 C2 C3 C5 C6 C6 C1 C1 C1 C1 C1 C1 C1 C1 C1 C1 C1 C1 C1	8.8.8.8.8.4.4.8.8.8.4.4.8.8.8.8.4.4.0.0.0.0	C399 C4412345 C443445 C448 C448 C448 C5512345 C5567 C5567 C5567 C567 C777 C775		C76 C77 C78 C78 C80 C81 C82 C82 C83 C84 C85 C89 C91 C91 C92 C93 CR1	C.C.C.C.C.C.B.B.C.B.D.D.A.B.B.C.B.B.B.B.B.B.B.B.B.B.B.B.B.B.B.B	CR201 CR201 CR201 CR201 CR201 CR201 CR201 CR201 CR201 CR301	ระหน่าย และสมาชาย เล่า เล่า เล่า เล่า เล่า เล่า เล่า เล่า	L7 L8 L111234567890112334567890112345678901223456789012334567890123345678901233456789012334567890124243		L14444490125345678012345678 123 12345678		R9 R10 R112 R113 R115 R116 R122 R224 R225 R227 R228 R320 R320 TP2 TP2 TP3 U12 U23 U44 U56 W11 Z1	BACOBBRACCCCCCCCCCCCCCCCCCCCCCCCCCCCCCCC				

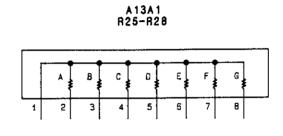
A13 MODULE BD 14

SEE REVERSE SIDE

#### Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- 3. L69 is a printed circuit trace inductor.
- 4. It is acting as a ground strap, connecting the stud of Q1 to ground.





#### All Serial Prefixes

On the Component Locator:

<u>CR51, CR52</u> - Immediately above C19, add CR51. Immediately above C22, add CR52.

In Component Coordinates:

• <u>CR51, CR52</u> - Add CR51 B,2. Add CR52 A,2.

On the schematic:

- To the left of RF INPUT AMPLIFIER, change "44" to "43" next to the bullet "IM".
- To the right of RF OUTPUT AMPLIFIER, change "44" to "43" next to the bullet "GR".
- CR51, CR52, In SWITCHED HIGH FREQUENCY FILTERS, in the 132.2 MHz filter, add CR51 (same symbol as CR19) from the cathode of CR19 to ground. Orient CR51 with its cathode to ground. Directly below, in the 93.5 MHz filter, add CR52 from the cathode of CR21 to ground in the same orientation and same symbol as CR51.
- C29, C38 In SWITCHED LOW FREQUENCY FILTERS, in the 46.7 MHz filter, change the value of C29 to 160p. In the 23.4 MHz filter, change C38 to C42 and assign it a value of 220p.
- C27, C35 In SWITCHED LOW FREQUENCY FILTERS, in the 66.1 MHz filter, change the value of C27 to 68p Farads. In the the 23.4 MHz filter change the value of C35 to 150p Farads.
- HF 5 In SWITCHED HIGH FREQUENCY FILTERS, change HF 5 frequency from 246.4 to 264.4 MHz.
- To the left of SWITCH DRIVE LOGIC, change the service sheet number for FILTER SELECT LINES, "GP" from 43 to 44.
- In SWITCHED LOW FREQUENCY FILTERS, in the 16.5 MHz filter, change the reference designator for C38 to C42.

# 2511A to 2550A 2511A to 2550A

#### On the Component Locator:

• Note changes on 8P-102.6

#### On the schematic:

- In the upper left portion of the schematic, change A13A1 part number to 08642-60212.
- R3, R5, R6, R7, C75 In RF INPUT AMPLIFIER, change R3 value to 178. Change R5, R6, and R7 values to 42.2 ohms. Change C75 value to 3.3p.
- C26, C85, C86 In the SWITCHED LOW FREQUENCY FILTERS, change C26 value to 120p. (C26 is in the 66.1 MHz filter). Change C85 and C86 values to 1100p. (C85 and C86 are in the 5.85MHz filter).
- Replace the appropriate portion of the schematic with the partial on 8P-102.5.
- Note: The 08642-60212 board ground comes from the 08642-60213 board by the outer conductor of the coax cables and the castings.

#### On the schematic partial:

- C97 On change page 8P-102.5, in OUTPUT PATH SWITCH add C97, 1p, from the anode of CR41 to ground. Change the caption below the schematic partial to read "CHANGES TO FIGURE 8P-103 (2512A to 2550A)
- To the right of RF OUTPUT AMPLIFIER, change "44" to "43" next to the bullet labeled "GR".

#### On the schematic:

C74 - In RF INPUT AMPLIFIER, change the value of C74 to 1000p.

### 2512A to 2550A

#### **SS42** 8P-102.2

## 2529A to 2550A

2534A to 2550A

2535A to 2550A

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On the Component Locator:

Note changes on page 8P-102.7

In Component Coordinates:

C100, C101, R39 - Add C100, C101, and R39. Assign grid locations of C,1 for all three.

On the schematic partial:

• C100, C101, R39 - On change page 8P-102.5, in RF OUTPUT AMPLIFIER, add a resistor R39 in series with the cathode of CR 50 and ground. Assign it a value of 220 ohms. In parallel with R39, add a capacitor, C100. Assign it a value of 220p Farads. Also in parallel with R39, add another capacitor, C101. Assign it a value of 220p Farads. Change the caption below the schematic partial to read "CHANGES TO 8P-103 (?529A to 2550A).

On the schematic partial:

• C96, L70, R34, R35 - On change page 8P-102.5, remove the series path between U5 pin 11 and the anode of CR49. This path includes all parts listed above and amplifier USG becomes unused. Change the caption below the schematic partial to read "CHANGES TO 8P-102.3 (2534A to 2550A).

On the schematic:

• C25-C28, C30 - In SWITCHED LOW FREQUENCY FIL-TERS, in the 66.1 MHz filter, change the values of the following components to these new values:

C25 - 47p

C26 - 100p

C27 - 47p

In the 46.7 MHz filter, change the values of the following components to these new values:

C28 - 82p

C30 - 82p

C29 - 160p

#### **SS42** 8P - 102.3

# 2551A and above

NATIONAL CONTRACTOR CO

and the contract of the second state of the se  On the Component Locator:

Note new Component Locator on page 8P-102.10

In Component Coordinates:

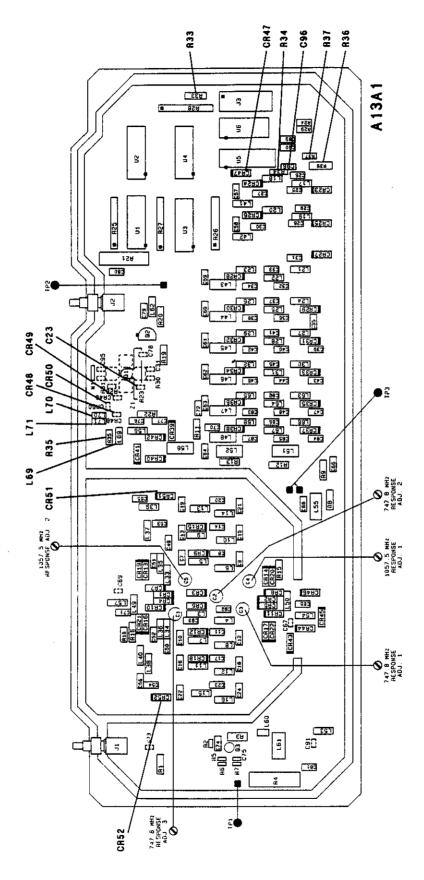
Note new Component Coordinates table on page 8P-102.10

On the schematic:

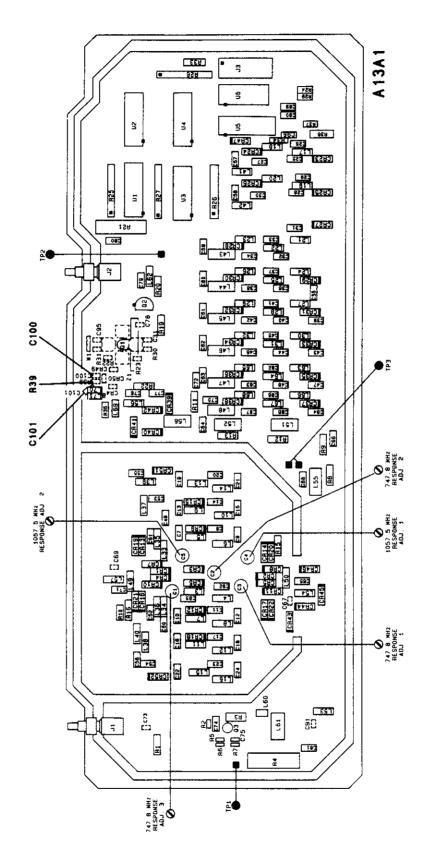
<u>C96, C97, C98, C99, R34, R35, R38, L70</u> - Note new SS42 on page 8P-102.11

Lugings###blua **SS42** 

8P-102.4



CHANGES TO FIGURE 8P-102 (2511A to 2550A)



CHANGES TO FIGURE 8P-102 (2529A to 2550A)

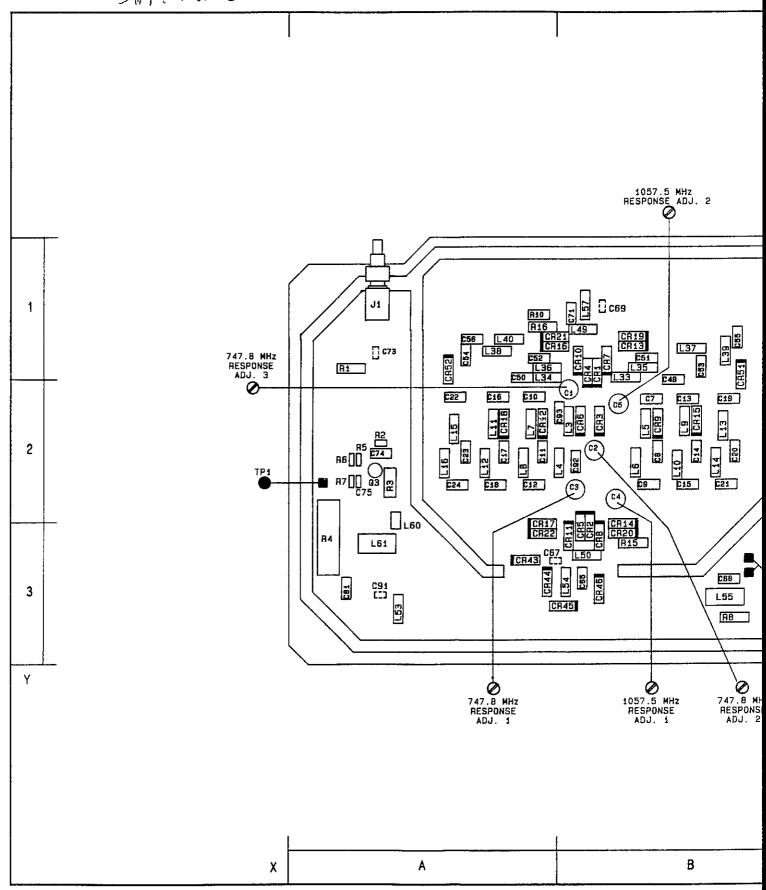
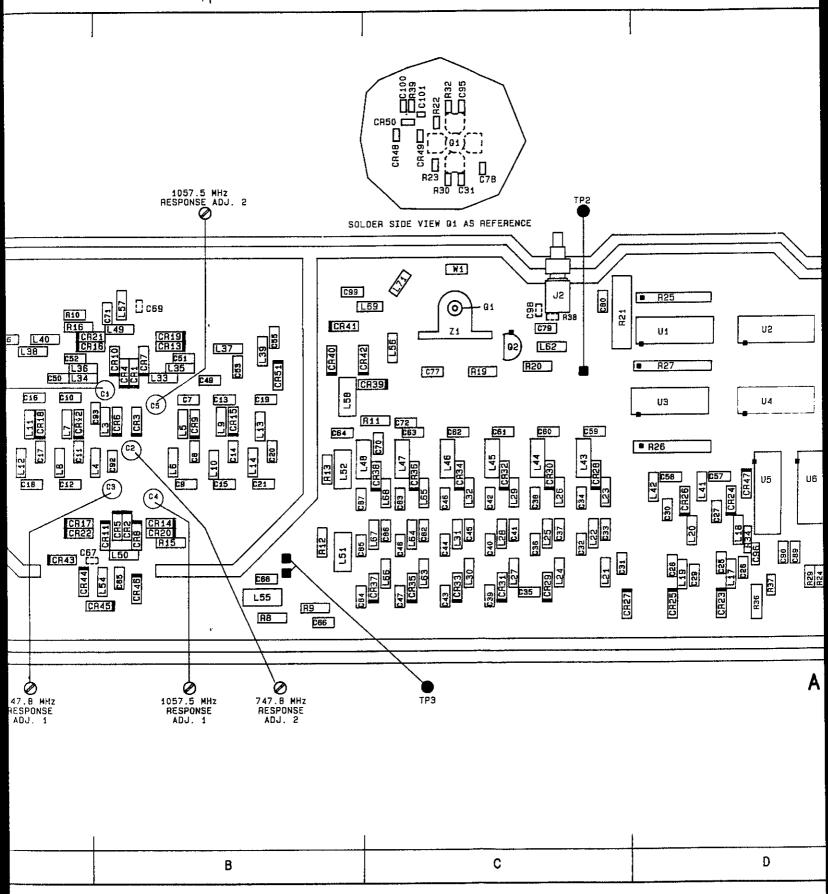
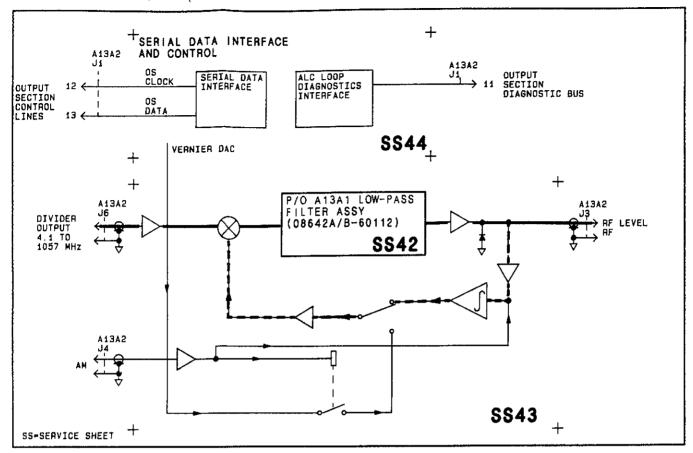


Figure 8P-102. SERVICE SHEET 42 INFORMATION

F16. 8P-102 Str. 2 OF 5





Reference Block Diagram

#### Component Coordinates

СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C1 C2 C3 C4 C5 C7 C8 C9 C10 C11 C12 C13 C14 C15 C21 C21 C22 C22 C22 C22 C22 C22 C22 C23 C23 C23	<ul><li>・ 222222222222222222222222222222222222</li></ul>	C39 C441 C42 C444 C445 C447 C449 C551 C554 C557 C558 C661 C667 C669 C772 C775	CCCCCCCCCCBABABABABACCCCCCCBBBBABBCBCAAA	C76 C778 C78 C78 C78 C80 C81 C82 C83 C84 C85 C87 C89 C99 C99 C99 C100 CR1	CCCCCACCBBCBCBCABCCCCCC BBBBBBBBBBBBBBB	CR14 CR15 CR15 CR16 CR16 CR17 CR21 CR22 CR22 CR22 CR22 CR22 CR22 CR22	- 321321313333232323232323232323211113333323232323232323232323232323232323232	CRS 123 3 4 5 6 CRS 123 4 6 CR		L335 L335 L335 L336 L336 L441 L447 L447 L447 L447 L447 L455 L556 L556 L566 L667 L667 L667		G12 G2 G2 G2 G2 G2 G2 G2 G2 G2 G2 G2 G2 G2	CC.A. A.A.A.A.A.B.A.C.B.B.B.A.C.C.C.C.C.D.D.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.D.C.C.C.D.D.D.C.C.C.D.D.D.D.D.D.D.D.D.D.C.C.C.D	R39 TP1 TP2 TP3 U1 U2 U3 U4 U5 U6 W1 Z1	C. 1 A.C. 13 D.D. 12 D.D. 12 D.D. 12 C. 1 C. 1		

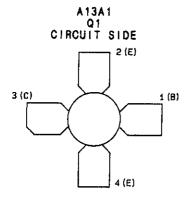
A13 MODULE BD 14

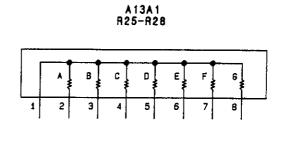
SEE REVERSE SIDE

Model 8642A/B

#### Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the
  module configuration code. When servicing a module, note any changes that apply specifically to its module
  configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- 3. L69 is a printed circuit trace inductor.
- 4. Zi is acting as a ground strap, connecting the stud of  $\mathbf{Q}\mathbf{i}$  to ground.





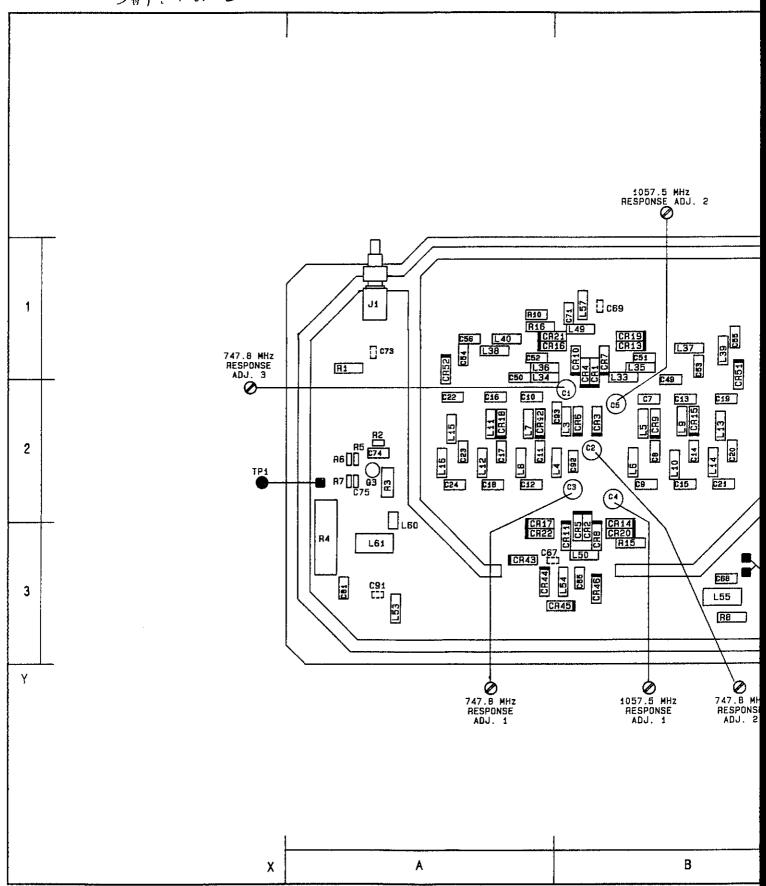
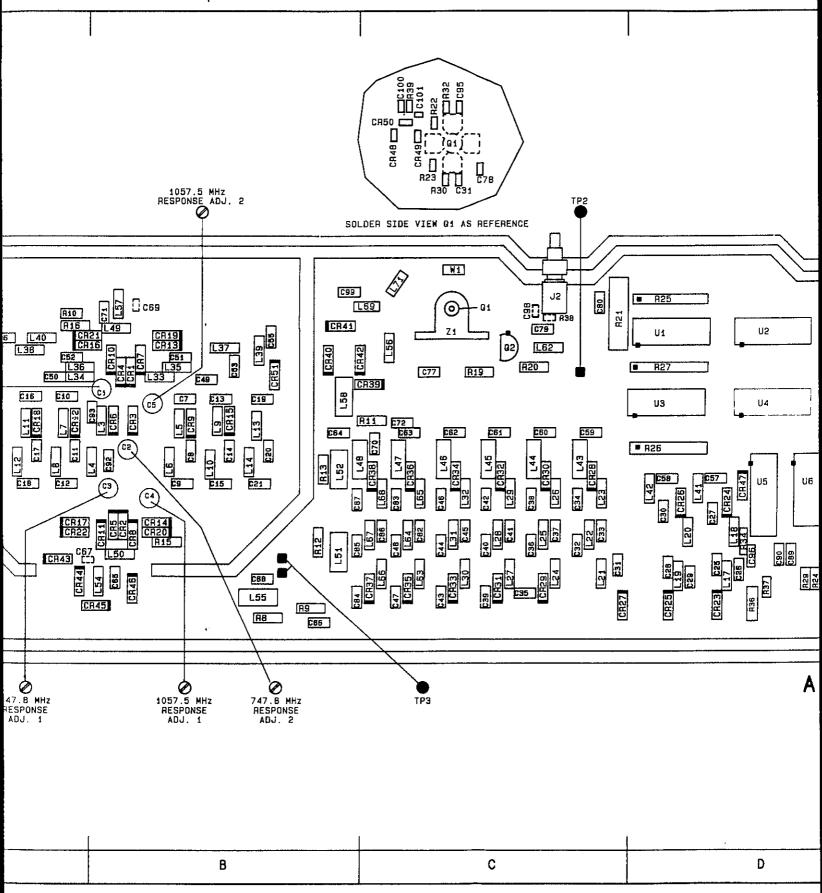
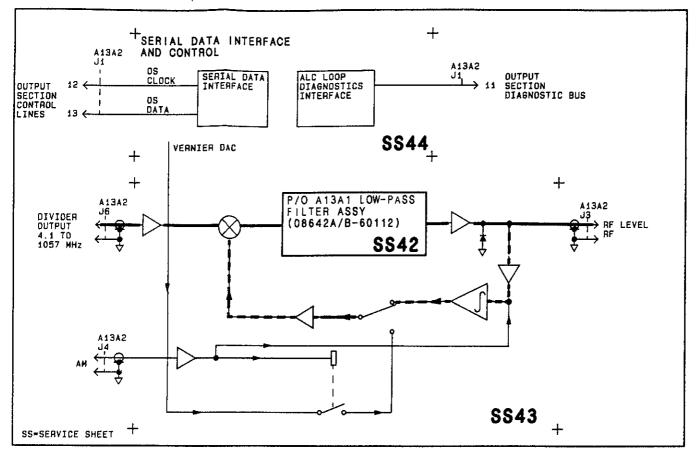


Figure 8P-102. SERVICE SHEET 42 INFORMATION

FIG. 8P-102 Str. 2 OF 5





Reference Block Diagram

# Component Coordinates

A13 MODULE BD 14

SEE REVERSE SIDE

r R

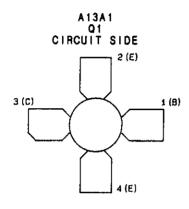
8 F

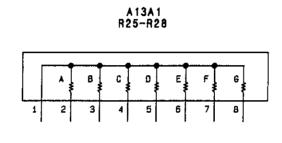
F16.8P-102 SHT. 5 OF 5

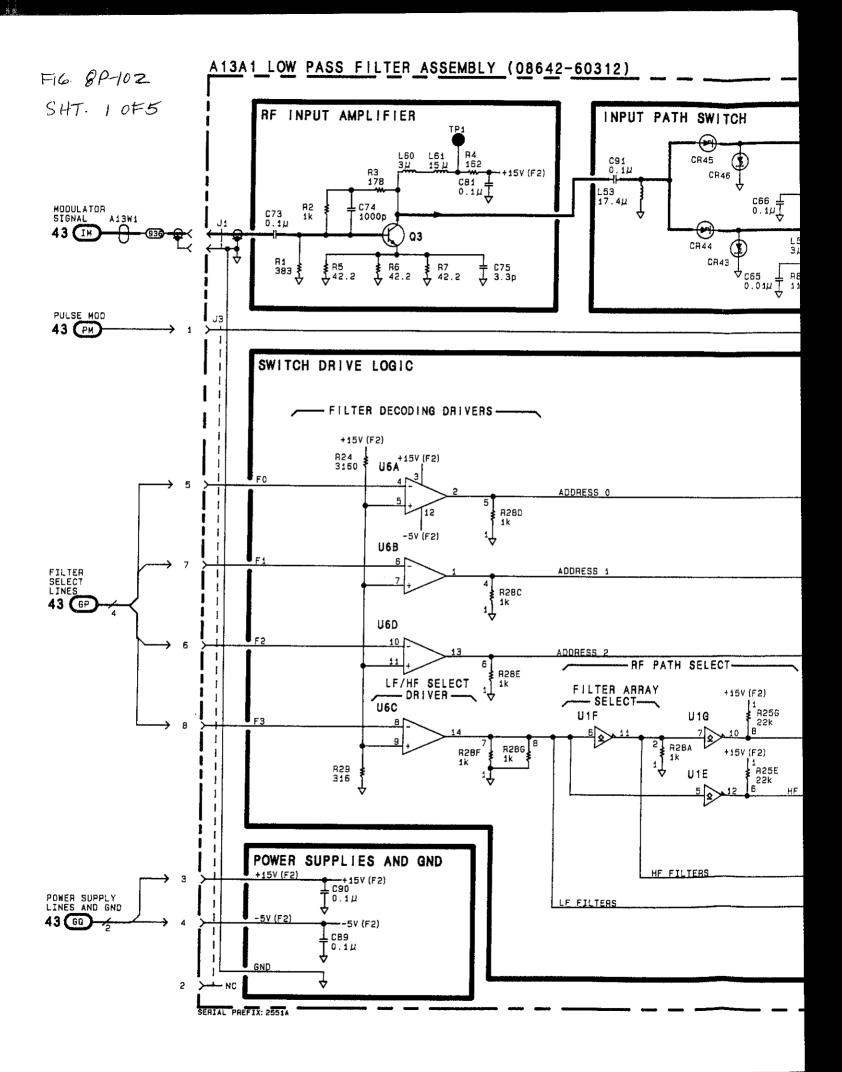
Model 8642A/B

### Notes:

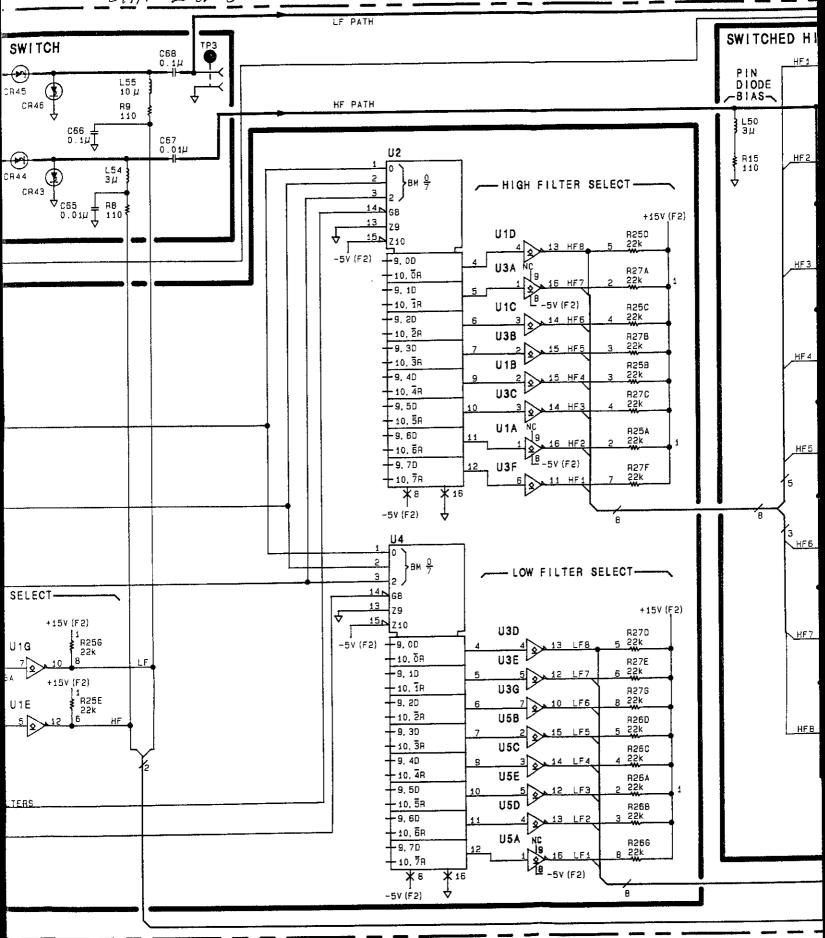
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the
  module configuration code. When servicing a module, note any changes that apply specifically to its module
  configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- 3. L69 is a printed circuit trace inductor.
- 4. Zi is acting as a ground strap, connecting the stud of Gi to ground.

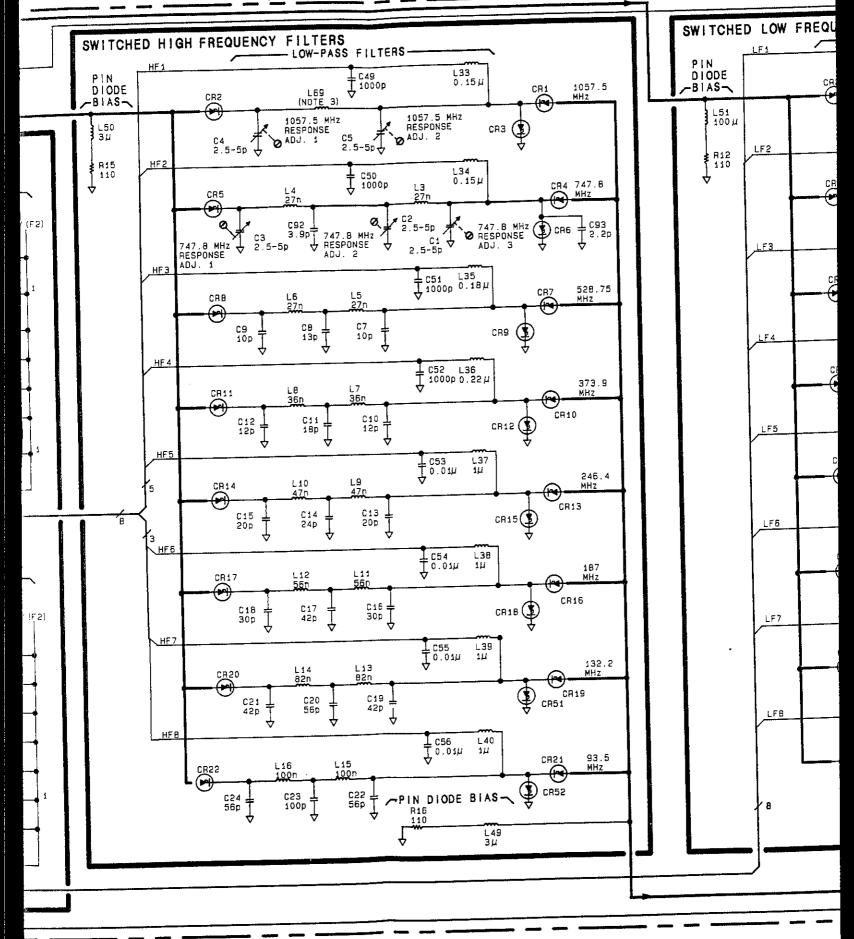




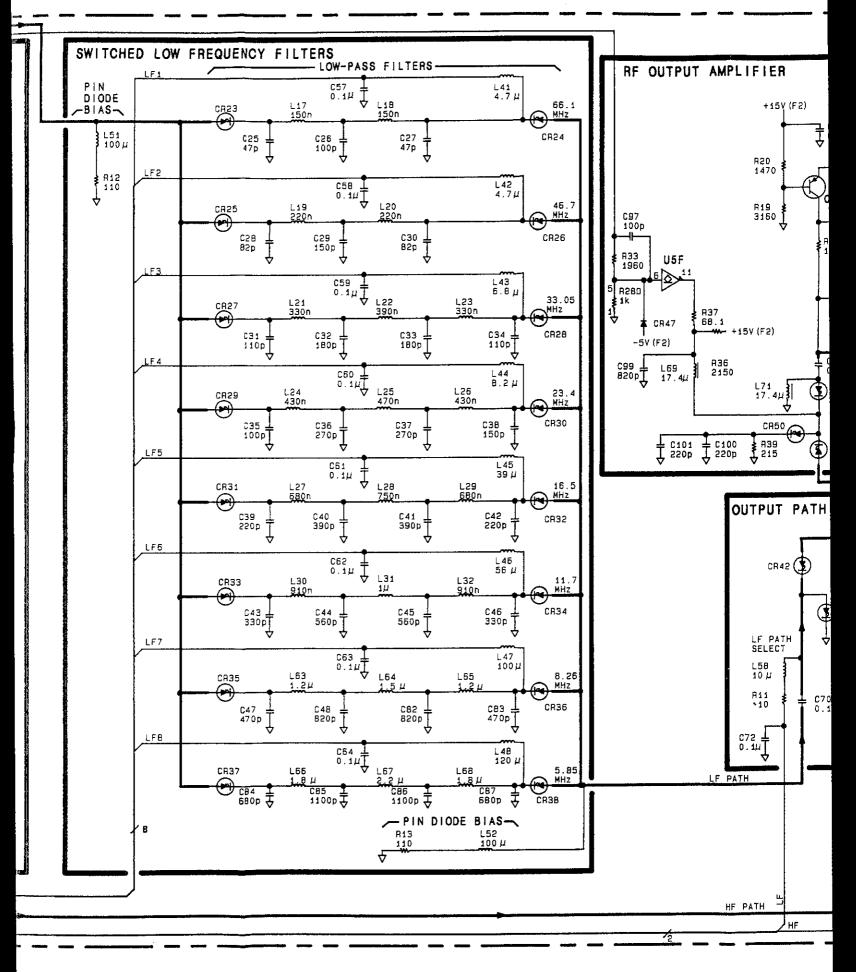


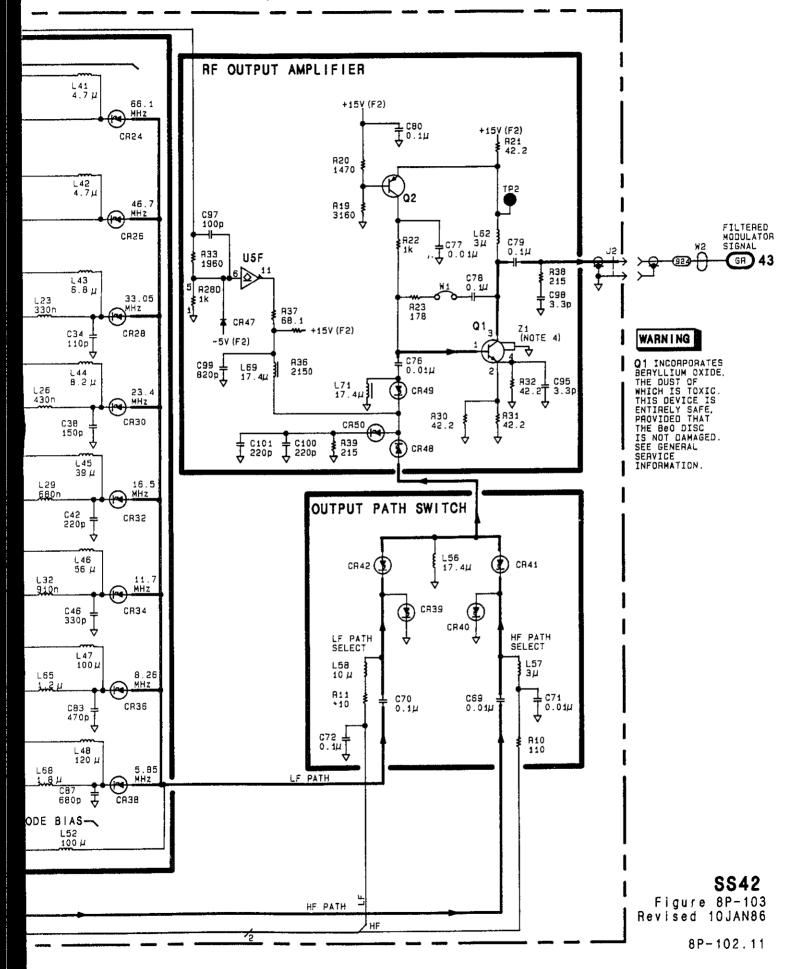
eze .....

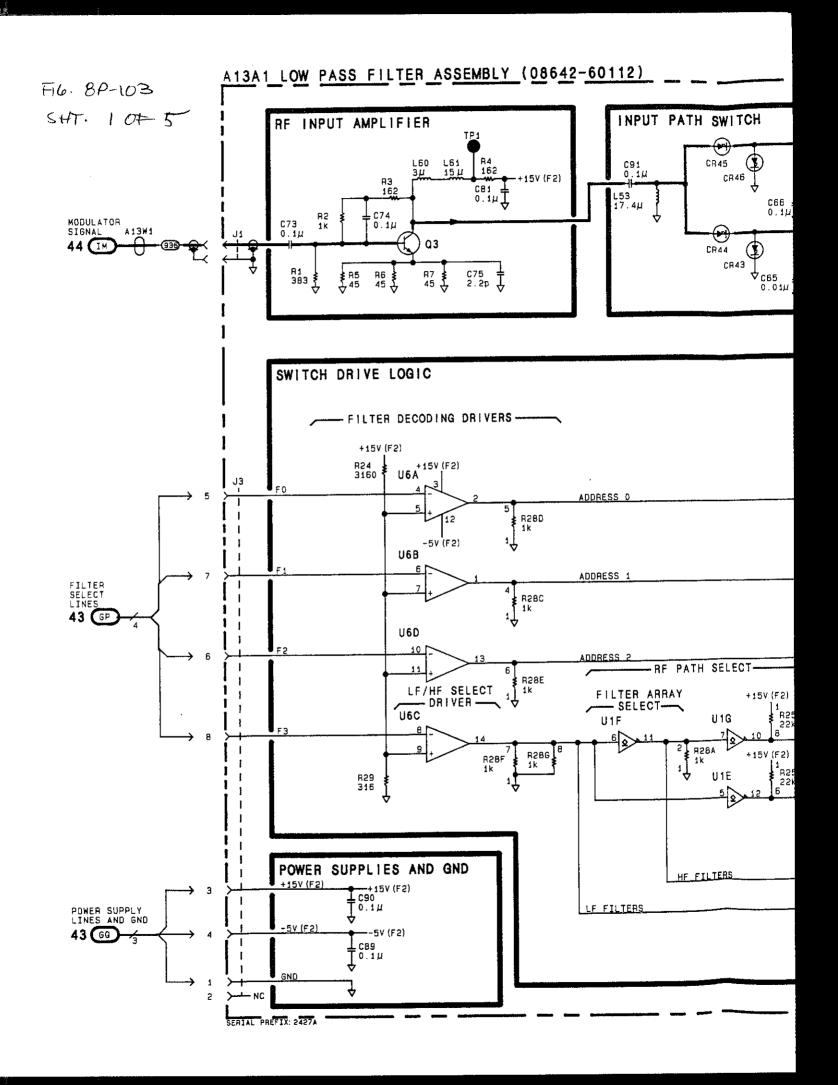


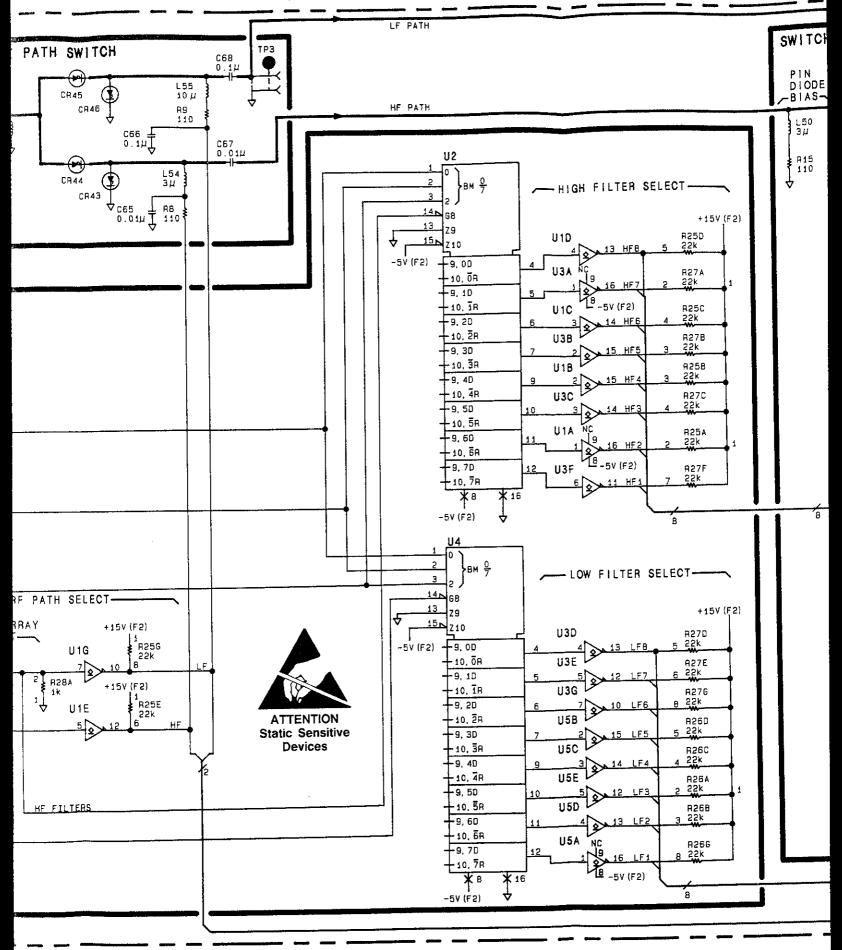


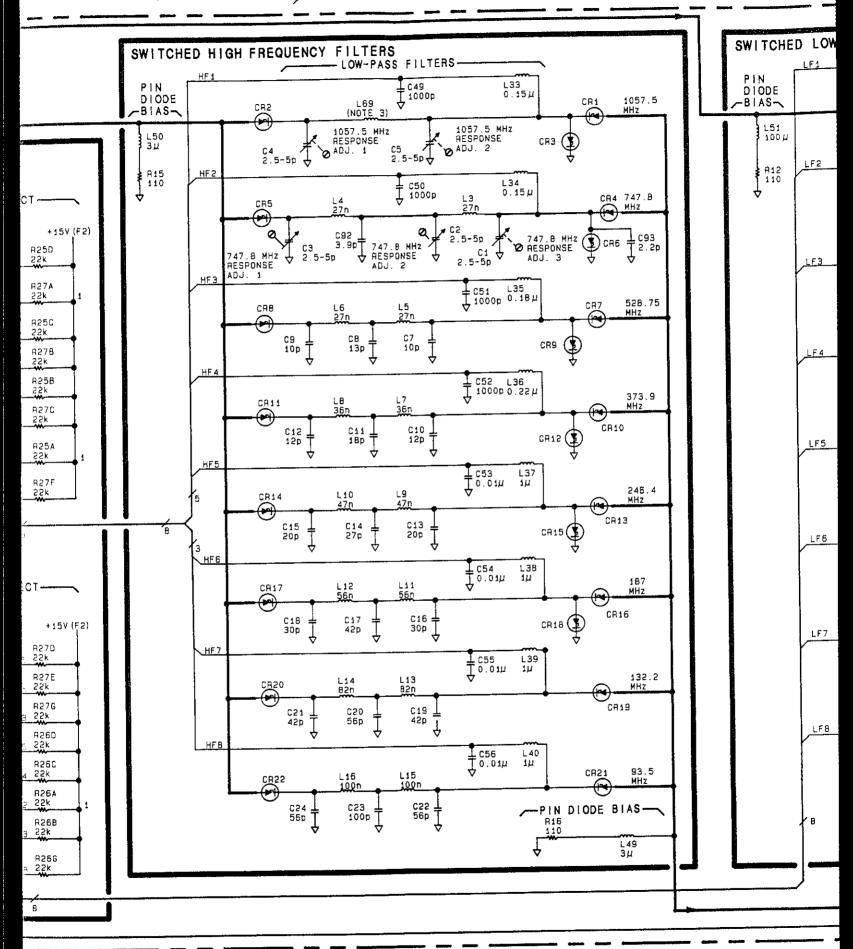
723

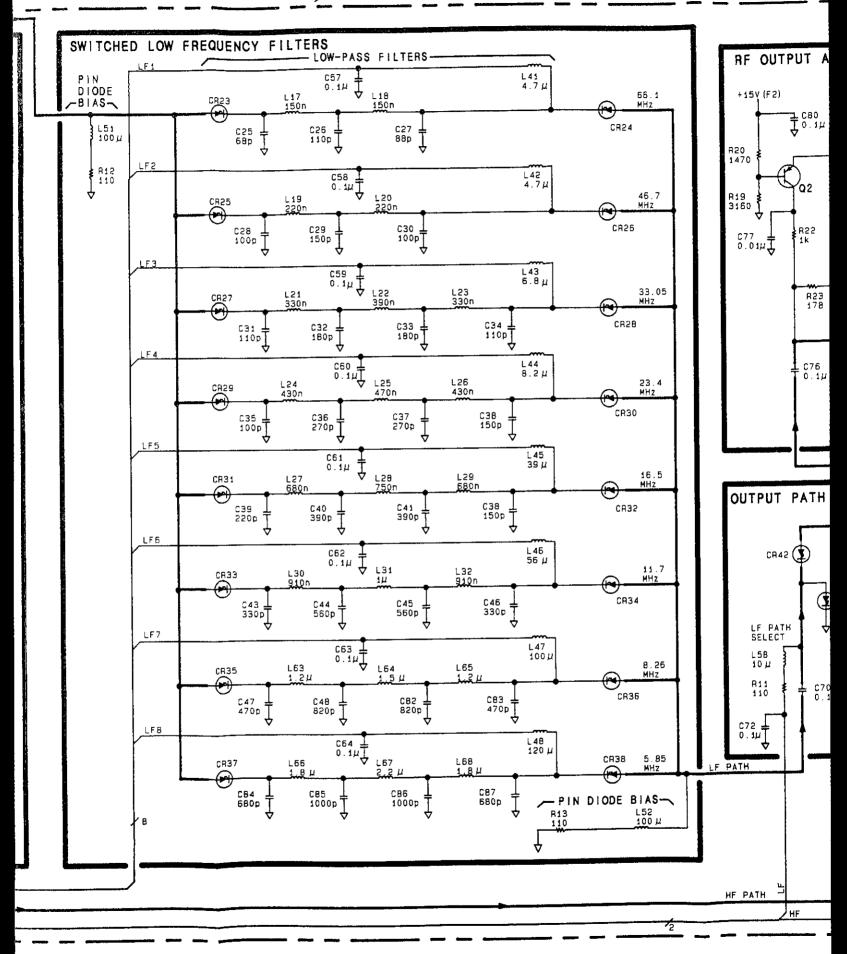


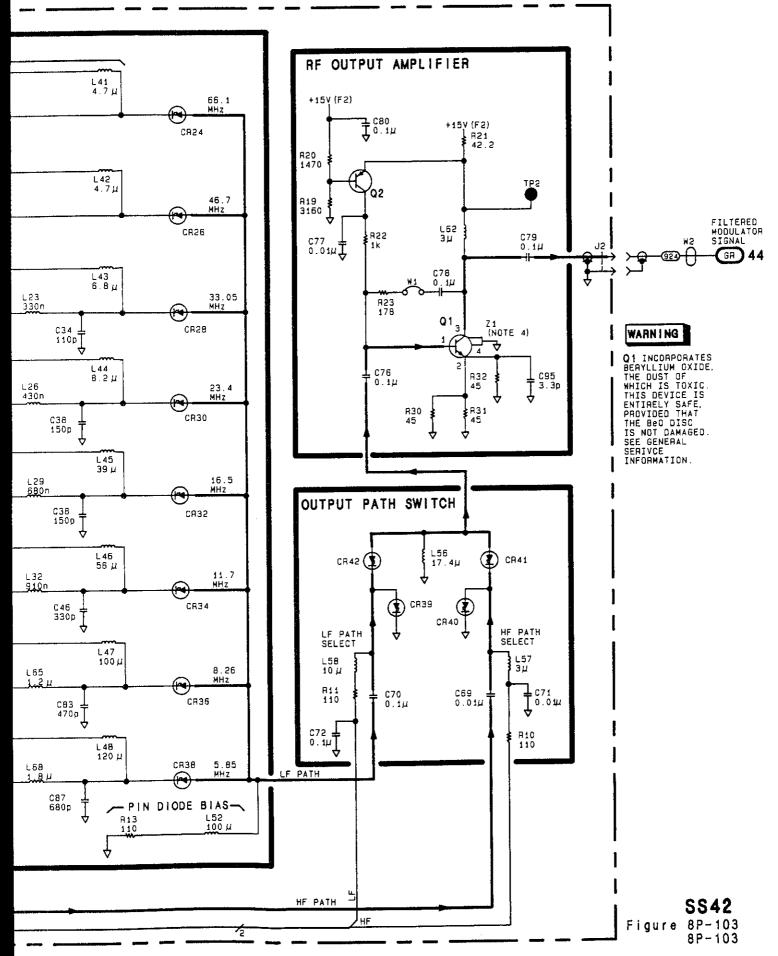












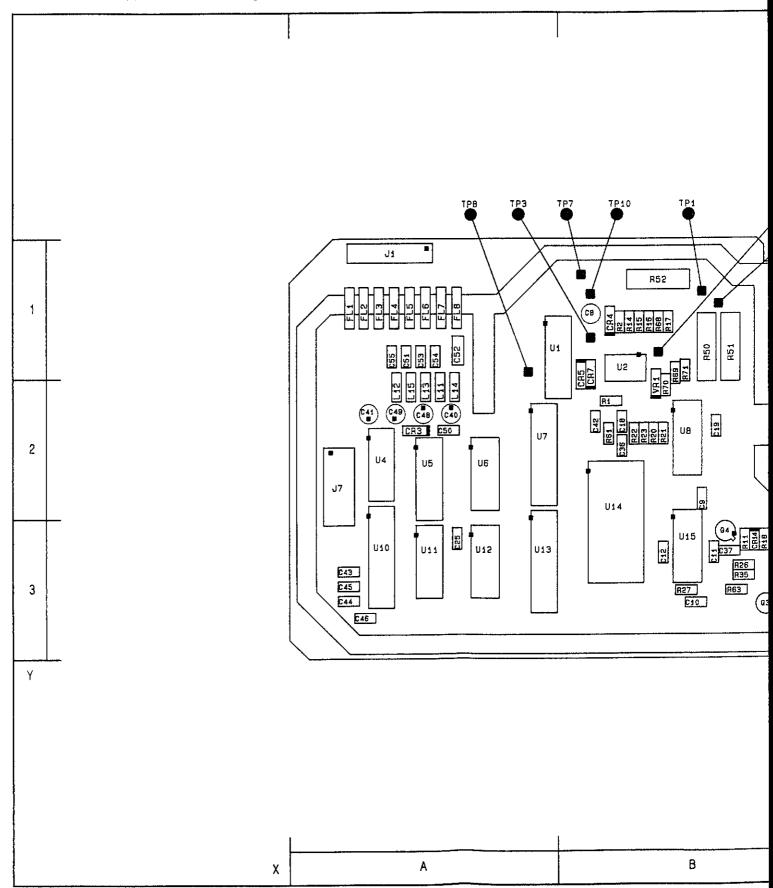
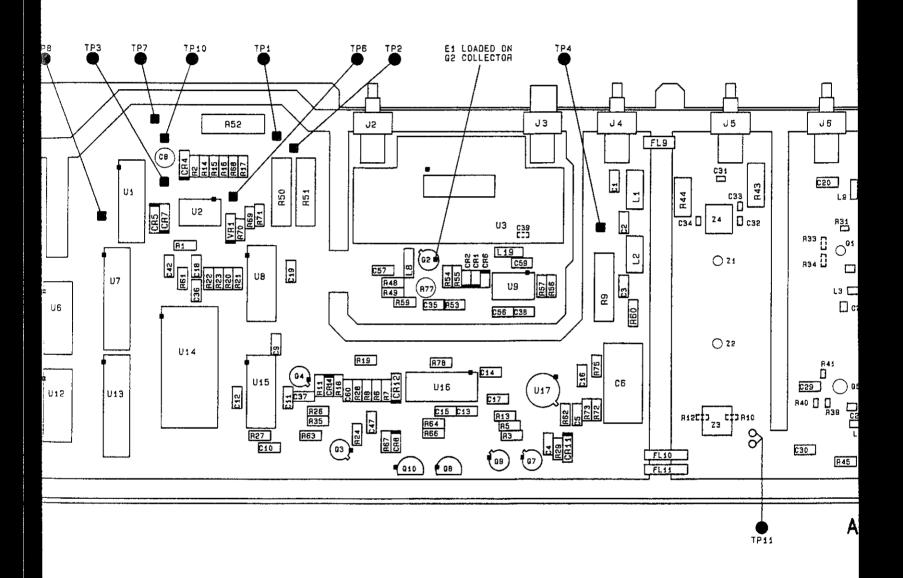


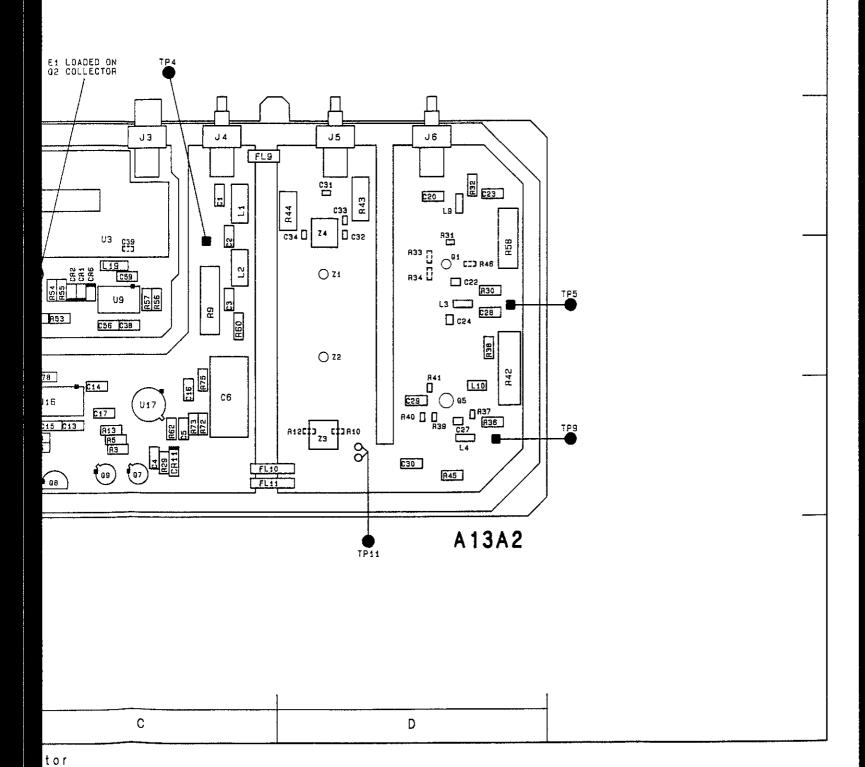
Figure 8P-104. SERVICE SHEET 43 INFORMATION

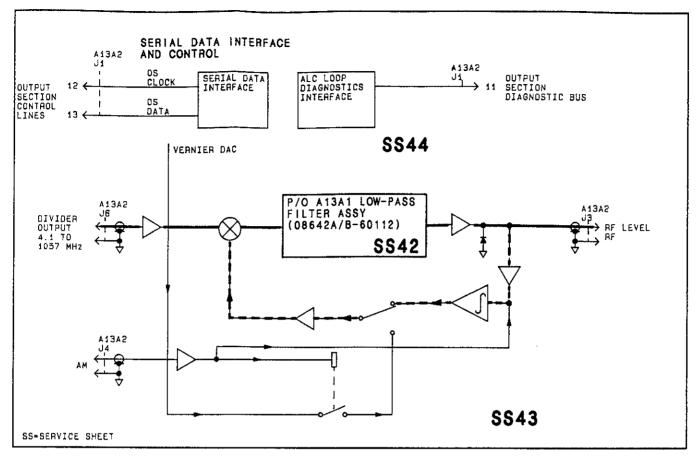


В

C

D





Reference Block Diagram

### Component Coordinates

СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C1 C2 C3 C6 C6 C6 C6 C6 C6 C6 C6 C6 C6 C6 C6 C6	C.C.C.C.C.C.G.G.G.G.G.G.G.G.G.G.G.G.G.G	C534 C554 C554 C557 C56 C66 C683 C6811 C6811 C6811 C6811 C6811 C78	A.A.C.B.C.B. C.C.A.C.B.C.B.B. C. A.A.A.A.C.C.C. A.B.C.C.C.C.	L12344B9 011234459		R2112344 R2112344 R2212344 R23131467 R338901123445 R6338901123445 R65567 R6561 R6561	######################################	R62 R634 R6534 R650 R77 R77 R77 R77 R77 R77 R77 R77 R77 R7	C.B.C.C.B.B.B.C.C.C.C.C. B.B.C.C.A.C.B.C. C.B.C.B.C.C.B.C.C.B.C.C.C.C.C.C.								

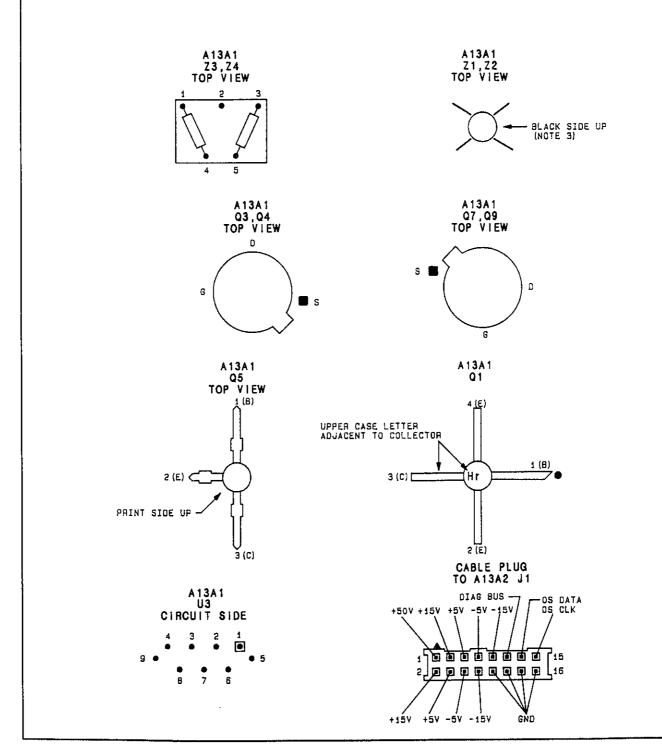
A13A1

LOW-PASS FILTER ASSEMBLY SS42

SEE REVERSE SIDE

### Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. FL9 outer body must be soldered to pad in notched area of shielding.
- Z1, Z2 are diode rings as shown on schematic, Pin numbering is not shown because devices can be oriented any way and still operate properly.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.



Schematic General Information

## **CHANGES**

251IA and above

On the Component Locator:

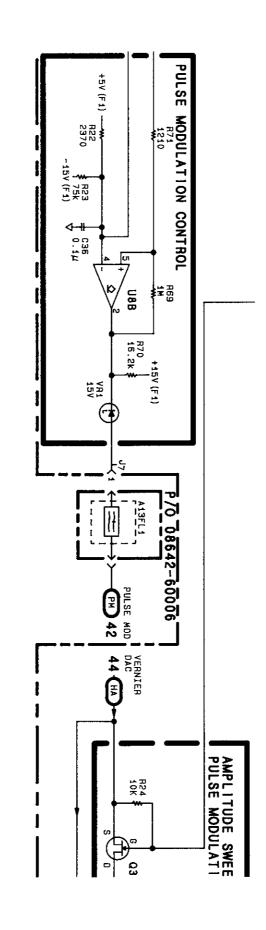
• R61 - Remove R61.

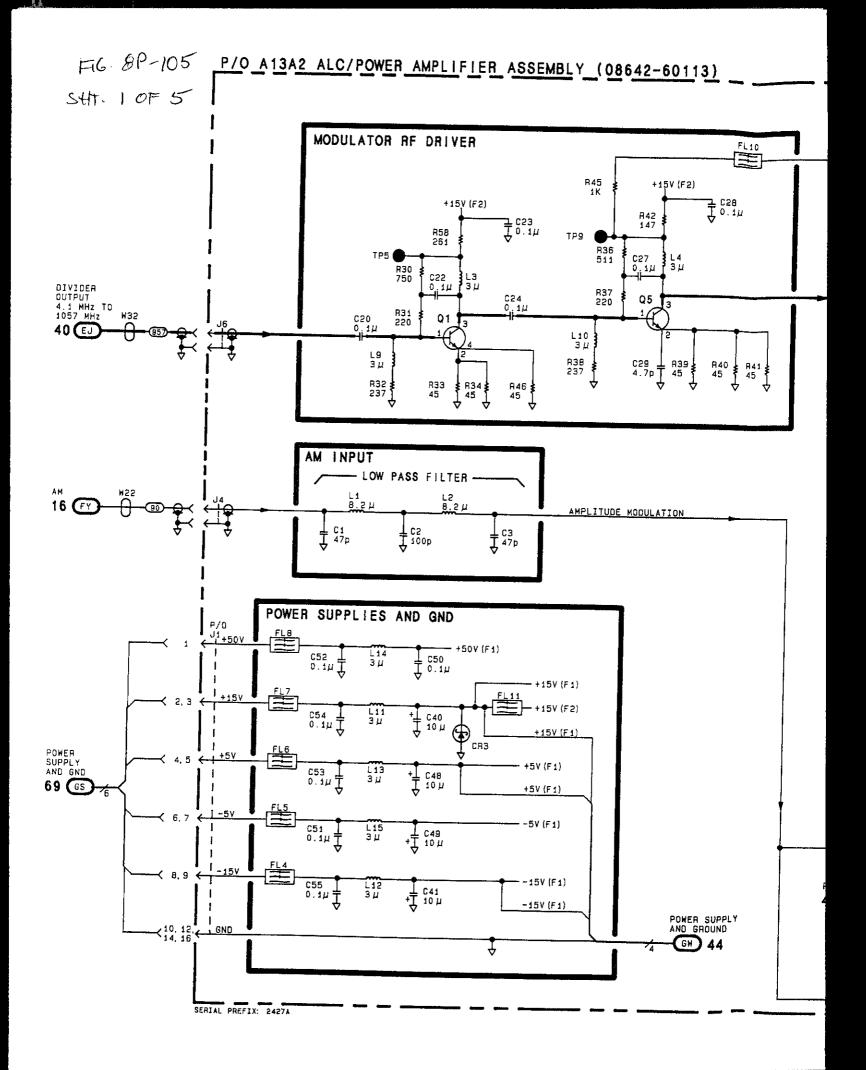
In Component Coordinates:

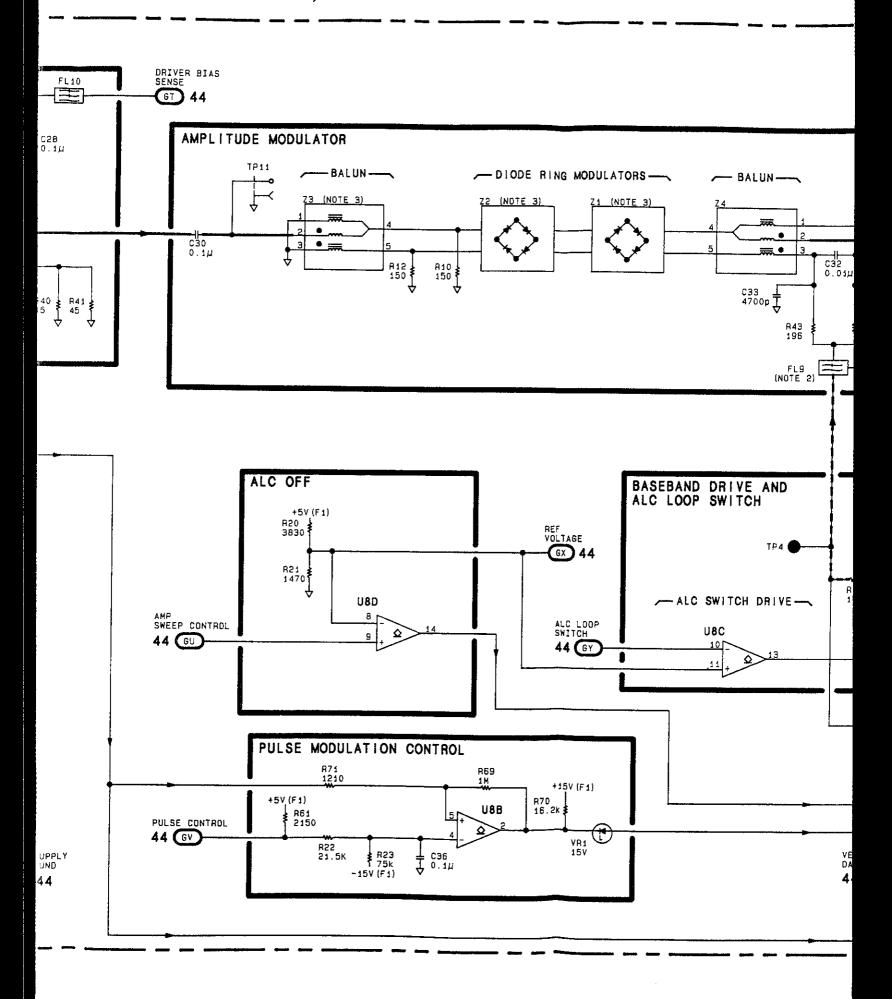
• R61 - Remove R61.

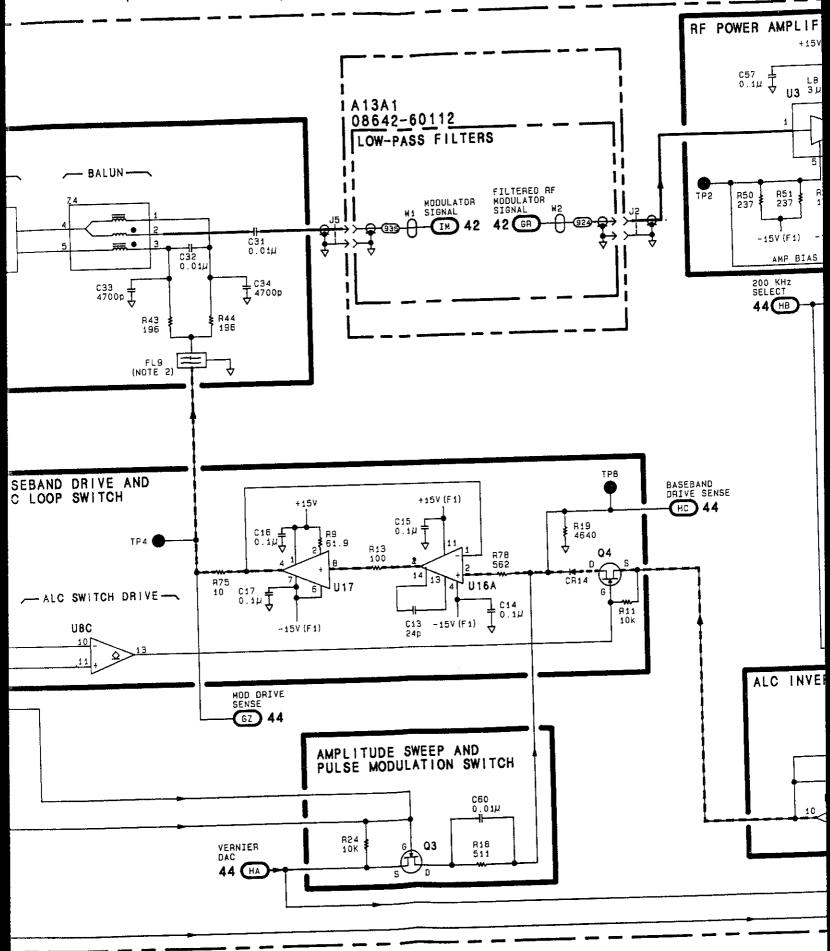
On the schematic:

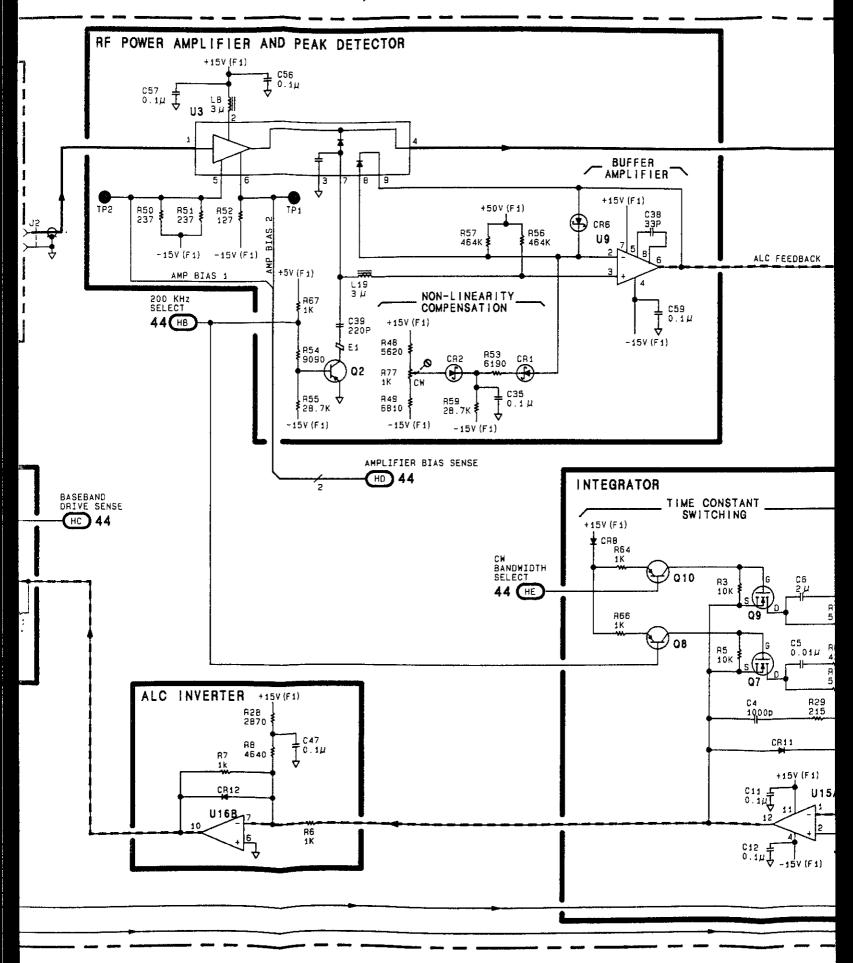
- In the upper right portion of the schematic, change A13A2 part number to 08642-60213.
- Replace appropriate portion of the schematic with the partial on 8P-104.3.
- To the left of ALC OFF, change bullet GU from "AMP SWEEP CONTROL" to "ALC OFF SELECT".





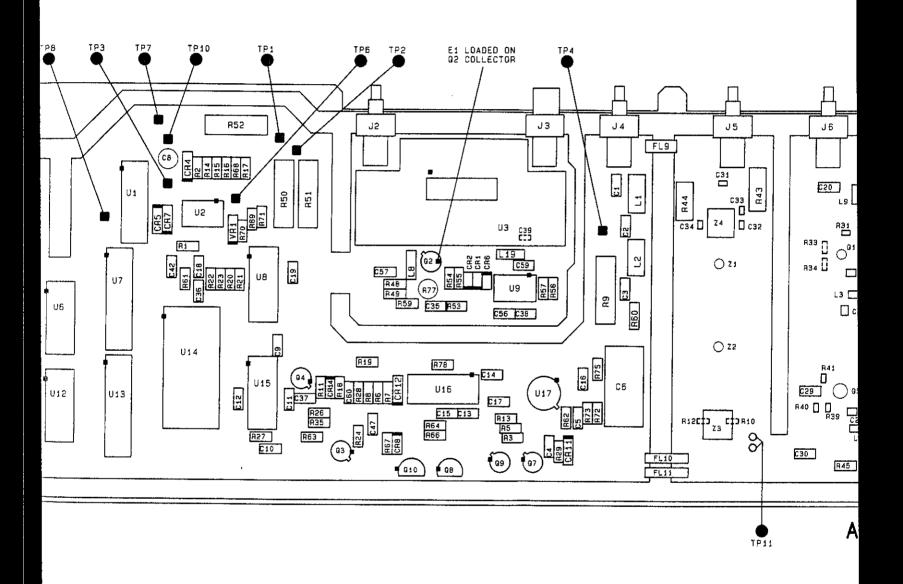






**SS43**Figure 8P-105
8P-105

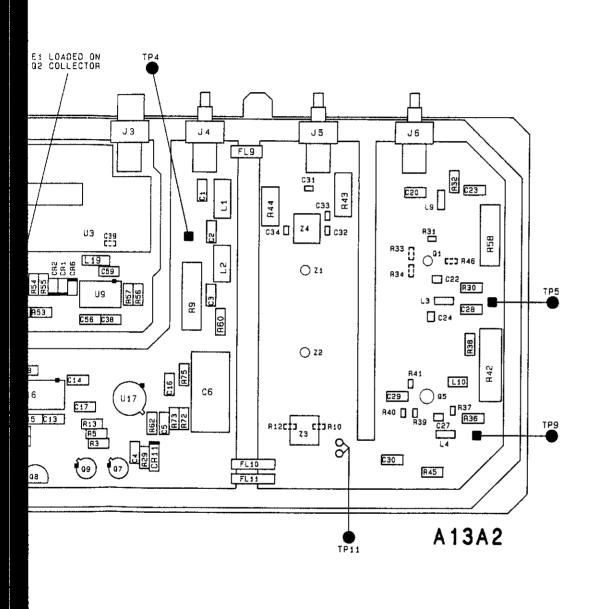
Figure 8P-106. SERVICE SHEET 44 INFORMATION



C

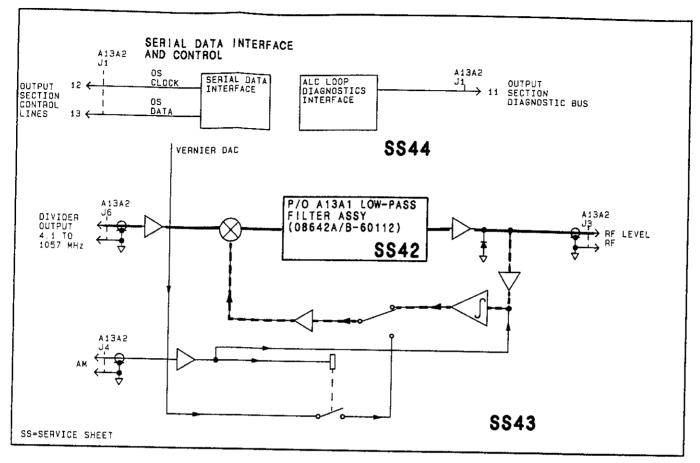
D

В



D

С



Reference Block Diagram

# Component Coordinates

0000																	
СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X.Y	СОМР	X,Y	СОМР	ΧY
C8 C9 C10 C18 C19 C25 C42 C44 C45 C45	A, 3 A, 3	U1 U2 U4 U5 U6 U7 U8 U10 U11 U112 U13 U14	112222223333323 A.B. A.A.B. A.A.A.B.B.											COMP	Х, 1	COMP	
CR4 CR5 CR7	8, 1 8, 1 8, 1	U15	B, 3										1	 			
FL1 FL2 FL3	A, 1 A, 1 A, 1																
J1 J7	A, 1 A, 2											!					
R2 R14 R15 R16 R17 R26 R27 R35 R68	B. 1 B. 1 B. 1 B. 3 B. 3 B. 3 B. 3 B. 3																
TP3 TP6 TP7	B, 1 B, 1 B, 1																

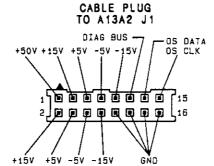
P/O A13A2 ALC/POWER SS43

Model 8642A/B

#### Notes:

Service

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. FL1, FL2, FL3 outer bodies must be soldered to pads in notched area of shielding.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Aefer to General Service Information, paragraph 8-3.
- A13FL1 is an array of feedthrough filters passing through the center of the module to make connections between two (2) printed circuit boards.



## **CHANGES**

### All Serial Prefixes

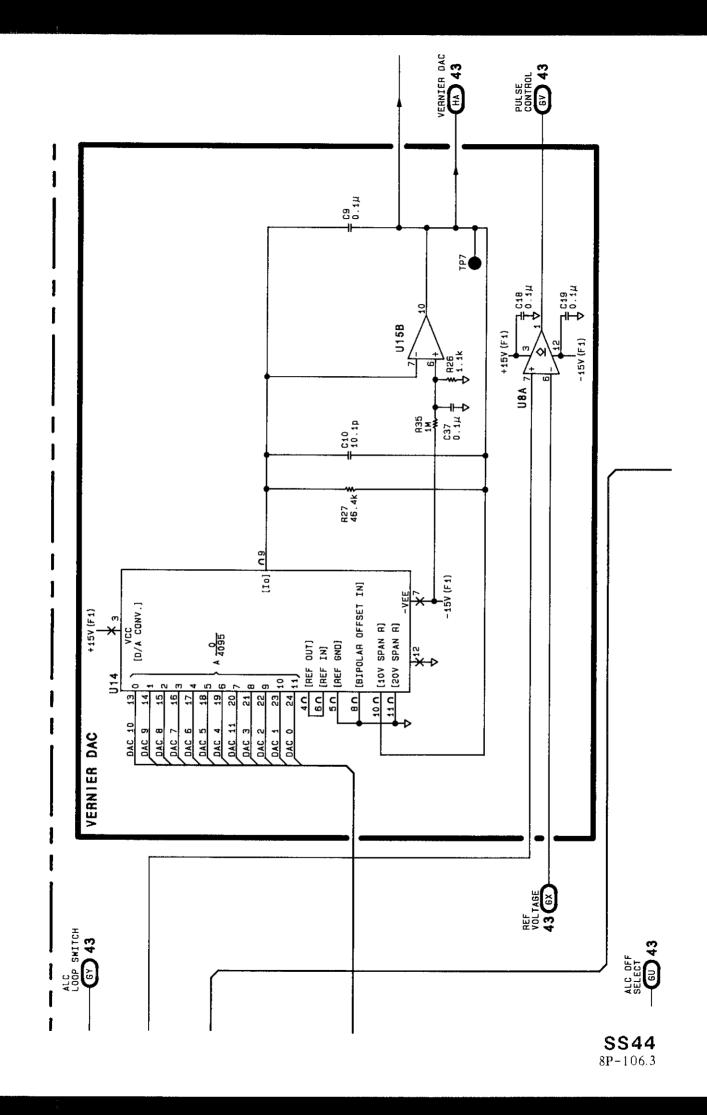
#### On the schematic:

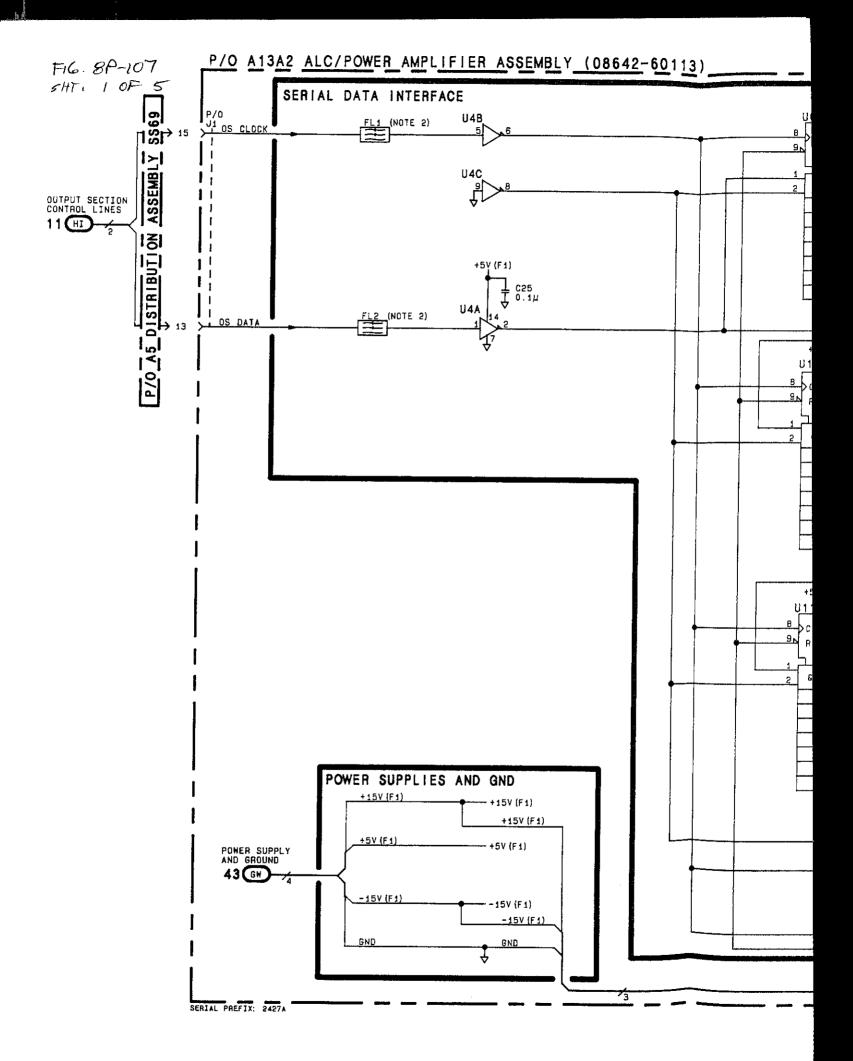
- To the left of OUT-OF-LOCK WINDOW COMPARATOR, add "43" next to the bullet "HH" and delete "A13A2".
- <u>J7</u> On the right side of the schematic, under P/O J7, change the following pin numbers:
  - 3 to 8
  - 4 to 6
  - 1 to 7
  - 8 to 5
  - 6 to 3
  - 7 to 4
  - 5 to 1

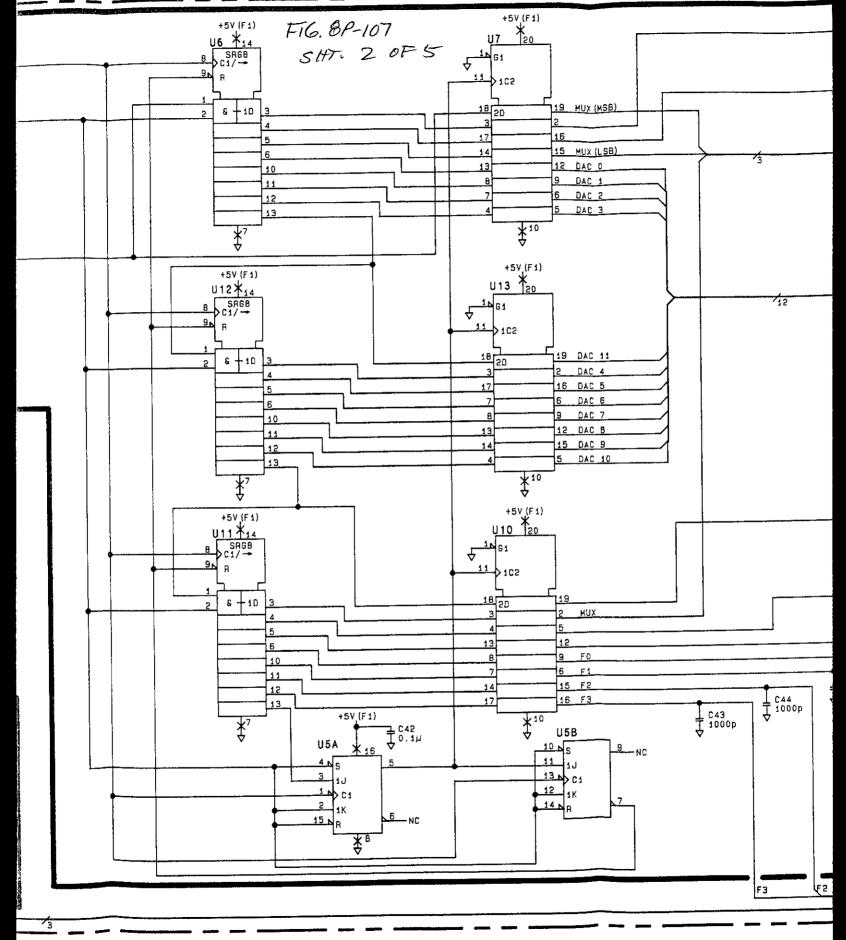
#### 2511A and above

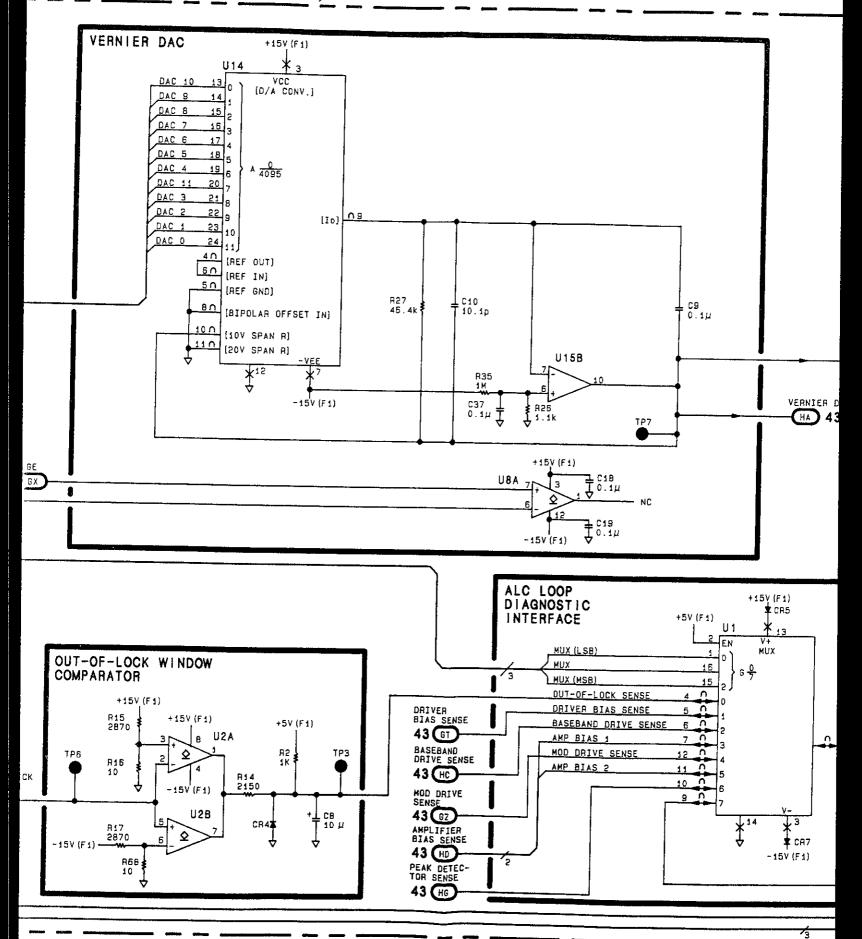
#### On the schematic:

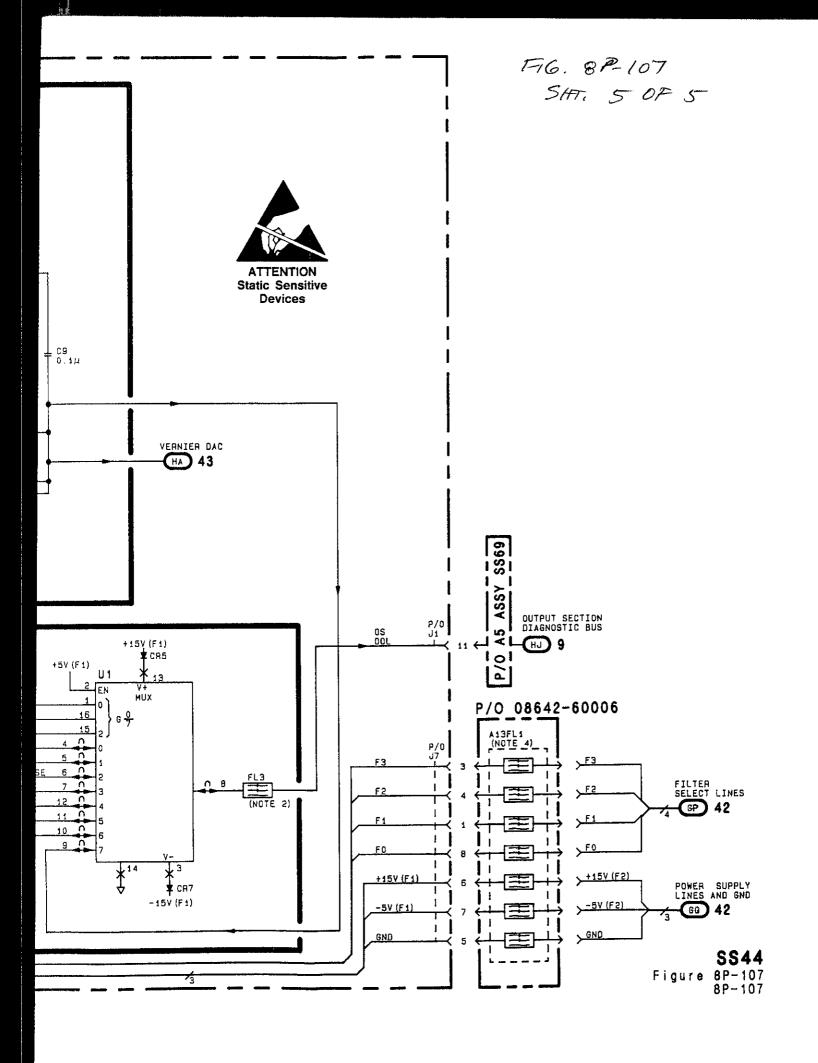
- In the upper left portion of the schematic, change A13A2 part number to 08642-60213.
- Replace the appropriate portion of the schematic with the partial on 8P-106.3.
- <u>J7, A13FL1</u> On the right side of the schematic, delete the line labeled GND, J7 pin 1, and the feed through filter connected to J7 pin 1. Be sure J7 pin numbering changes were made first! (See All Serial Prefixes).
  - To the right of SERIAL DATA INTERFACE, change bullet GU from "AMP SWEEP CONTROL" to "ALC OFF SELECT".



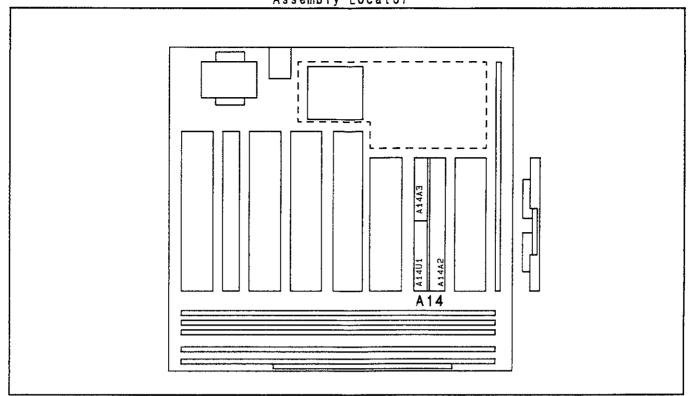








A14 Heterodyne Module



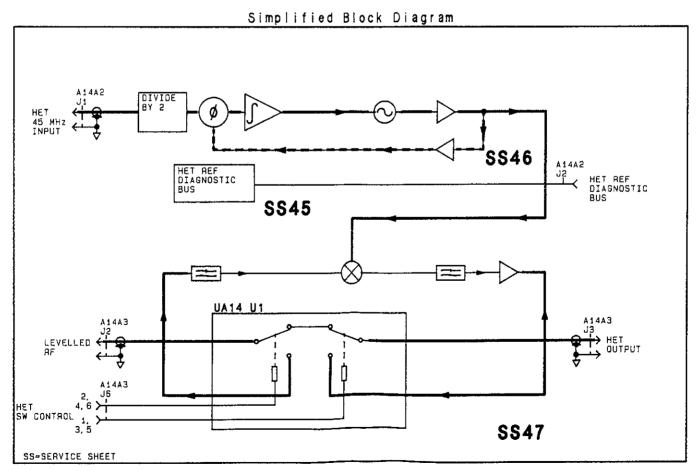
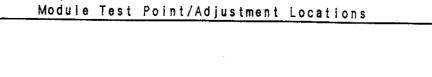
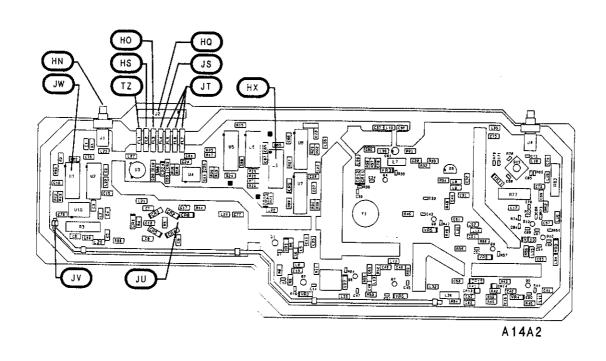
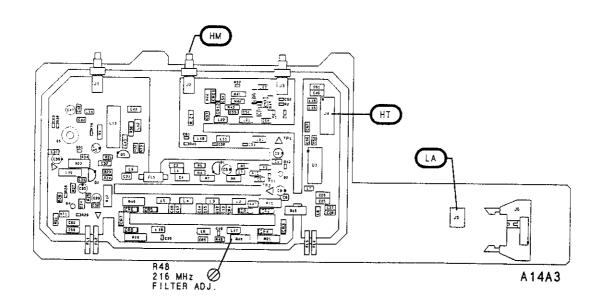


Figure 8Q-100 BD15 General Information.







# **CHANGES**

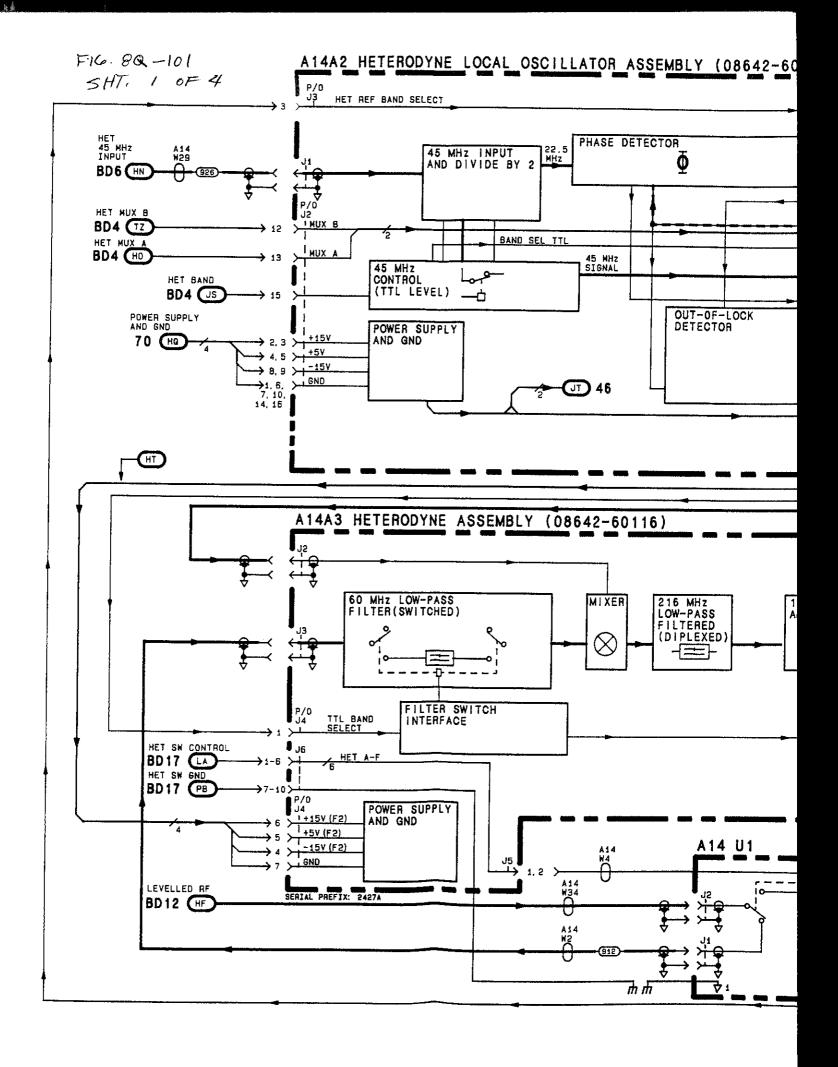
# 2509A and above 2526A and above 2.2 o a compression

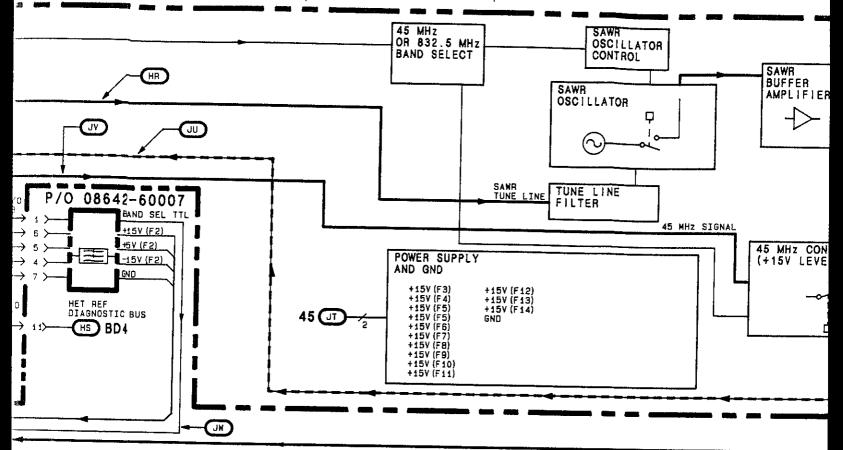
On the block diagram:

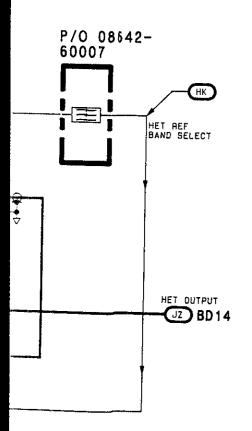
• A14A2 - In the upper left portion of the block diagram, change the A14A2 assembly number to 08642-60215.

On the block diagram:

• A14A2 - In the upper left portion of the block diagram, change the A14A2 assembly number to 08642-60315.







SAWR OSCILLATOR CONTROL
WR CILLATOR
CILLATOR
TEL LINE
LINE
LINE
LINE
LINE
SAWR BUFFER AMPLIFIERS

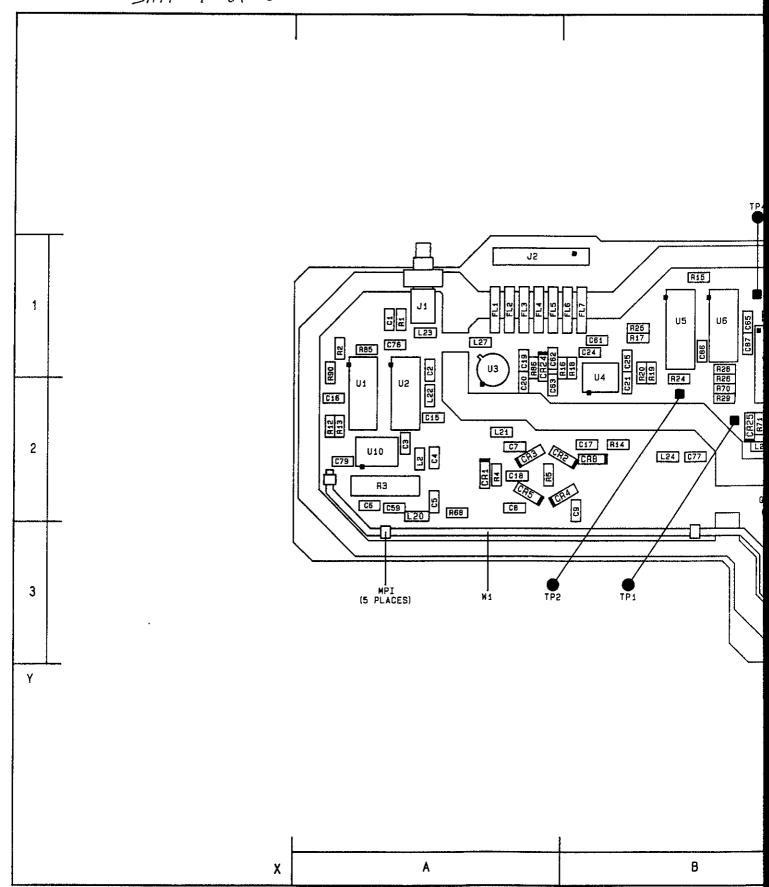
45 MHz CONTROL
(+15V LEVEL)

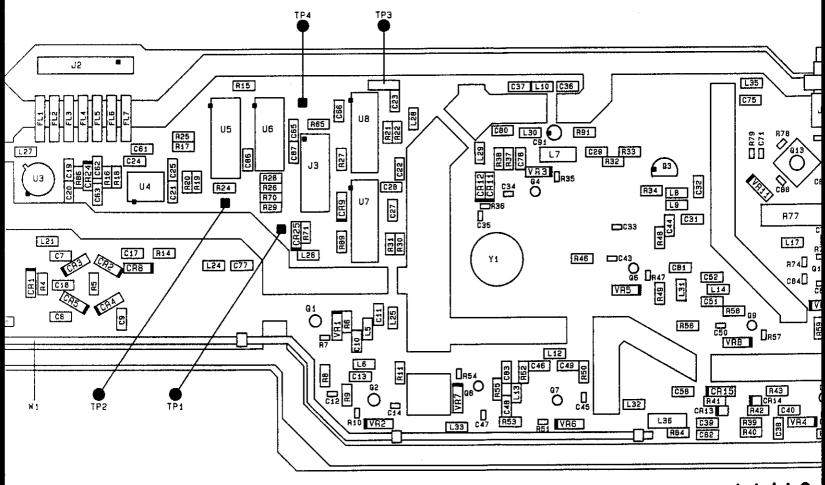
SAWR FEEDBACK AMPLIFIERS

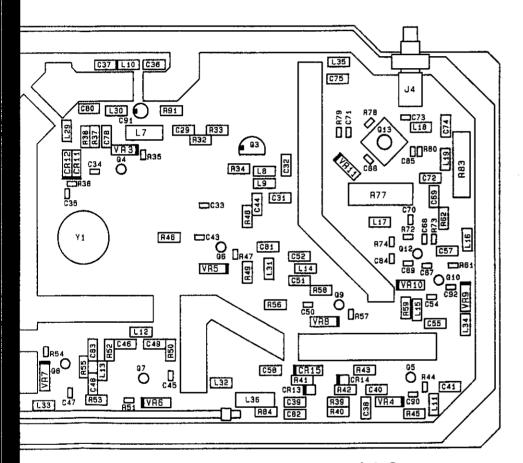
SAWR FEEDBACK AMPLIFIERS

SAWR FEEDBACK SAWR FEEDBACK AMPLIFIERS

SAWR FEEDBACK SAWR FEEDBACK AMPLIFIERS





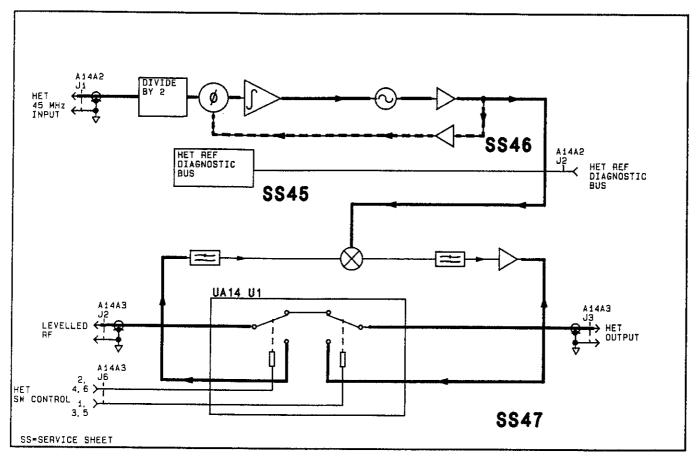


A14A2

С

£

FIG. 86-102 SHT. 4 675



Reference Block Diagram

# Component Coordinates

COMP	Χ,Υ	СОМР	X,Y	COMP	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
C23 CCCCCCCCCCCCCCCCCCCCCCCCCCCCCCCCCCC	21221111212112112112114	L23 L24 L26 L27 MP1 R1 R2	A.A.A.A.B.B.A.A.A.A.B.B.A.A.A.A.A.B.B.A.C.A.A.A.A	R5 R112 R114 R115 R116 R116 R116 R116 R116 R116 R116	A. 2 A. 2 B. 2 B. 1 B. 1 B. 1	V1 U2 U3 U4 U5 U6 U7 U8 V10	A. 2 A. 12 B.B. 1 B.B. 1 B.B. A. 3										•

A14 MODULE BD15

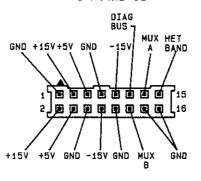
SEE REVERSE SIDE

Service

#### Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- Ai4FL1 is an array of feedthrough filters passing through the center of the module to make connections between two (2) printed circuit boards.
- 4. W3, W4 are printed circuit trace inductors.
- 5. Wi is a blue post jumper. In one position it connects points A and B for normal operation. When moved to the other position, it connects points B and C to ground the SAWR tune line.

## CABLE PLUG TO A14A2 J2



# **CHANGES**

#### All Serial Prefixes

## On the schematic:

• <u>U6</u> - In **OUT-OF-LOCK DETECTOR**, change U6D pin 4 to the inverting input and pin 5 to the non-inverting input.

## 2514A and above

# On the Component Locator:

• R92 - Add R92 between C15 and L21.

# In Component Coordinates:

• R92 - Add R92, A,2.

#### On the schematic:

• R92 - In PHASE DETECTOR, add a resistor from U3 pin 3 to ground. Designate it R92 and assign a value of 1M ohms.

# 2526A and above

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A STATE OF THE STATE OF THE

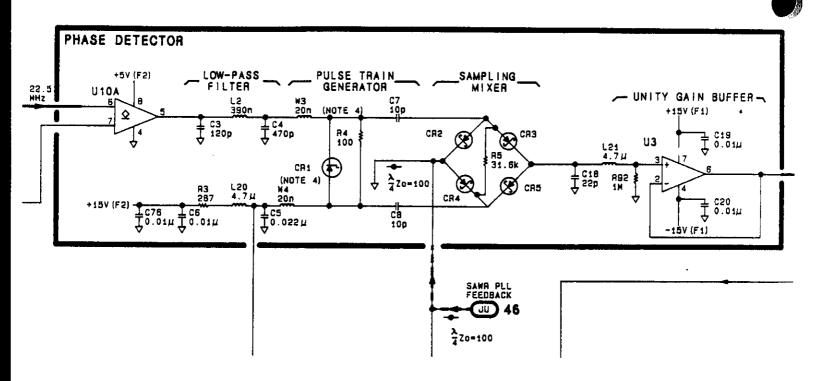
talah digawa di sebahai di digamban salah di

## On the Component Locator:

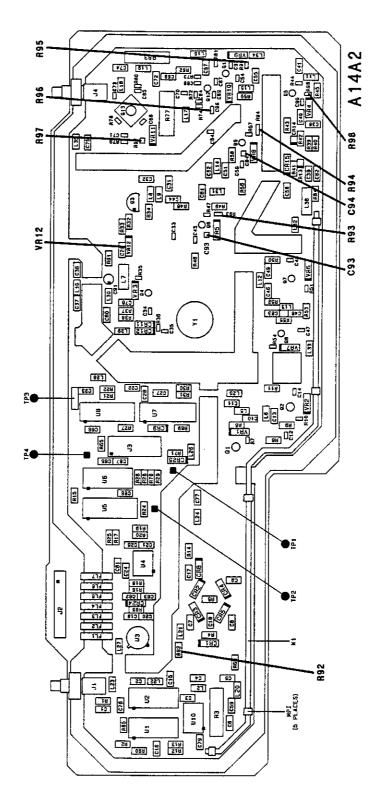
Note changes shown on 8Q-102.3

## On the schematic:

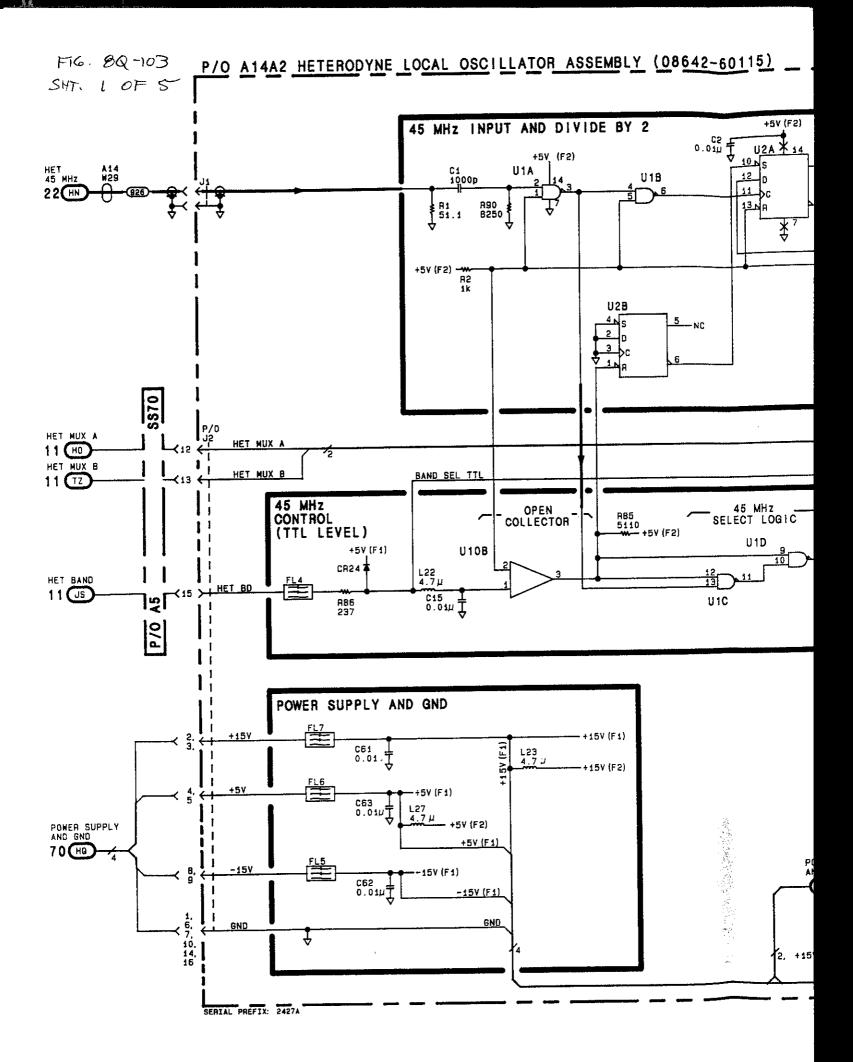
- In the upper left portion of the schematic, change the A14A2 part number to 08642-60315.
- R3 Replace the appropriate portion of the schematic with the partial on page 8Q-102.2

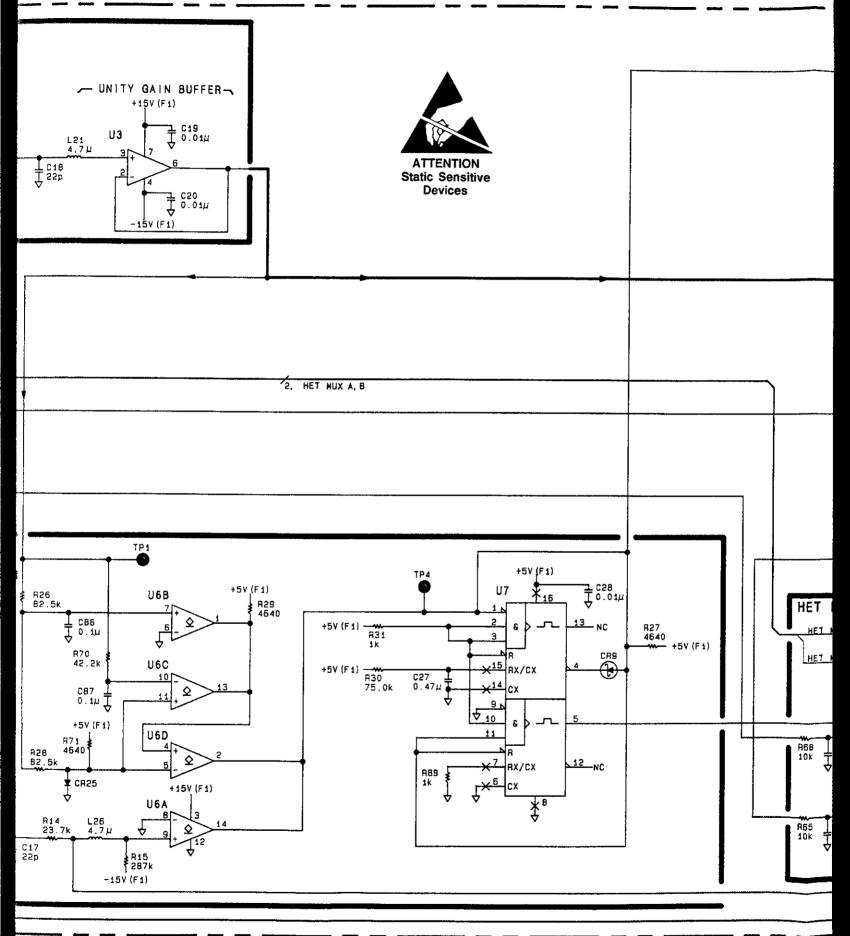


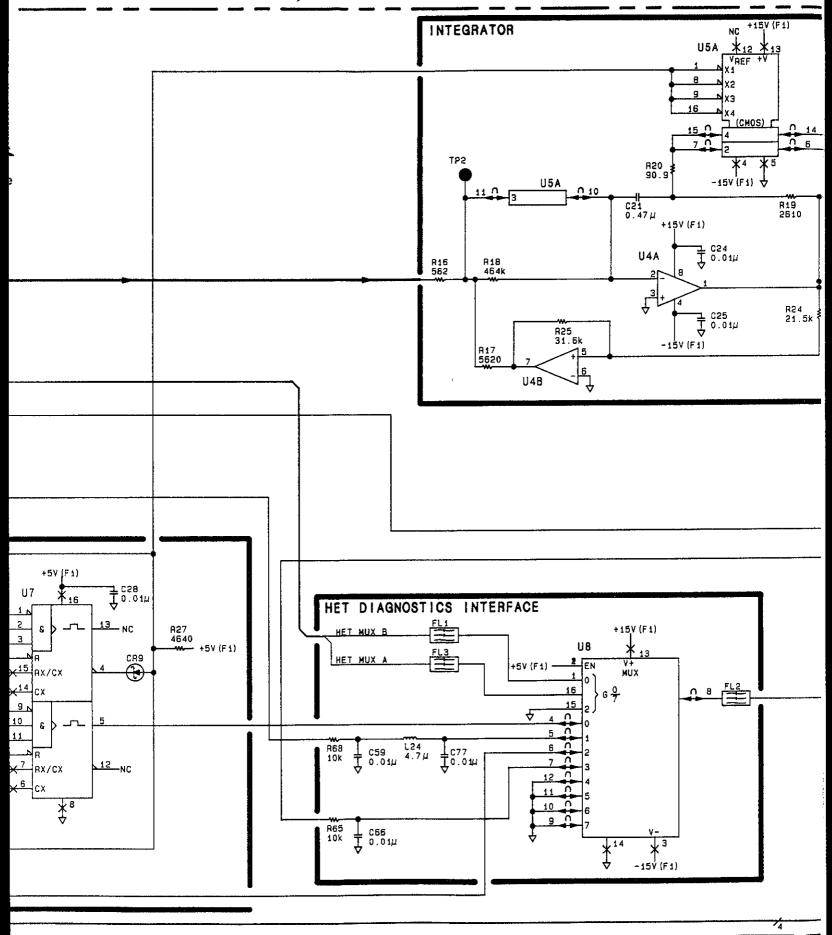
P/O FIGURE 8Q-103 (2526A and above)

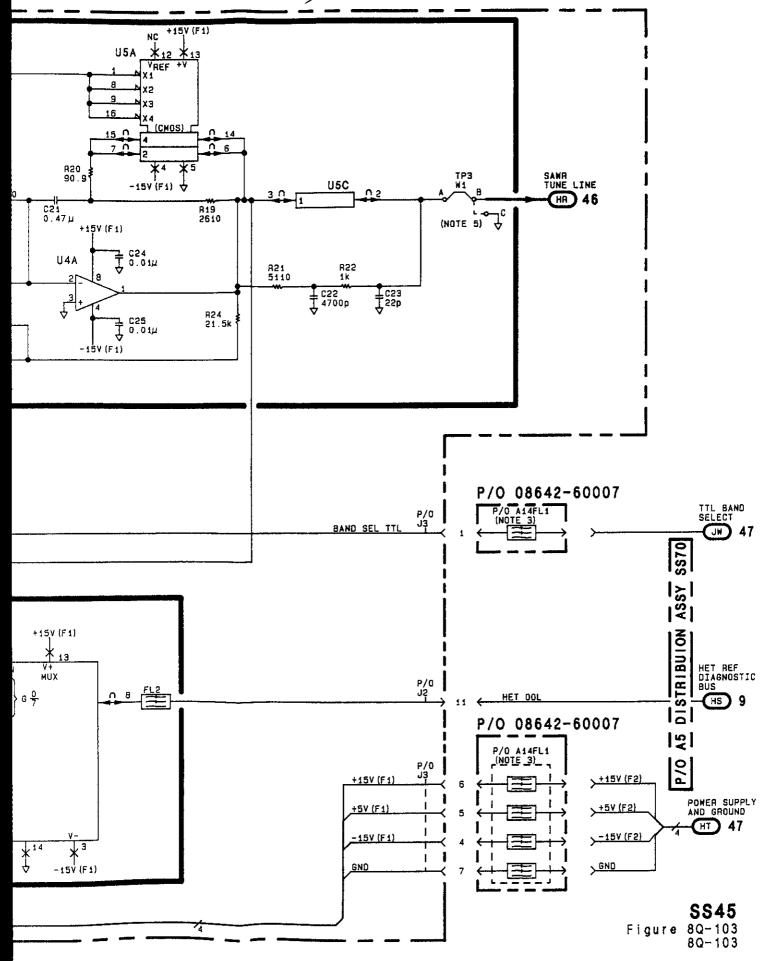


CHANGES TO FIGURE 8Q-102 (2526A and above)









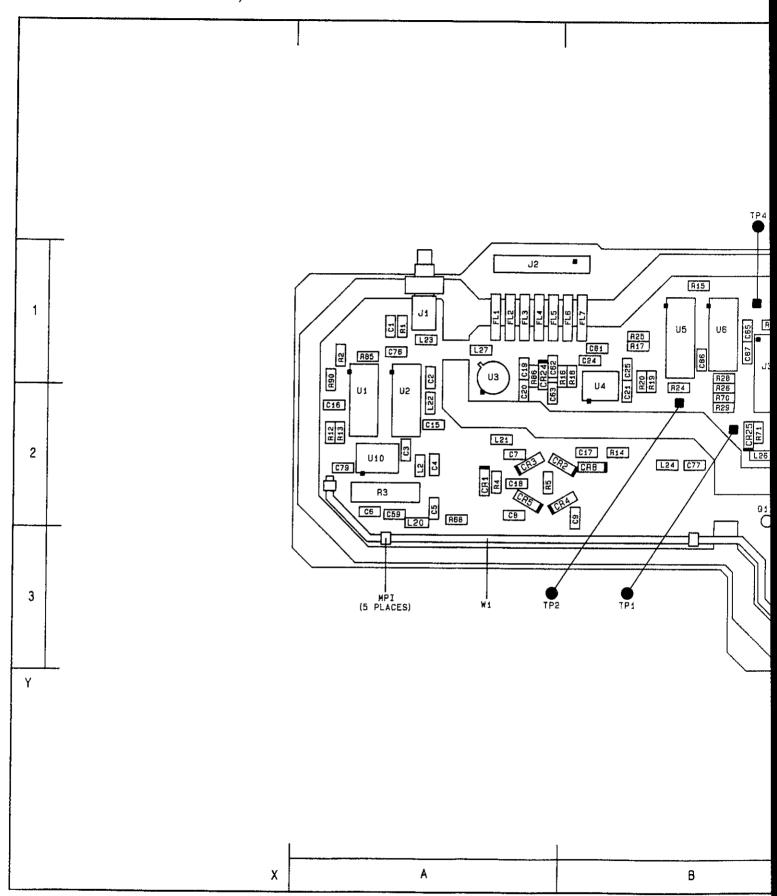
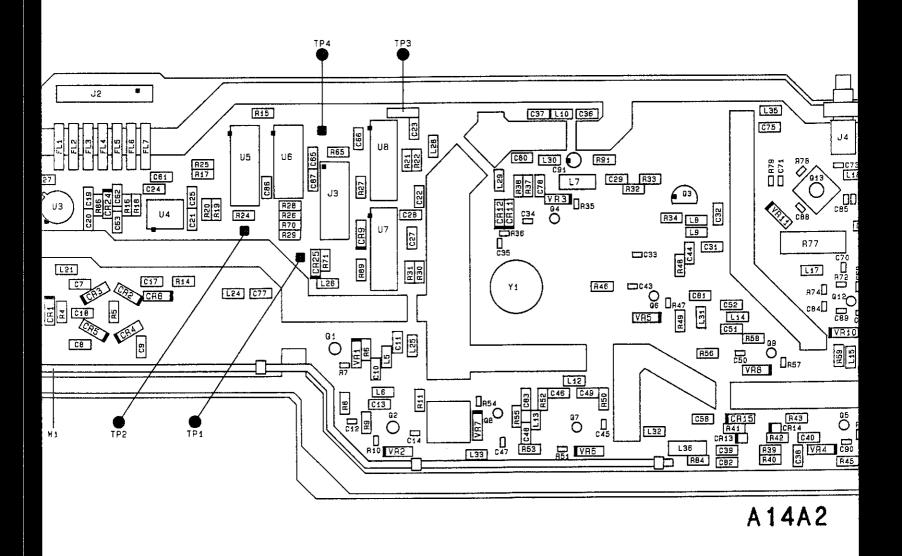


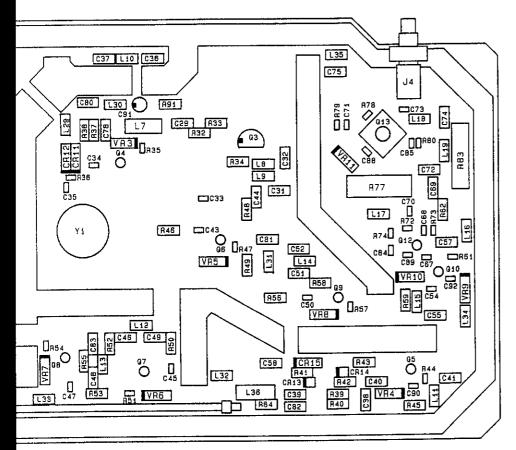
Figure 8Q-104. SERVICE SHEET 46 INFORMATION



Component Locator

С

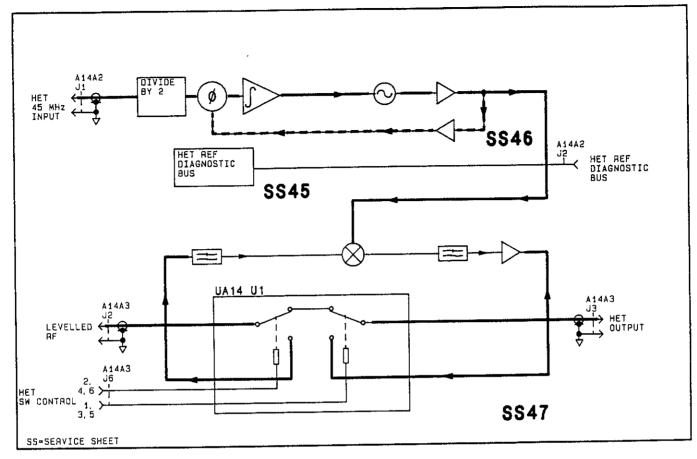
D



A14A2

D

С



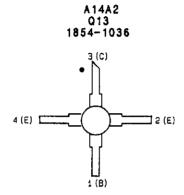
Reference Block Diagram

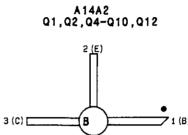
# Component Coordinates

P/O HETERODYNE LOCAL ASSEMBLY SS 45

## Notes:

- Each module in the HP 8642 has a nine digit module indentification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- 3. W4 and W5 are printed circuit trace inductors.
- 4. W2 is semi rigid coax cable.





# **CHANGES**

## All Serial Prefixes Z427A to 2507A 2509A and above 2526A and above Cycles Charles College College College

On the schematic:

• <u>C43, R46</u> - In SAWR BUFFER AMPLIFIER, move C43 to the right of R46.

On the schematic:

• C93 - In SAWR OSCILLATOR, change C93 to 3.9p.

On the schematic:

- C93, W3 In SAWR OSCILLATOR, remove C93 and W3.
- In the top left portion of the schematic, change the assembly number to 08642-60215. In the bottom left portion of the schematic, change the serial prefix to 2509A.

On the Component Locator:

 C93, C94, R93, R94, R95, R96, R97, R98 - Note changes to Component Locator shown on page 8Q-104.3

In Component Coordinates:

C93, C94, R93, R94, R95, R96, R97 - Add the following components and coordinates to the Component Coordinates table:

C93 C,2

C94 D,3

R93 C,2

R95 D.3

R96 D,2

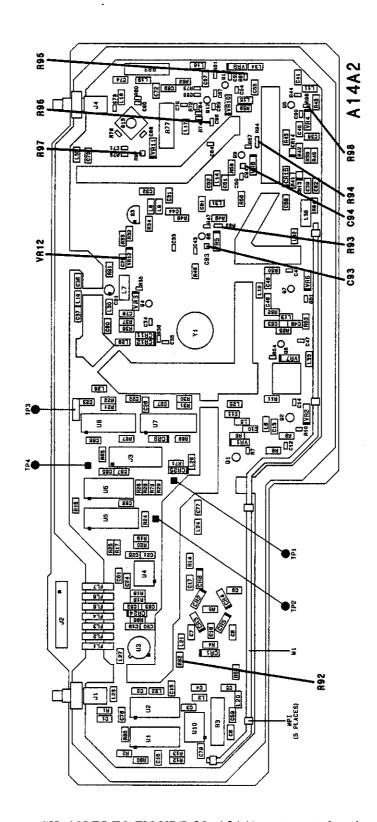
R97 C,1

On the schematic:

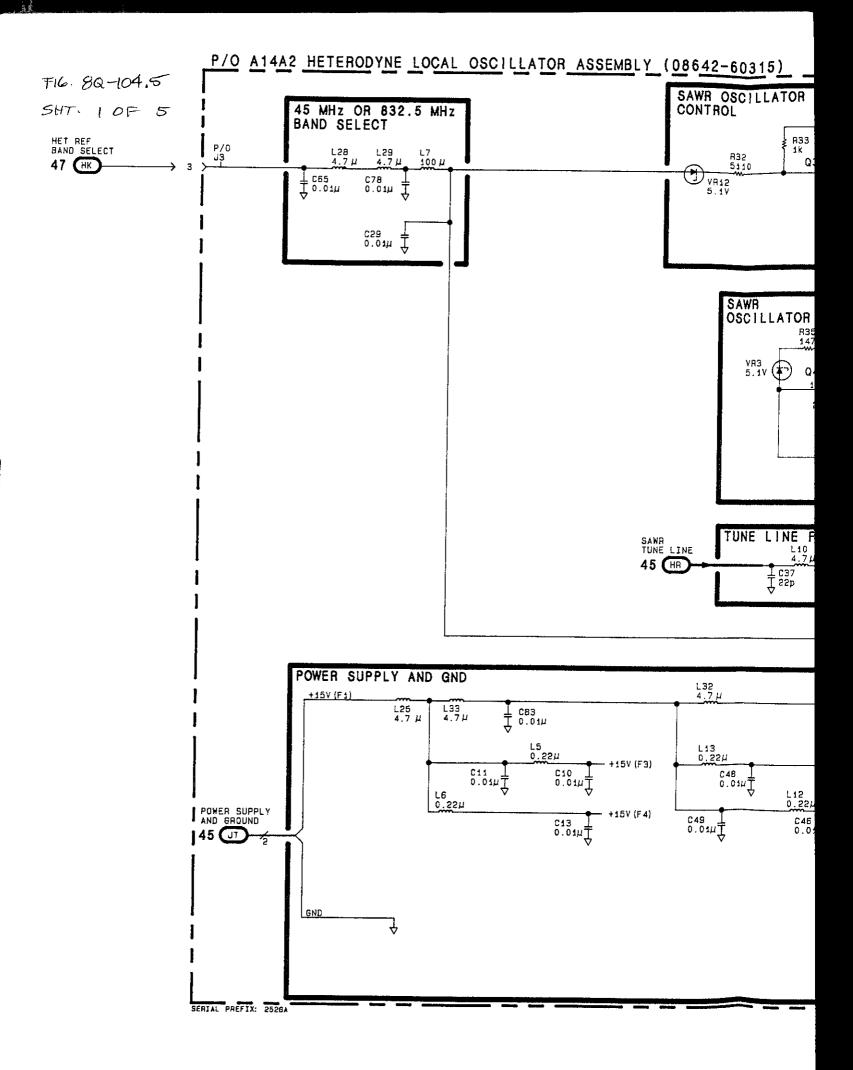
C89, C90, C93, C94, R32, R93, R94, R95, R96, R97, R98 Replace SS46 with the foldout on page 8Q-104.5

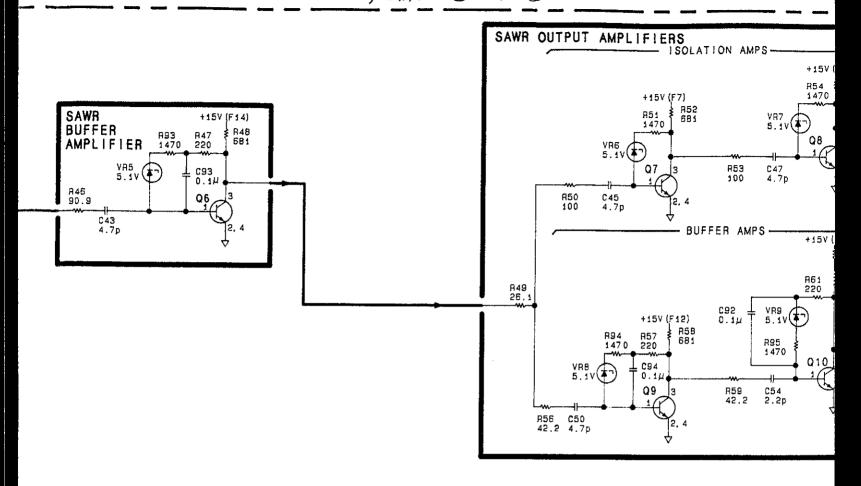
On the foldout (page 8Q-104.5):

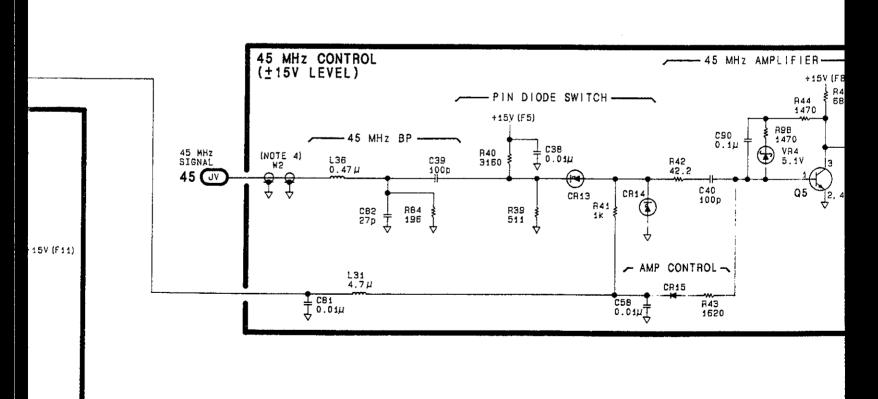
- <u>L16</u> In SAWR OUTPUT AMPLIFIERS, under BUFFER AMPS, replace L16 with a circuit trace. On the circuit board this is a wire jumper.
- R44 In 45 MHz CONTROL (+15V LEVEL), under 45 MHz AMPLIFIER, change the value of R44 from 1470 to 215 ohms.

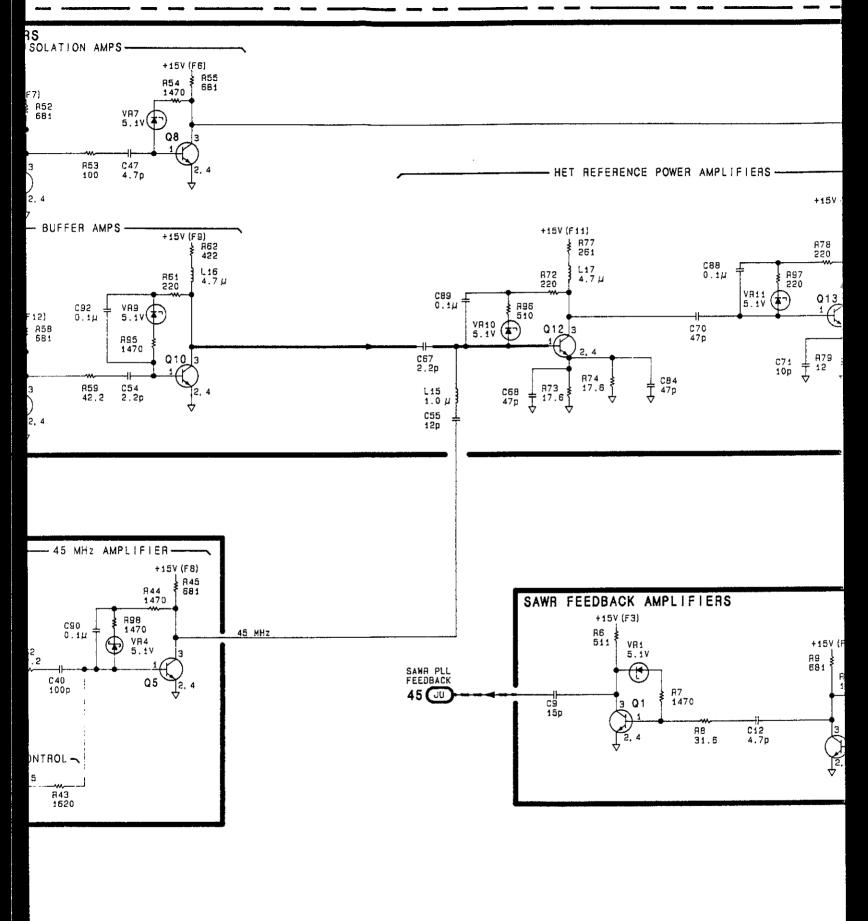


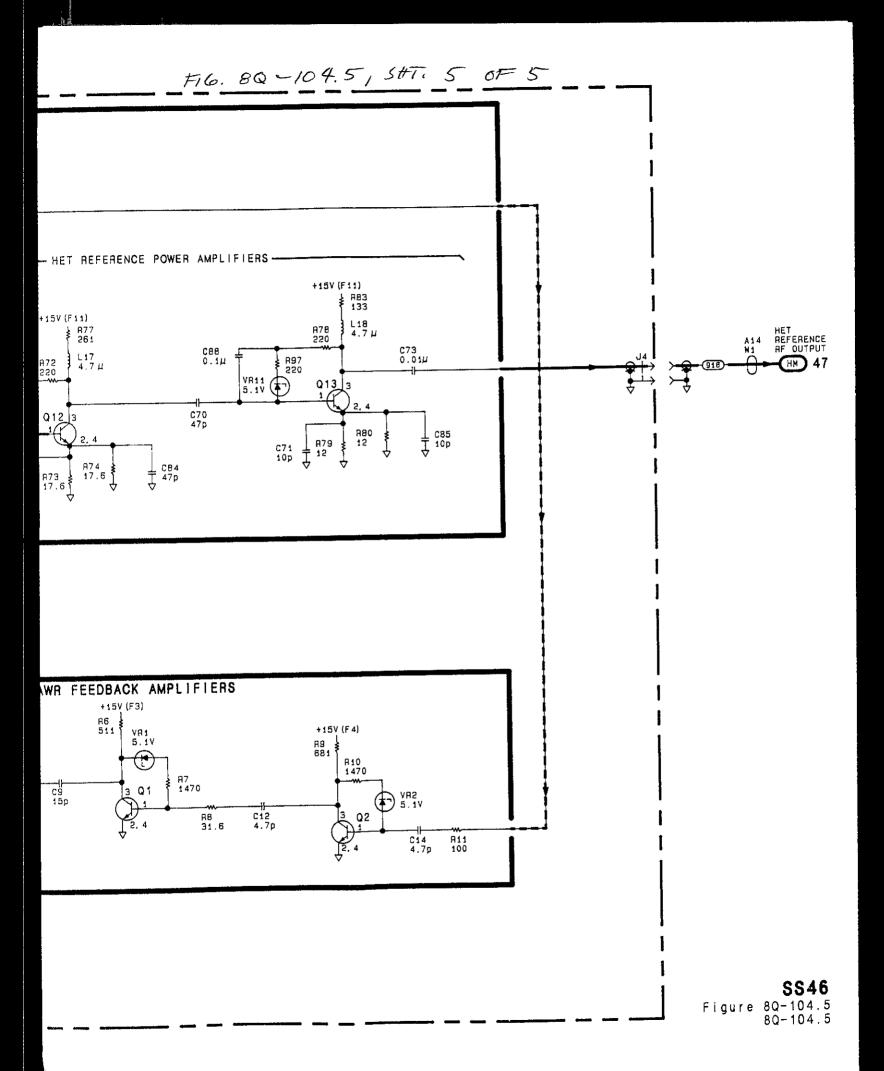
CHANGES TO FIGURE 8Q-104 (2J26A and above)

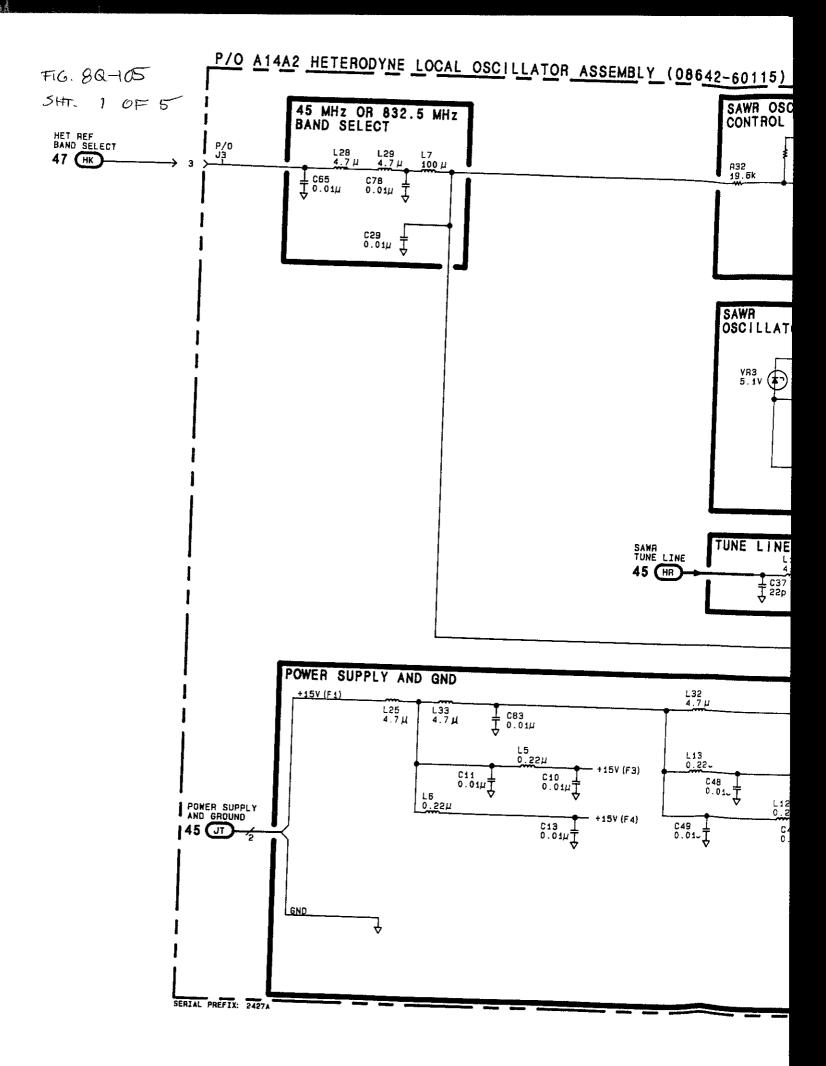


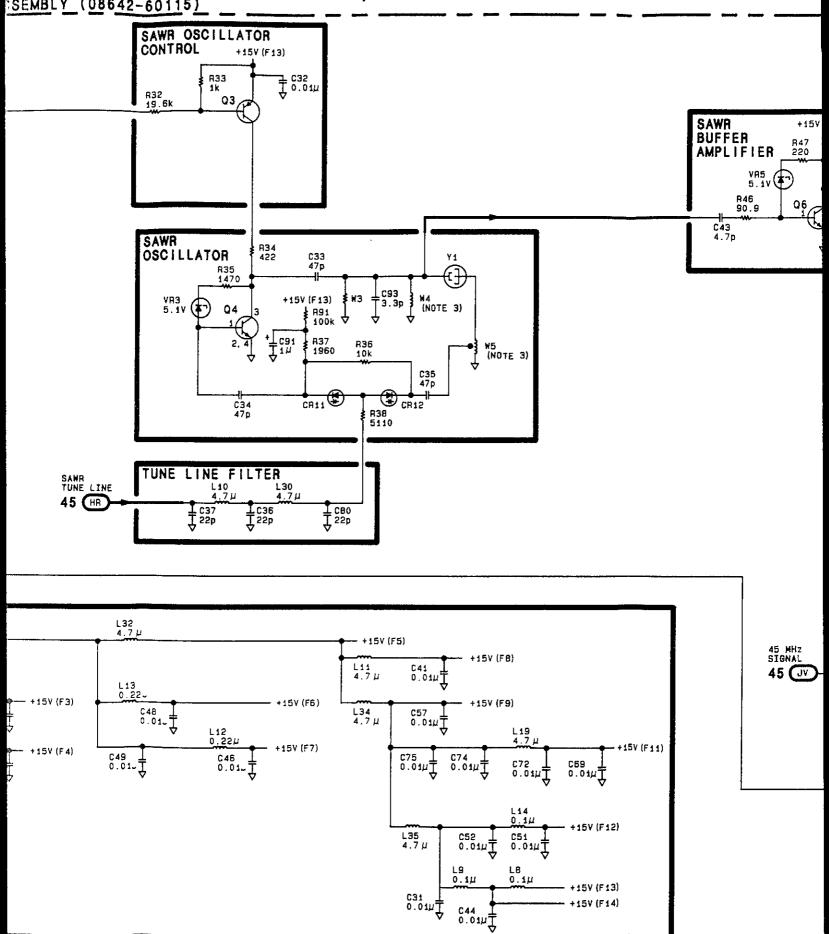


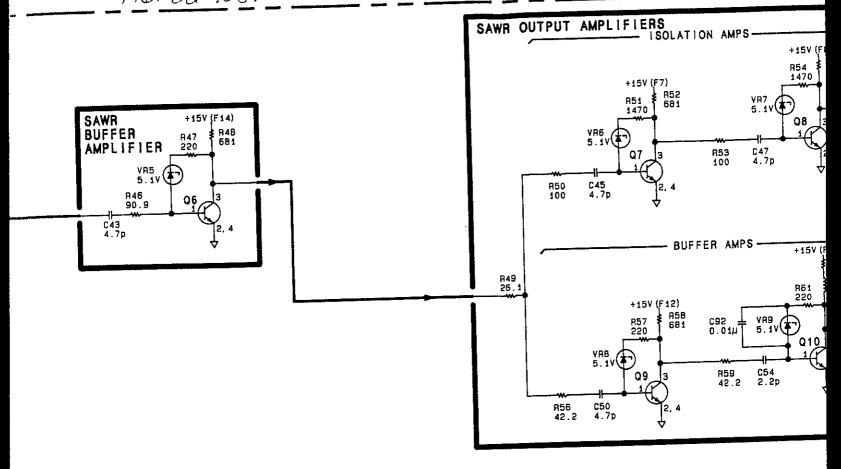


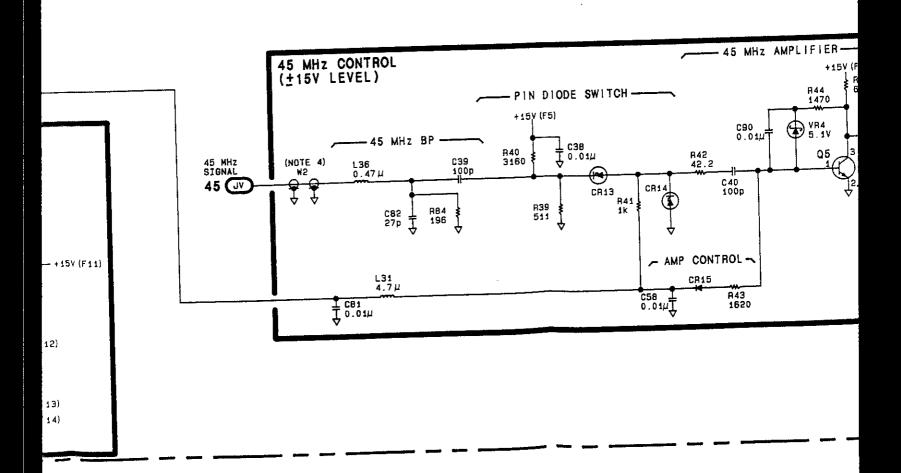


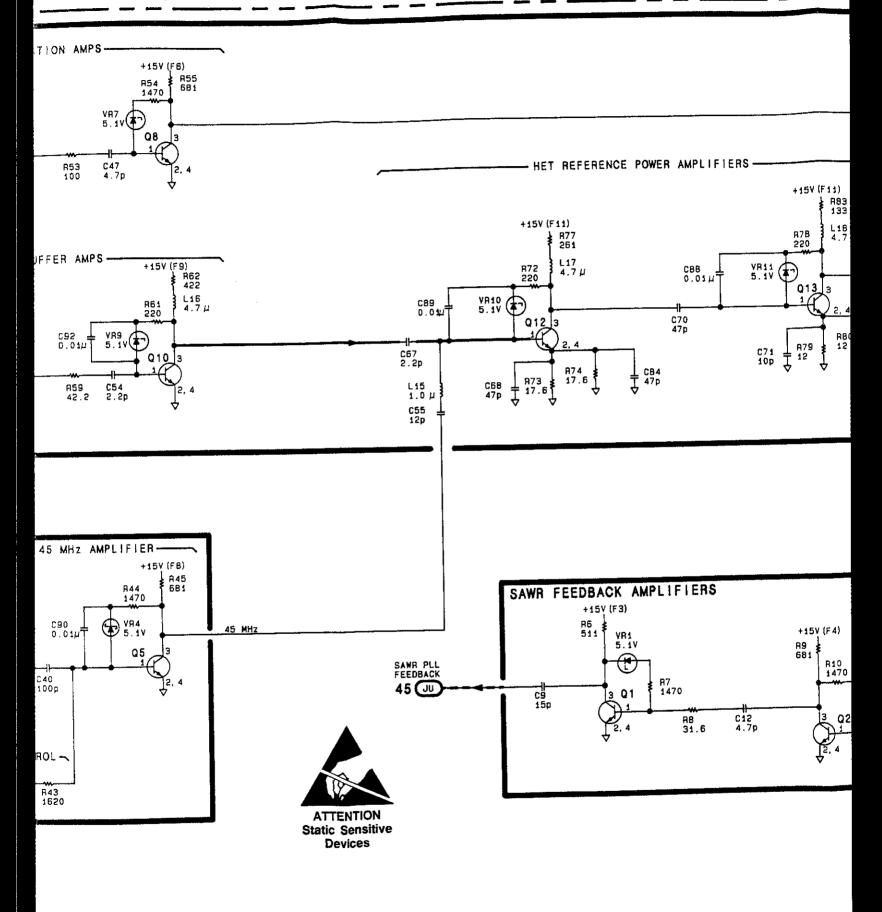












**SS46**Figure 8Q-105
8Q-105

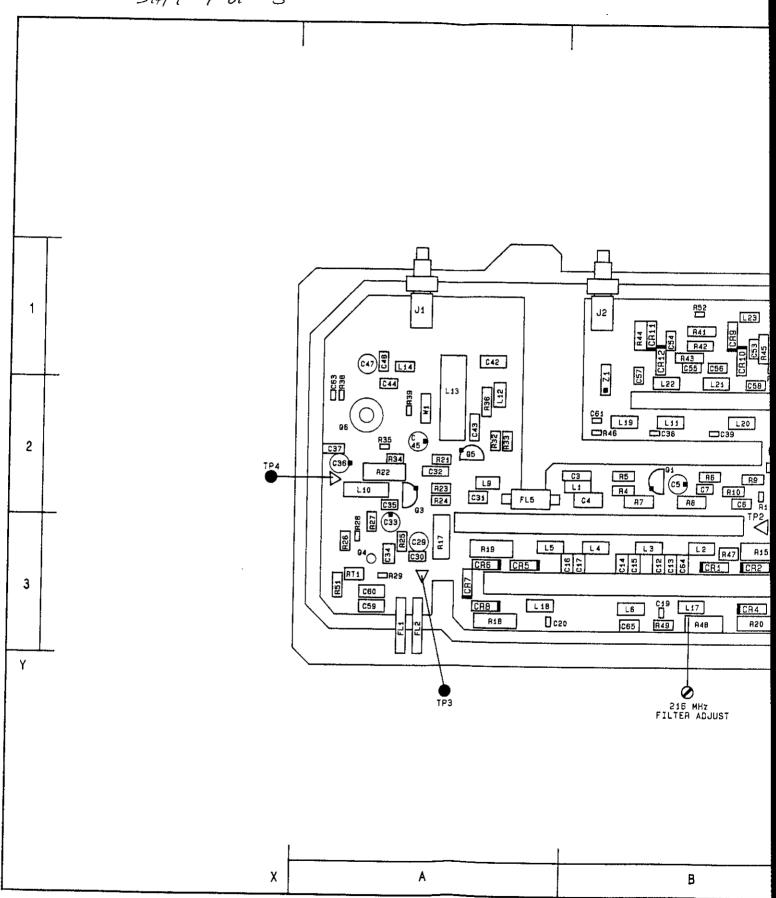
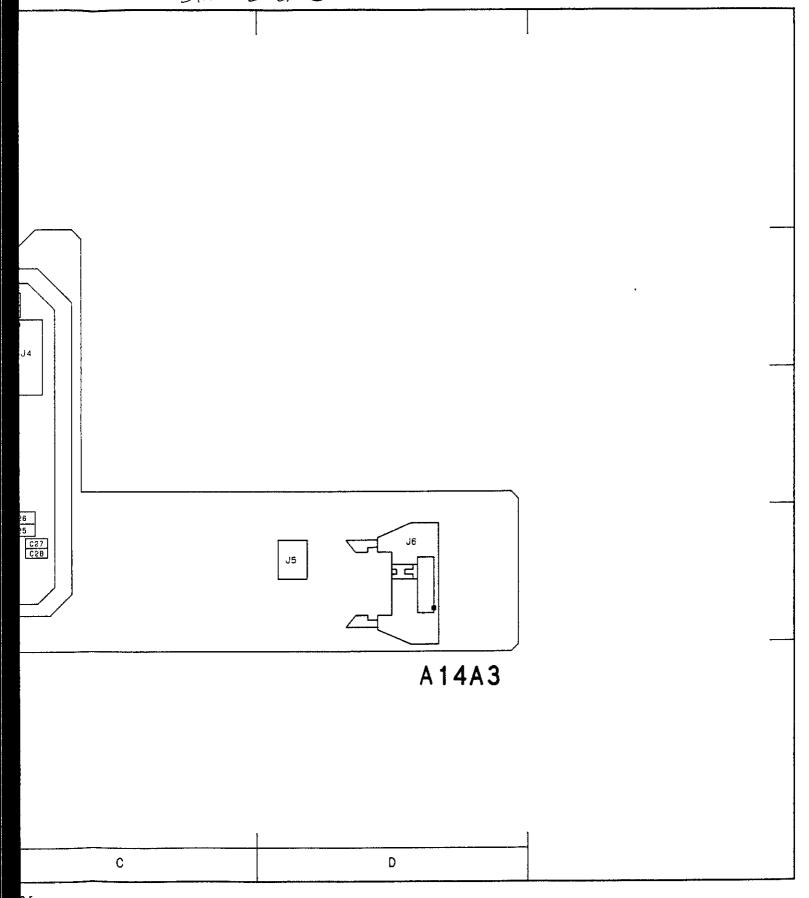


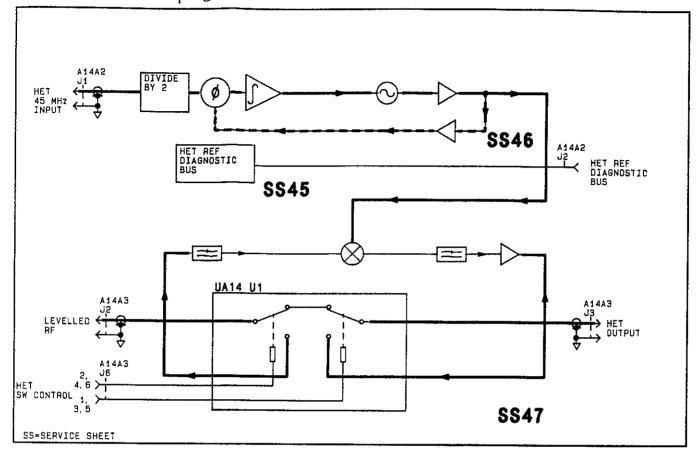
Figure 8Q-106. SERVICE SHEET 47 INFORMATION

В

C

D





Reference Block Diagram

# Component Coordinates

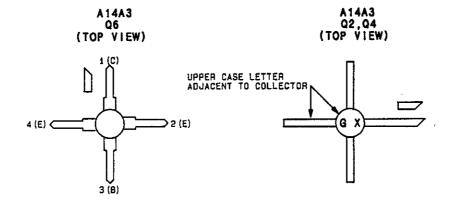
COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y	COMP X,Y
8.2 2 2 2 2 2 2 3 2 3 3 3 3 3 3 3 3 3 3 3	A.C.C.C.C.B.B.B.1113322223331 333333331111 48901234556789012348.B.B.B.B.A.A.B.B.B.B.B.B.B.B.B.B.B.B.B.	A.3332 111133 23333332222211113322111 A.A.C.C.A. A.B.C.C.D. B.B.B.A.B.C.C.A.A.C.C.B.A.B.B.B.B.B.B.B.	01 03 04 04 05 06 05 06 07 08 08 08 08 08 08 08 08 08 08	R36 A. 2 R36 A. 2 R37 B. 11 B. 11 B. 11 B. 12 B. 13 B. 3 B. 3 B. 3 B. 2 R51 A. 3 R51 A. 3 R51 A. 3 R51 A. 3 R71 B. 2 R51 B. 3 R51				

P/O HETERODYNE LOCAL OSCILLATOR ASSEMBLY

**SS46** 

## Notes:

- Each module in the HP 8642 has a nine digit module indentification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- A14FL1 is an array of feedthrough filters passing through the center of the module to make connections between two (2) printed circuit boards.
- 4. Het switch circuit common ( $\stackrel{1}{\nabla}$ i on Ai4Ui) is connected to J6 pins 7-10 through chassis parts. These lines are a ground for the het switch (Ai4Ui) coming from the Ai7 module.



CABLE PLUG TO A14A3 J6 HET HET HET A C E GND

1 D D D D D D 10

## CHANGES

## All Serial Prefixes :

On the Component Locator:

A14A3R53 - Immediately to the left of J1, add R53.

In Component Coordinates:

A14A3R53 - Add R53 (A,1)

In Schematic General Information:

- A14A3Q6 Switch "(C)" and "(B)".
- A14A3Q2, Q4 Beginning at the symbol for the angled lead, number the leads clockwise 1, 2, 3, 4.

On the schemetic:

- A14A3R52 In 60 MHz LOW PASS FILTER (SWITCHED), change the value of R 52 to 26.1
- A14A3R53 In HET POWER AMP, immediately to the right of the parallel combination of C47 and C48, add a resistor to ground. Assign it R53, 10K ohms.
- W34, W35, W36 A14 U1 cables with reference designators A14W34, A14W35, and A14W36 should have the A14 deleted. On the lower right portion of the schematic, change "HET OUTPUT" service sheet numbers to 50 (8642B), and 48 (8642A).
- ◆ A14A3R52 Add an asterisk (\*) to R52 located in the upper right portion of 60MHz LOW PASS FILTER (SWITCHED) to indicate a factory selected component.

2531A and above The second of the

 On the schematic:

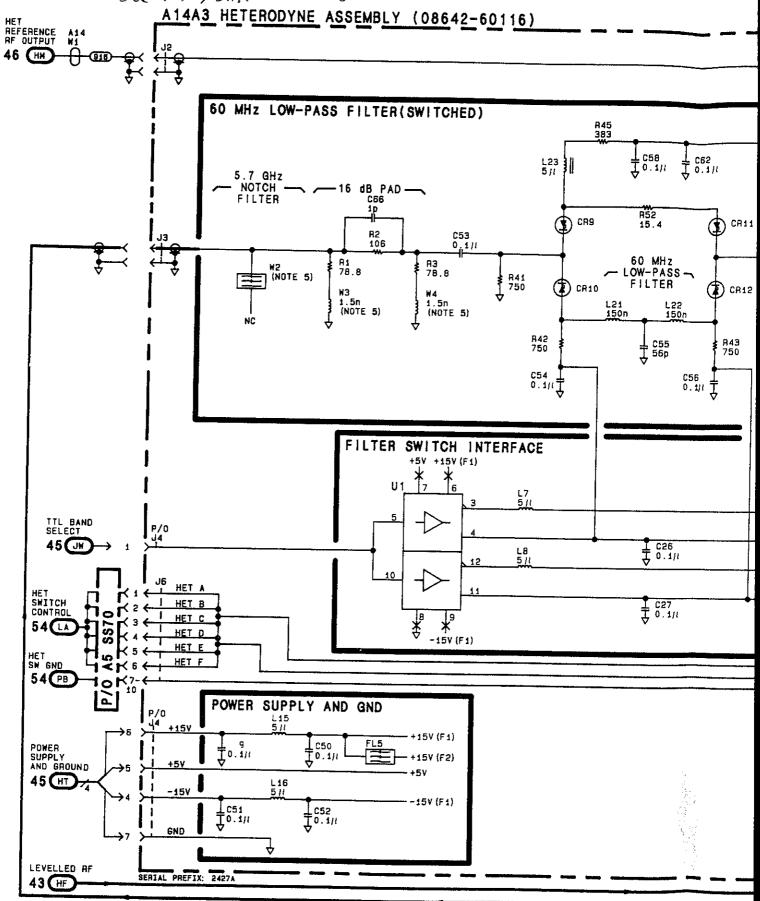
• R47, R48, R49, R52 - In 60MHz LOW-PASS FILTER (SWITCHED), change the value of R52 to 14.7 ohms. In 6.8 MHz/216 MHz LOW-PASS FILTER, change the following components to their corresponding values:

R47, 196 ohms

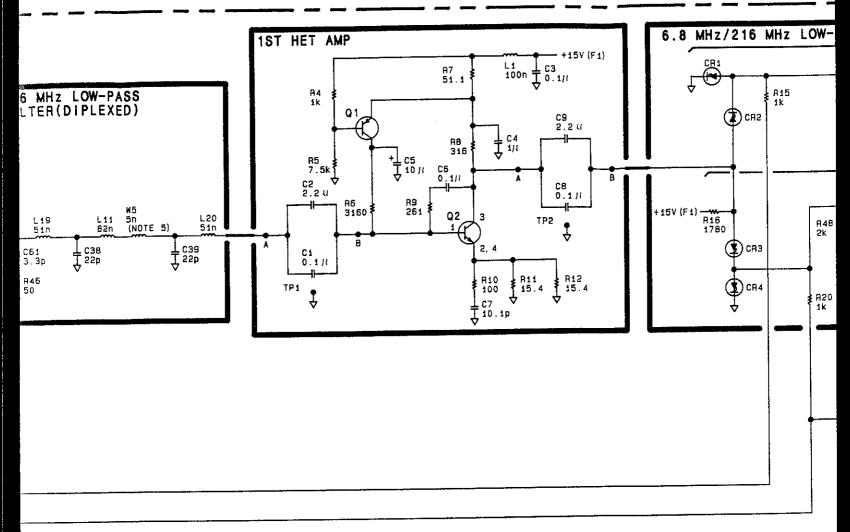
R48, 500 ohms

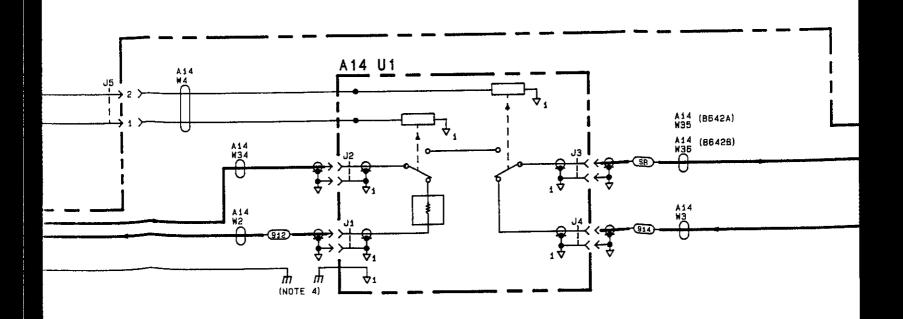
R49, 75 ohms

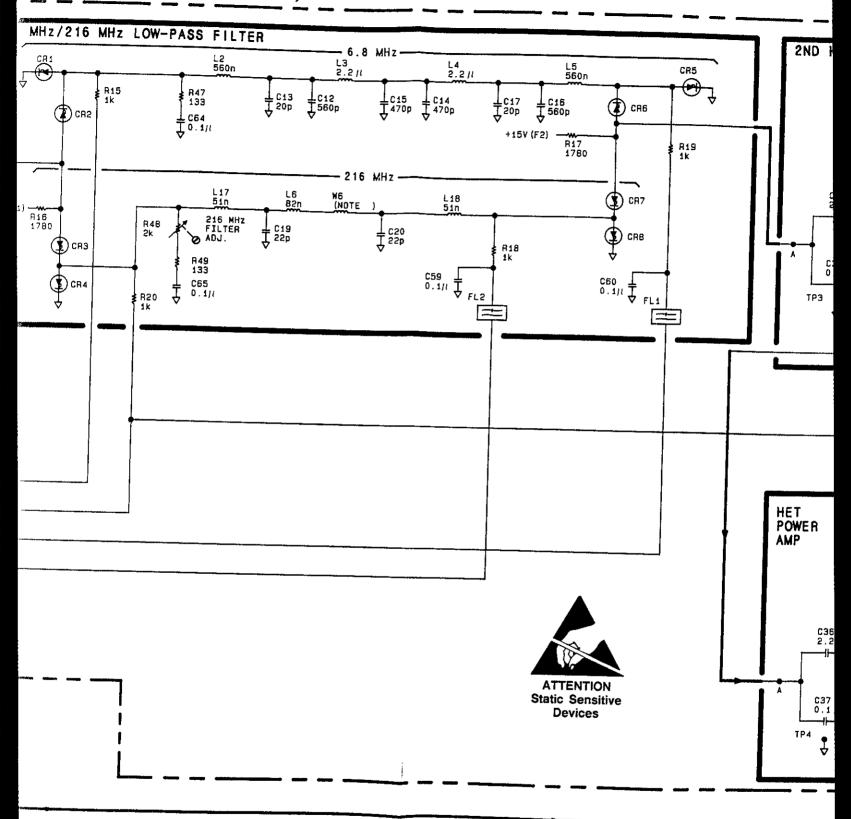
Street, and

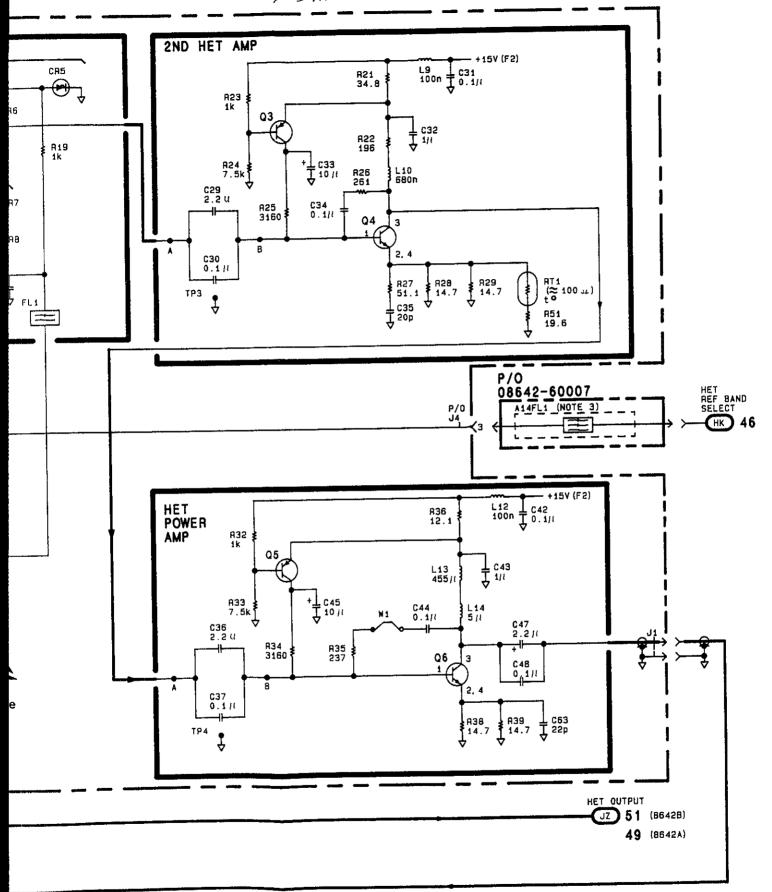


nt (NOTE









**SS47** oure 80-101

Figure 8Q-107 8Q-107 All Attenuator Module (8642A)

# **CHANGES**

#### All Serial Prefixes

· P. Merskers, var 1795 c · Property & Merskers (Merskers) · Property & Merskers (Merskers) 

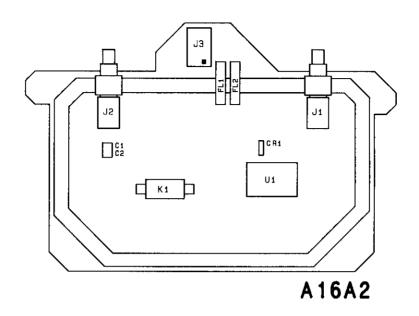
in the second of the second of

# On the component locator:

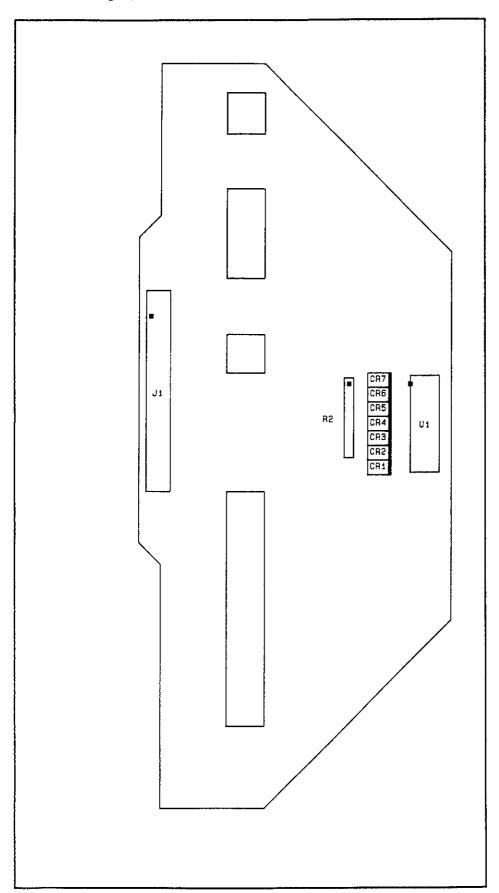
• Delete the entire component locator and replace with the component locator on page 8R-100.3.

## On the schematic:

Mark the schematic "For Option 003 Only".



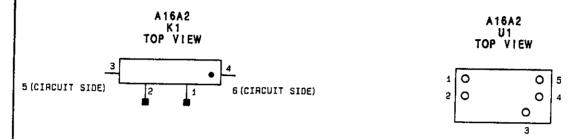
A16A2 COMPONENT LOCATOR (P/O Errata)



Component Locator

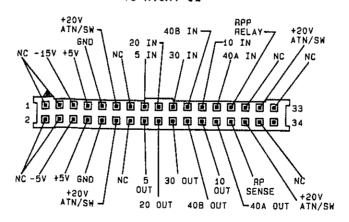
#### Notes:

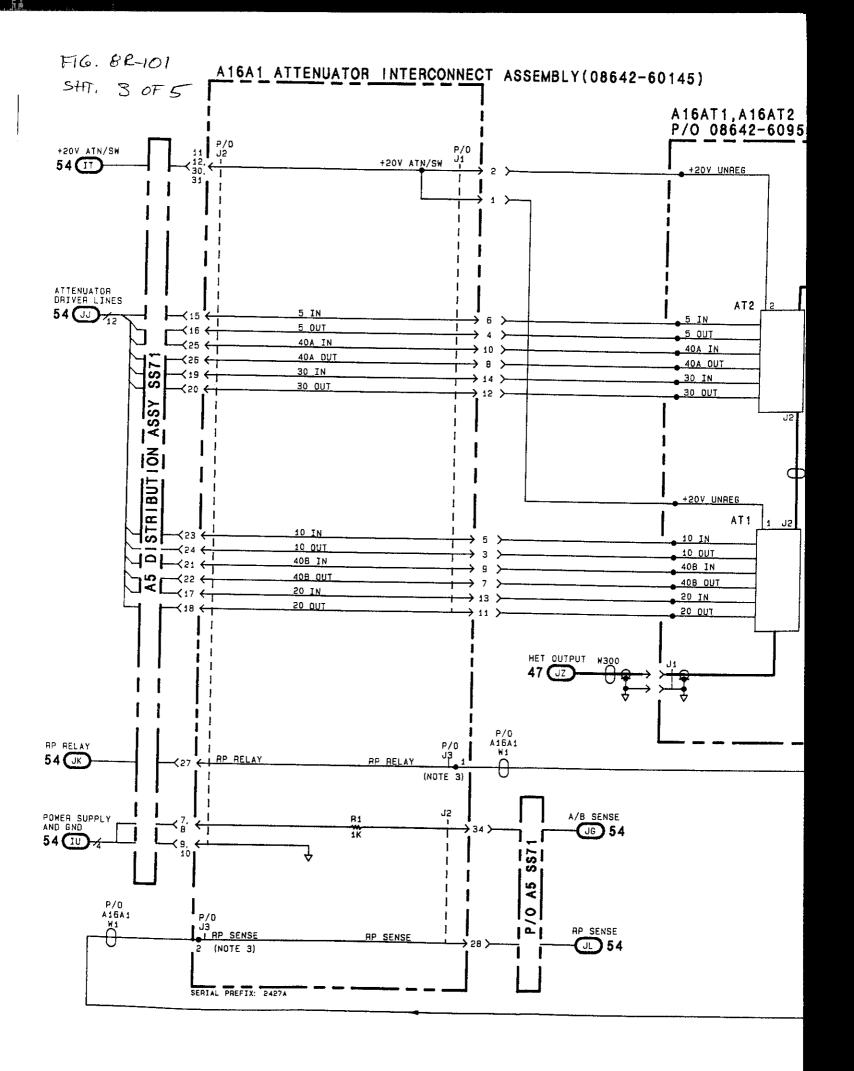
- Each module in the HP 8542 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- 3. A16A1 Wi consists of two wires and connector soldered to two pads A16A1. (J3 pins 1, 2)

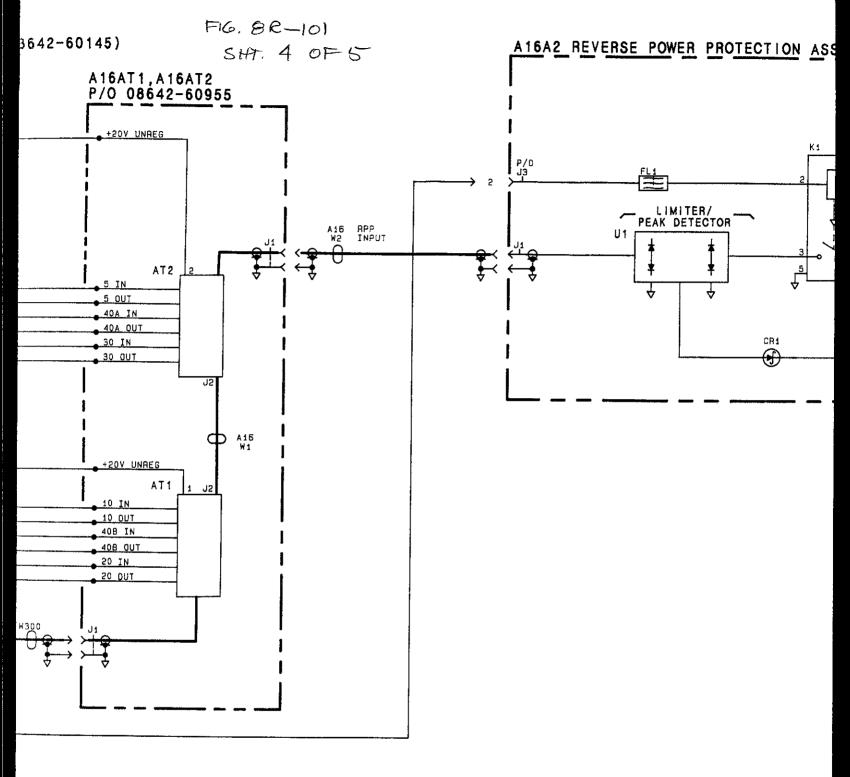




CABLE PLUG TO A16A1 J2

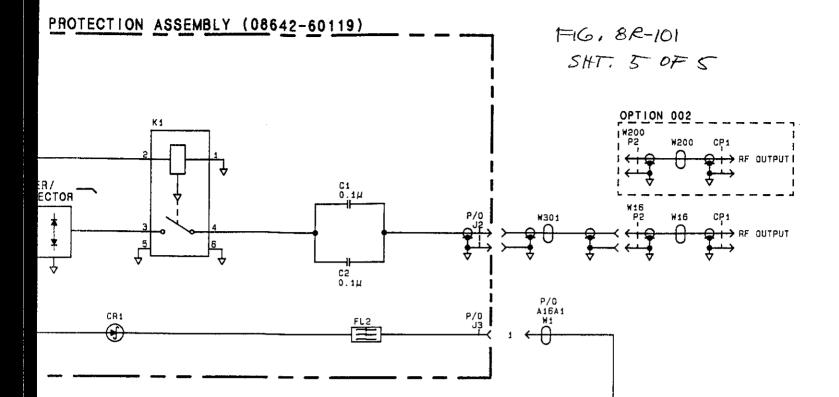






SENSE D 54

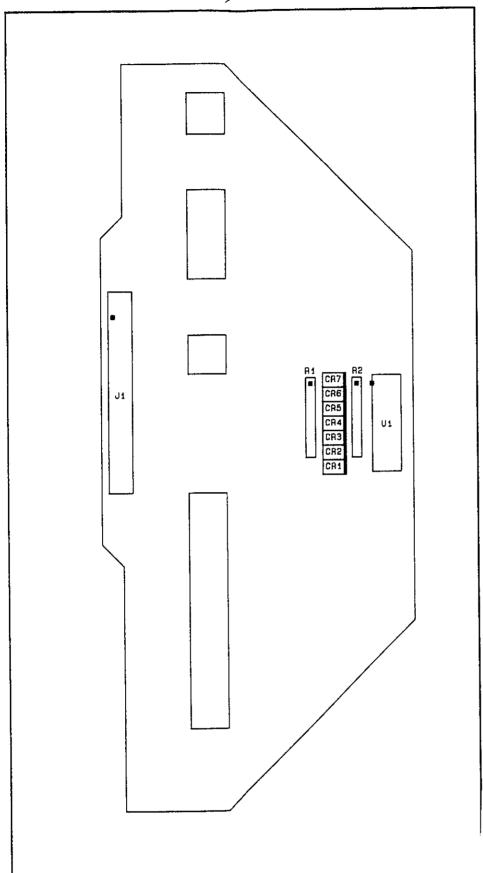
54





**SS48** 

Figure 8R-101 8R-101

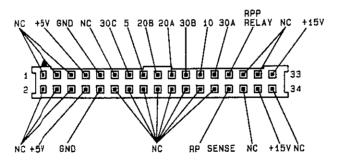


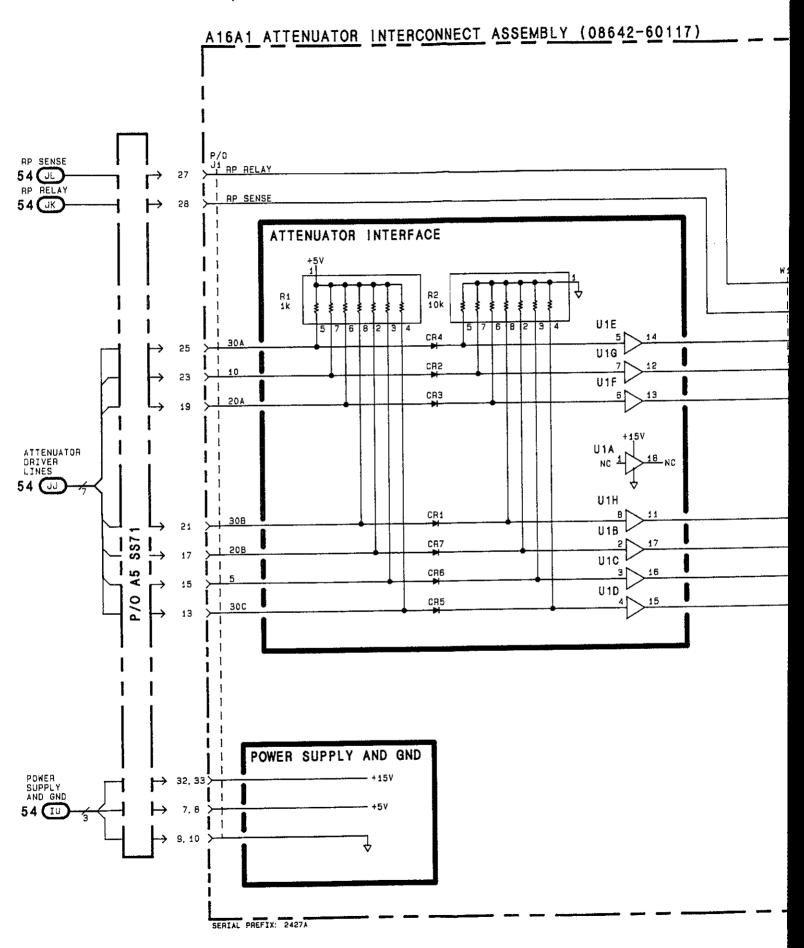
Component Locator

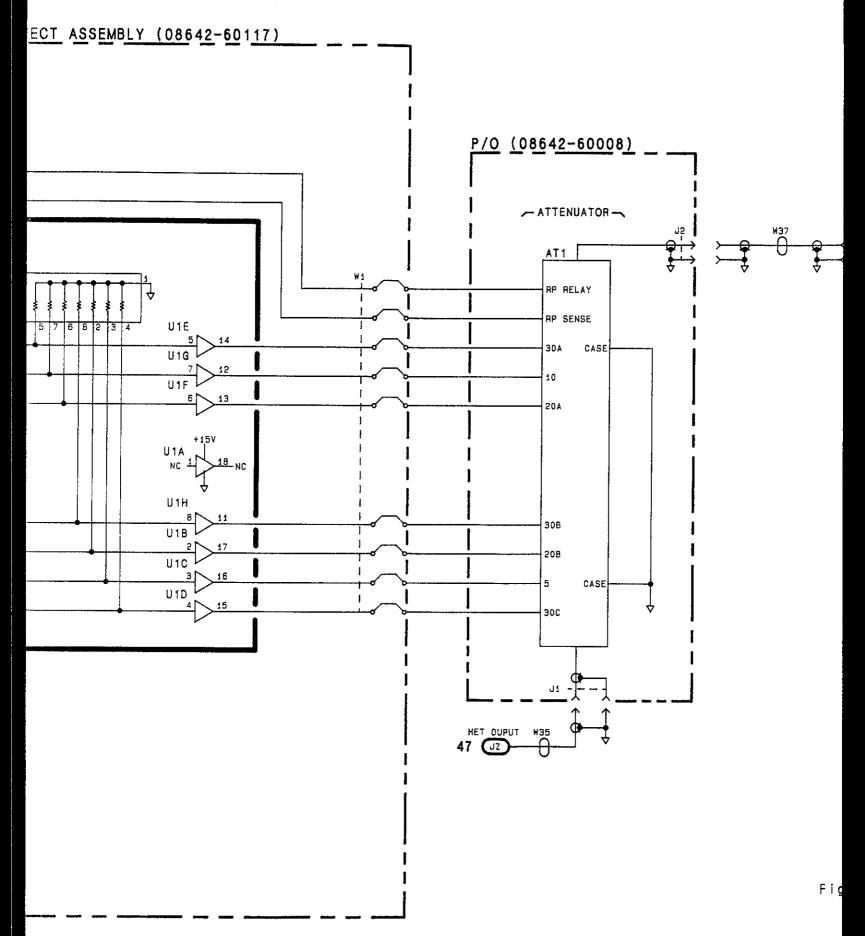
### Notes:

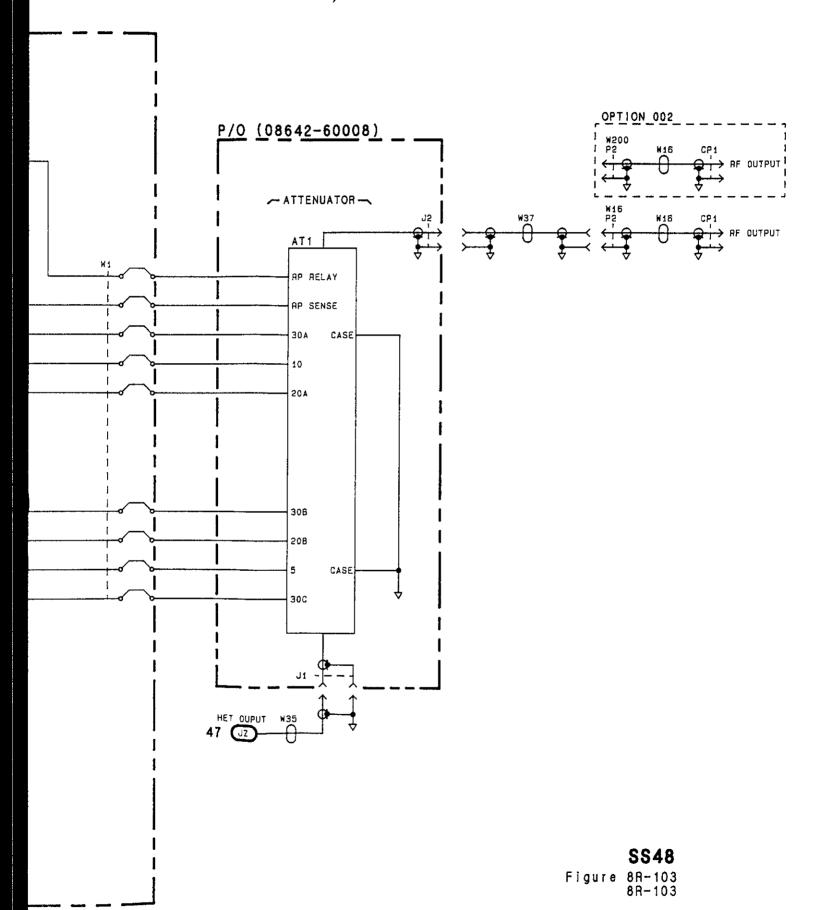
- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

### CABLE PLUG TO A16A1 J1

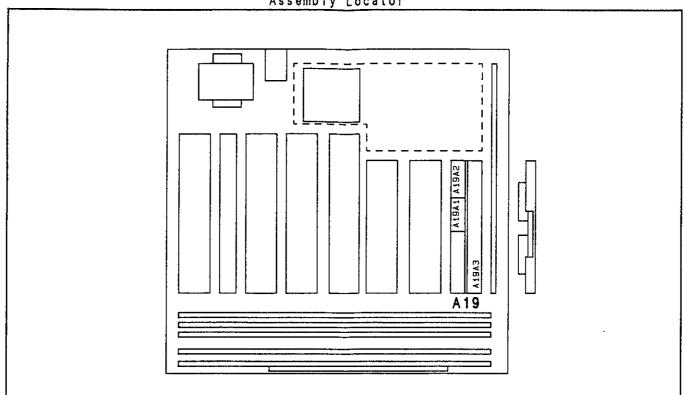








# A19 Doubler/Altenuator Module (8642B)



Simplified Block Diagram

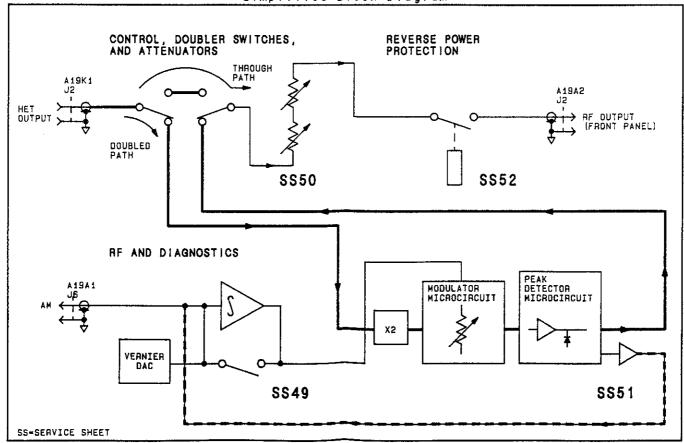
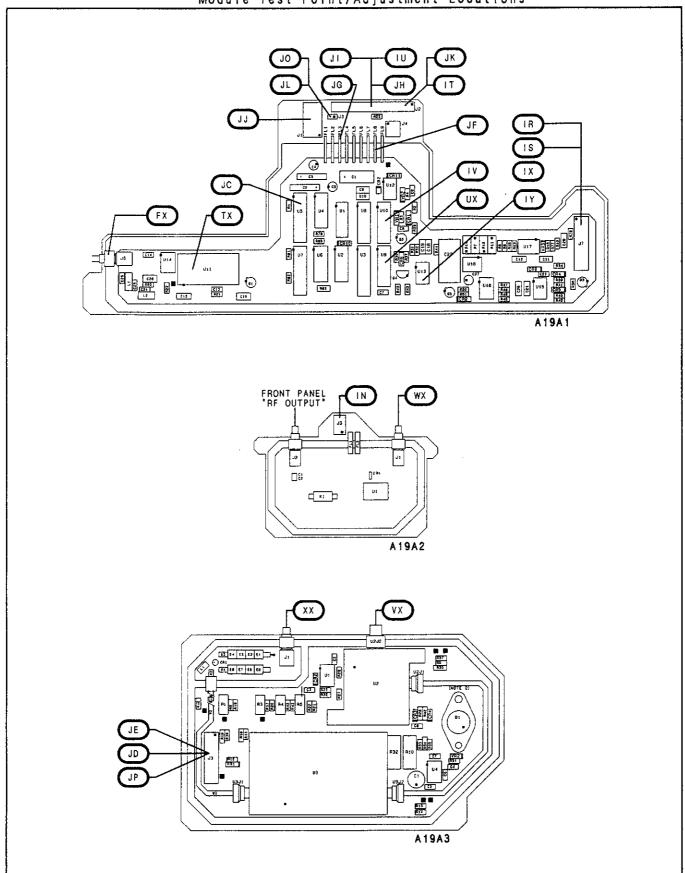
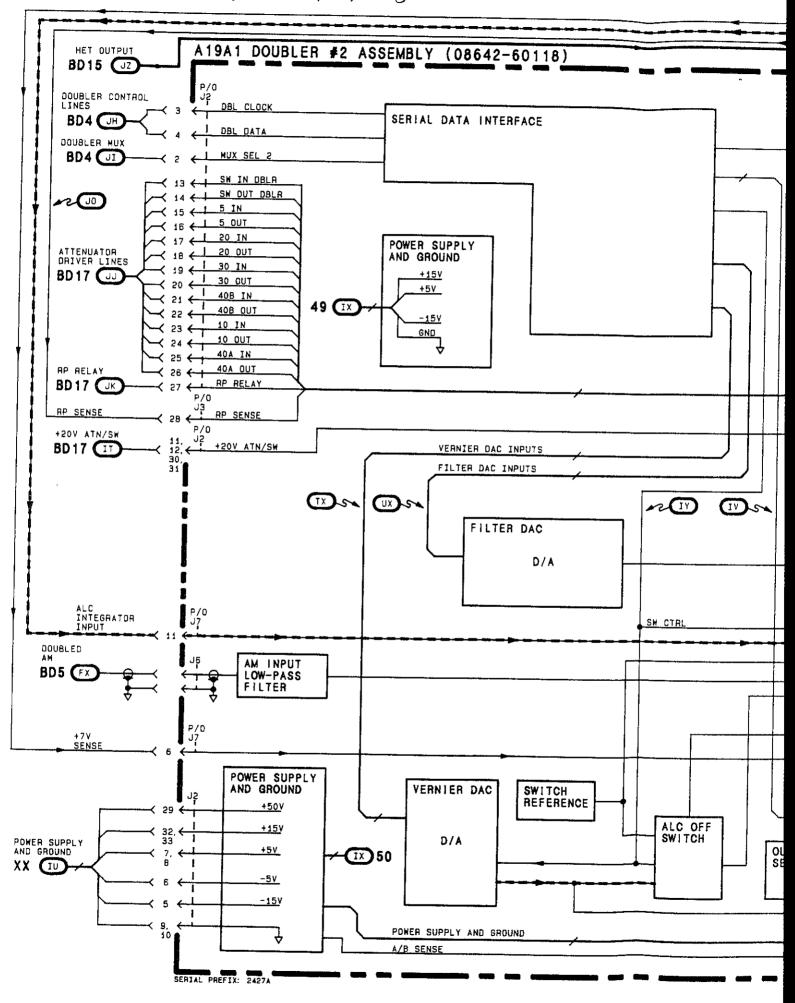
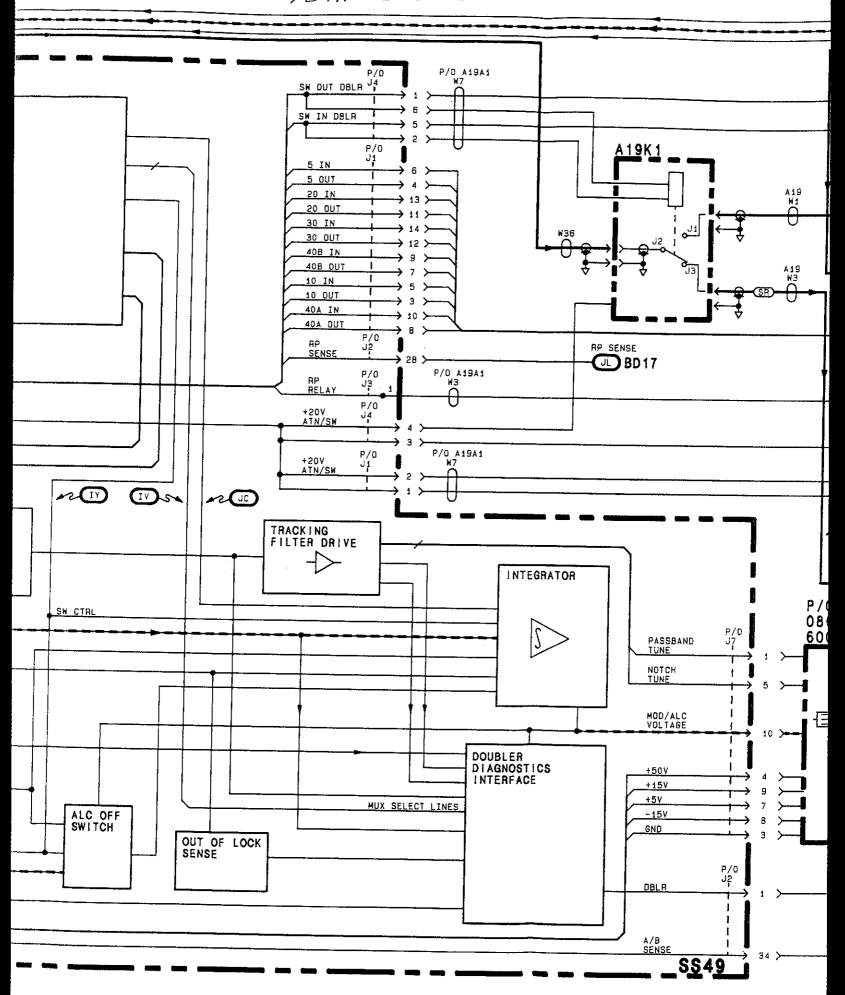
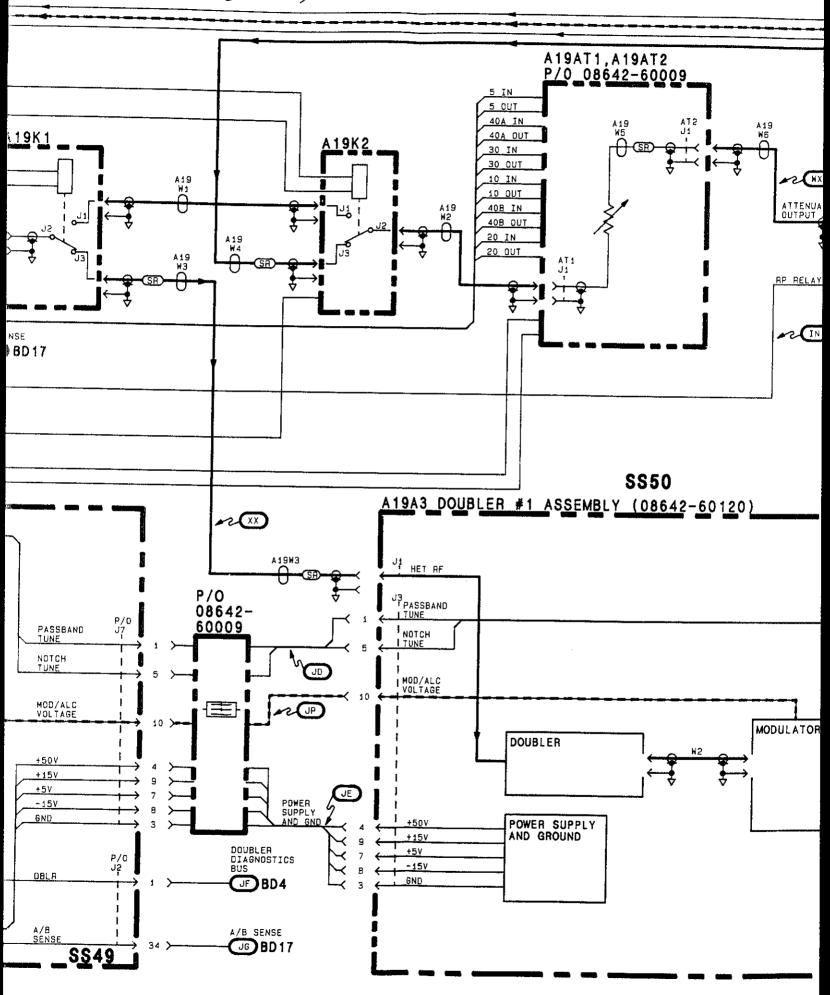


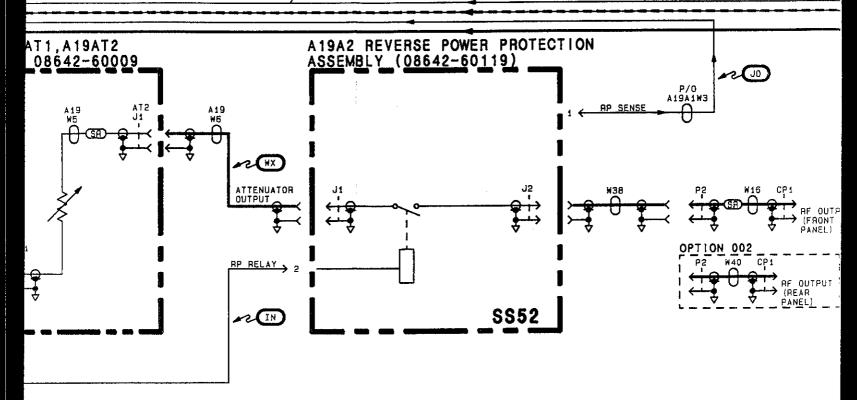
Figure 8S-100 BD16 General Information.



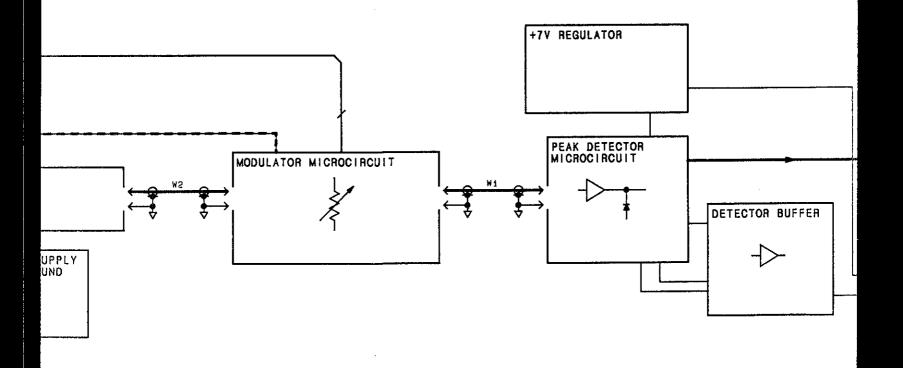


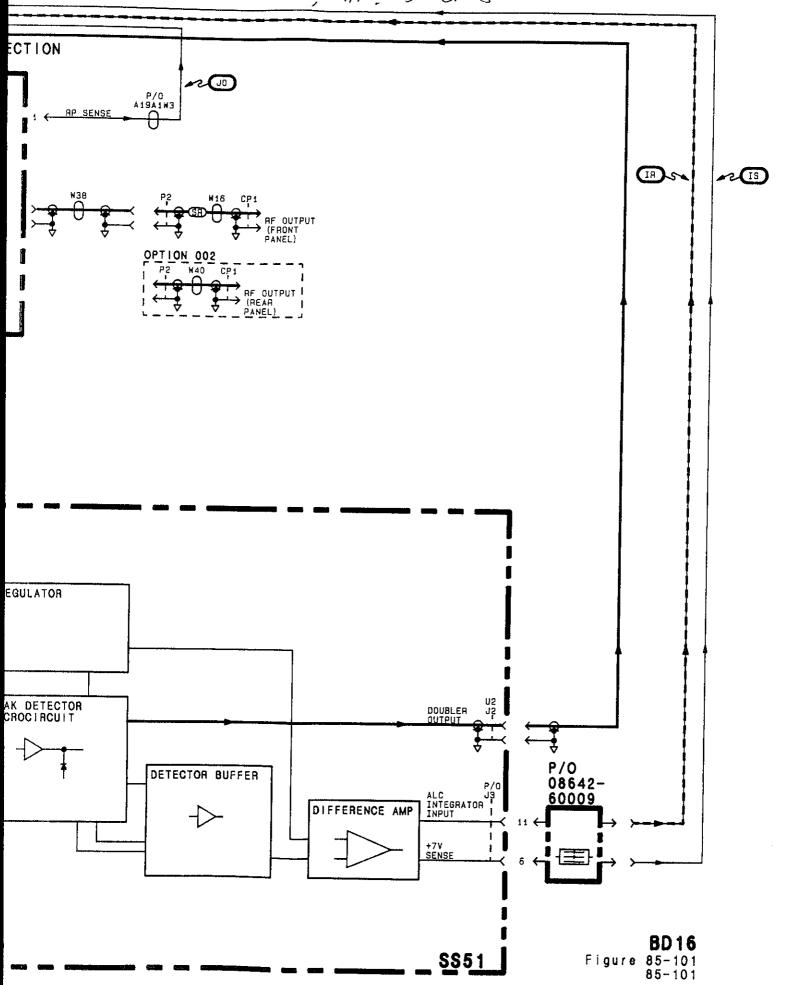












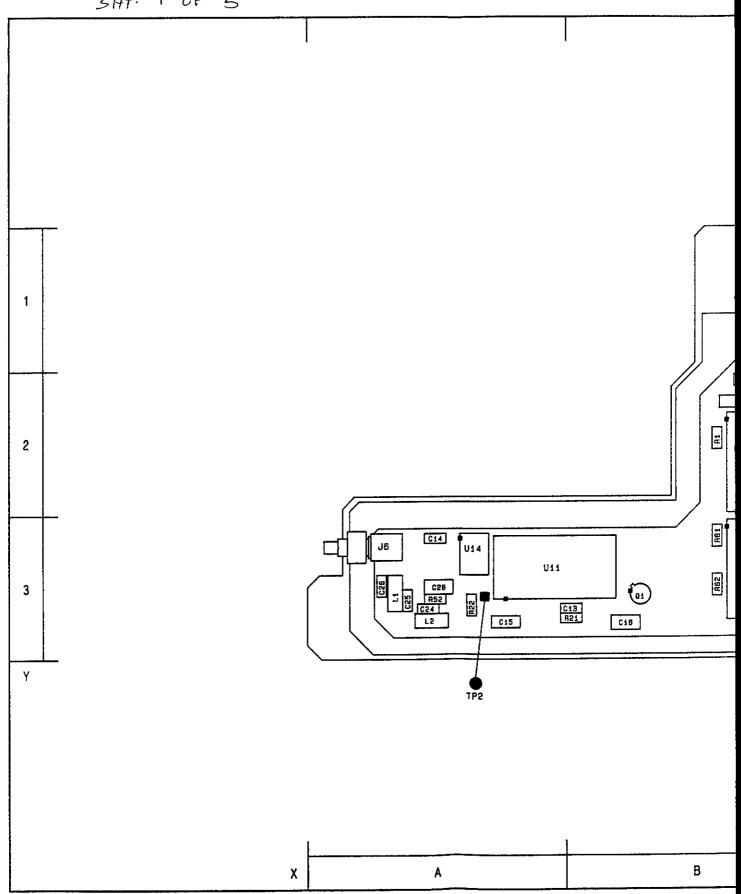
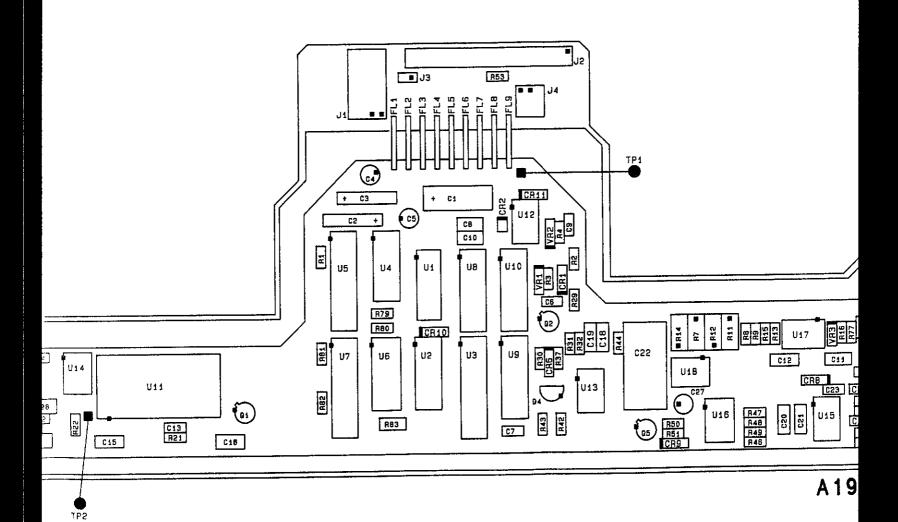


Figure 85-102. SERVICE SHEET 49 INFORMATION

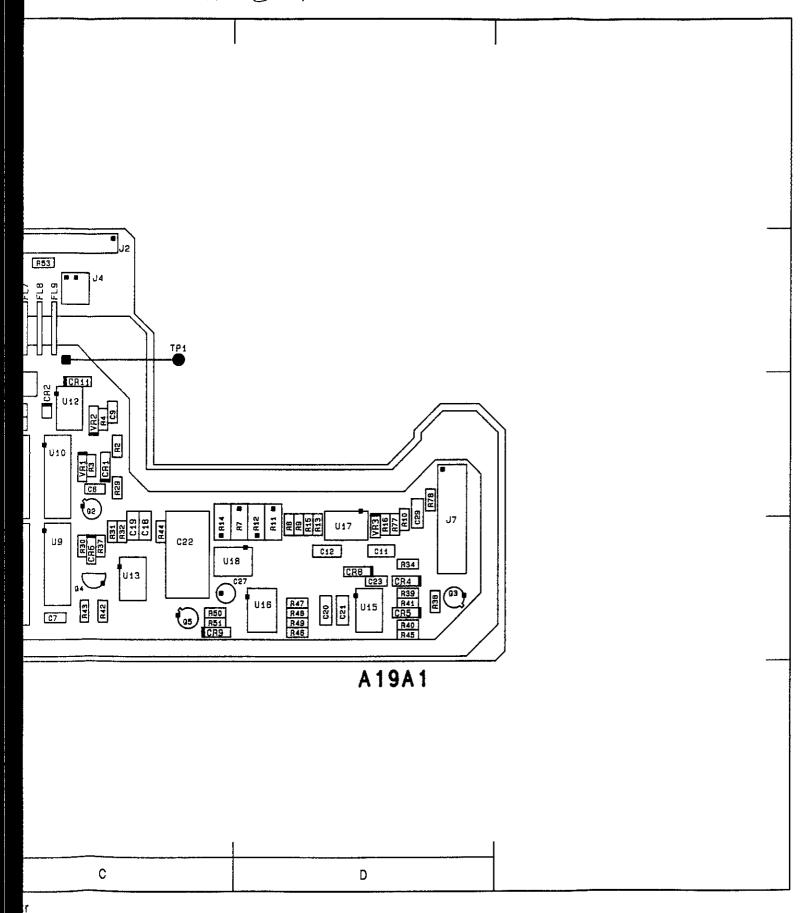


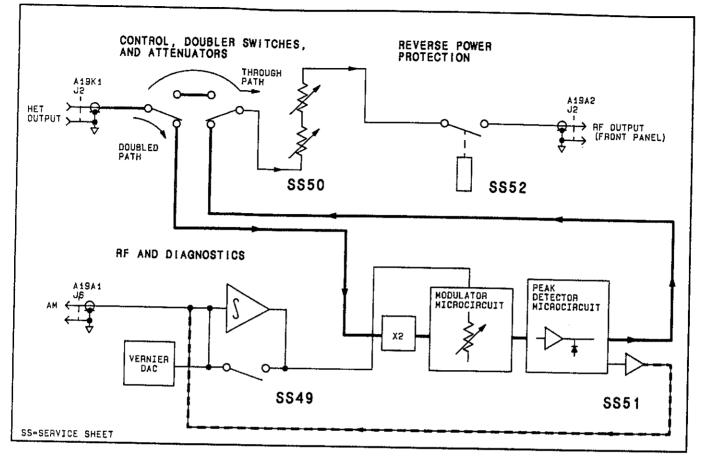
Component Locator

В

C

D





Reference Block Diagram

# Component Coordinates

COMP X,	/ СОМ	P X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	COVE	V V	00110	V U
C1 CB, B, B, C,	CR12CR45CR66CR111111111111111111111111111111111	CCCCCCC BEBCCCC CAC AA BCCCC CCCCCCC	<b>∤</b>		TP1 TP2 U9 U10 U11 U12 U13 U14 U15 U16 U17 U18 VR1 VR3	13 3232333333 225 C.A. C.C.A.C.C.A.C.C.C.C.C.C.C.C.C.C.C.C		6,1	COMP	<b>7.1</b>	COMP	Α,Υ	COMP	х, ү	СОМР	X,Y

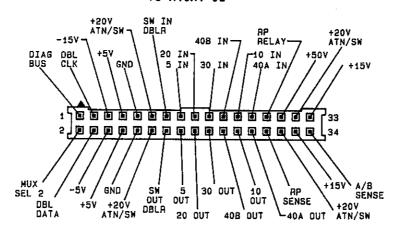
A19A1 MODULE BD 16

SEE REVERSE SIDE

#### Notes:

- Each module in the HP 8542 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- 3. A19 FL1 is an array of feedthrough filters passing through the center of the module to make connections between two (2) printed circuit boards.

#### CABLE PLUG TO A19A1 J2



## **CHANGES**

# All Serial Prefixes

#### On the schematic:

• R45 - In INTEGRATOR, change R45 value to 990 ohms.

#### On the Component Locator:

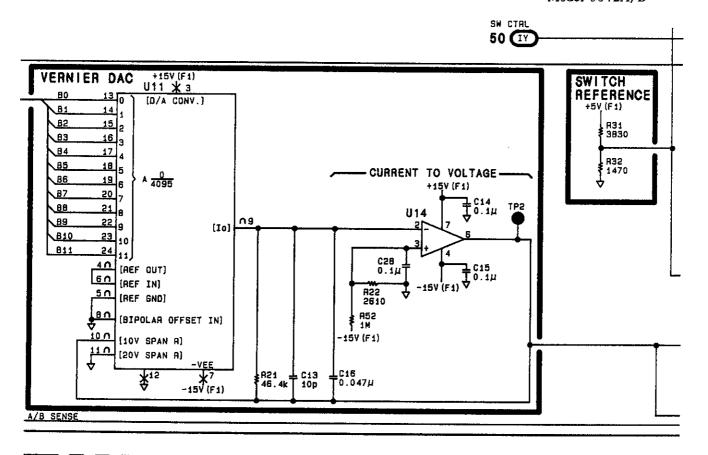
• <u>C6, R43</u> - Replace U18 with the following two component moves: Move C6 to the immediate right of C22. Move R43 to the right of C22, underneath C6.

#### In Component Coordinates:

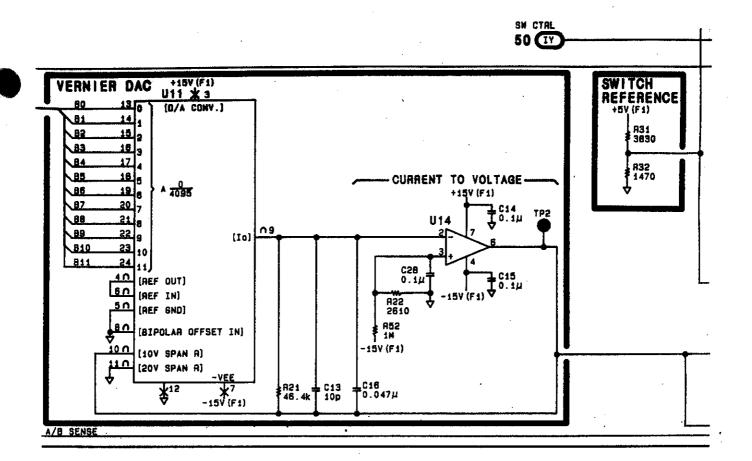
• C6 - Change C6 coordinates to C,3.

#### On the schematic:

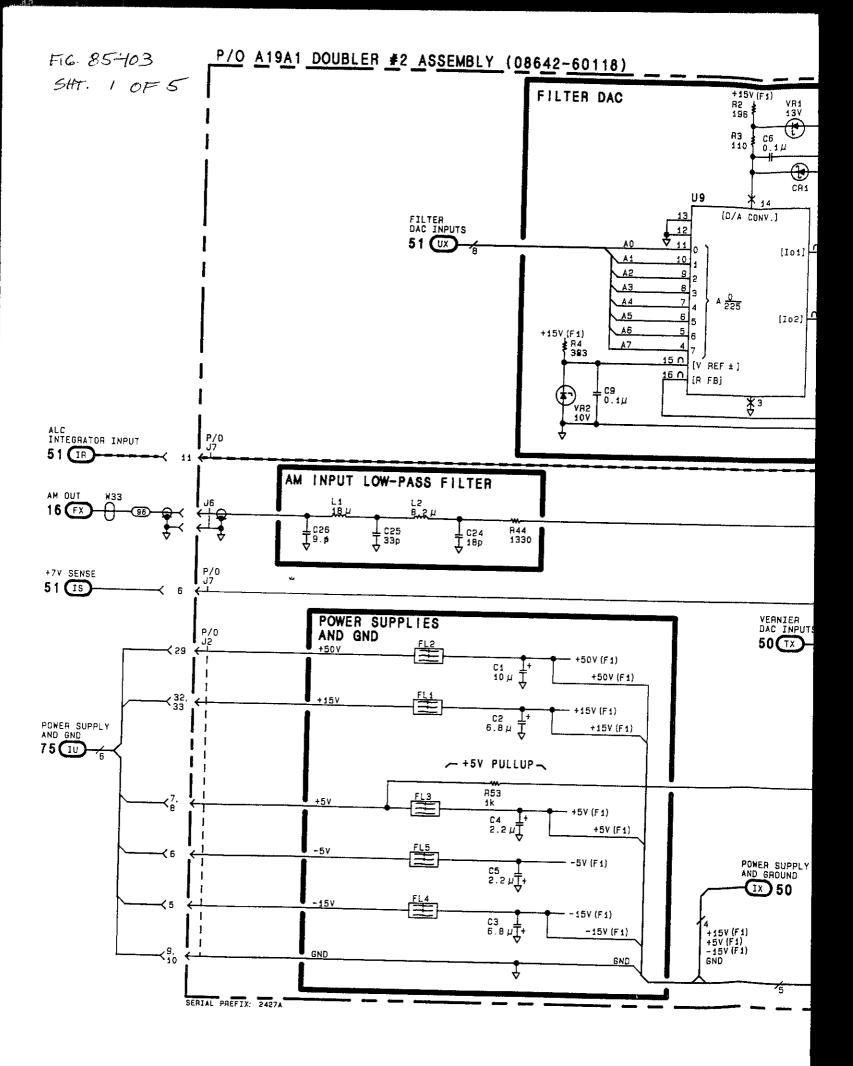
- A19A1 In the upper left portion of the schematic, change the A19A1 part number to 08642-60218.
- A19A1 R30, Q1, U18, C16 Replace the appropriate portion of SS49 with the schematic partial on page 8S-102.2 (P/O FIGURE 8S-103 (2517A and above).

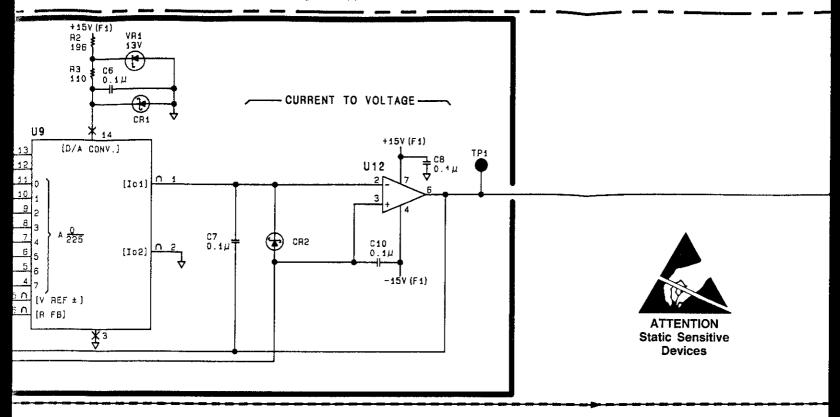


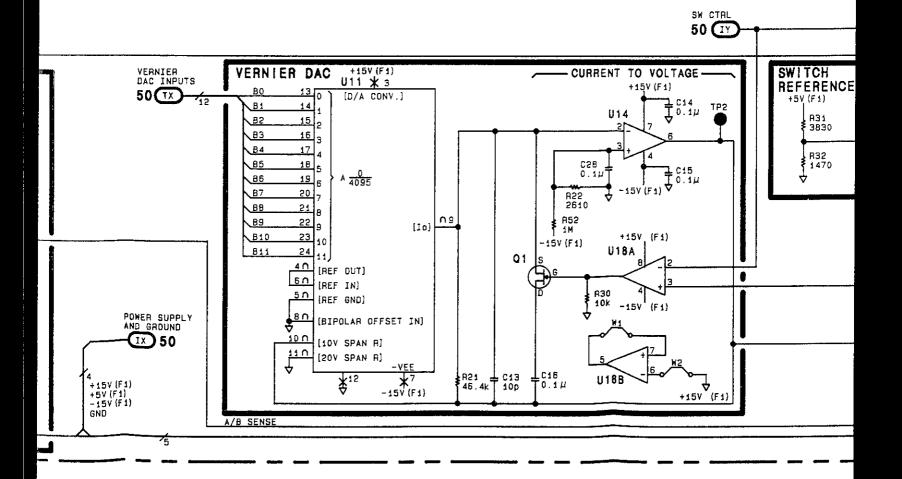
P/O FIGURE 8S-103 (2517A and above)

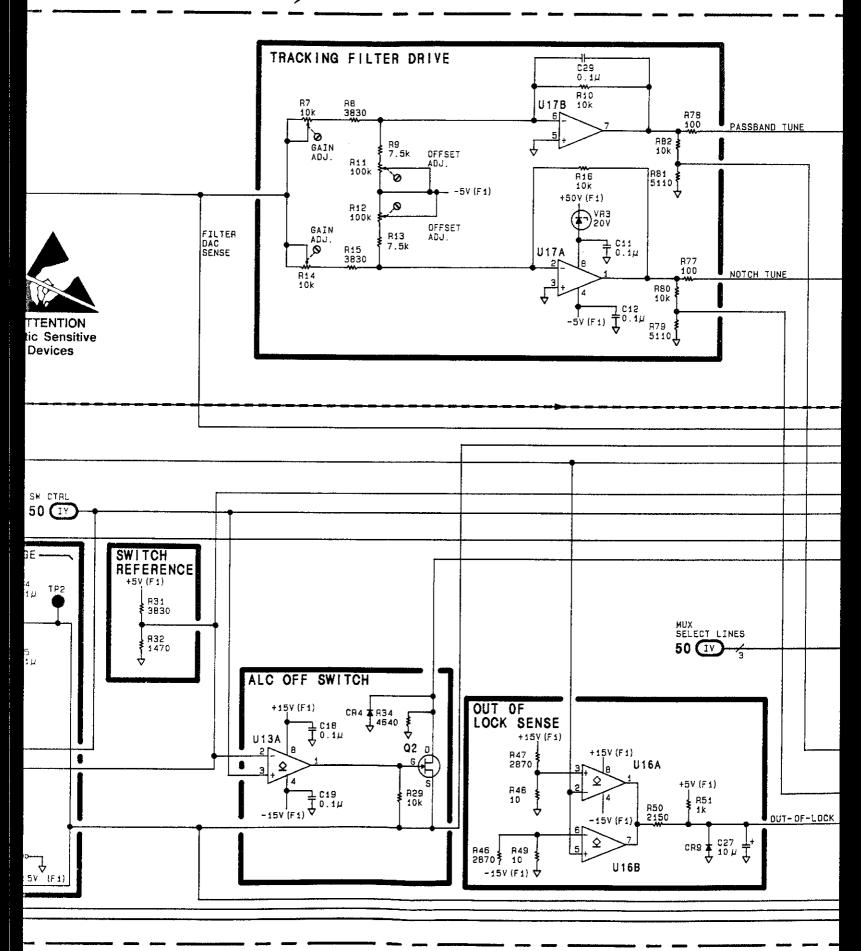


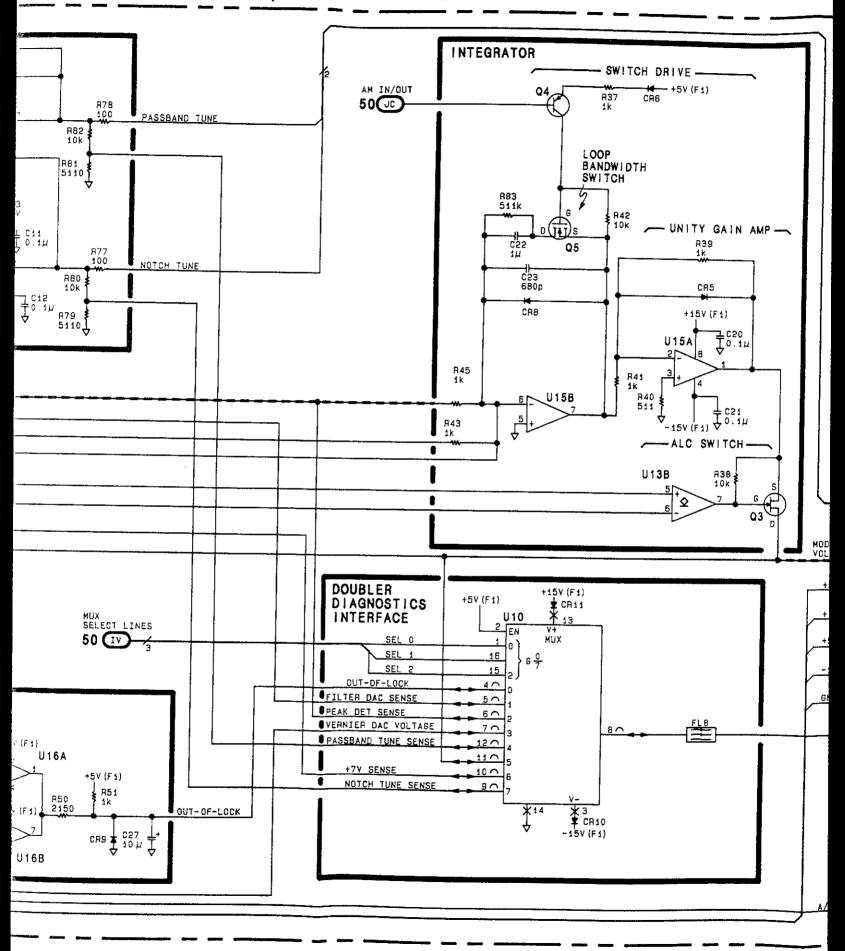
P/O FIGURE 8S-103 (2517A and above)

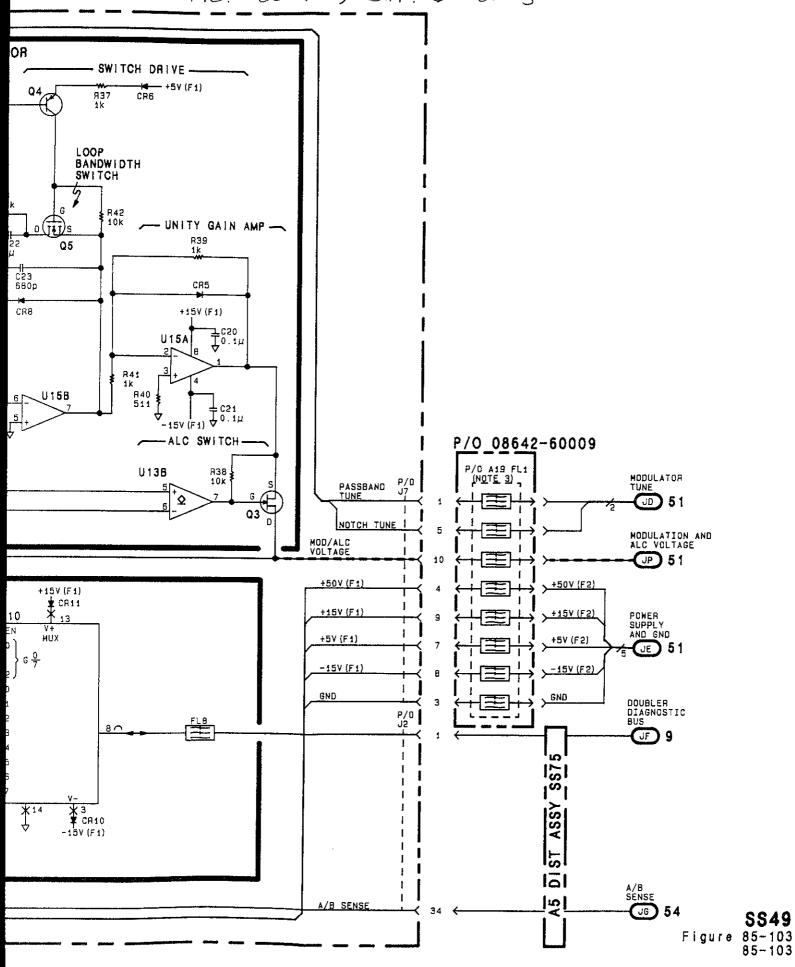












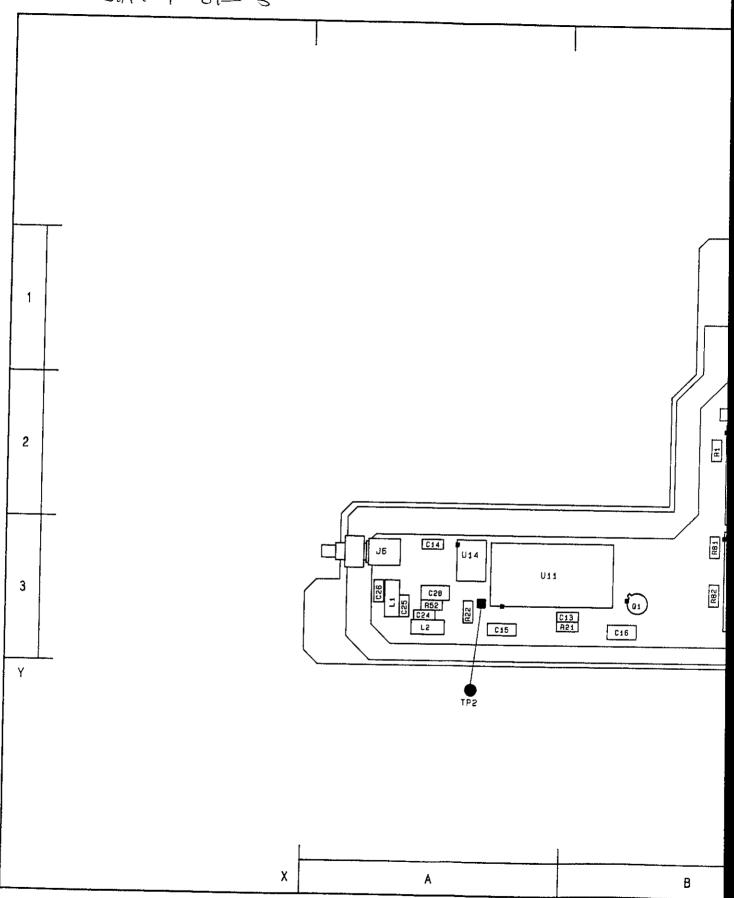
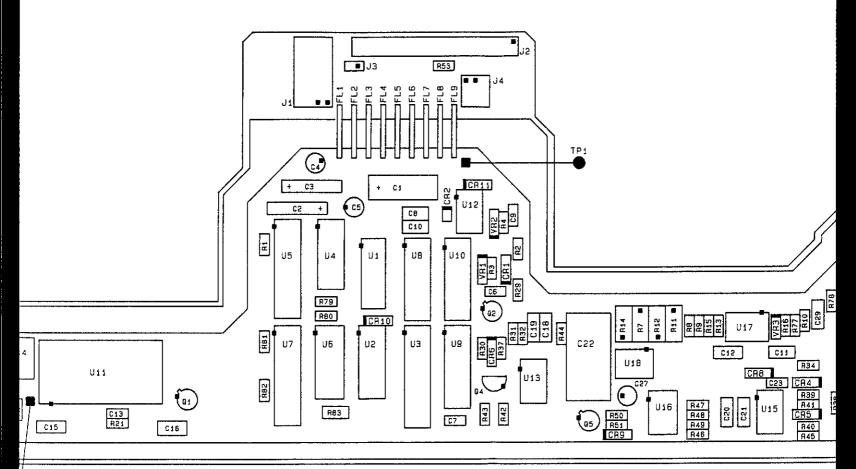
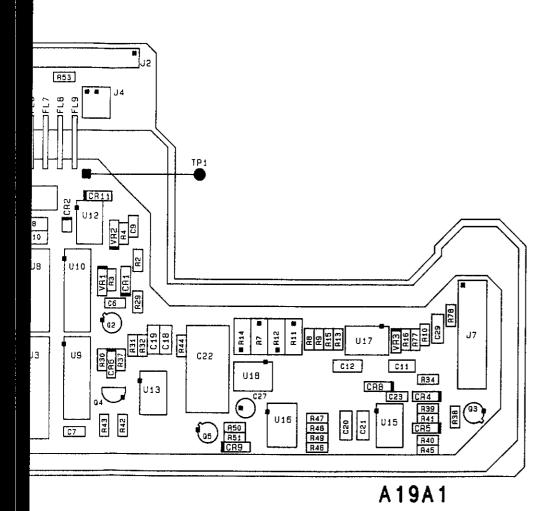


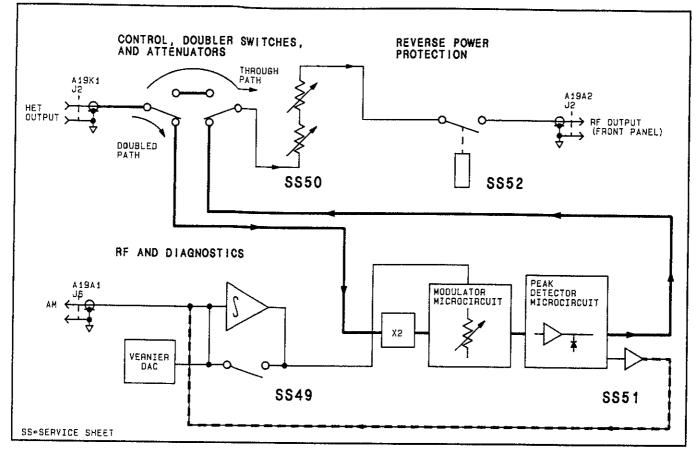
Figure 85-104. SERVICE SHEET 50 INFORMATION



A19A1

B C D





Reference Block Diagram

#### Component Coordinates

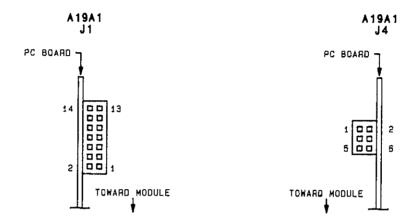
COMP X,Y COM	v v
J1 B. 1 J2 C. 1 J3 B. 1 J4 C. 1 R1 B. 2	A, T
R1 B, 2	
R1   B, 2	
U1	

P/O DOUBLER #2 SS49

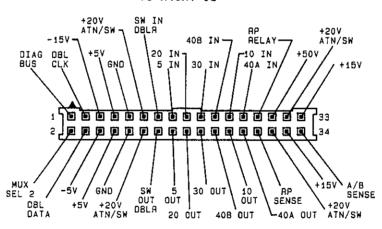
SEE REVEASE SIDE

#### Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. A19A1 W9 consists of two wires and a connector soldered to two pads on A19A1. (J3 pins 1,2)
- 3. All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.



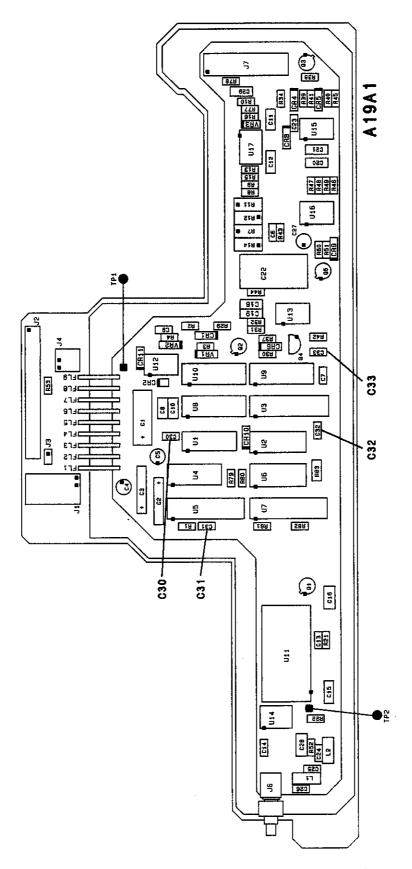
#### CABLE PLUG TO A19A1 J2



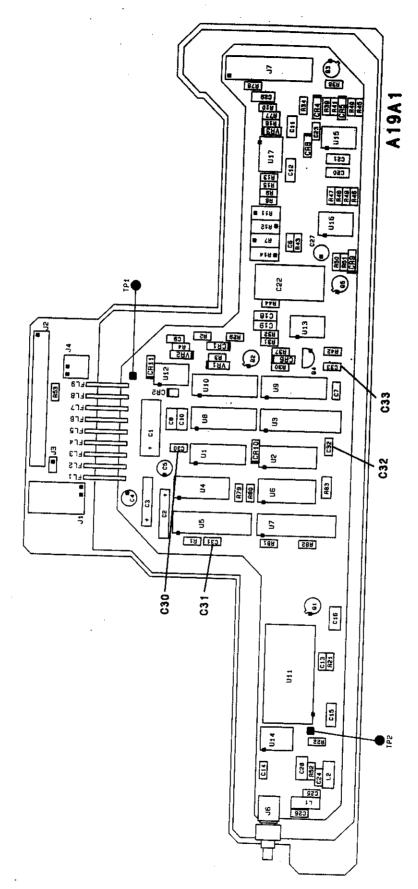
1

X A B

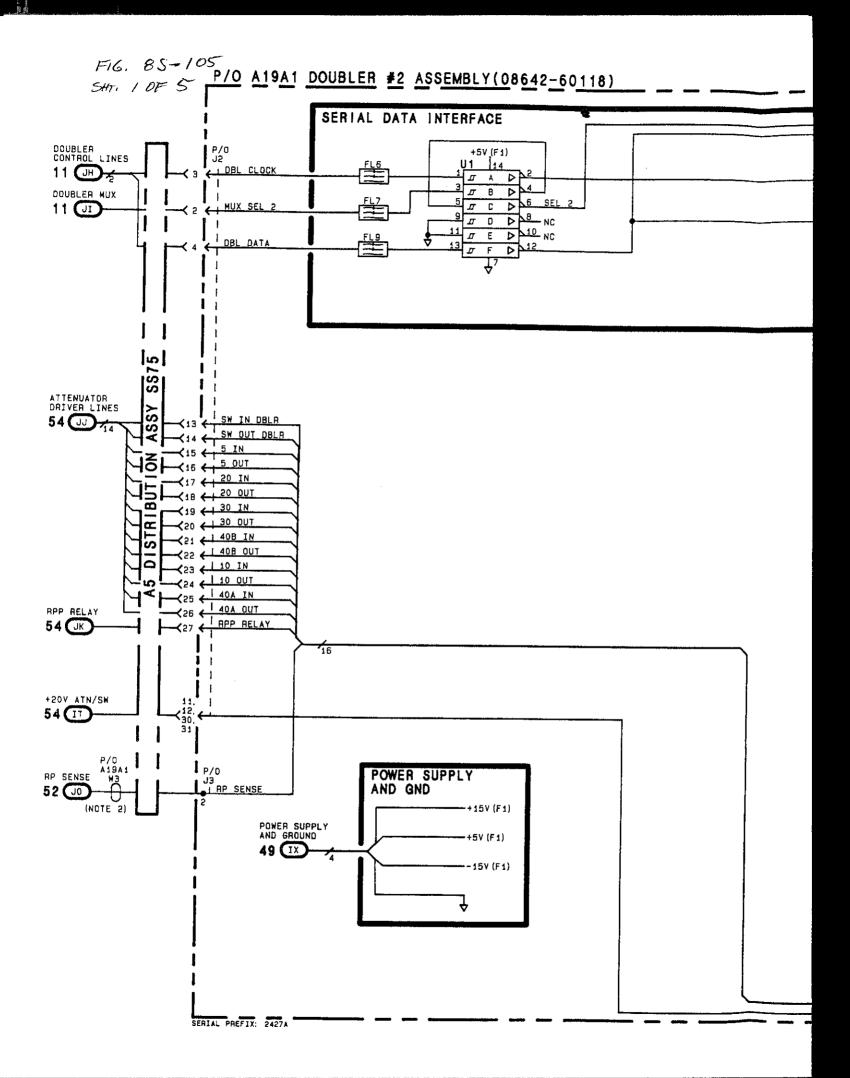
Υ

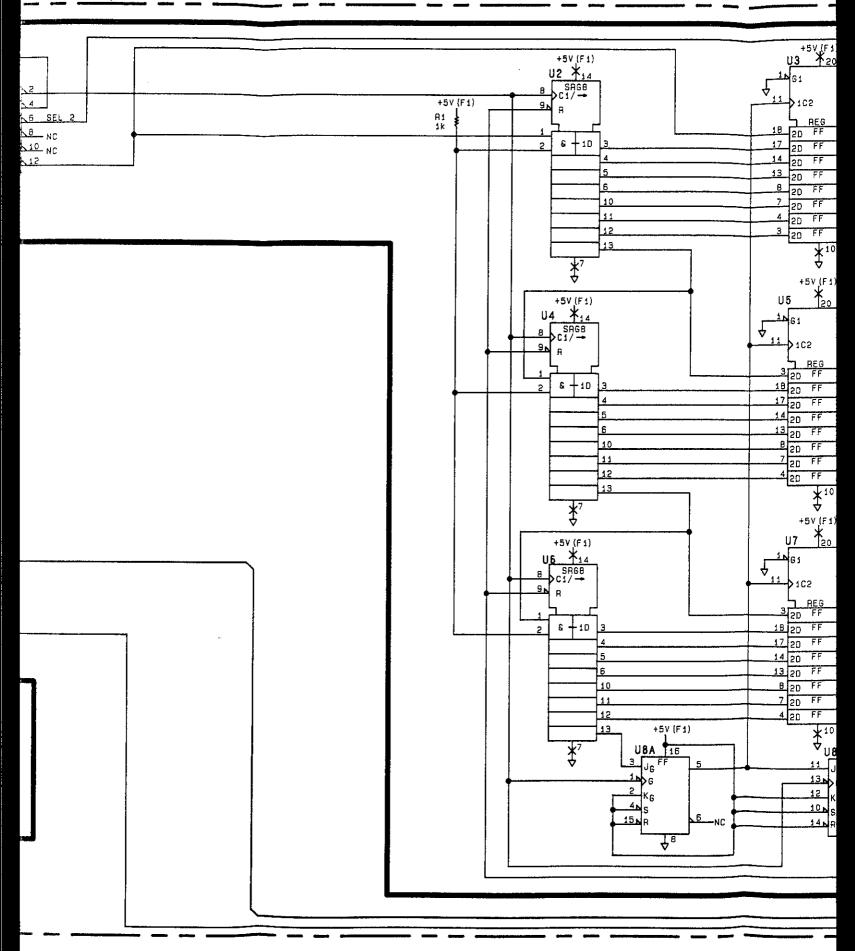


P/O FIGURE 8S-102 (2517A and above)



P/O FIGURE 8S-102 (2517A and above)





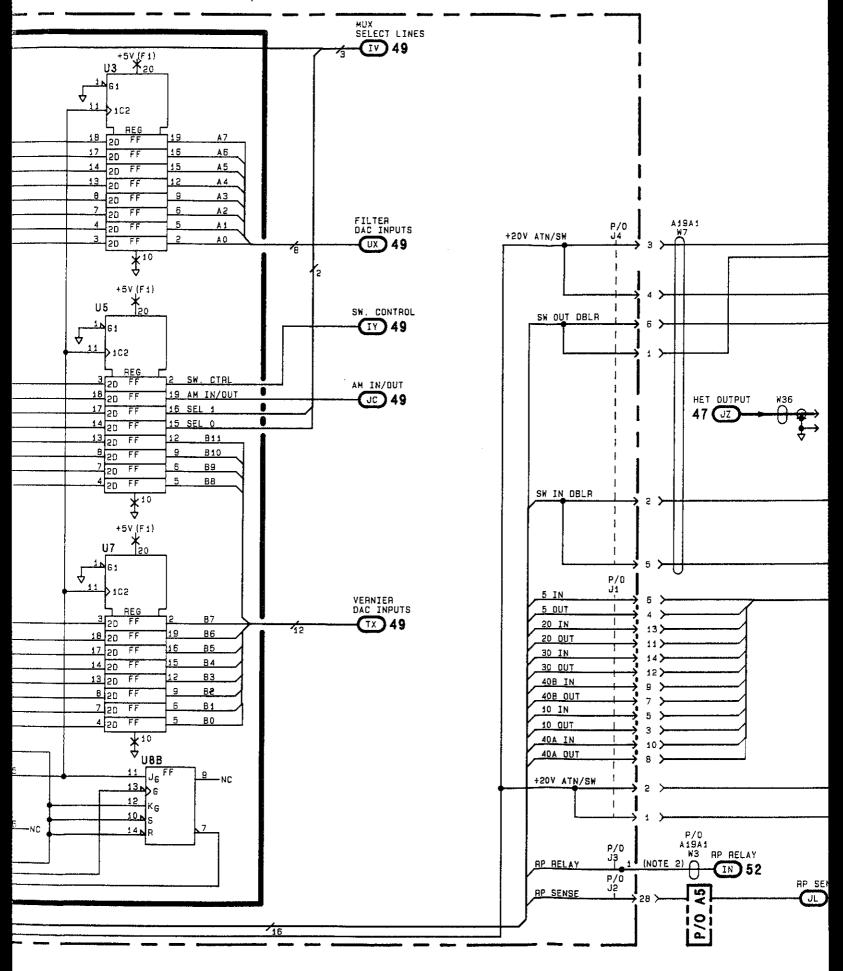
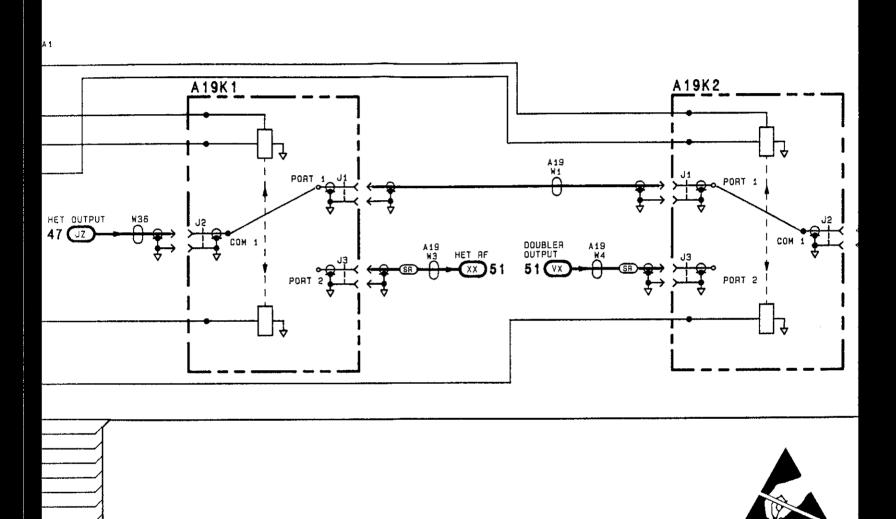
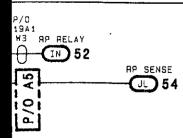
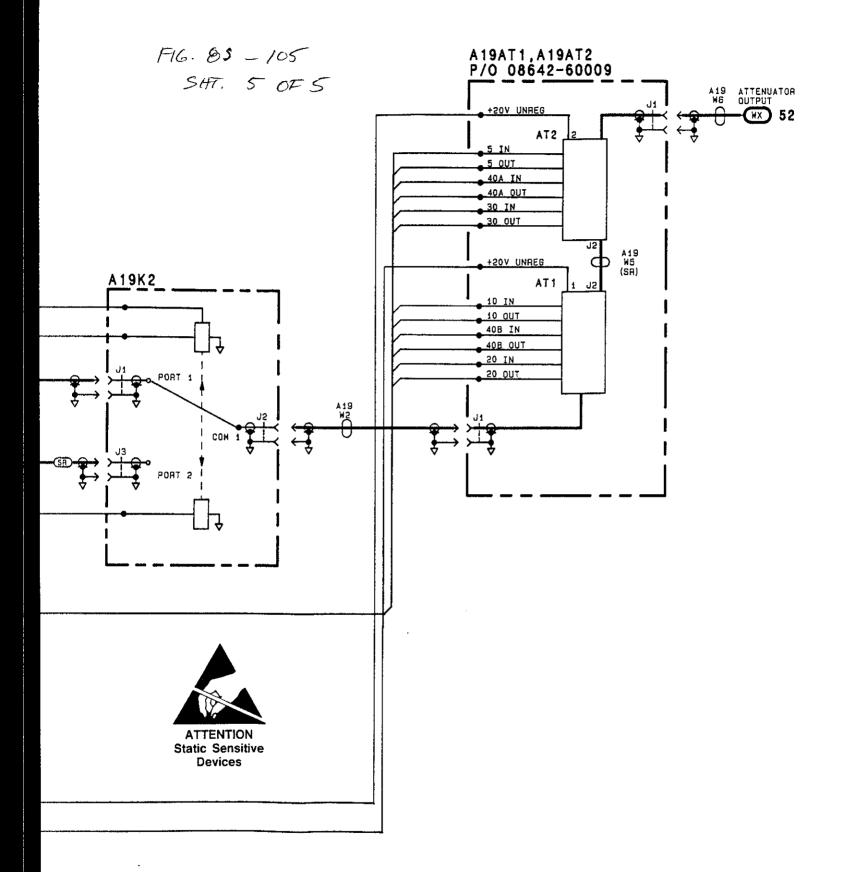


FIG. 85-105 SHT. 4 OF 5



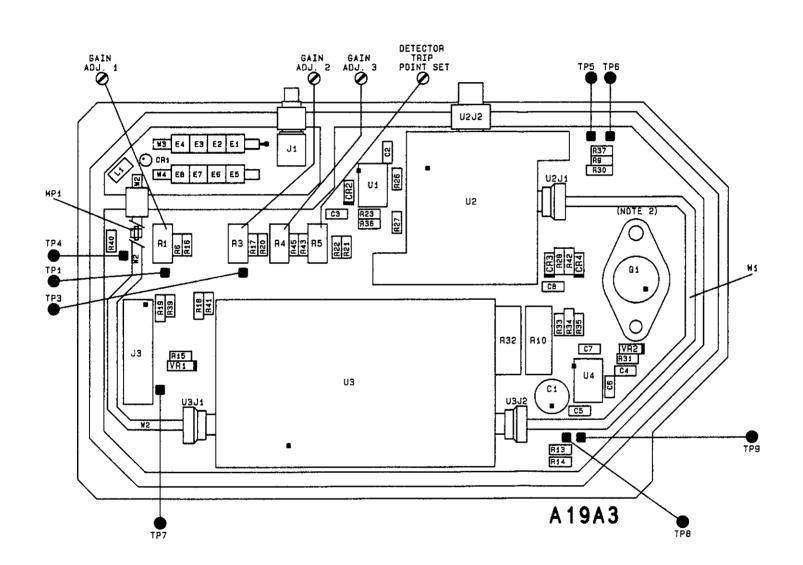
ATTENTION Static Sensitive Devices



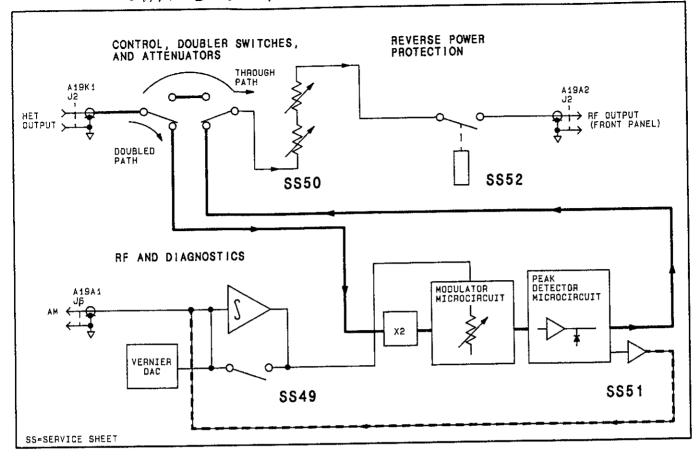


X A B

Υ







Reference Block Diagram

## Component Coordinates

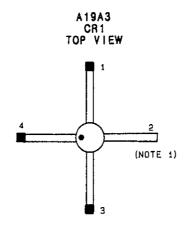
COMP	ΧΥ	СОМР	X.Y	СОМР	X.Y	СОМР	X,Y	COMP	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
COMP C122034 CC567CB CRR234 CCR34 CCR34 CCR34 E12345567B JJ3 L1 MP1 G1 RR24 R5	X, Y C.3 B.1133322 A.1122 A.11122 A.11121 A.111 12 A.2222 A.2222	COMP R6	Y A D C C C A A B A A B B B B B C C C C C C C	COMP TP7 TP8 TP9 U1 U2 U3 U4 VR1 VR2 W1 W2 W3 W4	X, Y A, 3 D, D, B, 1 B, 1 B, 1 B, 1 B, 1 B, 1 B, 1 B,	СОМР	х, ү	COMP	Х, Ү	СОМР	Х, Т	COMP	X,1	COMP	A.1		

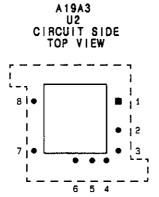
P/O DOUBLER #2 SS50 A19A1 ASSEMBLEY

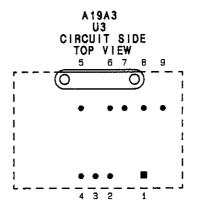
SEE REVERSE SIDE

#### Notes:

- 1. Do not touch CR1 with soldering iron. Heat pad only.
- 2. G1 mounts to heatsink.
- 3. Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.
- 5. A19 FL1 is an array of feed through filters passing through the center of the module to make connections between two (2) printed circuit boards.







## **CHANGES**

#### All Serial Prefixes

All Serial Prefixes

#### On the Component Locator:

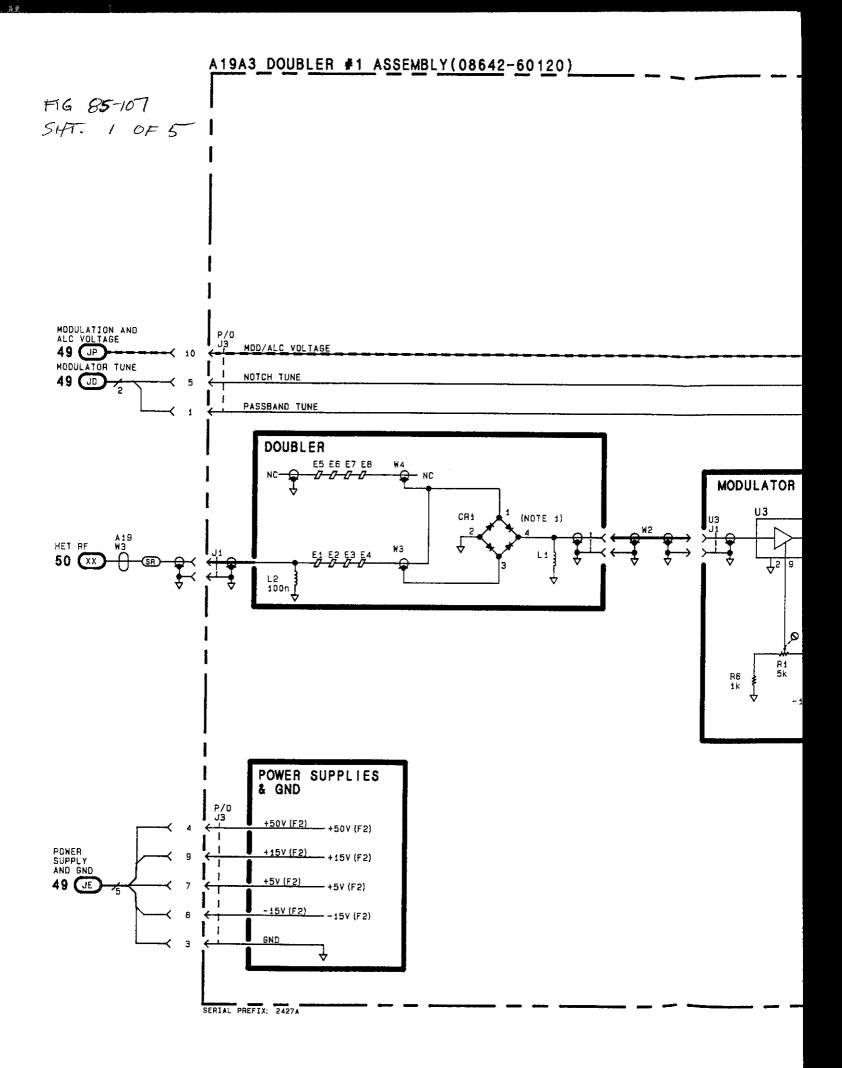
- R46 Add R46 immediately below R5.
- L2 Add L2 immediately below J1.

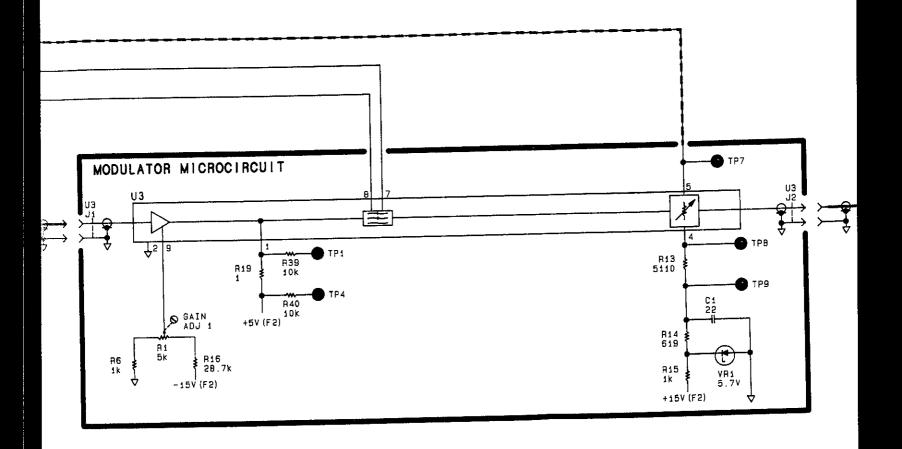
#### In Component Coordinates:

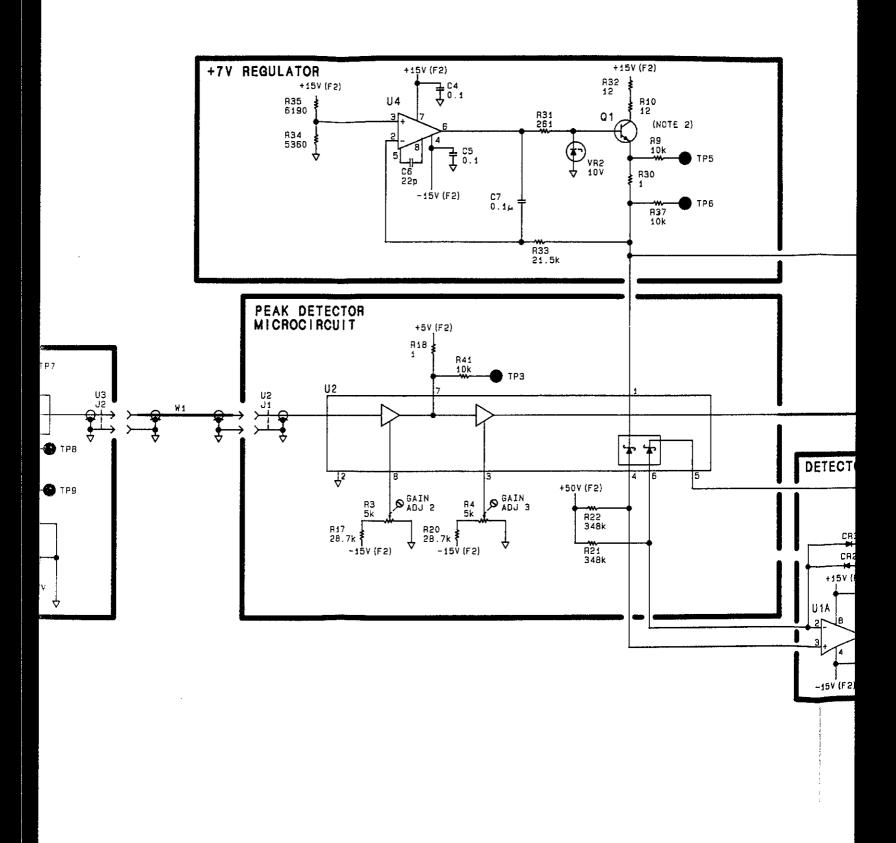
- R46 Add R46, B,2.
- <u>L2</u> Add L2, B,1.

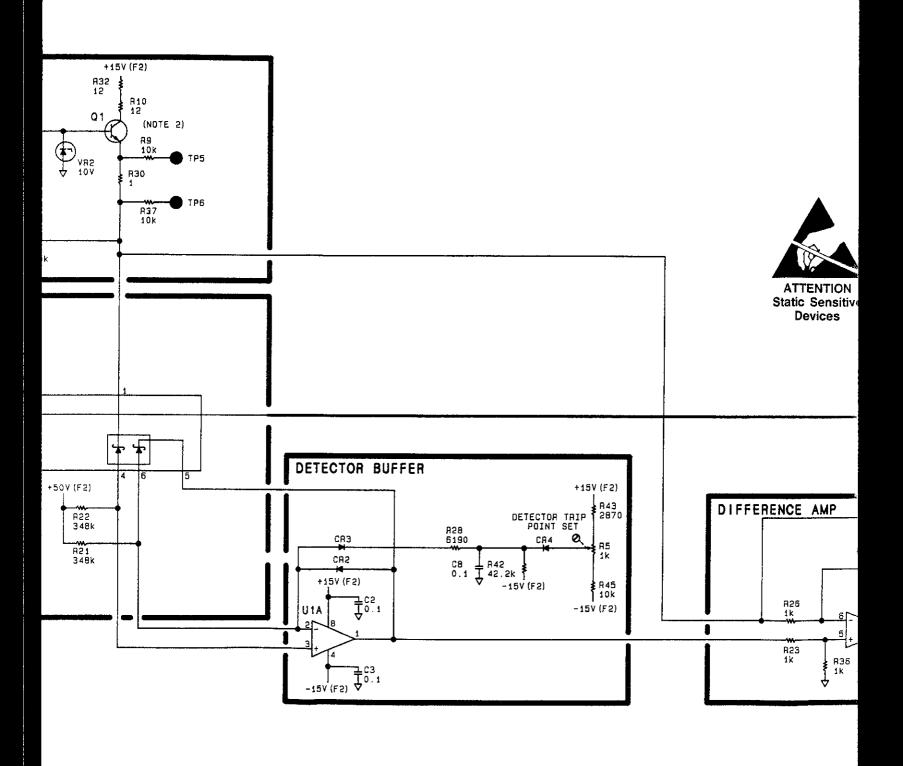
#### On the schematic:

- In the upper left portion of the schematic, change the A19A3 assembly number to 08642-60220.
- R46 In DIFFERENCE AMP, add R46 between pin 7 of U1 and pin 11 of J3. Assign a value of 10 ohms.

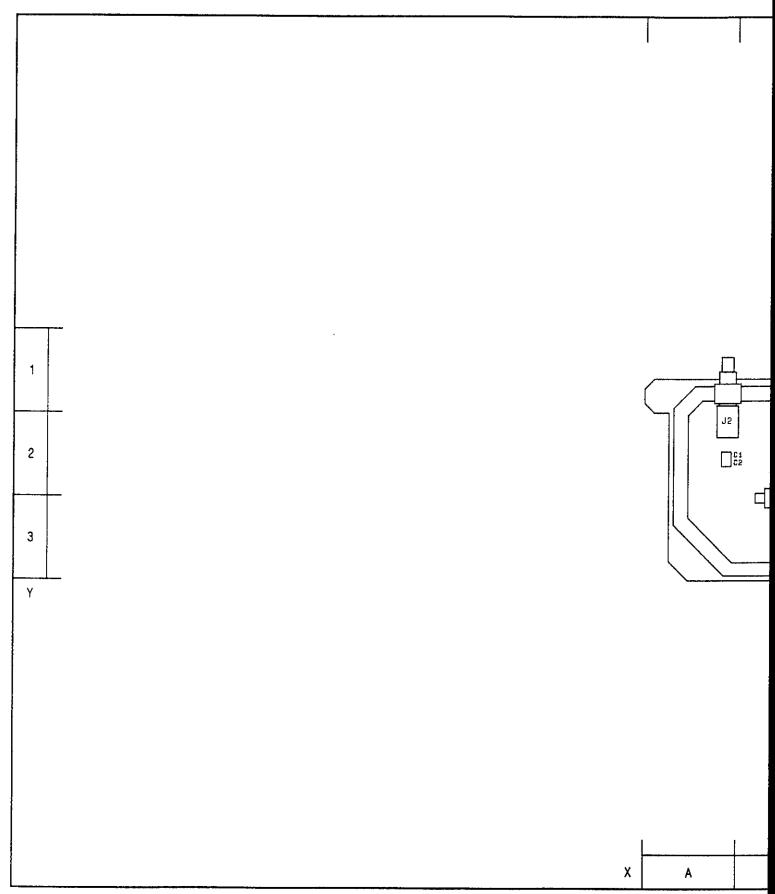


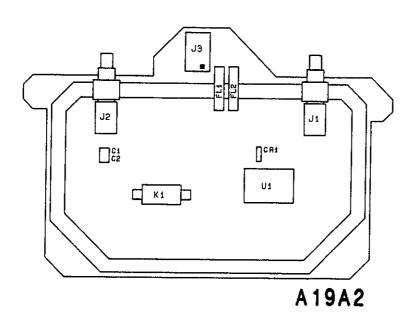






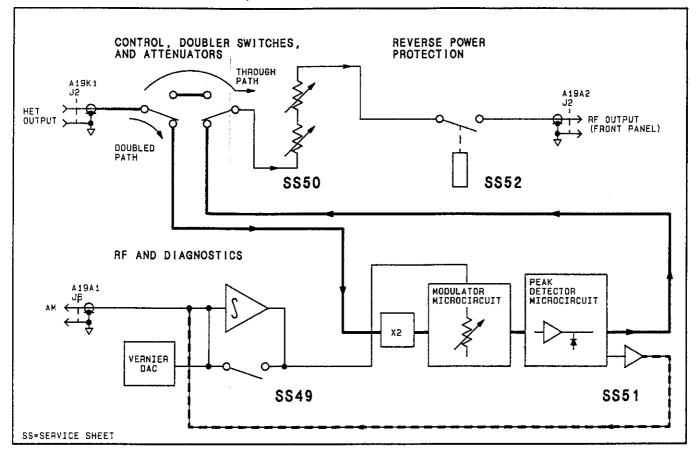
**SS51**Figure 85-107
85-107





X	A	В	С	D

Component Locator



Reference Block Diagram

Component Coordinates

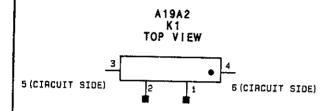
COMP	v v 1	СОМР	v v	COMB	V V	COMB	v v l	COMB	v v l	COMB	y v	COMP	ΥV	COMP	y v	COMP	y v
COMIT		COMIT	^,, '	COMI	^, '	COMIT	^,,	COMIT		COMI	^,,	COMI	Λ,,	OOWII		001411	^,,,
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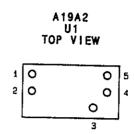
P/O DOUBLER #1 SS51

SEE REVERSE SIDE

### Notes:

- Each module in the HP 8542 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.





## **CHANGES**

# All Serial Prefixes

On the Component Locator:

• Above K1, add "NOTE 3."

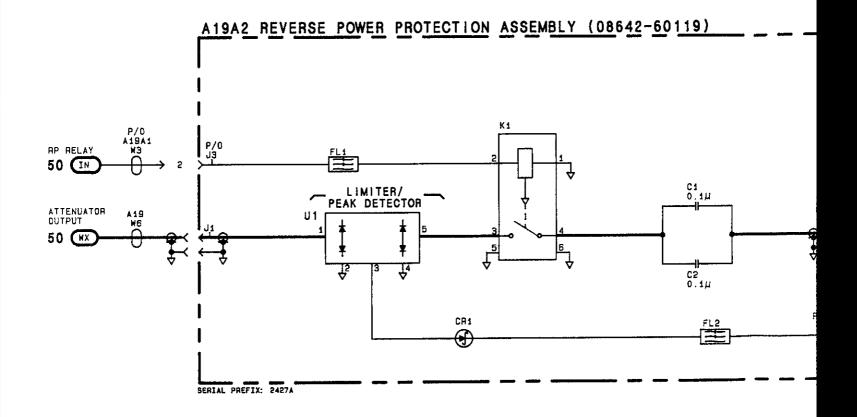
### In Schematic General Information:

• Add "NOTE 3"; Small gold disc(s) are tunable stubs, positioned on the circuit board for optimum SWR characteristics. There may be more than 1 tunable stub, and the positoning may vary on the RF path from J1 to C1.

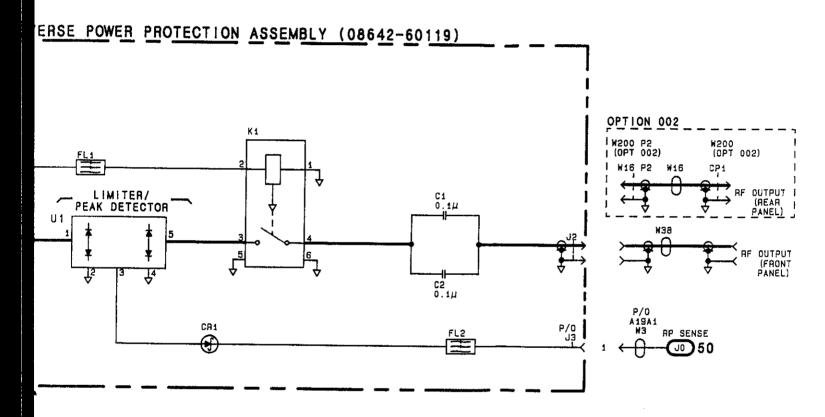
#### On the schematic:

- Add Z1, a tunable stub, from the circuit main signal path (U1 Pin 5) to ground. Add "NOTE 3" to the nearest available space.
- <u>C2</u> In REVERSE POWER PROTECTION ASSEMBLY, remove C2.

F16. 85-109 SHT, 1 OF Z



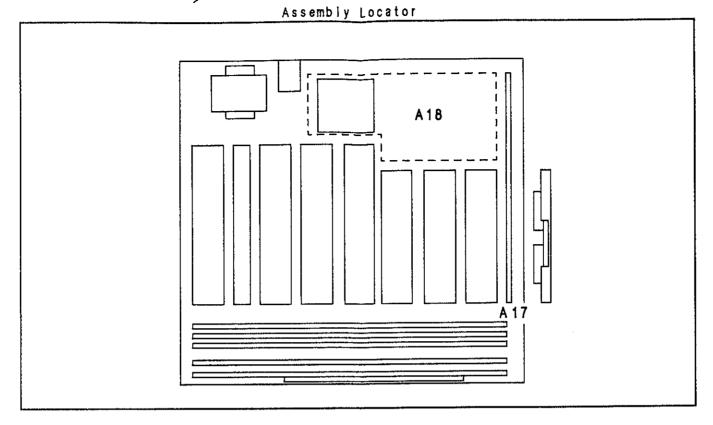
F16. 85-109 SHT. 2 OF 2



**SS52**Figure 85-109
85-109

A17 Power Supply/ A18, A10 Atten Drivers

A8 10 MHz. High Stability Timebase



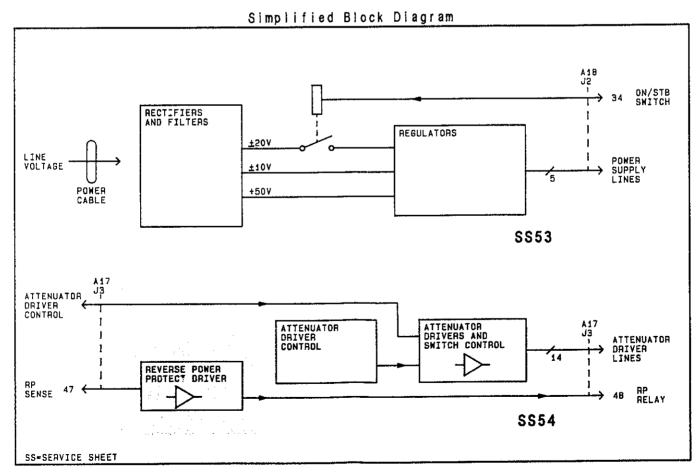
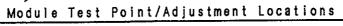
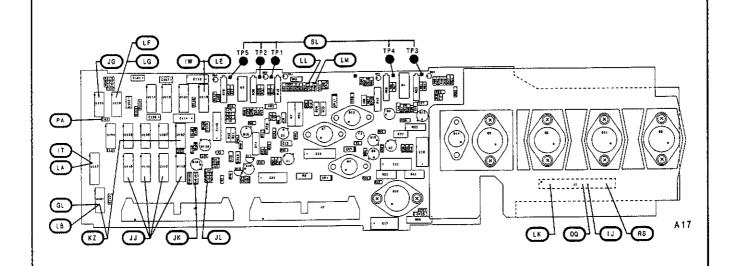
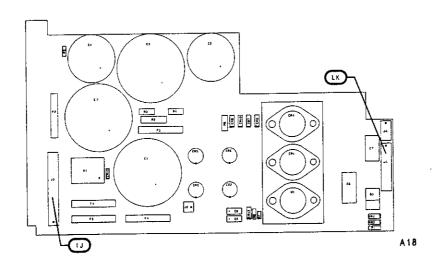
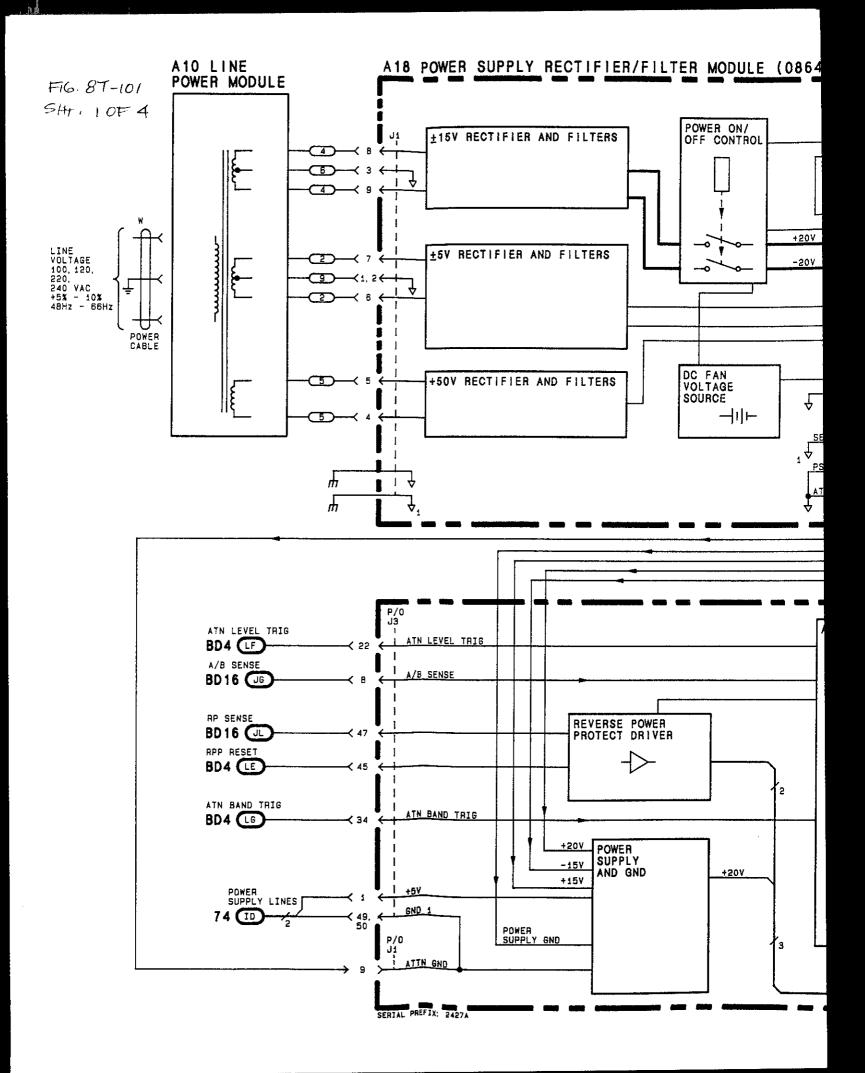


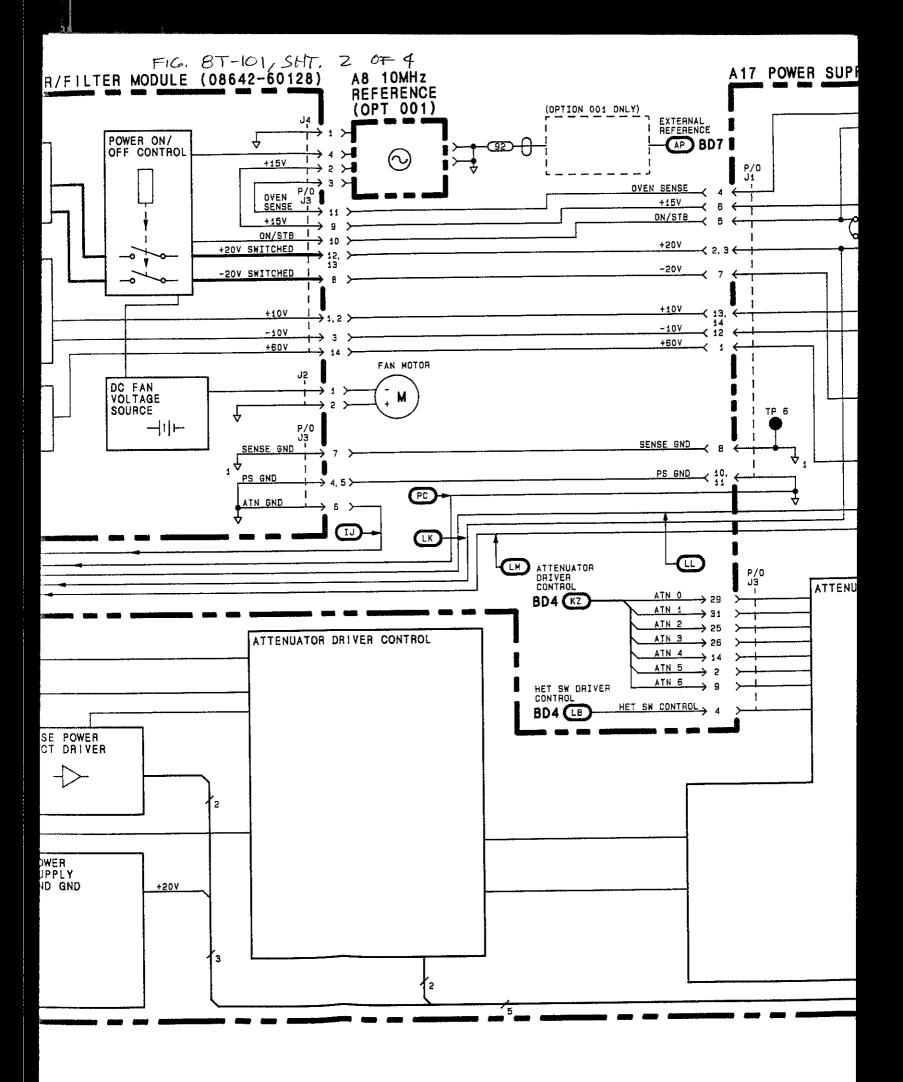
Figure 8T-100 BD17 General Information.











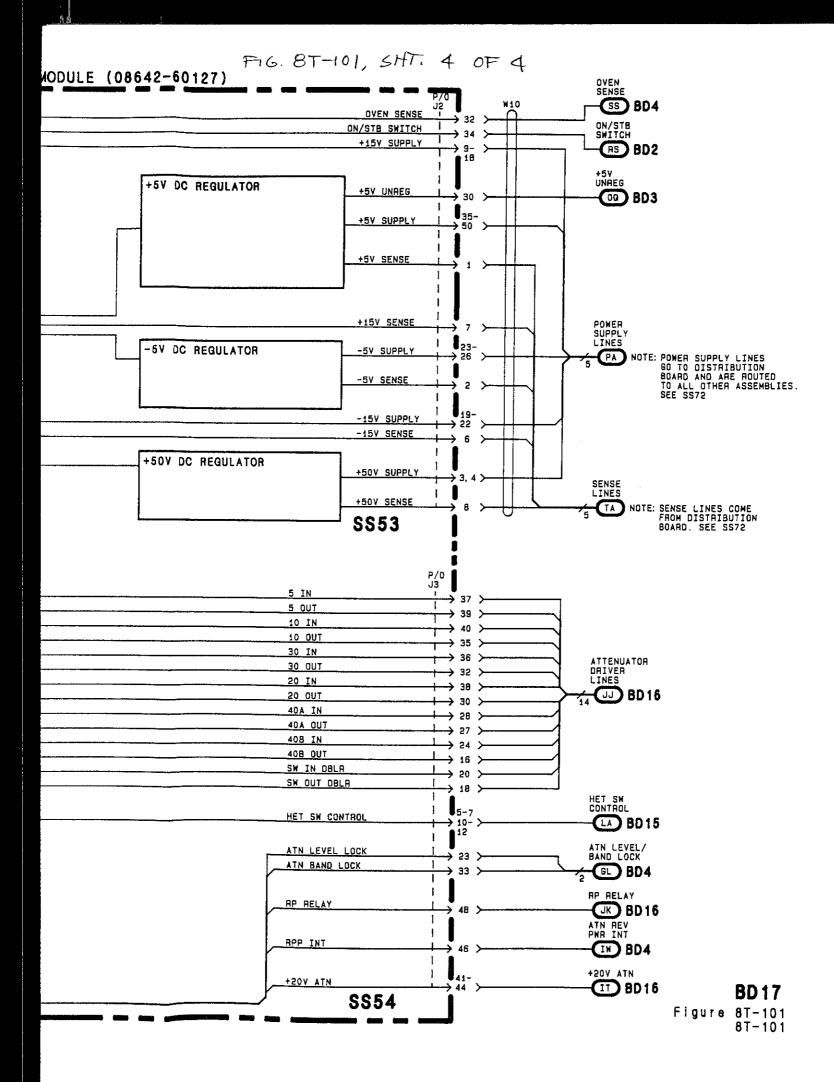
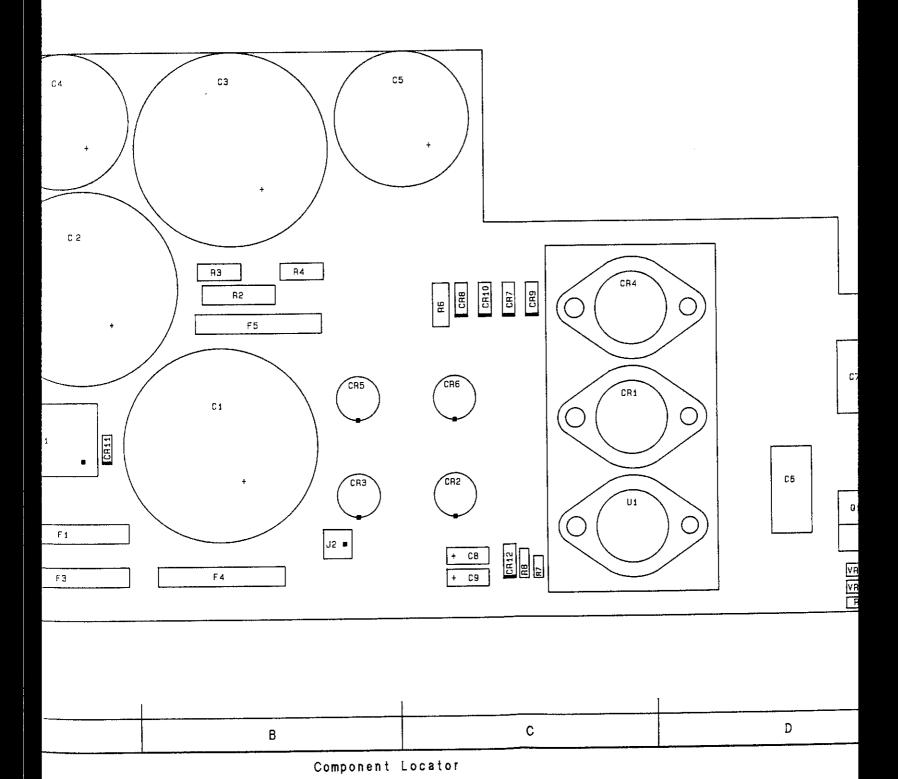
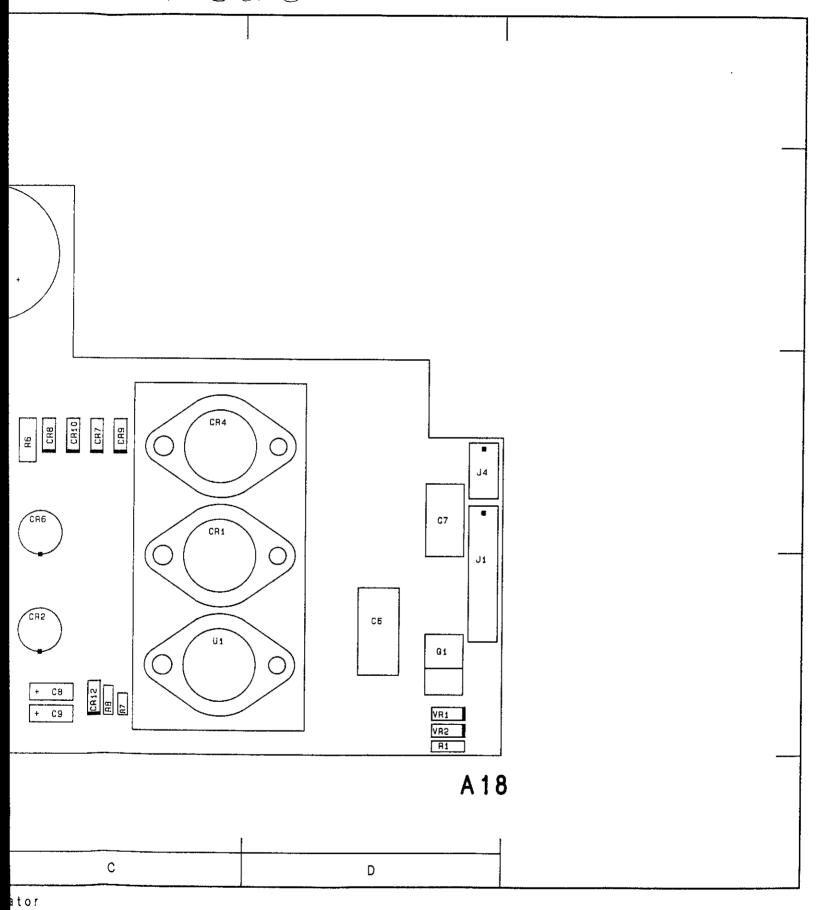
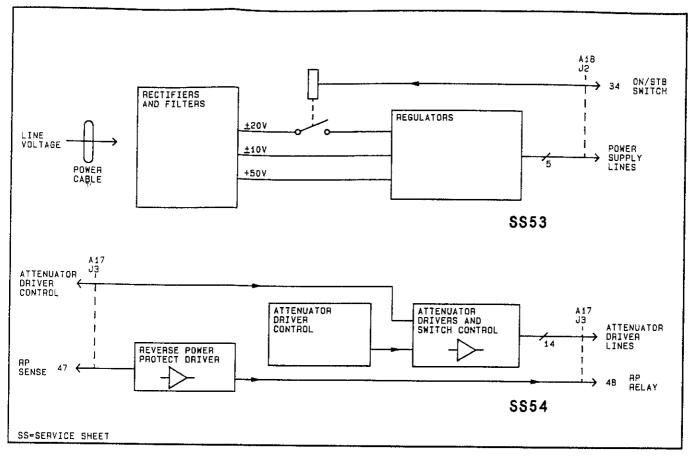


Figure 8T-102. SERVICE SHEET 53 INFORMATION







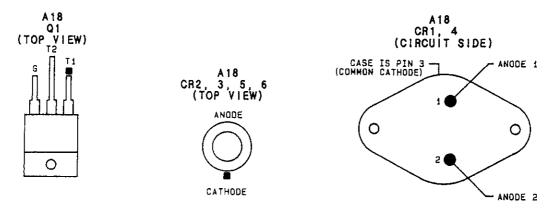
Reference Block Diagram

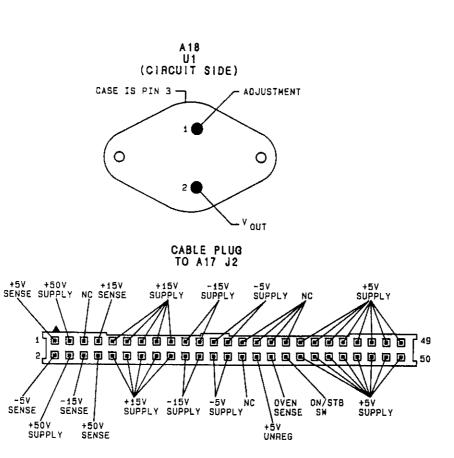
Component Coordinates

СОМР	X,Y	СОМР	X,Y	COMP	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	COMP	X,Y	СОМР	X,Y	СОМР	X,Y									
C2	B, 2 A, 2	R1 R2	D, 3 B, 2								·															
04	B. 1 A. 1	R4	B, 2																							
C1 C2 C3 C4 C5 C6 C7 C8 C9	B, 2 2 1 1 1 1 2 2 3 3 3 3 5 5 5 5 5 5 5 5 5 5 5 5 5 5	R1 R2 R3 R4 R5 R6 R7	30000000000000000000000000000000000000									1 1														
CB C9	E.3	! !																								
CR1	C, 2	U1	C, 3																							
CR3	B, 3	VA1 VA2	D. 3 D, 3																							
CR5 CR6	B. 2						Ī						Ī													
CR1 CR3 CR5 CR5 CR6 CR7 CR8 CR81 CR11 CR112	0.000000000000000000000000000000000000										l				ľ											
CR10 CR11	C, 2																									
1							İ						Ì													
F2	E ,A 2 ,A						}				- 1		- 1		ŀ											
F1 F2 F3 F4 F5	A, 3 A, 2 A, 3 B, 3 B, 2														l											
I .	t 1								- 1																	
J1 J2 J3 J4	D, 3 B, 3 A, 3 D, 2								i						i		1									
Ki	E.A				Ì								İ													
0:	р, з												•				l									
															7		7									
						<				A 1	7, A	18 MC	DULE	E	5 L	]										
							SE	E REVERS	E SIDE						SEE REVERSE SIDE											

#### Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2.  $\sqrt{1}$  is a sense ground. It is a printed circuit trace, independent of ground plane, originating from a chassis screw on At8.
- 3. Do not apply power at test points.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.



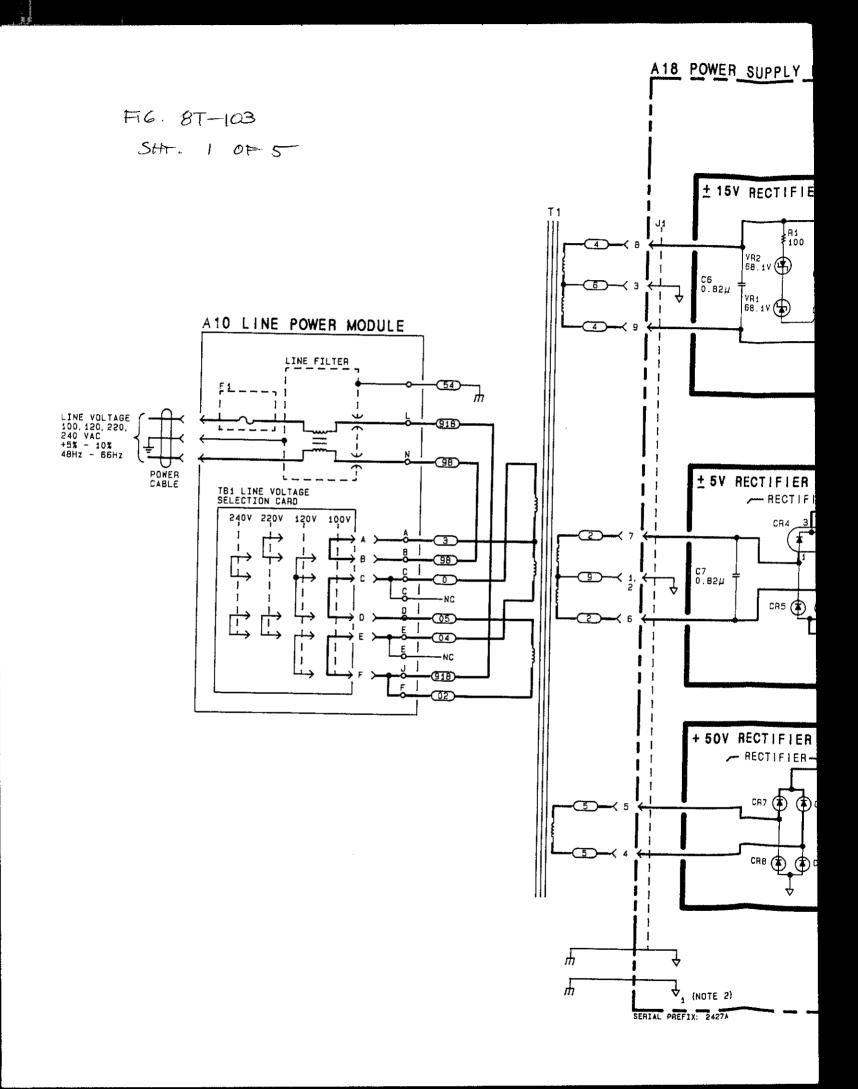


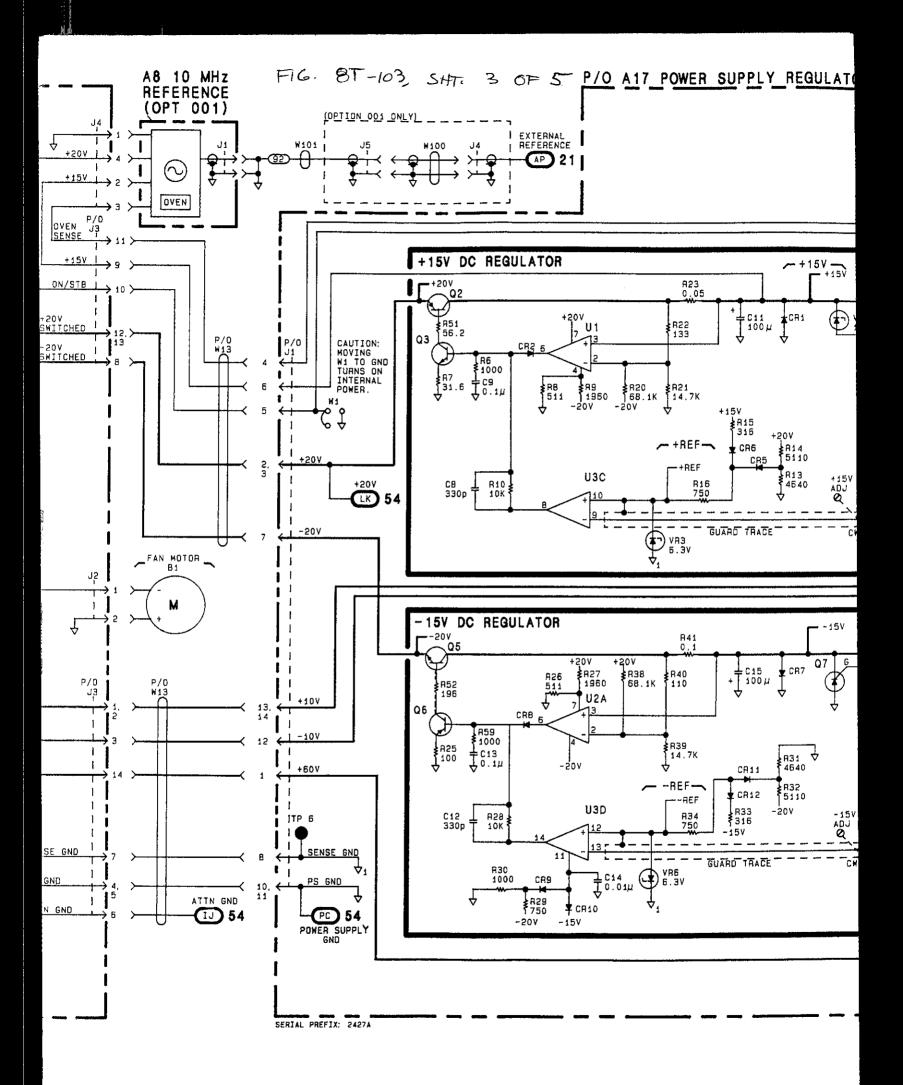
# **CHANGES**

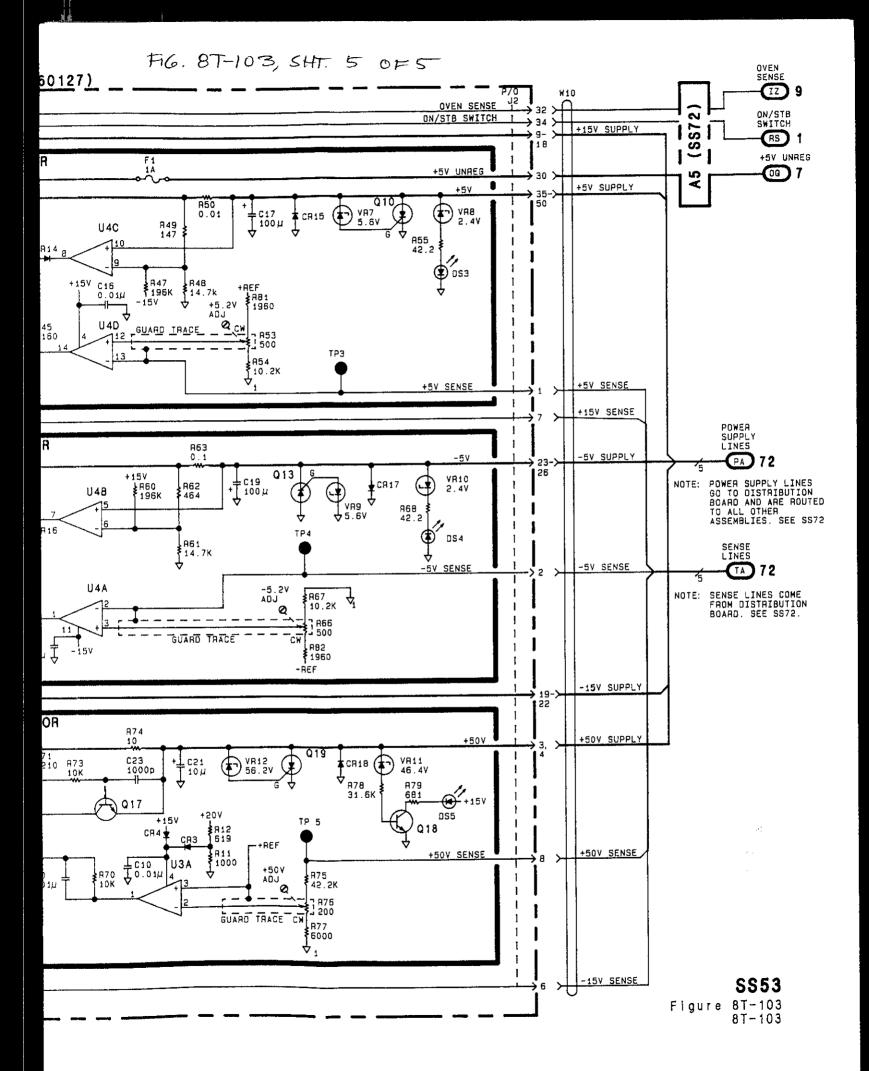
#### 2533A and above A-1112 (A120) ... - 1,500,000,000,000,000,000,000,000

 On the schematic:

◆ A17R84 - In +50V DC REGULATOR, add a resistor from the collector to the emitter of Q15. Designate it R84 and assign a value of 1K ohms. Note that the component locator for A17 is on page 8T-104, and that R84 is mounted to the back of the board directly under Q14.





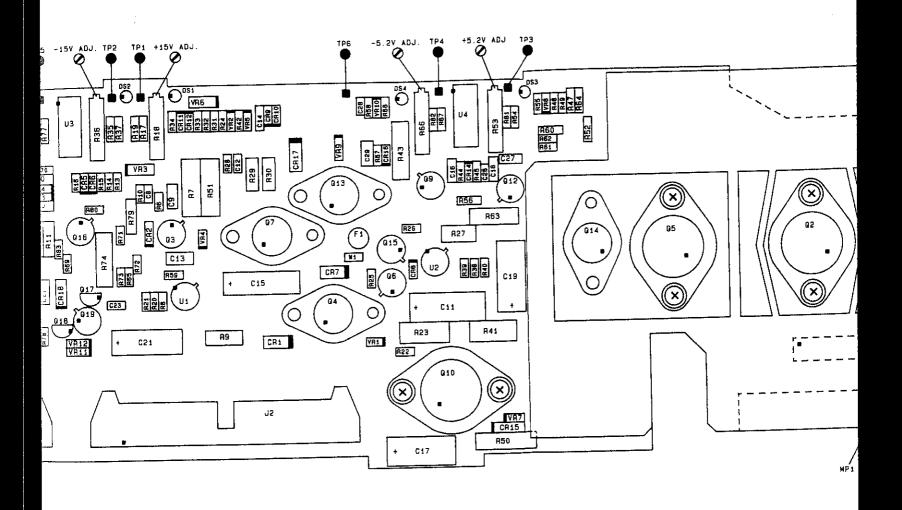


В

Figure 8T-104. SERVICE SHEET 54 INFORMATION

X

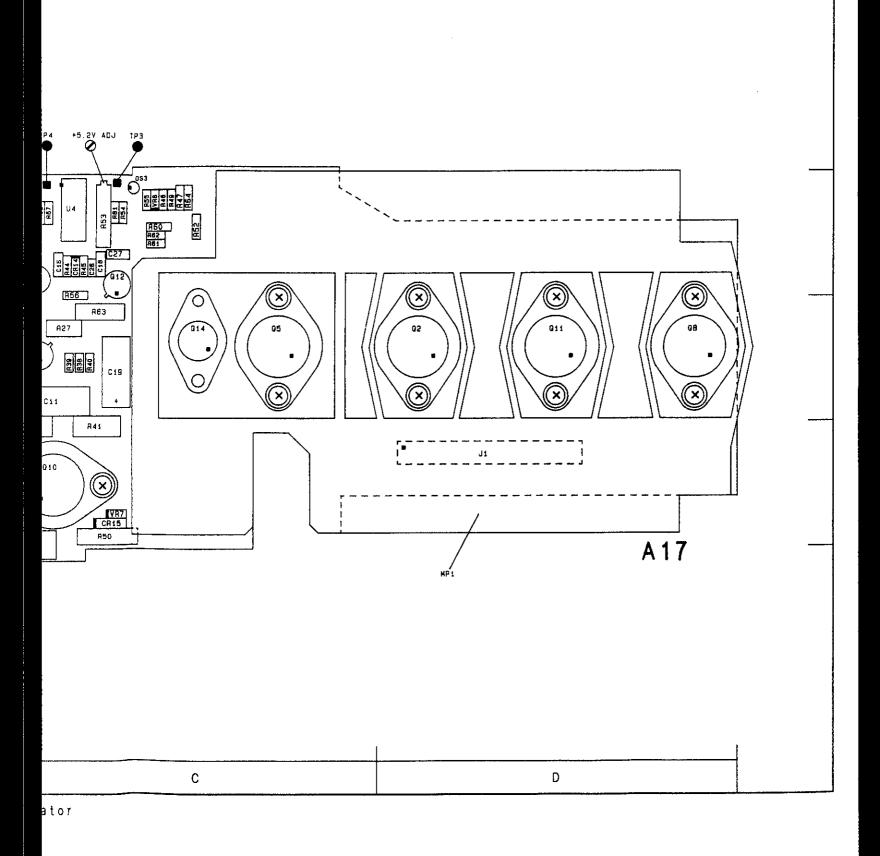
Α

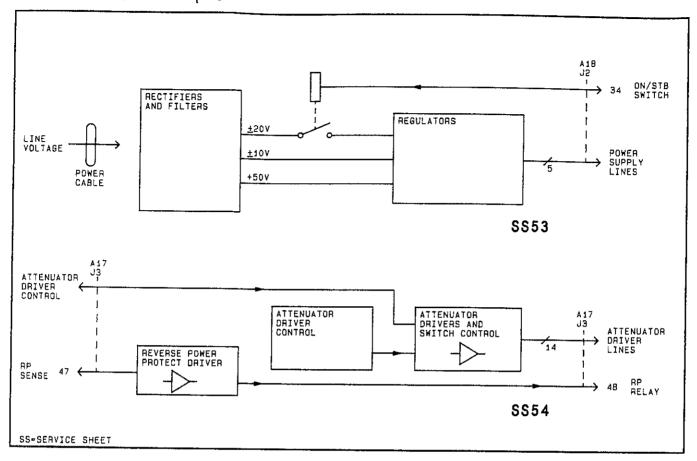


В

С

FIG. 8T-104 SHT. 3 0= 5





Reference Block Diagram

# Component Coordinates

COMP X,	У СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y	СОМР	X,Y
CB B. 21 CC11 B. 21 CC12 B. 21 CC12 B. 21 CC13 B. 21 CC14 B. 21 CC14 B. 21 CC15 CC. A. 32 CC16 CC. A. 32 CC26 CC27 CC28 B. 11 CC102 A. 11 CC103 A. 11 CC106 A. 12 CC107 CC109 A. 12 CC107 CC109 A. 12 CC107 CC108 A. 12 CC108 A. 13 CC108 A. 12 CC108	C120 C121 CR1 CR2 CR3 CR5 CR6 CR7 CR9 CR10	AAA BBAABBBBBBBCCBBB BBCBA B DBA D	02 03 04 05 06 07 08 09 011 012 013 014 017 019 019 019 017 019 017 018 017 018 019 017 019 019 019 017 019 019 019 019 019 019 019 019 019 019		R23 R24 R24 R256 R27 R30 R312 R33 R33 R35 R35 R35 R35 R35 R35 R35 R35	0.000000000000000000000000000000000000	R61 R623 R64 R65 R667 R667 R71 R72 R77 R77 R77 R78 R79 R79 R801 R801 R801 R104 R104 R105 R107 R106 R107 R107 R108 R107 R108 R107 R108 R108 R109 R109 R109 R109 R109 R109 R109 R109		R117 R118 TP1 TP2 TP3 TP4 TP5 TP6 U1 U2 U3 U4 U1004 U1005 U1007 U110 U1112 U1113 U1114 U1115 U1117 U1116 U1117 U1119 U1120 U1121	A.A. B.B.C.C.A.B. B.C.B.C.A.A.A.A.A.A.A.A.A.A.A.A.A.A.A.A.	VR12944567VR90VR90VR90VR90VR90VR90VR90VR90VR90VR90	BBBBBBCCBBBBBAA BAA				

P/O A17, A18 SEE REVERSE SIDE P/O REG/ATTEN
DRIVER MODULE,
POWER SUPPLY
RECTIFIER/FILTER ASSY

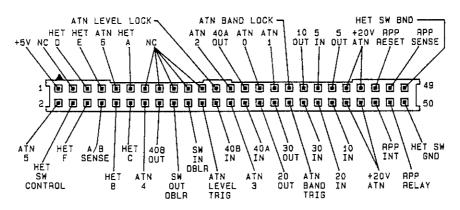
**SS53** 

Model 8642A/B

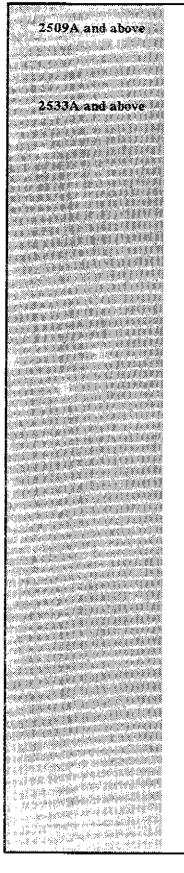
## Notes:

- Each module in the HP 8642 has a nine digit module identification code. The first four digits comprise the module configuration code. When servicing a module, note any changes that apply specifically to its module configuration code.
- 2. Do not apply power at test points.
- 3. W2, W3 are post type jumpers. To open line pull top connector away.
- All circuit boards are manufactured using a hot air leveled process. These boards require extra care when replacing components. Refer to General Service Information, paragraph 8-3.

### CABLE PLUG TO A17 J3



## **CHANGES**

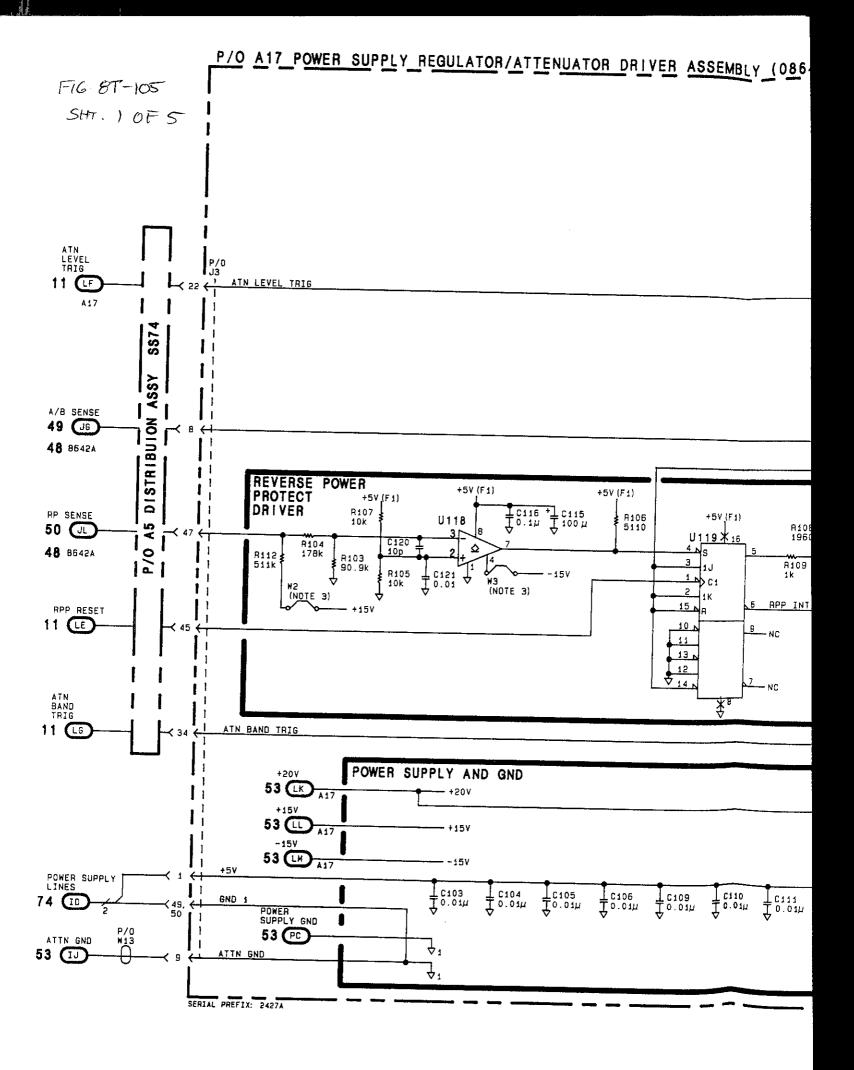


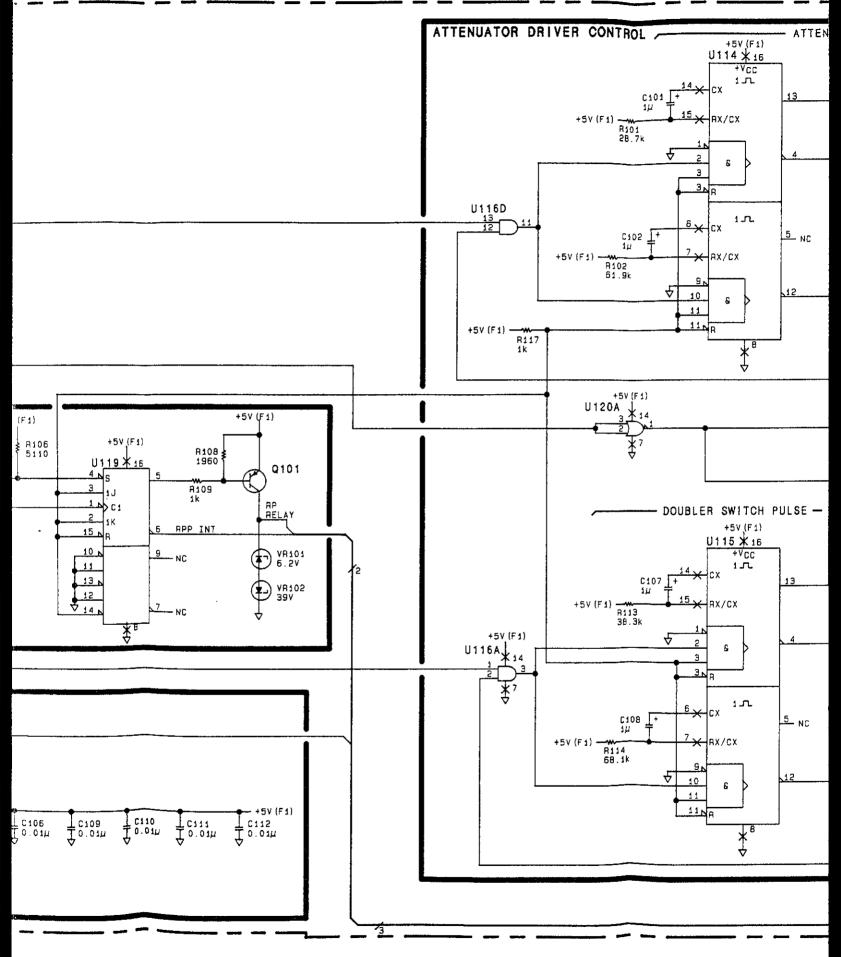
On the schematic:

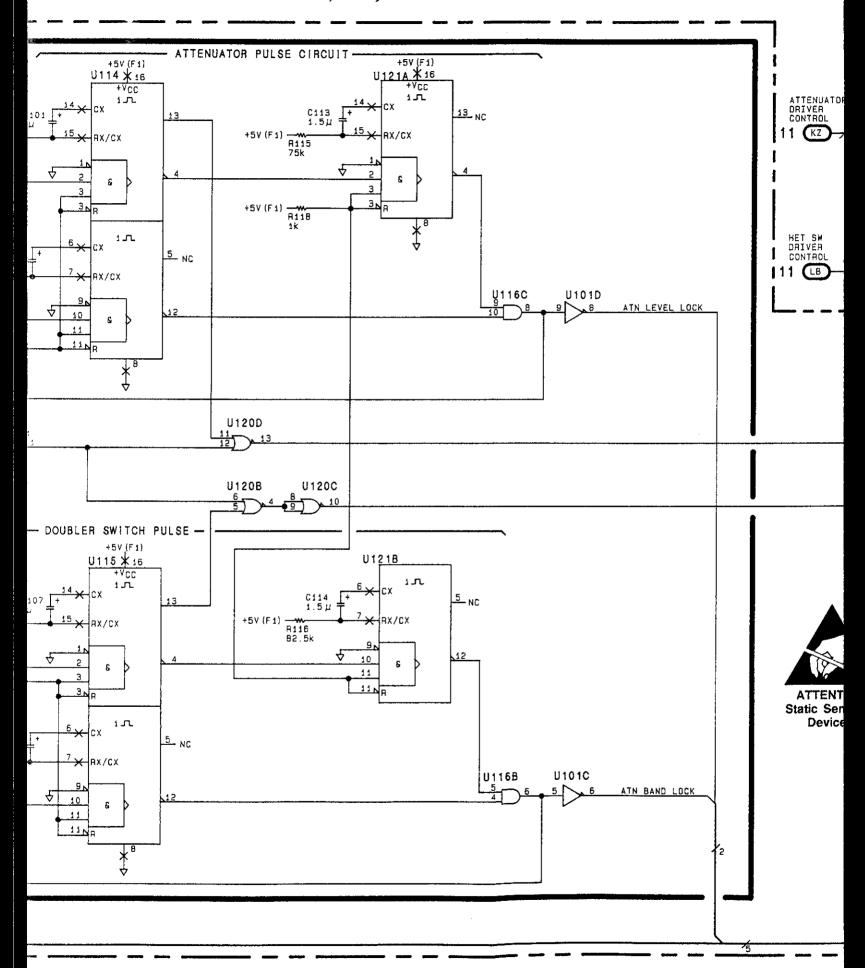
 <u>R113, R114, R116</u> - In ATTENUATOR DRIVER CONTROL, change R113 to 56.2K, R114 to 82.5K, and R116 to 56.2K.

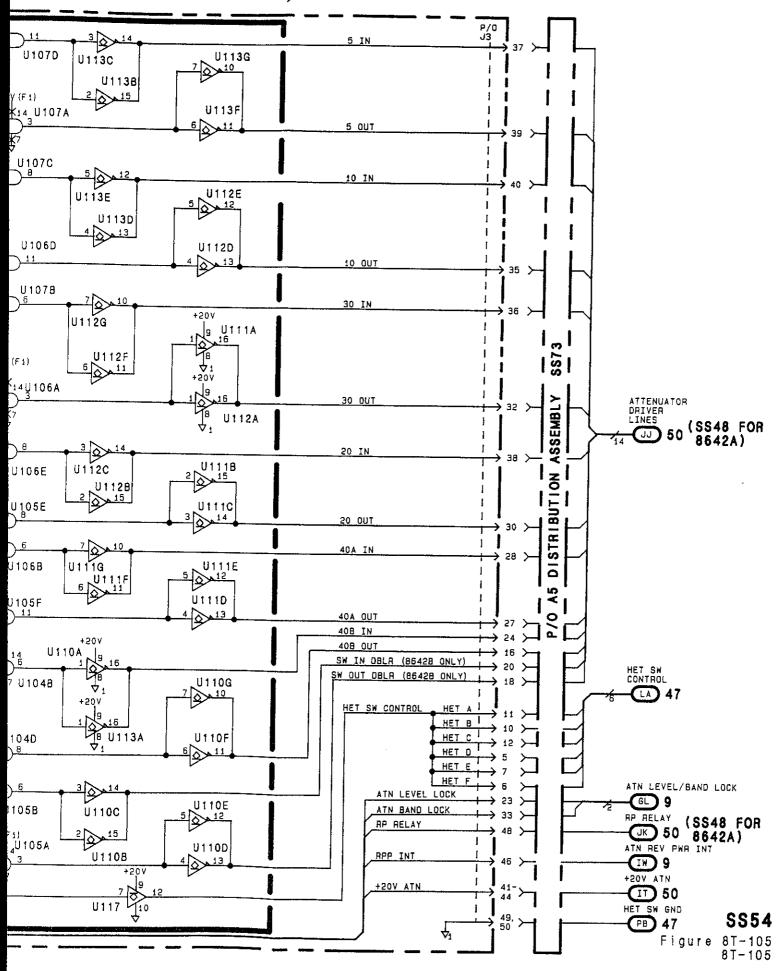
On the Component Locator:

• A17R84 - Add R84 to the center of Q14 and indicate that it is attached to the back of the board.









A5 Distribution Assembly

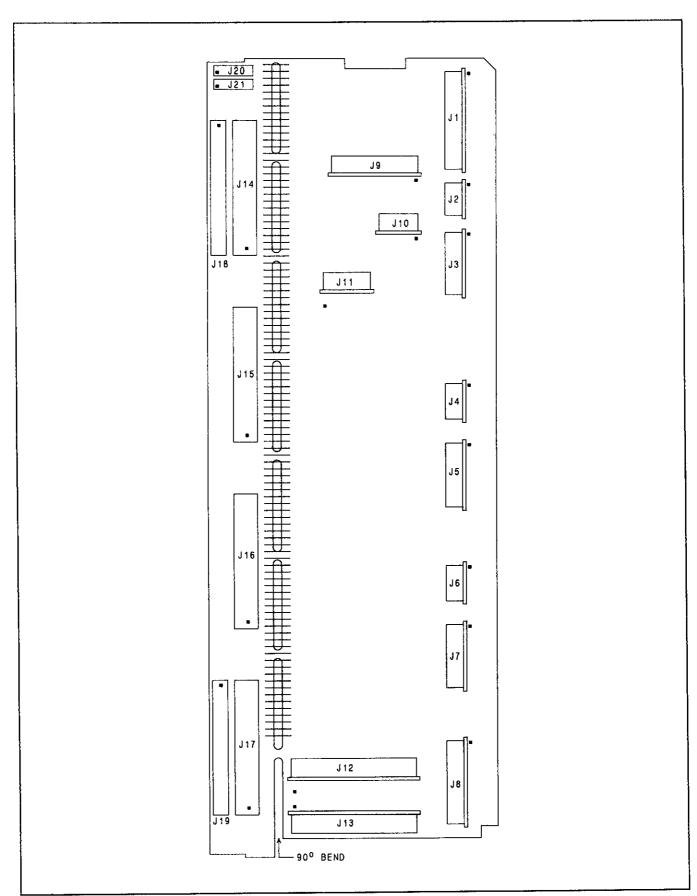


Figure 8U-100 Component Locator

P/O A5 POWER SUPPLY/DIGITAL DISTRIBUTION ASSEMBLY (08642 - 60126)W15 P/0 J14 P/0 J9 SIO(H) > SIO (H) В 6 SI1 (H) > SI1 (H) 10 5 SI2 (H) S15 (H) 11 13 P/0\_J10 513 (H) SI3 (H) ₹ 12 16 J9 LCD SERIAL LCD SERIAL SI4(H) 12 SI4(H) IN DATA 15 IN DATA SI5 (H) 11 > SI5 (H) 11 (10 17 **(**[[] 2 SI6 (H) S16 (H) 19 1 SI7 (H) > SI7 (H) 23 10 SIB(H) SIB (H) 7 SI9 (H) > SI9 (H) Q SI 10 (H) > SI 10 (H) RESET KEYS (L) 13 RESET KEYS (L) 11 💷 46 32 (LJ) 2 ON/STB SWITCH ON/STB SWITCH P/0 J12 53 (RS) 46 (RS) 1 LCD DRIVER INPUTS LCD DRIVER INPUTS P/0\_J14 C (H) /D (L) > C (H) / D (L) 11 (II) **く 16 - (11)** 2 CSALL (L) CSALL (L) 20 SCK (L) SCK (L) 18 P/0.J10 > KEYBOARD 30 RESET LCD (L) KEYBOARD RESET LCD (L) MATRIX LINES 21 14 MATRIX LINES P/0 J9 COL 0 COL 0 9 (AX) 14 (AX) 1 25 COL 1 COL 1 30 15 COL 2 COL 2 31 18 COL 3 COL 3 32 COL 4 > COL 33 27 > COL 34 NOW O ROW 0 37 17 HOW 1 NOW 1 38 20 > ROW 2 ROW 2 39 16 E WOR > ROW 3 40 23 ROW 4 NOW 4 41 24 ROW 5 > RON 5 42 21 NOM 6 ROW 6 43 22 A1A1 NOW 7 ROW 7 RESET RPG (L) 44 20 RESET APG (L) 11 💷 25 19 (II) 2 KEY DWN (L) KEY DWN (L ဂ 9 IK (IK) 2 45 31 RPG DIR APG DIA 9 EM (EM) 2 28 RPG CHANGE (L) RPG CHANGE (L) 9 26 (HW) 2 P/0 Ji9 22 P/D J14 P/0\_J10 4 (HW X 1 22 1 HP-IB SWITCH OUTPUTS Χ2 ХZ HP-IB 14 SWITCH OUTPUTS ΣХ 6 3 16 16 9 (AD 5 4 AD 2 8. "8" 4 5 -4" \*4\* 3 6 \*2\* 2 LCD LIGHT ON LCD LIGHT ON 1 8 P/0 J16 11 KY BUSY (L) 5 13 (KY) 2 DISP BUSY (L) P/0 J14 9 (FH **≺** 24 (FH) 2 15 > +5V SUPPLY →9, 10 > +5V SUPPLY POWER SUPPLY AND GND 72 (TD) A5 (BT) 1 11, > GND Т -57 (BX) 2 -5V SUPPLY P/0\_J9 **SS55** 72 (TE Figure 8U-101

SERIAL PREFIX: 2427A

8U-101

